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DC 510 UNIVERSAL COUNTER/TIMER With Options

INSTRUCTION MANUAL

Tektronix, Inc. P.O. Box 500 Beaverton, Oregon 97077

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TABLE OF CONTENTS

		Page			Page
LIST OF ILL	USTRATIONS	iii	Section 2	OPERATING INSTRUCTIONS (cont)	
LIST OF TA	BLES	iii		Ratio B/A	2-11
OPERATOR	S SAFETY SUMMARY	iv		Width A and Time A → B (Time	
SERVICE S	AFETY SUMMARY	V		Interval)	2-11
				Null	2-12
				Events B During A	2-12
Section 1	SPECIFICATION			Time Manual	2-12
	Instrument Description			Totalize A	2-12
	Instrument Options	1-1		Totalize A+B	2-13
	Standard Accessories	1-1			2-13
	Performance Conditions	1-1		Risetime A and Falltime A	2-13
	Safety Certification	1-1		Probe Compensation	2-14
	Electrical Characteristics	1-2		Test Function	2-14
	Miscellaneous	1-12		Arming (ARM Input)	2-15
	Environmental	1-12			
	Physical Characteristics	1-13			
Section 2	OPERATING INSTRUCTIONS				
	Introduction	2-1	m	WARNING	
	First Time Inspection	2-1	://:CO.	WARNING	
	Repackaging for Shipment	2-1	OKIII.		
	Operating and Non-Operating	20.5	THE FO	OLLOWING SERVICING INSTRUCTION	
	Environments	2-100	ARE FO	R USE BY QUALIFIED PERSONNEL ONL	
	Preparation For Use	⊘2-1	TO AVO	ID PERSONAL INJURY, DO NOT PERFOR	
	Introduction. First Time Inspection Repackaging for Shipment Operating and Non-Operating Environments Preparation For Use Rear Interface Considerations Installation and Removal	2-1	ANY SE	RVICING OTHER THAN THAT CONTAINE RATING INSTRUCTIONS UNLESS YOU AF	
	Installation and Removal	2-1	OUALIE	IED TO DO SO.	1L
	Front Panel Operation		GOALIII	12D 10 D0 30.	
	Front Panel Display	2-3			
	Display	2-3			
	Front Panel Controls	2-3			
	Front Panel Connectors	2-3			
	Front Panel Push Buttons	2-5	2 5 2		
	Operators Familiarization	2-7	Section 3	THEORY OF OPERATION	
	Introduction	2-7		Block Diagram Description	
	General Operating Characteristics	2-7		Detailed Circuit Description	3-3
	Self Test Display	2-7			
	Input Considerations	2-8			
	Maximum Safe Input Voltage				
	Limits	2-8			
	Connecting External and Internal				
40	Signal Sources	2-8	Section 4	CALIBRATION	
	Measurement Considerations	2-8		Performance Check Procedure	4-1
	Input Coupling, Noise, and			Introduction	4-1
	Attenuation	2-8		Calibration Interval	4-1
	Triggering the Counter	2-9		Service Available	4-1
	Reducing Measurment Errors			Test Equipment Required	4-1
	Measurement Examples			Preliminary Control Settings	4-3
	Frequency A and Period A			Adjustment Procedure	4-15

TABLE OF CONTENTS (cont)

		Page			Page
Section 4	CALIBRATION (cont)		Section 5	MAINTENANCE (cont)	
	Introduction	4-15		Diagnostics	5-8
	Test Equipment Required	4-15		Introduction	
	Preliminary Control Settings	4-15		Equipment Required	-
	Preparation	4-15		Adjustment and Test Point	
Section 5	MAINTENANCE			Locations	
occuon 5	Static-Sensitive Components	5-1		Self Test	5-8
	Test Equipment			TEST Function	
	Circuit Board Removal and	5 -1		Troubleshooting	
	Replacement	5-1		Signature Analysis	
	Magnetic Latch Relays			Introduction	
	Cleaning Instructions			Internal Signature Analysis	
	Obtaining Replacement Parts			Kernel Signature Analysis Selected Components (R1307 and	
	Ordering Parts	5-4		R1326)	
	Soldering Techniques	5-4		***************************************	(500)
	Interconnecting Pins	5-5			
	Square Pin Assemblies		Section 6	OPTONS	
	Bottom Entry and Side Entry		Section 6	Option 01	6-1
	Circuit Board Pin Sockets	5-5	Kill.	option of	•
	Multipin Connectors	5-5	SC.		
	Rear Interface Connectors	5-7	Section 7	REPLACEABLE ELECTRICAL PARTS	
	Introduction	5-7			
	Functions Available at Right Rear	0	Section 8	DIAGRAMS AND ILLUSTRATIONS	
	Interface Connector (P1600)Q	5-7	Section 6	DIAGRAMS AND ILLUSTRATIONS	
	Functions Available at Left Rear				
	Interface Connector (P1820)	5-8	Section 9	REPLACEABLE MECHANICAL PARTS	

(a)

LIST OF ILLUSTRATIONS

Fig. No.		Page
2-1 2-2	Plug-in installation and removal DC 510 front panel display, controls and	2-2
	connectors	2-4
2-3 2-4	Advantages in signal attenuation Typical triggering levels and sources of	2-9
2-4	triggering errors	2-10
2-5	Measurement examples for WIDTH A and	2 10
2-5	TIME A-B	2-11
2-6	Measurement example for synchronous	
2-0	input signals	2-12
2-7	Measurement example, EVENTS B	
2-7	DURING A	2-13
2-8	Measurement example for risetime	2-13
2-9	Examples of arming	2-16
4-1	Performance Check setup for step 3	4-4
4-2	Performance Check setup for steps 4 and 7	
4-3	Performance Check setup for steps 5 and 14	100
4-4	Performance Check setup for step 6	4-7
4-5	Performance Check setup for steps	
4.5	8,9,10,11,12, and 13.	4-9
4-6	Performance Check setup for step 15	4-13
5-1	Circuit boards removal and replacement	5-2
5-2	Method of removing magnetic latch relay	-
0-2	armature	5-4
5-3	Typical square pin assembly	5-5
5-4	Bottom entry circuit board pin socket	5-5
5-5	Orientation and disassembly of multipin	
0-0	connectors	5-6
5-6	Right rear interface connector assignments	5-7
5-7	Left rear interface connector assignments .	5-8
5-8	Kernel signature analysis connections	5-11

LIST OF TABLES

Table No.		Page
1-1	Electrical Characteristics	1-2
1-2	Miscellaneous	1-12
1-3	Environmental	1-12
1-4	Physical Characteristics	1-13
2-1	Front-Panel Display Error Codes	2-8
4-1	List of Test Equipment Requirements	4-2
5-1	Relative Susceptibility to Static Discharge	
	Damage	5-1
5-2	RAM and ROM Test Sequence	5-9

OPERATORS SAFETY SUMMARY

The general safety information in this part of the summary is for both operating and servicing personnel. Specific warnings and cautions will be found throughout the manual where they apply, but may not appear in this summary.

TERMS

In This Manual

CAUTION statements identify conditions or practices that could result in damage to the equipment or other property.

WARNING statements identify conditions or practices that could result in personal injury or loss of life.

As Marked on Equipment

CAUTION indicates a personal injury hazard not immediately accessible as one reads the marking, or a hazard to property including the equipment itself.

DANGER indicates a personal injury hazard immediately accessible as one reads the marking.

SYMBOLS

In This Manual



This symbol indicates where applicable cautionary or other information is to be found.

As Marked on Equipment



DANGER - High voltage.



Protective ground (earth) terminal.



ATTENTION - refer to manual.

Power Source

This product is intended to operate from a power module connected to a power source that will not apply more than 250 volts rms between the supply conductors or between either supply conductor and ground. A protective ground connection by way of the grounding conductor in the power cord is essential for safe operation.

Grounding the Product

This product is grounded through the grounding conductor of the power module power cord. To avoid electrical shock, plug the power cord into a properly wired receptacle before connecting to the product input or output terminals. A protective ground connection by way of the grounding conductor in the power module power cord is essential for safe operation.

Danger Arising From Loss of Ground

Upon loss of the protective-ground connection, all accessible conductive parts (including knobs and controls that may appear to be insulating) can render an electric shock.

Use the Proper Fuse

To avoid fire hazard, use only the fuse of correct type, voltage rating and current rating as specified in the parts list for your product.

Refer fuse replacement to qualified service personnel.

Do Not Operate in Explosive Atmospheres

To avoid explosion, do not operate this product in an explosive atmosphere unless it has been specifically certified for such operation.

Do Not Operate Without Covers

To avoid personal injury, do not operate this product without covers or panels installed. Do not apply power to the plug-in via a plug-in extender.

SERVICE SAFETY SUMMARY

FOR QUALIFIED SERVICE PERSONNEL ONLY

Refer also to the preceding Operators Safety Summary.

Do Not Service Alone

Do not perform internal service or adjustment of this product unless another person capable of rendering first aid and resuscitation is present.

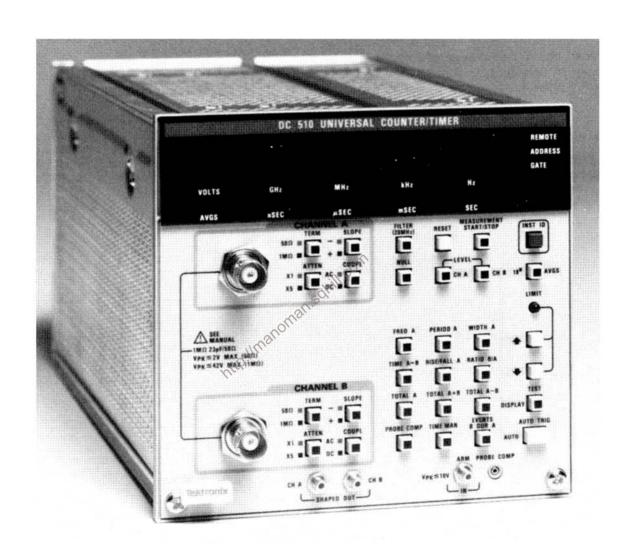
Use Care When Servicing With Power On

Dangerous voltages may exist at several points in this product. To avoid personal injury, do not touch exposed connections and components while power is on. Disconnect power before removing protective panels, soldering, or replacing components.

Power Source

This product is intended to operate in a power module connected to a power source that will not apply more than 250 volts rms between the supply conductors or between either supply conductor and ground. A protective ground connection by way of the grounding conductor in the power cord is essential for safe operation.





DC 510 Universal Counter/Timer.

SPECIFICATION

Instrument Description

The TEKTRONIX DC 510 is a universal counter/timer plug-in. It features reciprocal Frequency, Period, Ratio, and Events B During A measurements to 350 MHz. For timing measurements, the Time Interval, Width, Risetime and Falltime functions feature 3.125 nsec single-shot resolution. For these measurements, averaging and identical A and B channels provide increased accuracy. Also included is a time manual mode, as well as three 350 MHz Totalize modes (A, A+B, and A-B). The DC 510 also has an auto-trigger feature, a probe-compensation feature, an auto averages function, and an extensive set of automatic power-up self tests.

The DC 510 has a DVM mode that reads out the channel A and channel B trigger level voltages. Shaped outputs and an arming input are available at the front panel. Also available at the front panel is a signal for use with the probe compensation function.

The DC 510 can be equipped with an optional, oven-controlled, 10 MHz crystal oscillator to obtain an even more stable and precise internal time base.

A GPIB conversion kit (Field Modification Kit 040-1023-00) for the DC 510 is available from Tektronix, Inc.

Instrument Options

Option 01 replaces the internal 10 MHz time base (clock) circuit with a self-contained proportional temperature controlled oven oscillator for increased accuracy and stability.

Standard Accessories

- 1 Instruction Manual
- 1 Cable Assembly, bnc-to-slide on connector
- 1 Reference Guide

NOTE

Refer to the tabbed Accessories page at the rear of this manual for more information.

Performance Conditions

The limits stated in the Performance Requirements columns of the following tables are valid only if the DC 510 has been calibrated at an ambient temperature between +20°C and +30°C and is operating at an ambient temperature between 0°C and +50°C, unless otherwise stated.

information given in the Supplemental Information and Description columns of the following tables is provided for user information only and should not be interpreted as Performance Check requirements.

The DC 510 must be operated or stored in an environment whose limits are described under Environmental Characteristics.

Allow at least 30 minutes warm-up time for operation to specified accuracy, 60 minutes after storage in a high-humidity environment.

Safety Certification

This instrument is listed with Underwriters Laboratories, Inc. under UL Standard 1244 (Electrical and Electronic Measuring and Testing Equipment).

Table 1-1
ELECTRICAL CHARACTERISTICS

Characteristics		Performance Requirements		Supplemental Information
CHANNEI	A and CHA	Rise/Fall MEASUREMENT MO	ODE INPUT SPECIFICATION)	
Input Frequency Coupling DC AC	Range	50 Ω >0 to ≥350 MHz 100 kHz to ≥350 MHz	1 MΩ >0 to ≥300 MHz 16 Hz to ≥300 MHz	
Input Sensitivity Sinewave		50 Ω (Term low)	1 MΩ (Term high)	1 M Ω performance is from a 25 Ω source impedance.
Coupling	Attenuation			Typical sensitivity is 50 mV p-p ± 20 mV.
DC	X1	<25 mV rms <70 mV p-p pulse	≤25 mV rms to 200 MHz ≤42 mV rms from 200 MHz to 300 MHz ≤70 mV p-p pulse	
			(<200 MHz)	
	Х5	≤125 mV rms	<125 mV rms to 200 MHz <210 mV rms from 200 MHz to 300 MHz	
		≤350 mV p-p pulse	≤350 mV p-p pulse	
AC	X1			
	Х5	<125 mV rms +3 dB at <100 kHz <350 mV p-p pulse	≤125 mV rms to 200 MHz 210 mV rms to 300 MHz +3 dB at ≤16 Hz ≤350 mV p-p pulse (≤200 MHz)	
Dynamic Range Attenuation X1				70 mV p-p to 4 V p-p
X5				350 mV p-p to 20 V p-p
Trigger Level Rai Attenuator X1	nge	>+2 V to ≤-2 V	10.0	In approximately 4 mV steps.
X5		≥+10 V to ≤-10 V		In approximately 20 mV steps.
Trigger Level Accuracy	***************************************	±1% of full scale trigger ±2% of reading for a do	1. The state of th	Trigger level is calibrated in + slope and is firmware compensated in - slope.

Table 1-1 (cont)

Characteristics		Performance Requirements	Supplemental Information
CHANNEL A and CHANNEL B INPUTS (also see Rise/Fall MEASUREMENT M			MODE INPUT SPECIFICATION) (cont)
Auto Trigger Range (A or B)		10 Hz to ≥350 MHz Minimum signal required for Auto Trigger is 100 mV p-p.In Ratio mode, with Channel B frequency ≥200 MHz, the Auto Trigger will provide a CHA B level within ±24 mV of the 50% point.	Trigger point is set (once) to a nominal 50% of the p-p input signal. For signals dc to 10 Hz (inclusive), level will still be set between 0% and 100%, but not necessarily near 50%. A ten-bit DAC is used, giving nominal 4 mV steps (X attenuation factor).
Operating Range Attenuation X1		+2 V to -2 V (dc + peak ac)	
X5		+10 V to -10 V (dc + peak ac)	
AC Coupling	1,-	50 Ω input dc \leq \pm 2 V (dc plus peak ac) times attenuator 1 M Ω input \leq 42 V dc $+$ peak ac	
Maximum Allowa (Damage Level)	ble Input	V _{pk} ≤2 V http://manoman.sqhill.com	In 50 Ω input mode, 50 Ω overvoltage protection trips in 1 M input impedance for signals greater than approximately ± 2 V times attenuator dc + peak ac to 200 kHz.
	Impedance 50 Ω	V _{pk} ≤2 V nttp://mat	dc to 350 MHz
X1	1 ΜΩ		±42 V dc + peak ac, dc to 200 kHz ±2 V dc + peak ac, 2 MHz to 300 MHz
-	50 Ω	V _{pk} ≤10 V	\pm 10 V dc + peak ac, dc to 350 MHz
X5	1 ΜΩ		\pm 42 V dc + peak ac, dc to 1 MHz \pm 10 V dc + peak ac, 1 MHz to 300 MHz
Input Impedance	50 Ω	50 Ω approximately $\pm 3\%$ dc	VSWR approximately 1.5:1, dc to 350 MHz
	50 Ω ac		Bleeder resistor results in \approx 390 k Ω dc input resistance.
	1 ΜΩ	1 M Ω approximately \pm 1% 23 pF approximately \pm 10% (2.2 pF)	For inputs greater than ±5 Vdc + peak ac, input impedance becomes approximately 300 kΩ 1000 pF, X1. Input C from X1 to X5 are equal by
REV OCT 1981			approximately ±1%.

Table 1-1 (cont)

Characteristics	Performar	nce Requirements	Supplemental Information
CHANNEL A and CHA	NNEL B INPUTS (also see Ri	se/Fall MEASUREMENT N	NODE INPUT SPECIFICATION) (cont)
Bandwidth Limit			Above 20 MHz minimum signal increases 40 dB/decade to ≈1 V p-p Above approximately 80 MHz no amount of input signal can cause triggering.
Channel Isolation, Crosstalk			A ≤4 volt p-p signal into CH A will not cause triggering in CH B and vice versa.
	RISE/FALL MEASUREM	ENT MODE INPUT SPECI	FICATION
Range Coupling	50 Ω	1 ΜΩ	In this mode, the input amplifiers are commoned to the CH A bnc. CH B bnc is an open circuit.
DC	4.0 nsec to 2.5 × 10 ⁴ sec	5 nsec to 2.5×10^4 sec	CH B bric is an open circuit.
AC	4.0 nsec to 18 μsec	5 nsec to 22 msec	AC measurements near the slower limit are not recommended, be- cause they become duty cycle dependent.
Prequency DC	50 Ω >0 to >80 MHz,\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\	>0 to >80 MHz	Upper frequency limit is essentially a limit on the repetition rate at which rise/fall edges may occur.
AC	100 kHz to >80 MHz	16 Hz to >80 MHz	
Input Sensitivity Coupling Attenuation	50 Ω	1 ΜΩ	1 M Ω response is from 25 Ω source impedance.
DC X1	50 mV rms 140 mV p-p pulse	25 mV rms 70 mV p-p pulse	Both channel modes set the same.
X5	250 mV rms 700 mV p-p pulse	125 mV rms 350 mV p-p pulse	50 Ω input impedance is maintained via an internal powersplitter causing X2 attenuation.
X1	50 mV rms +3 dB at 20 kHz 140 mV p-p pulse	25 mV rms +3 dB at 16 Hz 70 mV p-p pulse	These specifications apply when both channels have the same setup.
Х5	250 mV rms +3 dB at 20 kHz 700 mV p-p pulse	125 mV rms +3 dB at 16 Hz 350 mV p-p pulse	

1-4 REV OCT 1981

Table 1-1 (cont)

Characte	eristics	Performa	ance Requirements	Supplemental Information
		RISE/FALL MEASUREMENT MODE INPUT SPECIFICATION (cont)		FION (cont)
Dynamic Range	// // // // // // // // // // // // //			
,		50 Ω	1 ΜΩ	
Attenuation	X1	140 mV p-p to	70 mV p-p to 4 V p-p	Maxima are centered at zero
		8 V p-p		volts. Minimum measurable
				rise/fall signal amplitude is ten
	X5	700 mV p-p to	350 mV p-p to	times greater than
		10 V p-p	20 V p-p	minimum dynamic range.
Trigger Level Ra	inge		-	50 Ω , \times 5, only \pm 5 V of the
				trigger level range is usable
		50 Ω	1 ΜΩ	because only ±5 V is allowed
				as an input.
Attenuation	X1	+4 V to -4 V	+2 V to −2 V	
		≈8 mV steps	≈4 mV steps	When using 50 Ω input mode,
			140.00	the displayed trigger level
	X5	(+5 V to −5 V)		is 1/2 true trigger level due
		+20 V to -20 V	+10 V to -10 V	to 50 Ω power splitter divider
		≈40 mV steps	≈20 mV steps	action.
Operating Range	9			
Attenuation		50 Ω	1 ΜΩ	For 10% and 90% trigger point.
			y com	For inputs less than minimum,
	X1	1.4 V p-p	700 mW n-n	10% and 90% points are not
		minimum, +4.V to	minimum, +2 V to	achievable due to sensitivity.
		-4 V dc + peak	2 V dc + peak	Mimimum signal is 10 times
		ac max	minimum, +2 V to 2 V dc + peak ac max	minimum dynamic range.
	X5	7.0 V p-p	3.5 V p-p	
		minimum, +5 V to	minimum, +10 V to	
		-5 V dc + peak	-10 V dc + peak	
		ac max	ac max	
Maximum Allowa	able Input			
(Damage Level)	2004 S 100 F 30 S			
Attenuation Im	pedance			
X1	50 Ω			±4 V dc + peak ac, dc to 80 MHz
	1 ΜΩ			See CHANNEL A and CHANNEL B
				inputs
X5	50 Ω			±5 V dc + peak ac, dc to 80 MHz ^a
	1 mΩ			See CHANNEL A and CHANNEL B
				inputs
Input Impedance			11.1 (1)	Channel B is an open circuit.
Channel A				
	1 ΜΩ	500 kΩ, ±2%		X5 probe becomes X9
		47 pF, ±10%		X10 probe becomes X19
	50.0			+
	50 Ω	50 Ω, ±3%		

Adjustment Resolution

 $\pm 5 \times 10^{-8}$

Table 1-1 (cont)

Table 1-1 (cont)				
Characteristics	Performance Requirements	Supplemental Information		
	GENERAL			
Probe Compensation Output Jack		5 V p-p nominal. 110 Hz nominal. 1 ms width nominal.		
Arming Input Required Signal Input	low ≤0.4 volts high ≥2.4 volts (TTL)	Maximum voltage V _{pk} <10 volts.		
Pulse Response	Pulse width ≥100 ns			
Shaped Output		≥100 mV typically to 350 MHz into 50 Ω load. Delay from front-panel input to shaped output		
	19	CH A 7.2 nsec typically CH B 7.0 nsec typically CH B commoned from CH A 7.6 nsec typically.		
External Clock Input	\geqslant 500 mV rms into 1 k Ω (ac coupled) 1, 5, or 10 MHz			
10 MHz Clock Output	low ≤0.4 V high ≥2.4 V (TTL) (pins 15B and 15A (gnd))	Drives 1 TTL load.		
Phase Modulated Clock (time interval functions)	low ≤0.4 V high ≥2.4 V (TTL) (pins 15B and 15A (gnd))	≥3 ns p-p jitter induced onto 1 MHz reference. (Test point on rear of Auxiliary board.)		
	STANDARD INTERNAL TIME BASE			
Frequency at calibration	10 MHz $\pm 1 imes 10^{-7}$	10 MHz		
Error Terms Temperature Stability (0°C to +50°C)	±5 × 10 ⁻⁶			
Aging	≤1 X 10 ⁻⁶ /year			

1-6 **REV OCT 1981**

Table 1-1 (cont)

Characteristics	Performance Requirements	Supplemental Information
	OPTIONAL INTERNAL TIME BASE	I.
Frequency at calibration	10 MHz ±2 × 10 ⁻⁸	With proportional oven
Error terms:		
Temperature Stability (0°C to +50°C)	$\pm 2 imes 10^{-7}$ after warmup	
Warm-up Time	Within $\pm 2 \times 10^{-7}$ of final frequency in less than 10 minutes when cold started at 25°C ambient.	
Aging At time of shipping	$1 imes 10^{-8}$ /day maximum.	
After 30 days of continuous operation	4 × 10 ⁻⁸ /week maximum	
After 60 days of continuous operation.	<1 × 10 ⁻⁶ /year maximum	
Short Term Stability		<1 × 10 ⁻⁹ rms based on 60 consecutive 1 second measurements.
Adjustment Resolution	±2 × 10 ⁻⁸	
Adjustment Range	±2 × 10-8 ±2 × 10-8 phtp://manoman.sqriil.com Functions	Sufficient for 8 years of aging.
	http://mia	
Frequency A Range	≪36 μHz to ≥350 MHz	
Resolution		\pm LSD \pm 1.4 \times Trigger Jitter Error
		X (Freq. A) ²
Accuracy		Resolution ±(Timebase Error × Freq. A)
Period A		
Range	3.125 ns to 7.6 hours	
Repetition Rate	≥350 MHz	
Clock Period Counted		3.125 ns
Resolution		±LSD ^b ± 1.4 × B Trig Jitter Error
Accuracy		Resolution ±(Timebase Error) × Period A

Table 1-1 (cont)

Table 1-1 (cont)		
Characteristics	Performance Requirements	Supplemental Information
	FUNCTIONS (cont)	
Ratio B/A		Averaged by A
Range	10 ⁻⁸ to 10 ⁹ with correct decimal point displayed. (10 ⁻¹¹ to 10 ¹² without decimal point.)	
Frequency Range (A & B)	<36 μHz to ≥350 MHz	#
Resolution		\pm LSD \pm $\frac{1.4 \times B \text{ Trig Jitter Error} \times \text{Freq. B}}{N}$
Accuracy		Same as Resolution
Time A → B Range	2.0 nsec ^c to 7.6 hours	
Resolution		$\pm LSD + \frac{1}{\sqrt{N}} (\pm A \text{ Trigger Jitter Error})$ $\pm B \text{ Trigger Jitter Error})$
Accuracy		Resolution ± (Timebase Error × Time Interval) ± Channel Delay Mismatch ^d + B Trigger slew error-A Trigger slew error
Clock Period counted	ill cour	3.125 nsec
Minimum Time A → B	0.0 ± 2.0 nsec ^c	
Minimum Time B → A	≤12.5 nsec	(≽70 MHz Rep. Rate)
Channel Delay Mismatch Internal	0.0 ± 2.0 nsec ^c squill com ≤12.5 nsec ≤2 nsec nominal, without null	
Front Panel (Shaped Out)		≤500 ps
Events B Dur A		Averaged by A
Range	10 ⁻⁸ to 10 ⁹	
Maximum B Frequency	≥350 MHz	
Maximum A Frequency	≥80 MHz	
Minimum A Pulse Width	≤4.0 nsec	
Minimum A Pulse Width	≤8.5 nsec	
Resolution		$+$ LSD $+$ $\frac{\text{Freq B}}{\sqrt{N}}$ (\pm A Start Trigger Jitter error \pm A Stop Trigger Jitter Error)
Accuracy		Resolution + Freq B (Stop Slew Rate Error - Start Slew Rate Error) + Freq B × (5 ±2 nsec)

Table 1-1 (cont)

Characteristics	Performance Requirements	Supplemental Information
13200 Table 1112	FUNCTIONS (cont)	La Caraciana de Ca
Width A		
Range	<4 nsec to 7.6 hours	
Repetition Rate	≥80 MHz	
Resolution		$\pm \text{LSD} + \frac{1}{\sqrt{N}}$ ($\pm \text{Start edge Trigger}$ Jitter Error \pm Stop Edge Trigger Jitter Error)
Accuracy		Resolution ±Timebase Error × Width A + (Stop Slew Rate - Start Slew Rate Error) ±2 nsec
Clock period counted		3.125 nsec
Minimum Time Stop Edge to Start Edge	<8.5 nsec	
Totalize A Range	0 to 10 ⁹ counts	(to 8.7×10^{12} with no decimal point.)
Repetition Rate	0 to ≥350 MHz	See CHANNEL A and CHANNEL B INPUTS for pulse specifications.
Totalize ^e A+B Range	0 to 10 ⁹ (A + B ≤10 ⁹)	(to 8.7×10^{12} with no decimal point.)
Repetition Rate (A or B)	0 to ≥350 MHz	See CHANNEL A and CHANNEL B INPUTS for pulse specifications.
Totalize ^e A – B Range	0 to 10^9 (A + B ≤ 10^9) 0 to ≥350 MHz $-10^8 \text{ to } 10^9 \text{ this.}$	$(-8.7 \times 10^{12} \text{ to } 8.7 \times 10^{12} \text{ with no}$ decimal point or minus indication.)
		Note: either A $\geq 10^{12}$ or B ≥ 12 will lead to overflow, independent of the value of (A-B). See CHANNEL A and CHANNEL B INPUTS for pulse specifications.
Rise/Fall A		
Range	4.0 ns \rightarrow 7.6 hrs. (dc coupling) 50 Ω 5.0 ns \rightarrow 7.6 hrs. (dc coupling) "1 M Ω ".	Risetime of "1 M Ω " is \approx 4.5 ns
Repetition Rate	Minimum time between rising (falling) edges is 12.5 ns (80 MHz)	
Trigger Points	Trigger levels are automatically set to the 90% and 10% points of the incoming signal, to a resolution that depends on the incoming signal amplitude.	In this mode Channels A and B are commoned. This changes the input characteristics. See RISE/FALL MEASUREMENT MODE INPUT SPECIFICATION.

Table 1-1 (cont)

Characteristics	Performance Requirements	Supplemental Information
	FUNCTIONS (cont)	
Resolution		\pm LSD $+$ $\frac{1}{\sqrt{N}}$ (\pm Start Trig Jitter Error \pm Stop Trigger Jitter Error)
Accuracy		Resolution ±(Timebase Error × TI) ±2 nsec ±4 mV × slew rate A (near 10%) ±4 mV × slew rate A (near 90%)
Time Manual Range	$3.125~\mathrm{ns}$ to $3.125~\times~10^4~\mathrm{sec}$ ($pprox 8~\mathrm{hours}$)	
Resolution		3.125 nsec clock is counted, but usable resolution is $\approx \pm 10$ ms due to START/STOP buttons
Probe Comp Accuracy		×5 probe, 1.5% nominal. ×10 probe, 3% nominal. ×100 probe, 30% nominal.

Resolution and Accuracy **Definitions**

Trigger Jitter Error (seconds rms) = $\frac{\sqrt{(^e n^1)^2 + (^e n^2)^2 \text{ Volts rms}}}{| \text{Input slew rate at trigger point | (volts/sec)}}$

where $^{\rm e}$ n¹ = 140 μ V rms typical counter input noise for 1 M Ω filter on; 240 μ V rms typical for 1 M Ω filter off; 340 μ V rms typical for 50 Ω .

en2 = V rms noise voltage of users input signal at trigger point, measured with the appropriate bandwidth.

Note: Best usable resolution is ± 1 psec in Time Interval (TI) modes.

*trigger level error (Volts) Slew Rate Error (seconds) = Input slew rate at trigger point (volts/sec) *Trigger level error = All functions pos slope trigger accuracy times attenuation factor except WIDTH A and EVENTS B DUR A neg slope (trigger accuracy ±10 mV) times attenuation factor WIDTH A, ____ start edge trigger accuracy times attenuation factor (trigger accuracy + hyst) stop edge times attenuation factor start edge (trigger accuracy + hyst) times attenuation factor trigger accuracy times attenuation factor

stop edge

Table 1-1 (cont)

FUNCTIONS (cont)

EVENTS B

Same as WIDTH A, except each number is multiplied by

DUR A

Freq B

Note:

Trigger Accuracy, (see CHANNEL A and CHANNEL B

INPUTS)

Input hysteresis is typically 50 mV p-p times attenuation.

maximum 70 mV p-p times attenuation.

Internal slew rate = 800 ps (50 Ω)

1.3 nsec (1 MΩ)

18 nsec (20 MHz filter)

N = Number of Averages

The minimum number of averages is selected by the AVERAGES button and the
buttons in decade steps from 1 to 109. At Channel A repetition rates above approximately 250 Hz the actual number of averages will be:

$$N \approx [FREQ A (Hz) \times 4 msec] + AVGS$$

N = AVGS setting (below 250 Hz)

This typically leads to better than expected resolution in the displayed answer for small N with only minimal impact on measurement time. Arming must be used when measuring only one event out of a pulse train (multiple events) with signals ≥250 Hz.

In the AUTO mode the counter measures with a fixed measurement time of about 300 msec (or the time for one event, (Freq A)² $\times 10^{8}$ MR Anoman sqhill co whichever is greater).

 $N \leq Freq A (Hz) \times .3 seconds (N always <math>\geq 1$)

LSD:

FREQ

PER

 \leq 3.125 nsec for N \leq 10, \leq $\frac{10 \text{ nsec}}{N}$ for N >10

RATIO

Freq A Freq B X N

TIME A→B

& RISE/FALL A

 \leq 3.125 nsec for N \leq 10, $\frac{10 \text{ nsec}}{\sqrt{N}}$ for N \geq 10

WIDTH A

 \leq 3.125 nsec for N \leq 10, $\frac{10 \text{ nsec}}{\sqrt{N}}$ for N > 10

EVENTS B DUR A

Period B $\frac{1}{\text{Width A} \times \text{N}} \times \text{Events B dur A}$

Time Base Error: The sum of all the errors specified for the time base used.

^aOver voltage protection still functions, but in rise/fall, (50 Ω and imes5) it may not always protect the 25 Ω series input resistor.

^bWith 10⁹Averages selected, LSD can be 31.25 atto sec.

^cCan be set to 0.0 ns by use of "NULL" function.

^dCan be removed by use of "NULL".

^eThe B channel will not count events until after the first valid A channel count.

Table 1-2 MISCELLANEOUS

Characteristics	Description	
Power Requirements	TM 500 series power module	TM5000 series power module
DC 510	14.6 W	14.0 W
DC 510 Opt 01	18.9 W	18.2 W
Recommended Calibration Interval		2000 hours or 6 months whichever occurs first
Minimum Display Time		100 msec (typical)
Auto Averages Measurement Time		300 msec (typical)

Table 1-3 ENVIRONMENTAL^a

Characteristics	De	Description	
Temperature		Meets MIL-T-28800B, class 5.	
Operating Non-operating	0°C to +50°C -55°C to +75°C		
Humidity	0°C to +50°C -55°C to +75°C 95% RH, 0°C to 30°C 75% RH to 40°C 45% RH to 50°C	Exceeds MIL-T-28800B, class 5.	
Altitude Operating Non-operating	4.6 km (15,000 ft) 15 km (50,000 ft)	Exceeds MIL-T-28800B, class 5.	
Vibration	0.38 mm (0.015") peak to peak, 5 Hz to 55 Hz, 75 minutes.	Exceeds MIL-T-28800B, class 5 when installed in qualified power modules. ^b	
Shock	30 g's (1/2 sine), 11 ms duration, 3 shocks in each direction along 3 major axes, 18 total shocks.	Meets MIL-T-28800B, class 5 when installed in qualified power modules. ^b	
Bench Handling ^c	12 drops from 45°, 4" or equilibrium, whichever occurs first.	Meets MIL-T-28800B, class 5.	
Transportation ^c	Qualified under National Safe Transit Association Preshipment Test Procedures 1A-B-1 and 1A-B-2.		
EMC	Within limits of MIL-461A, with exceptions ^d , and F.C.C. Regulations, Part 15, Subpart J, Class A. Unused plug-in compartments must be filled with blank plug-ins.		
Electrical Discharge	20 kV maximum charge applied to instrument case.		

^aWith power module.

^bRefer to TM 5000-Series power module specifications.

^cWithout power module.

^dWithin 4 dB of REO2 at 130 MHz and 960 MHz. Within 8 dB of REO2 at 320 MHz.

Table 1-4
PHYSICAL CHARACTERISTICS

Characteristics	Description	
Finish	Anodized aluminum chassis.	
Net Weight (nominal)		
DC 510	3 lb. 5 oz.	
Option 01	3 lb. 9 oz.	
Nominal Overall Dimensions		
Height	126.0 mm (4.96 inches)	
Width	134.5 mm (5.29 inches)	
Length	278.8 mm (10.98 inches)	
Enclosure Type and Style per		
MIL-T-28800B		
Type	lli lii	
Style	E (Style F in rackmount power module)	

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OPERATING INSTRUCTIONS

INTRODUCTION

First Time Inspection

Inspect the instrument for visible damage (dents, scratches, etc.). Keep the original shipping container and packing material for future use. If the instrument is damaged, notify the carrier and the nearest Tektronix Service Center or representative.

Repackaging for Shipment

Should it become necessary to return the instrument to a Tektronix Service Center for service or repair, attach a tag to the instrument showing the owner (with address) and the name of the individual to be contacted, complete instrument serial number, option number, and a description of the service required.

If the original container and packaging material is unfit for use or not available, repackage the instrument as follows:

- 1. Obtain a carton of corrugated cardboard having inside dimensions no less than six inches more than the instrument dimensions; this will allow for cushioning. The shipping carton test strength for your instrument is 200 pounds.
- 2. Surround the instrument with polyethylene sheeting to protect the finish.
- 3. Cushion the instrument on all sides by tightly packing dunnage or urethane foam between carton and instrument, allowing at least three inches on all sides.
- 4. Seal the carton with shipping tape or industrial staples.
- 5. Mark the shipping carton "FRAGILE INSTRUMENT" to indicate special handling.

Operating and Non-Operating Environments

The instrument may be operated, stored, or shipped within the environmental limits stated in the Specification section of this manual. However, the counter should be protected at all times from temperature extremes which can cause condensation to occur within the instrument.

PREPARATION FOR USE

Rear Interface Considerations

A slot between pins 21 and 22 on the rear connector identifies this instrument as a member of the TM 500 counter family. If you desire to use your counter to build a system, insert a family barrier key (Tektronix Part No. 214-1593-02) in the corresponding position of the selected power module jack in order to prevent plug-ins belonging to a different family from being used in that compartment of the power module.



To avoid electric shock, disconnect the power module power cord before inserting the family barrier key in the power module jack. Refer the barrier key insertion to qualified service personnel.

The DC 510 has the following rear interface input and output features:

Arming Input

10 MHz Clock Output

External Clock Input (1, 5, 10 MHz)

Prescaler Function

Reset Input

NOTE

Rear interface information will be found in the Maintenance section of this manual. Refer the interface connections to qualified service personnel.

Installation and Removal

The DC 510 can be used in the TM 5000-Series or TM 500-Series power modules.

Operating Instructions—DC 510

NOTE

Refer to the Operator's Safety Summary in the front of this manual before installing this instrument in the power module.

Refer to the power module instruction manual and make sure that the line jumpers are positioned correctly for the line voltage in use. Check the counter and the power module for the proper fuses. Be certain that the power plug for the power module has the proper grounding conductor.



To prevent damage to the instrument, turn the power module off before installation or removal from the power module. Do not use excessive force to install or remove the instrument from the power module. Check to see that the plastic barrier keys on the interconnecting jack of the selected power module compartment match the cutouts in the rear interface connector for the counter. If they do not match, do not insert the counter until the reason is investigated.

If the cutouts and barrier keys match, align the chassis of the counter with the upper and lower guides of the selected compartment. See Fig. 2-1. Insert the counter into the compartment and press firmly to seat the rear interface connector. Apply power by operating the POWER switch on the power module.

To remove the counter from the power module, turn off the POWER switch, pull the release latch knob (located in the lower left front corner) until the interconnecting jack disengages. Pull the counter straight out of the power module compartment.

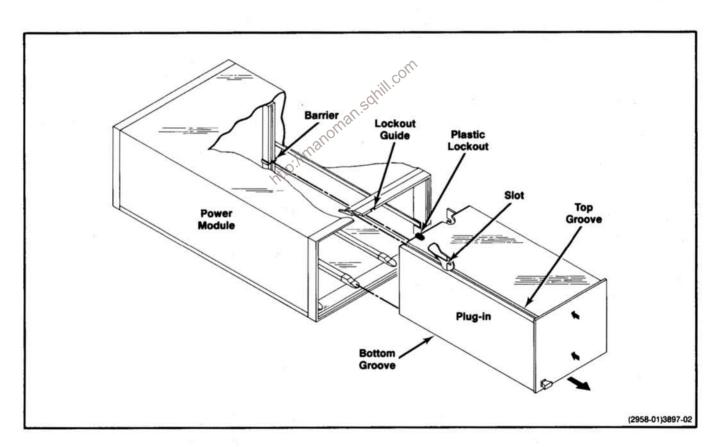


Fig. 2-1. Plug-in installation and removal.

FRONT PANEL OPERATION

The following information is a brief, functional description of the front panel display, controls, and connectors (See Fig. 2-2).

FRONT PANEL DISPLAY

1 Display

The display contains nine seven-segments LEDS and eight annunciators. All measurement results are displayed with the best possible resolution. The readout (result) for the measurement is always displayed in a right-hand justified format with the decimal point automatically positioned. Displayed count overflow is indicated by a flashing display. In measurements such as Time A→B, where the number of resolved digits increases more slowly with an increase in averaging, only correct (resolvable) digits are displayed.

Five of the annunciators are used to indicate the units of measurements: Hz/SEC for Hertz or seconds, kHz/mSEC for kilohertz or milliseconds, MHz/µSEC for megahertz or microseconds, GHz/nSEC for gigahertz or nanoseconds, and VOLTS/AVGS for (trigger level) Volts, and (the exponent of) the number of Averages.

The GATE annunciator, when illuminated, indicates that the counter is in the process of accumulating counts for the measurement.

The REMOTE annunciator indicates the instrument is in a remotely-programmed state, when illuminated. The AD-DRESS light indicates that the instrument is actually being addressed over the GPIB bus.

In addition to displaying the measurement results, the counter uses the extreme left three digits of the seven-segment LED display to indicate internal or operating error codes. The two digits (extreme left-digit Channel A and the extreme right-digit Channel B) on the display report the results of compensating external signal probes. See Self Test Display and Probe Compensation.

In addition, many of the front-panel pushbuttons are illuminated.

FRONT PANEL CONTROLS

2 TERM, SLOPE, ATTEN, and COMPL (CHANNEL A and CHANNEL B)

TERM-50 Ω , **1 M\Omega** (termination). When unlighted, selects 1 M Ω , 23 pF; when lighted, selects 50 Ω . Allows user to properly terminate 50 Ω inputs when required. (Unit will automatically revert to 1 M Ω , 23 pF in the event of an overload.)

ATTEN-X1, X5. When unlighted, selects X5; when lighted, selects X1. Allows the signal to be applied directly to the amplifier without attenuation or attenuated by a factor of five. The attenuator effectively increases the input hysteresis and trigger level range by a factor of five.

SLOPE -,+. When unlighted, selects +; when lighted, selects -. This button selects the slope of the signal at the trigger level crossing, which is recognized as a countable event CHANNEL A slope also selects between risetime (+ Slope) and fall time (- Slope); it must be set before the CHISE/FALL A button is pushed.

COUPL-AC, DC. When unlighted selects DC; when lighted selects AC. DC is direct coupled. AC inserts a capacitor in series with the input which allows small signals with large dc offsets to be measured.

FRONT PANEL CONNECTORS

3 CHANNEL A - CHANNEL B (Identical in performance)

1 M Ω 23 pF/50 Ω . Signal input conectors. Vpk \leq 2 V max (50 Ω) Vpk \leq 42 V max (1 M Ω)

4 CH A, SHAPED OUT - CH B, SHAPED OUT (Shaped Out A/B/COM)

These outputs provide an exact replica of the internal signal that is being measured. It is an aid to proper triggering on complex waveforms. The outputs provide a 100 mV signal near ground from 50 Ω (200 mV unterminated). These are full bandwidth outputs, and function well beyond 350 MHz.

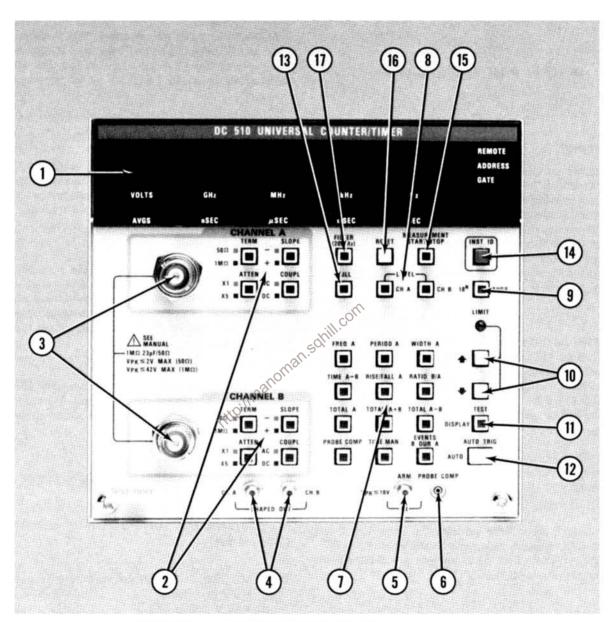


Fig. 2-2. DC 510 front panel display, controls and connectors.

(5) ARM, IN - Vpk ≤10 V (Arming TTL)

This input (normally high) allows the counter to measure only when in the high state. When in the low state, this input prevents the counter from measuring. (Alternatively, this input may be provided through the rear interface.)

(6) PROBE COMP

This test point provides a rectangular waveform (\approx 5 volts) that can be used in conjunction with the "PROBE COMP" function to compensate test probes (see Probe Compensation in this section.)

FRONT PANEL PUSHBUTTONS

7 Function Pushbuttons

FREQ A (Frequency A). Measures the period of the Channel A signal, calculates and then displays frequency.

PERIOD A. Measures and displays the period of the Channel A signal.

WIDTH A. Measures the width of a pulse on Channel A. When CHANNEL A SLOPE is +, the positive pulse width is measured. When CHANNEL A SLOPE is negative, the negative pulse width is measured.

TIME A → B. Measures the time between the first occurrence of an event on Channel A and the first succeeding event on Channel B.

RISE/FALL A (Risetime A - Falltime A). Automatically measures the risetime/falltime (10% and 90%) of the signal appearing on CHANNEL A. The appropriate trigger levels are measured and calculated at the time the button is pressed. If the signal amplitude changes, the button may be pressed again. When CHANNEL A SLOPE is +, risetime is measured; for falltime, press CHANNEL A SLOPE =(-) before pressing RISE/FALL A. Since this measurement uses the B channel, its settings are automatically updated to match those of CHANNEL A. After pressing RISE/FALL A, the user is free to modify either CHANNEL A or CHANNEL B separately to suit special measurement needs, though the result may no longer be a traditional Rise/Fall time. (See Risetime A and Falltime A later in this section).

RATIO B/A. Measures and displays the ratio of events occurring on Channel B divided by the events occurring on Channel A over the same time interval.

The three totalize modes of operation count the events that are the occurrences of pulses on Channel A and B.

TOTAL A (Totalized A). In Total A, only Channel A events are displayed.

TOTAL A+B. Displays the total number of events on Channel A plus the total number of events on Channel B. Channel B events are counted only after the first valid Channel A event.

TOTAL A-B. Displays the total number of events on Channel A minus the total number of events on Channel B. Channel B events are counted only after the first valid Channel A event. If A-B is negative, a minus sign is lighted.

NOTE

After a TOTALIZE button is pushed, the START/ STOP button lights to indicate a "STOPped" condition. It must then be pressed to start the Totalize process.

Also, the number of digits displayed is "scaled" by the AVGS setting. This scaling does not affect the actual count process, and therefore may be changed while counting without losing counts. Even when counting has been stopped, the display may be moved to the right or left.

PROBE COMP. When in this mode, a visual indication is given (in the display area) that allows the user to easily compensate attached high impedance probes. (See Probe Compensation in this section.)

TIME MAN (Time Manual). Measures time after pressing the MEASUREMENT START/STOP pushbutton (once to start and once to stop). The accumulated count (time) is not reset until the RESET pushbutton is depressed. Like the Totalize modes, this function defaults to the STOPped state when first selected, as indicated by the START/STOP button being illuminated.

EVENTS B DUR A (Events B During A). Measures the number of occurrences of pulses on Channel B during the time interval where the Channel A input signal is greater than (+ SLOPE) or less than (- SLOPE) the Channel A trigger level.

LEVEL CH A, CH B

Displays the chosen trigger level. Trigger level settings may be set for either channel by depressing the appropriate LEVEL button and then using the increment or decrement buttons (labeled 10). To exit this mode, the user can press the LEVEL A (B) button a second time or press any function button.

(9 AVGS (Averages)

Pressing this button displays the current AVGS setting and readies the instrument for a new setting. The user can then choose between several modes.

AUTO - (push the AUTO button, a-1 will be displayed). This mode provides the best resolution possible with a measurement time of approximately 300 mS.

0 - (decrement exponent to zero). The selected measurement is made with at least one event. This is the mode to be used for single-shot measurements. At most frequencies, more than one event will actually be averaged; see the Specification section for further detail.

10", n=1 to 9 - Provides selection of minimum number of averages in decade steps.

The increment/decrement keys are used to in crease or decrease the exponent to the next believed.

NOTE

The AVGS settings affects the number of digits displayed for Totalize measurements. When in Auto on n=0, the first nine digits to the left of the decimal point are displayed. When n=1 to 9, the measurement result is "scaled" by 10 n and displayed.

10

This button increments the appropriate trigger level if LEVEL CH A - CH B is selected, or the number of averages if AVGS has been selected. Voltage levels are incremented or decremented in steps of 4 mV × attenuating setting.

This button decrements the appropriate trigger level if LEVEL CH A - CH B is selected, or the number of averages if AVGS has been selected.

LIMIT

This light goes on whenever either the increment (†) or decrement (1) button has incremented or decremented a setting to its limit. This light goes out when increment (†) or decrement (1) button is released.

TEST/DISPLAY

When either of the LEVEL CH A, LEVEL CH B buttons or the AVGS button is lighted, this button alternates what is being displayed in the seven-segment readout. Pressing it once makes the readout revert back to displaying the functional results (frequency, period, etc.) while still leaving the increment/decrement buttons active. Pressing the button again will alternate the display back to showing the voltage level or averages exponent. This allows the user to view either the parameter being changed or the effect of that change on the functional results.

When the LEVEL buttons or the AVGS button is unlighted, the TEST/DISPLAY button is used to select the Test mode. In this mode a portion of the power up test (all but the RAM portion) is repeated. If an error is ever encountered, the test stops, with the appropriate error code displayed. To exit Test mode, push any other function key.

COM **AUTO TRIG/AUTO**

If the LEVEL buttons or the AVGS button is unlighted, pressing this button causes an auto trigger on both Channel A and Channel B (the maximum and minimum peak values of the Channel A and B input signals are measured and the trigger levels are set at the midpoints). If LEVEL CH A is selected, pressing this button causes an Auto trigger on Channel A only, and similarly for LEVEL B lighted. If AVGS is lighted, pressing the button enters a - 1, which is the code for Auto Averages.

NULL

(12)

Pressing the NULL button stores the present measurement result and then subtracts that number from all subsequent measurements (while the button remains lighted). It is most useful in Time A→B measurements, where it can be used to null out systematic errors such as unequal cable lengths and channel mismatches; however, it is available in all measurement functions.

The averages setting may be changed without losing the NULL stored measurement. Now, the instrument will be subtracting two numbers of differing resolution. Since the result of such a subtraction actually has the resolution of the lesser resolution number, that is the one that the counter automatically uses to determine how many digits to display.

Pressing the button again will re-null the result.

To exit the Null mode, press any function button (including that of the function already chosen).

INST ID (14)

This pushbutton, when pressed blanks the display. In the programmable instrument, this button (when pressed) displays the current GPIB address and message termination.

MEASUREMENT START/STOP (15)

This pushbutton can be used in all of the Function modes except Probe Comp and Test. When it's lighted, measurement is in the "STOPped" state. Pressing the button causes a "STOPped", Totalize, or Time Manual measurement to "Start" from the displayed result. Other measurements (except Probecomp and Test) will "Start" a new measurement. When "Started", pressing the button causes all measurements (except Probecomp and Test) to stop counting.

When "STOPped", Totalize and Time Manual measurements read the final count in the count chains and update the display one more time.

RESET

a measurement has been stopped, this pushbutton, when pressed, will initiate another single measurement. If RESET is pressed while the counter is in the middle of a measurement, the current measurement will be aborted and a new measurement started. RESET, while pressed, also provides a segment test for all the front panel LEDs, including pushbuttons and annunciators.

FILTER (20 MHz) (CHANNEL A and

When this button is lighted, the bandwidth of both channels is reduced to 20 MHz. This allows rejection of high frequency noise. It may also be used when initially setting Auto trigger levels or Rise/Fall levels for a signal with overshoot or undershoot.

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INTRODUCTION

General Operating Characteristics

The DC 510 is a programmable universal counter based on a microprocessor system. The counter is capable of 11 measurement functions with full nine-digit resolution, plus two specialized functions; probe compensations (PROBE COMP) and self-test (TEST).

The microprocessor system automatically sets the measurement gate interval, performs the necessary calculations on the acquired data, and causes the result to be displayed with the best possible resolution for the selected measurement FUNCTION, number of averages (AVGS), and operating conditions.

Self Test Display

When power is applied, one of the error codes listed in Table 2-1 may appear in the display window if the counter fails its self-test routine. Refer the error code condition to qualified service personnel.

NOTE

At power up, a signal with a large dc offset voltage connected to the input terminals for either channel may cause the entire input signal to be outside the triggering level range. If this condition exists, an error code may be displayed. If any of these conditions occur, disconnect all inputs and reapply power. This error condition can also be caused by a low level ARM input signal during power-up.

Table 2-1 FRONT-PANEL DISPLAY ERROR CODES

Serial I/O Fault	313
Channel A	
Counter Integrity	320-324, 329
Channel B	
Counter Integrity	330-334, 339
System RAM Error U1410	340
System RAM Error U1311	342
ROM placement error U1610	361
ROM placement error U1410	380
ROM checksum error U1610	381

NOTE

Refer error code conditions to qualified service personnel.

INPUT CONSIDERATIONS

Maximum Safe Input Voltage Limits





To avoid instrument damage, make certain that the input voltages to the front panel connectors or rear interface inputs do not exceed their specified limits. See Specification section.

The outer shell of the front panel bnc connectors is connected to earth ground through the ground connection for the power module power cord.

Always use a step-down isolation transformer (less than 15 V output) when measuring power line frequencies (50 or 60 Hz).

Be careful with high-frequency, high-amplitude signals (above 80 MHz). The front panel maximum safe input voltage at these high frequencies is 4 V, peak-to-peak times attenuator setting.

Connecting External and Internal Signal Sources

The DC 510 can be used to measure input signals to either channel from the front panel. The SLOPE, TERM, ATTEN, and COUPL pushbuttons are effective in conditioning the signal.

If a high impedance signal probe is to be used between the front panel bnc connectors and the measurement source, use a probe capable of compensating for the input capacitance of the counter (less than 24 pF). A probe is recommended for all digital logic applications; the TEKTRONIX P6125 has been designed specifically for these counters, and its use is recommended. The counter has been designed, however, to properly trigger on ECL signals even when a X10 attenuator probe is used.

MEASUREMENT CONSIDERATIONS

Input Coupling, Noise, and Attenuation

You can use either the ac coupling (AC COUPL) or dc coupling (DC COUPL) mode to couple the input signal to the CHANNEL A or CHANNEL B input amplifiers. If the signal to be measured is riding on a dc level, its amplitude limits may not fall within the triggering level range. The AC COUPL mode should be used for repetitive signals having a fixed frequency and a constant duty cycle, or for signals riding on a large dc level. Slope selection is relatively unimportant when measuring the frequency or period of sine-waves. The 50 Ω Termination is selected for high frequency 50 Ω systems, while 1 M Ω is selected for high impedance probes and for other high impedance situations. When in 50 Ω , the internal termination resistor could be damaged if the user accidentally applied an overly large signal. To prevent this, the DC 510 automatically reverts to 1 M Ω for most signals that might damage the 50 Ω resistor. See the Specification section for more detail.

If the signal frequency or duty cycle changes, the triggering point may shift, stopping the measurement process. Use the DC COUPL mode for low frequency ac signals, signals with a low duty cycle, and during any time interval measurement (Time A→B, Rise/Fall A, Events B Dur A, and Width A).

Noise may be coupled to the input amplifiers along with the signal to be measured. Noise may originate from the operating environment, the signal source, or be caused by improper connections. If the noise is of sufficient amplitude, it can result in inaccurate measurements due to false triggering. See Fig. 2-3. The DC 510 has a 20 MHz low pass filter (FILTER) that is helpful in removing or reducing noise.

The linear operating range describes the voltage limits that will allow proper triggering without distortion. The minimum signal amplitudes are defined by the input sensitivity requirements for the AC COUPL and DC COUPL modes for either the 1 M Ω or 50 Ω Termination selection (see the Specification section). Proper use of the ATTEN (attenuation) controls will ensure operation within the maximum limits; ± 2.0 V for X1 ATTEN, ± 10 V for X5 ATTEN.

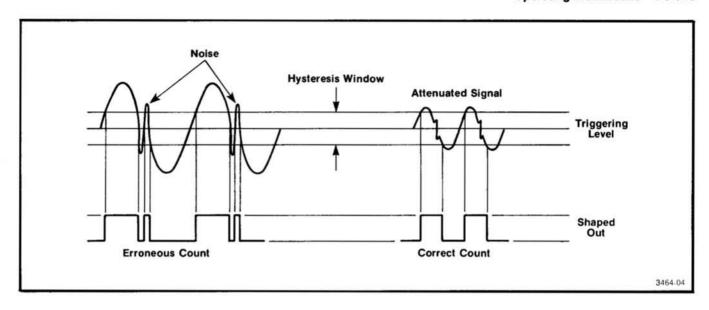


Fig. 2-3. Advantages in signal attenuation.

Triggering the Counter

The dc triggering level is determined by the SLOPE and LEVEL selection, or by the AUTO TRIG button.

The LEVEL CH A and CH B buttons, in conjunction with the increment (†), and decrement (‡) buttons, are used to move the triggering hysteresis window continuously up or down through a ±2.0 V range in 4 mV steps. The hysteresis window is typically 50 mV peak-to-peak. To determine the exact trigger level settings, push LEVEL CH A for LEV-EL CH B); the respective levels will be displayed. To return to the measurement cycle, press the LEVEL CH A or LEVEL CH B button again (whichever is lighted); pressing any function button will also return the instrument to the measurement mode.

When the AUTO TRIG button is activated, the microprocessor performs a software routine to determine the maximum and minimum limits of the Channel A and Channel B input voltage swings in Channel A and Channel B. Then the routine automatically sets the triggering levels of each channel to 50% (+24 mV for + slope, -24 mV for slope) of its respective measured minimum and maximum values when making frequency, period, and totalize measurements. AUTOTRIG is also useful for pulse width measurements (WIDTH A mode) and TIME A→B measurements. Successful use of the Auto Trig here requires signal amplitudes of at least twice the effective hysteresis. Thus, signals with amplitudes greater than 140 mV peak-to-peak are typically necessary. This is because the actual trip level of the hysteresis window is set exactly at the 50% point for Width and Time A→B.

Figure 2-4 illustrates typical trigger level settings and shows the importance of setting trigger levels properly in order to avoid errors due to input signal risetimes (falltimes), or where the transition times of the start and stop pulses are different (or just slow). Observation of the SHAPED QUT signals on an oscilloscope, while setting the trigger levels on slow but complex waveforms, aids in reducing trigger setting difficulties.

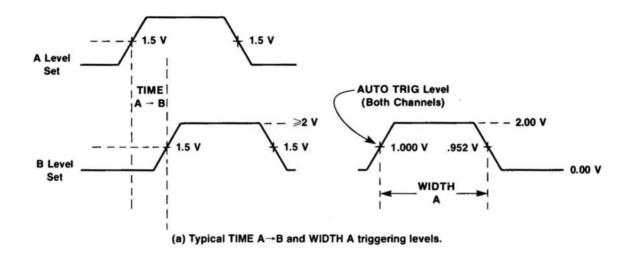
The use of the Auto Trig , though very convenient, does not reduce the need to consider input noise amplitudes, coupling, impedance matching, and attenuation factors. Large amounts of overshoot and ringing of the input signal may cause erroneous counts due to an undesirable level setting. The median value of the input signal may be displayed. For mid-point settings, the low frequency limit for the Auto Trig mode is 10 Hz. Below 10 Hz, the automatic triggering level will still be set between the signals maximum and minimum, but not necessarily at the 50% point. For dc inputs, the level determination provided by auto trigger once again becomes correct.

Reducing Measurement Errors

As an aid in reducing measurement errors, keep in mind the following factors.

- Use the ATTEN controls and high impedance, attenuator type probes when measuring signals from high impedance circuits.
- Use the 50 Ω TERMination control for low impedance, high frequency 50 Ω systems.

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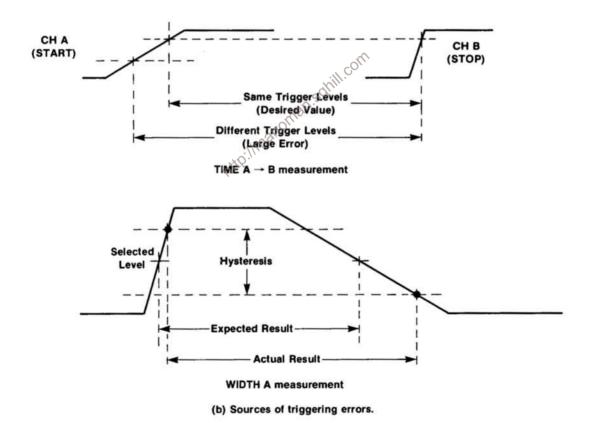


Fig. 2-4. Typical triggering levels and sources of triggering errors.

- Consider trigger errors caused by input signals with slow rise or fall times.
- Use the 20 MHz FILTER to reduce high frequency
- Average the measurement over a larger number of cycles of the input signal (greater number of AVGS)
- Maintain the counter environment at a constant temperature.
- For greater stability, allow extra instrument warm-up time (> 1/2 hour).
- Substitute the standard time base with the optional, higher stability time base.
- Apply a 1 MHz, 5 MHz, or 10 MHz external time reference standard (NBS) to the rear interface inputs.
- Recalibrate, if necessary.

The ratio range is from 10⁻⁸ to 10⁹. Applying the higher frequency to Channel B produces a ratio greater than one; applying the lower frequency to Channel B produces a ratio less than one. For better resolution, apply the higher frequency signal to Channel B.

Width A and Time A → B (Time Interval)

Figure 2-5 illustrates measurements for the WIDTH A and TIME A → B functions. The WIDTH A function measures the time interval between the first selected positive or negative edge (± SLOPE) of the waveform applied to Channel A and the next opposite polarity edge.

The TIME A → B function measures the time interval between the first selected occurrence (± SLOPE) of an event on Channel A to the first selected occurrence (± SLOPE) of an event on Channel B. The measurement can be averaged (AVGS) by the selected number of Channel A events because there is one Channel B event per Channel A event.

When either the WIDTH A, TIME A → B, or RISE/FALL A function is activated, the microprocesor turns on an internal pseudo-random noise generator that phase modulates the internal 3.125 ns time base, allowing the counter to measure without error, input signals that otherwise would be synchronous with its time base. See Fig. 2-5.

MEASUREMENT EXAMPLES

Frequency A and Period A

http://manoman.sol When the counter is in either the FREQ A or PERIOD A modes, it always measures the period of the Channel A input signal. For FREQ A, the microprocessor computes the frequency as:

$$f = \frac{1}{T}$$
 (T = period)

and displays the answer in frequency units. For PERIOD A, the answer is displayed in units of time. The 320 MHz internal clock insures very high resolution in both frequency and period. For period measurements of fast signals with 109 Averages, this resolution is ± 31.25 attosecs (31.25 imes10 18 sec).

Ratio B/A

In Ratio B/A mode, the counter measures the number of events on both channels during the time it takes to accumulate the selected number of Channel A events (averaged by A events). The total number of Channel B events is then divided by the total number of Channel A events and the answer displayed without units of time or frequency.

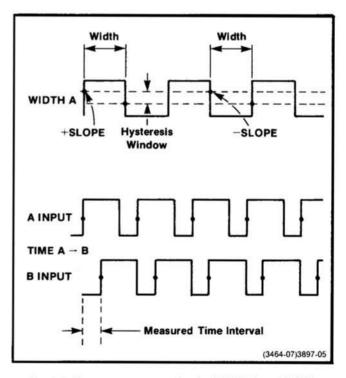


Fig. 2-5. Measurement examples for WIDTH A and TIME

Operating Instructions—DC 510

In Fig. 2-6 the time interval (4.68525 ns, WIDTH A) will not be measured with a non-modulated time base any more accurately with averaging than it could have been by making a single-shot measurement (AVGS = 0). Using the pseudorandom phase-modulated clock pulses, and setting the AVGS switch greater than 1, causes the counter in this example to count one clock pulse one-half of the time and two clock pulses one-half of the time. For example, if AVGS is set to 10 (10¹) the total time for the count is at least 46.8525 ns. Ten averages yields 15 counts (5 counts + 10 counts). Dividing the total count by the number of averages, the average (count/interval) of each count corresponds to 3.125 nsec. The answer, is then (15/10 \times 3.125 = 4.68525, which on the DC 510 would be displayed as 4.6 nsec.

Null

Pressing the NULL button stores the present measurement result and then subtracts that number from all subsequent measurements (while the button remains lighted). It is most useful in Time A → B measurements, where it can be used to null out systematic errors (such as unequal cable lengths and channel mismatches); however, it is available in all measurement functions.

The averages setting may be changed without losing the Null stored measurement. If the instrument is subtracting two numbers of differing resolution, the result of such a subtraction has the resolution of the lesser resolution number. This is the number that the counter automatically uses to determine how many digits to display.

Pressing the button again will re-null the result.

To exit the Null mode, press any function button (including that of the function already chosen).

Events B During A

The EVENTS B DUR A function is basically the same as WIDTH A; except, instead of clock edges, the counter counts the selected number of positive-going or negative-going events (\pm SLOPE, CHANNEL B) occurring during a selected positive or negative pulse width occurring on Channel A (\pm SLOPE, CHANNEL A). Therefore, the internal time base is not counted for this function. See Fig. 2-7 for a measurement example. The Channel B events are averaged over the selected number (AVGS) of Channel A pulse widths.

Time Manual

The TIME MANUAL function measures and displays the time interval (to the closest one-hundredth of a second) between the first and second depressions of the MEASURE-MENT START/STOP pushbutton. The time count can be reset to zero and restarted by pressing and then releasing the RESET pushbutton. The AVGS switch has no affect in the Time Manual mode. When first entering this function, the measurement is in the STOPped mode, as indicated by the lighted START/STOP button.

Totalize A

The Total A function is basically the same as TIME MAN-UAL except that instead of counting the internal time base pulses, the counter counts the total number of Channel A events occurring between two successive depressions of

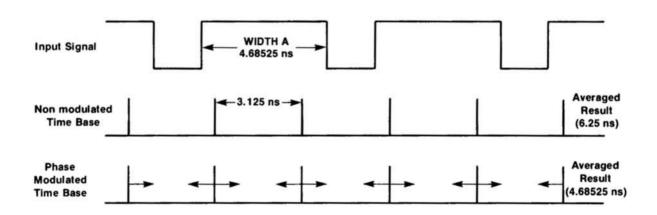


Fig. 2-6. Measurement example for synchronous input signals.

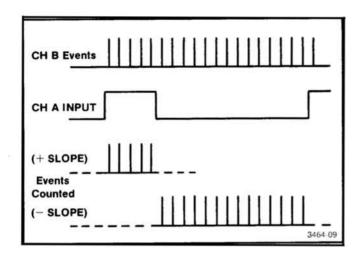


Fig. 2-7. Measurement example, EVENTS B DURING A.

the MEASUREMENT START/STOP pushbutton. The AVGS switch is active in this mode. With the AVGS exponent set to 0 or AUTO (-1), whole numbers are displayed. For other settings, AVGS operates as a power-of-ten scaling indicator (allowing totalizing to the full fourteen digits of the internal count chain). For example, with a 1 MHz input signal and the AVGS switch set to 10^6 , the least significant digit displayed would represent 10^6 counts and would increment at one count per second $(10^6 \, \text{Hz}/10^6 = 1 \, \text{Hz})$. This scaling factor may be changed (Refer to Text) after a measurement is over, effectively moving the display. This allows the user to view all thirteen digits of the count chain.

Totalize A+B

The TOTAL A+B function is as described for TOTAL A with the exception that the counter counts the total number of Channel A events plus the total number of Channel B events. The B count does not begin until after the first valid A count.

Totalize A-B

The TOTAL A-B function is similar to the TOTAL A+B function with the exception that the counter counts the total number of Channel A events minus the total number of Channel B events. The B count does not begin until after the first valid A count.

Risetime A and Falltime A

The RISE/FALL A function allows the operator to automatically measure the 10% to 90% risetime (or falltime) of the counter's specified input signal appearing on Channel A. See Fig. 2-8a. Select the SLOPE (+= risetime; -= falltime) before pressing the RISE/FALL A button. The input signal size is automatically measured and the 10% and 90% levels are automatically calculated and set.

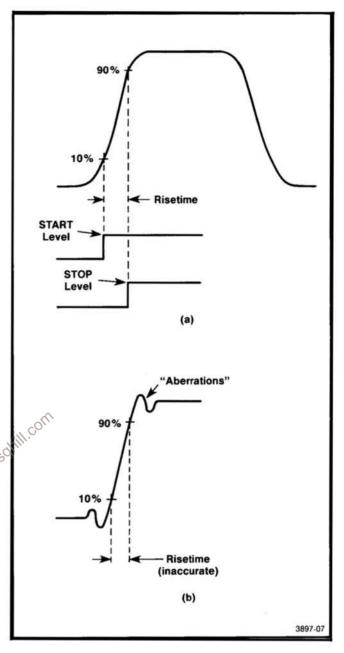


Fig. 2-8. Measurement example for risetime.

Internally, the A input is routed to both the A Channel and B Channel. The A Channel input conditioning is automatically duplicated (and indicated by the front panel lighted buttons) on the B Channel when the RISE/FALL A button is pressed. Although risetime measurements are simple to make, some operator problems can develop (even when using the automatic level setting capability of the counter). The signal being measured must satisfy the instrument requirements as detailed in the Specification section of this manual. The input signal amplitude must be greater than 1.4 V (50 Ω) or 700 mV (1 M Ω), have a risetime not less than 4 nsec (5 nsec for 1 M Ω), and not exceed 10% aberrations.

Operating Instructions—DC 510

The DC 510 uses a true peak detector circuit and detects the highest signal peak, even if the peak is an aberration (see Fig. 2-8b). If this aberration is too severe (greater than 10%), the instrument will not measure the correct risetime. Before pressing the RISE/FALL A button, the front panel FILTER (20 MHz) button can sometimes be selected to limit the internal risetime (less than 18 nsec) of the input signal to reduce these aberrations. Effective use of the filter will depend on the signal width and aberrations. Press the RISE/FALL A button. After the signal peak is measured and the 10% to 90% levels are set, the filter would be removed so the DC 510 may display the actual unlimited risetime (without filter).

The counter front panel pushbuttons remain active after pressing the RISE/FALL A button, to enable the operator to modify signal input conditioning and trigger levels. The modified conditioning and levels must satisfy the instrument requirements as detailed in the Specification section of this manual.

For example, if the AUTO button is pressed (while in RISE/FALL A) the Channel A and Channel B levels will move from the 10% and 90% points to the 50% point.

Other specific signal levels such as TTL High or TTL Low can be programmed by the operator; however, consideration must be given for the termination setting. In the 50 Ω termination, the displayed trigger level is one-half the true trigger level due to the internal power splitter (not evident to the instrument). In the 1 $M\Omega$ termination the instrument does not take into account any attached probes (see Rise/Fall specification for level information with the use of probes).

Probe Compensation

The DC 510 has been specifically designed to be compatible with standard probes when in 1 M Ω termination; however, the operator must still be sure that the probe is properly compensated.

In the DC 510, a probe compensation (PROBE COMP) function is built into the counter. It allows the user to compensate the probe in place and without the use of an external oscilloscope.

A square-wave signal of approximately 1 kHz and an amplitude of approximately 5 V is provided at the front panel PROBE COMP tip jack.

Connect the probe tip to the PROBE COMP tip jack before entering the PROBE COMP mode. The counter should display a zero for the most significant digit (far left) and a zero for the least significant digit (far right). The far left digit is for a probe connected to CHANNEL A and the far right digit for a probe connected to CHANNEL B. No decimal points or annunciators should be illuminated.

With the probe connected and the square-wave signal applied, perform the following steps.

- Slowly rotate the probe adjustment in either direction until the display changes to a continuous 1 reading for the channel being compensated.
- 2. Slowly reverse the rotation of the probe adjustment until the display *just goes back to a 0*. At this point, the probe will be compensated. A 1 indicates that the probe is over compensated; a 0 indicates under compensation. Final adjustment should be made in the direction where the 1 just changes to a 0.

NOTE

It a display goes to a 1 and remains in that condition for one or more complete revolutions of the probe adjustment, press the RESET pushbutton to clear the condition. This can occur if the connection to the square-wave source became open during the adjustment procedure.

Test Function

A 000 display in the three MSD's for the TEST function is an indication that the microprocessor has checked itself. The test also checks the DC 510's internal serial data path, the integrity of the internal counter chain (accumulators), and, as a by-product, the operation of the digital-to-analog converter (trigger levels) and input amplifier circuits.

The random-access memory space (RAM) is not checked during this front panel self-test; the RAM is checked only at power-up.

NOTE

If the CHANNEL A or CHANNEL B inputs are connected, the peaks of the input signals must be within the triggering level range of the counter for the test function to operate properly. If a failure occurs, first disconnect any CHANNEL A or CHANNEL B inputs and repeat the test. A connection to the arming input may also cause improper operation.

The gate light will flash once each time a full test cycle has been completed. If a failure is ever noted, the error code of that failure will be displayed in the three extreme left digits of the seven-segment display and the cycling will halt. The DC 510 will stay in test mode until another function is selected.

Arming (ARM Input)

Arming provides a means by which single events or sets of events can be selected for measurement within a complex analog or digital signal. Figure 2-9 shows three different examples of arming.

The ARM input requires TTL signal levels. With no signal attached the ARM input is normally pulled high and is thus continuously armed. When the ARM input is pulled low, the counter is prevented from starting a measurement. Arming may be used in all measurement functions with the exception of TIME MANUAL, PROBE COMP, and TEST. In these three functions the ARM signal must be high.

reriod (CH A)

I B = time from starting A event to stopping A

N = number of averages, i.e., 10⁶ or 10⁹, etc.

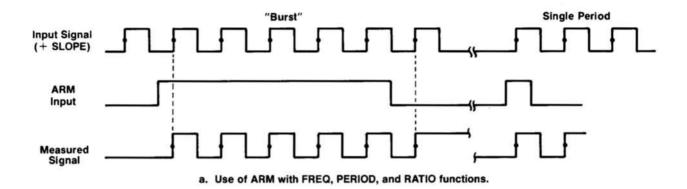
To when, in time, plex waveforms). When the arming signal changes to a high state, the first subsequent Channel A event will start the measurement process. When the arming signal changes to a low state, the next Channel A event will stop the measurement process. Therefore, the counter can be controlled as to when, in time, a measurement will be made (even in complex waveforms).

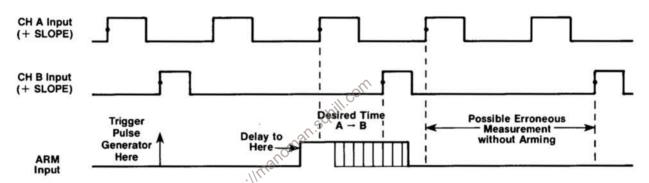
These armed measurements can then be averaged much like time interval averaging. The counter determines the number of digits to display (best possible resolution) based on the number of Channel A events averaged. Typically, each total measurement of Frequency, Period, and Ratio contains a 1 count error and the counter displays the number of digits that can be justified given this error. When using arming in the Frequency Period, or Ratio modes (nontime interval modes), each act of arming and disarming can introduce 1 count errors. The counter does not take this into account, however, and displays the number of digits based only on the total number of events per overall measurement, independent of the number of times the instrument was armed and disarmed.

The actual resolution for a period measurement using arming will be less than that displayed. It can be found using the following relationship:

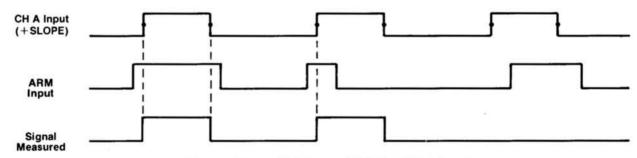
Resolution =
$$\frac{T_c}{N} \sqrt{\frac{N T_p}{T_B}}$$

T_p = time from starting A event to stopping A event





 b. Use of a triggered delay pulse generator to generate a TIME A → B arming signal.



c. Use of ARM with WIDTH A and EVENTS B DUR A functions.

Fig. 2-9. Examples of arming.

THEORY OF OPERATION

BLOCK DIAGRAM DESCRIPTION

Introduction

Refer to the Block Diagram illustration located in the foldout pages at the rear of this manual during the following discussion.

Signal Conditioning and Amplifiers

The functional blocks for the Signal Conditioning and Amplifiers (Channel A and Channel B) are essentially identical. Each channel amplifier circuit contains seven magnetic latching relays which control the input conditioning and routing of the front panel input signals. Six relays control the ac or dc coupling modes, the 1 or 5 attenuation factors, and the termination impedance. The seventh relay provides for a Channel A and Channel B commoning function. The data for these relays are sent from the microprocessor via data shifted through serial-to-parallel shift registers, in these functional blocks.

The Channel A and Channel B amplifiers used matched DMOS FET followers that buffer the input signal and trigger level. The buffered signal and trigger level are combined and amplified in a differential cascode integrated circuit (IC). This IC also provides for switching the output into a low pass filter or straight through at full bandwidth.

Schmitt Triggers

The amplified signal and trigger level are applied to the inputs of the Schmitt Trigge IC. The differential Schmitt output is applied to transistors that select the triggered slope. This circuit also provides the Shaped Out signals.

D/A's, Relay Protect, and Arming

This functional block contains triggering level control and 10-bit digital-to-analog converters (D/A converters) for Channel A and Channel B. The operational amplifiers driven from the D/A converter output, set both the offset and range for the individual channels.

The 50 Ω protect circuitry consists of two "window" comparators (Channel A and Channel B). These comparators

receive the protect sense levels from the Channel A or Channel B inputs (relays) and operate within a ± 2 volts window sense level. If these voltage levels vary up or down from this window, the comparators will send a protection signal (50 Ω protect) to the microprocessor. The microprocessor automatically changes the input impedance to 1 $M\Omega$ and protects the 50 Ω circuitry.

The arming input is applied from the front panel or rear interface. This circuit consists of a 1 TTL input load with appropriate input protection and a Schmitt trigger circuit for noise immunity. The output provides the arming signal (ARM).

Main Gating

After the Schmitt trigger, the signals to be measured are routed through the proper logic gates for the operating mode selected. These gates are enabled (or disabled) via latched data in a serial-to-parallel shift register located in this functional block.

The counter has what is sometimes called a "ratio architecture". That is, events are always accumulated in one count chain, called Accumulator A, and a time related or Channel B event count is accumulated in another counter chain, called Accumulator B. The microprocessor actually controls the measurement interval, which is typically asynchronous with the input signals. Thus, two flipflop synchronizers are used to guarantee that the accumulators always see a whole number of pulses of input signals or a whole number of pulses from the internal time base that is being counted.

The arming input (ARM), from D/A's, RELAY PROTECT and ARMING functional block, is applied to this block where it is logically ANDed with the measurement GATE generated by the microprocessor.

Time Base, 320 MHz PLL, and Noise Generator

This block contains the 10 MHz crystal-controlled time base, a 320 MHz PLL (phase locked loop) and a pseudo-

Theory of Operation-DC 510

random noise generator that is activated for time interval averaging measurements.

The 320 MHz PLL circuit contains a frequency and phase comparator, a filter circuit, a Varactor diode for 320 MHz tuning, and a feedback loop consisting of a fast divide-by-4 section followed by a divide-by-80 section.

CH A and CH B Count Chains

The Channel A signal is divided or counted by four ECL binary stages, five LS TTL binary stages, and then by four binary stages in a single CMOS counter. The Channel A SLOW output from the CMOS counter is then applied to a microprocessor peripheral device on diagram 9, where the signal is counted by another 16 binary stages internal to that device.

The Channel B accumulator is similar to the Channel A accumulator with four ECL binary stages, five LS TTL binary stages, followed by 15 binary stages in two CMOS counters. The Channel B SLOW signal is also applied to the microprocessor peripheral device on diagram 9. Each accumulator circuit has ECL to TTL or ECL to CMOS translator circuits where required.

The outputs of these counters are applied to the parallel inputs of five parallel to serial shift registers (two for Channel A and three for Channel B). To obtain the binary count accumulated in these counters, the microprocessor asserts the Serial Read Latch Line at least once for every measurement interval.

Processor and Display Drivers

The microprocessor control the measurement gate interval, generates the relay strobe signal, and by using address decoding circuits enables the shift registers, display strobe circuits, and the data buffer for the front panel button sens-

ing. This functional block has a microprocessor peripheral device containing a 128 X 18 static RAM, a 2048 X 8 ROM, a programmable counter, an 8-bit serial data channel, bidirectional data lines, and interrupt inputs. Additional program memory space is provided by a 4096 X 8 ROM and a 256 X 8 RAM.

Pushbuttons and LED's/Display

The key element in this functional block is a ten-state decade counter that provides the time slot decoding for scanning the front panel pushbuttons and other controls. The counter also provides the multiplexing functions for the seven-segment LED display and annunciators. Information is presented to the display by latching six bits of data from the microprocessor parallel data bus. Four bits of the latched data are then decoded from binary coded decimal to seven-segment information. The remaining two bits are used to drive the annunciators and decimal points.

The display consists of nine seven-segment LEDs, annunciators, and the LEDs of the lighted pushbuttons. The time slot lines generated by a ten-state decade counter drives the common cathodes of the seven-segment LEDs and scans the buttons and annunciators. The anodes of the seven-segment LEDs are connected to a buffer circuit through current limiting resistors.

Power Supplies

The instrument draws power from both of its power module connectors to derive its four primary supplies: +5 V and +12 V on the Auxiliary board and another +5 V and -12 V supply on the Digital board. Each supply is current limited and individually fused, and all four are referenced to a single precision 2.5 V reference IC. Several secondary supplies include +2.7 V for the ECL terminator, a +18 V three-terminal regulator chip (in Option 01 timebase only), a -15 V supply derived from the -12 V, a 2.5 V supply to drive the reference IC, and several isolated versions of +5 V, separated by L-C filters.

DETAILED CIRCUIT DESCRIPTION

SIGNAL CONDITIONING AND AMPLIFIERS—DIAGRAM (1)

NOTE

Since the Channel B Signal Conditioning and Amplifier circuitry is essentially identical to the Channel A circuitry, this description discusses the theory of operation for the Channel A circuits only.

The Channel A input signal is routed to two magnetic latching relays. Relays K1612S (Channel A) and K1632S (Channel B) provide a normal mode operation (separate channels) or common mode operation (both channels). In the common mode operation (Common Separate), Channel B input becomes an open circuit. The common mode operation is used when making risetime and falltime measurements. In this mode, with the input impedance set to 50 Ω , the leadless chip component, R1611, in conjunction with the 50 Ω (TERM) in each channel, becomes an internal power splitter. Relays K1611S and K1510S provide for 50 Ω termination. When in 50 Ω input impedance, relay K1610S selects either ac or dc coupling (COUPL). In the dc coupling position, resistor R1612 discharges the ac coupling capacitor C1610. Component R1512 is the isolation resistor for the 50 Ω Protect A Sense line, which will be discussed later. Relay K1511 selects either the X1 or X5 attenuation (ATTEN), when in 50 Ω (TERM).

In the 1 M Ω termination, selected by K1611S, relay K1600 selects either ac or dc coupling (COUPL). In the dc coupling position, resistor R1601 discharges the ac coupling capacitor, C1601. If X5 attenuation is selected, the signal enters the hybrid attenuator, AT1505. The component C1504 is a compensation capacitor and R1504 is the 1 M Ω 0 termination resistor. When attenuated, resistors R1506 and R1507 provide damping for optimum ac performance.

Input signal protection is provided by diode network, CR1512, CR1510, CR1511, CR1513, and resistor R1510 and capacitor C1518.

A matched pair of DMOS field effect transistors (FET), Q1410, provide buffering for both the input signal (at pin 8) and the triggering level signal (at pin 4). These matched FET devices cause a matched level shift from 0 volt to approximately —4.5 volts. Diodes CR1411, VR1412 and CR1410, VR1413 will limit large (overdriving) signals and protect integrated circuit (IC) U1311. In common mode operation, differential transformer, T1410 converts a single-ended signal

into a differential signal at high frequencies. This helps to provide for better high frequency performance and helps to reject noise. The FET source followers each have a current source. Transistor Q1402 is the current source for the triggering level source follower output. Transistor Q1403 is the current source for the input signal source follower output.

The IC U1311 is a cascode differential amplifier with switched signal output capability. Signals can be either passed straight through at full bandwidth or through a two-pole low pass filter that passes frequencies from dc to approximately 20 MHz. These signals are switched by control voltages generated from the logic signal FILTER at pins 12 and 11 of U1311. Being complementary, through Q1211 (signal inverter) and Q1210 (buffer) they appear in the Channel B circuitry as well. Therefore, the filters may or may not be selected by these inputs.

Resistor R1417 sets the gain for U1311 (pins 2 and 3). This leadless chip component is soldered directly to the IC pins for optimum ac performance. Transistors Q1400 and Q1401 are current sources for the cascode differential input. Low frequency peaking is provided by components R1406, R1405, and C1403.

SCHMITT TRIGGERS—DIAGRAM (2)



The buffered and amplified differential signal is applied to pins 2 and 3 of U1310 (Schmitt Trigger circuit). These signals are looped through this IC and appear at pins 12 and 11, with the load resistors R1313 and R1216. Transistor Q1303 is a current source for the Schmitt Trigger latch devices. The Schmitt Trigger differential output (pins 6 and 8 of U1310) is level shifted by transistors Q1204, Q1302, Q1300, and Q1301. Positive slopes are selected by Q1204 and Q1302 and negative slopes are selected by Q1300 and Q1301. These common base stage level shifters are driven by the + SLOPE A and - SLOPE A signals through transistors Q1202, Q1201, and associated circuitry. The shaped output signal from Q1204 or Q1300 enters Q1203 base, inverts and outputs to J1201 (CH A SHAPED OUT). The output signal (CH A ECL) from Q1302 or Q1301 routes to the ECL logic circuitry (Diagram 3). An operational amplifier, U1202B (Diagram 2) sets the mean dc level of the ECL signal to the correct value. A threshold level generated by an ECL signal (Diagram 3) is sensed at pin 5, U1202B and compared to the mean level sensed at pin 6, U1202B. The output (pin 7, U1202B) supplies the current necessary to adjust the level shifted output to the correct mean ECL threshold level.

MAIN GATING—DIAGRAM 3

The microprocessor controls the measurement gate interval through the GATE signal going to pin 4 of U1110B. The IC's U1000C and U1000B operate as synchronizers to ensure that the accumulator gates, U1001C and U1110A open and close at the proper time for the desired measurement. Synchronizing the accumulator gates with the signals to be counted ensures that the accumulators will contain a count corresponding only to a whole number of input and time-base pulses. In the absence of the synchronizers, the gates would sometimes pass fractional pulses, and the count chains might not be able to make a reliable count. The signals to be counted clock the synchronizers at pin 16, U1000C and pin 1, U1000B.

Before each measurement is initiated by the microprocessor, U1000C and U1000B are set by a MR₁ (Master Reset) pulse on connector J1010 pin 1. The IC's U1001C and U1110A are thus disabled by the high level synchronizer outputs at pins 14 (U1000C) and 11 (U1000B) until the measurement begins.

For those modes that use the Channel A Amplifier with positive slope triggering, negative-going edges are generated on pin 6 of U1001B. Pin 7 of shift register U1200 is latched high for all operating modes except the time interval modes (TIME A→B, WIDTH A, RISE/FALL Time, and EVENTS B DUR A). With pin 7 of U1200 high, U1210D pin 12 is low, so Q114 is enabled. The Channel A signal is then inverted by U1001C and clocks U1000A on pin 5. The Channel A complement signal appearing on pin 6 of U1001B, is inverted by U1001E and clocks the synchronizer flipflop U1000C pin 16 after passing through U1001D.

NOTE

Transistors Q1110, Q1114, Q1111, Q1112 and Q1000 operate as switches to route the Channel A, Channel B, and 320 MHz time base signals through the proper logic gates for the selected front panel function. These transistors are either completely "on" or completely "off", depending on whether their base resistors are pulled high or low. Transistor Q1100 is used to disable U1001A. See Table 3-1.

FREQ A and PERIOD A

If the GATE signal from the microprocessor (U1200 pin 4) and the arming signal (ARM) on J1102-1 are both low, a low is set on the D input (pin 15) of U1000C after passing through U1110B. This low is transferred to pin 14 on the first Channel A edge that clocks U1000C after the measurement gate started. The low on pin 14 enables the second synchronizer, U1000B, and the Channel A accumulator gate, U1001C. With U1001C enabled, the next negative edge of the Channel A signal is allowed to pass through

U1001C, gets inverted, and is counted by the first binary stage of the Channel A accumulator (U1000A, pin 5).

For the FREQ A and PERIOD A functions, pin 14 of shift register U1200 is latched low. This turns on U1110C and turns off Q1112, allowing the 320 MHz time base signal to clock U1000B on pin 1. The first positive time base edge to clock U1000B after U1000C changed state, sets a low on pin 11 of U1000B, enabling the Channel B accumulator gate, U1110A. The next negative edge of the 320 MHz time base signal then passes through U1110A in its inverted form and is counted by the first binary stage of the Channel B accumulator (U1011C).

Table 3-1
SIGNAL ROUTING SWITCHING LOGIC FOR U1200
(X = low, blank = high)

PIN NUMBERS

Function	11	12	13	14	7
FREQ A		-		Х	
PERIOD A				X	
WIDTH A		Х	х	X	×
TIME MAN				X	
TIME A→B	×		x	X	×
RISE/FALL A	x		х	X	×
RATIO B/A	x				
TOTAL A, A+B, A-B	×				
PROBE COMP	x				
EVENTS B DUR A		х	х		×

After the synchronizers and accumulator gates have been enabled, all succeeding input pulses are counted by the Channel A accumulator and all succeeding time base pulses are counted by the Channel B accumulator.

The counting process continues until the selected number of averages have been satisfied or the time out period, while in the auto mode, has been satisfied. At this point, the gate signal from the microprocessor goes high, setting the D input (pin 15) of U1000C high. The next positive edge of the Channel A signal then clocks U1000C and pin 14 goes high, disabling U1000B and U1001C. The next 320 MHz time base edge then clocks U1000B, disabling U1110C and sending END low alerting the microprocessor that the measurement cycle has ended.

3-4 REV OCT 1981

When the measurement cycle has ended, the microprocessor reads the total counts in both accumulators. The Channel A accumulator contains the number of events or periods and the Channel B accumulator contains the number of time base clock pulses counted over the same interval.; The microprocessor divides the number of events in the Channel A accumulator by the total time in the Channel B accumulator to obtain the frequency (FREQ A) or divides the total time in the Channel B accumulator by the number of events in the the Channel A accumulator to obtain the period, or time per Channel A event (PERIOD A).

RATIO B/A

The KATIO B/A mode is the same as FREQ A and PERI-OD A, except that instead of counting 320 MHz time base pulses, U1110C is disabled by a high on pin 14 of shift register U1200, and Q1112 is enabled by a low from inverter U1210E. This allows the Channel B signal to clock U1000B. The counts are accumulated over the time interval determined by the number of averges selected. The RATIO B/A result is then calculated by dividing the number of Channel B events by the number of Channel A events. The AVGS exponent refers to the count in Channel A.

TIME A→B

For the TIME A→B function, Q1110 and Q1112 are disabled; Q1111, Q1114, Q1000, U1001E, U1110C, and U1001D are enabled. The first Channel A pulse slope that is selected, is inverted by U1001B, inverted again by U1001E, and then applied to pin 19 of U1001D. The synchronizers have been set by the MR₁ (Master Reset) pulse and the Channel A pulse clocks on pin 16 of U1000C.

As soon as the gate signal from the microprocessor sets pin 4 of U1110B low, the next Channel A clock edge to U1000C transfers the low on pin 15 to pin 14 and sets pin 13 high. The high on pin 13 passes through Q1000, disables U1001E, and prevents U1001D from being clocked by succeeding Channel A pulses. The Q output of U1000C (pin 14), being low, enables U1001A and allows the first succeeding Channel B pulse edge to clock U1000C via U1001D, setting pin 14 high and pin 13 low again. Pin 13, going low with the Channel B edge, also re-enables U1001E again for the next Channel A edge to clock U1000C.

During the period of time that pin 14 of U1000C is low, U1000B is enabled. The 320 MHz time base clock pulses are synchronized and gated by U1000B and U1110A, and then counted by the binary stages in the Channel B accumulator, beginning with U1011C.

Since Q1114 is disbled, U1001C is enabled with a low on pin 17 and also enabled each TIME A→B interval appears as a negative pulse on pin 10. This negative time interval

pulse is converted to a positive time interval pulse by U1001C and then counted by the binary stages in Channel A accumulator. Thus, for each TIME A→B interval, a count is accumulated in the Channel A accumulator; and during each of these intervals, the 320 MHz clock pulses are accumulated in the Channel B accumulator.

The microprocessor is continually reading the counts (accumulated time intervals) in the Channel A accumulator. When it finally reads a count greater than or equal to the selected number of averages (10^{N}) or when the measurement time in the auto mode ($\approx\!0.3$ seconds) has been satisfied, the microprocessor sets the gate signal on pin 4 of U1110B to a high level. The next Channel A pulse clocks a high through U1000C to pin 18 of U1001C and disables U1000B. The next 320 MHz clock pulse then toggles U1000B, disabling U1110A and allows the $\overline{\text{END}}$ signal line (J1102-1) to go low. This alerts the microprocessor that the measurement cycle has been completed. The microprocessor then makes a final reading of both accumulators, divides the total time by the number of intervals, and updates the display during the next measurement cycle.

WIDTH A

The WIDTH A function is essentially the same as the TME A—B except that Q1111 is disabled and Q1110 is enabled. This then allows the leading edge of the Channel A pulse width to be measured, and applied to pin 23 of U1001E and the trailing edge to be applied to pin 2 of U1001A, through the 3.5 ns delay line (DL 500).

The synchronizers (U1000C and U1000B) and the accumulator gates (U1001C and U1110A) function exactly like they did in TIME A→B. The pulse widths are regenerated on pin 14 of U1000C and during each of the negative pulse intervals, U1000B and U1001C are enabled so that the 320 MHz clock pulses (via Q1110C) can be counted by the Channel B accumulator. Also, each regenerated pulse is passed through U1001C and counted by the Channel A accumulator. Again, when the averages conditions have been satisfied, the microprocessor stops the measurement gate, reads both the accumulators, and divides the total time by the number of regenerated time intervals to obtain the average pulse width.

EVENTS B DUR A

The EVENTS B DUR A function is the same as WIDTH A except that instead of counting 320 MHz clock pulses via U1110C, the instrument is counting Channel B events during the selected Channel A pulse width via Q1112. To do this, Q1110, Q1112, and Q1000 are enabled. The leading and trailing edges of the Channel A pulse are again applied to pin 23 of U1000E and pin 2 of U1001A.

REV OCT 1981 3-5

Theory of Operation—DC 510

The Channel B signal passes through Q1112 to clock the second synchronizer, U1000B. When the gate signal on pin 15 of U1000C goes low, the synchronizers and accumulator gates function exactly as they did in WIDTH A (and described for TIME A→B). With U1001C enabled on pin 18, the Channel A pulse widths are counted in the Channel A accumulator while the Channel B events are counted in the Channel B accumulator. In EVENTS B DUR A the instrument is counting Channel B events only during Channel A pulse widths and averaging by the selected number of Channel A events.

When the selected or auto averages condition has been satisfied, the microprocessor sends the gate signal on pin 15 of U1000C high. The next Channel A trailing edge disables U1000B (pin 2 high) and the succeeding Channel B edge sets a low on pin 12 of U1000B. This completes the measurement cycle.

TIME MANUAL and TOTALize A

For the TIME MAN and TOTAL A functions, the microprocessor asserts the gate signal on pin 15 of U1000C after the MEASUREMENT START/STOP pushbutton on the front panel is pressed to start the measurement. The gate is unasserted (set high) when the pushbutton is pressed to stop the measurement.

For the TIME MAN function, Q114, Q1100, and U11100 are enabled. Immediately after asserting the gate signal, the microprocessor momentarily changes the Channel A triggering slope from its current setting to the opposite setting and then back again. This change provides an artificial Channel A signal that enables U1000C and allows the 320 MHz clock signal count to be accumulated in the Channel B accumulator. The accumulation continues until the measurement is stopped, at which time the microprocessor unasserts the gate signal and provides another trigger slope change to disable U1000C. This stops the accumulation of time base clock count. Throughout the measurement, the B Channel is continually read and then directly displayed with the proper annunciator illuminated.

While taking this reading, the display will occasionally flicker during the measurement. This is not the result of miscounting by the Channel A or Channel B accumulators; the correct count will be displayed when the measurement is finished.

For the TOTAL A function, Q1114, Q1100, and Q1112 are enabled. When the gate signal is asserted, Channel A events are counted (totalized) in the Channel A accumulator until the measurement is stopped. In this case, the microprocessor does not read the Channel B accumulator; only the Channel A accumulator counts are displayed. Display

scaling is accomplished by the microprocessor using the AVGS setting to select the desired scaling factor (power-of-ten). This scaling is independent of the actual counting process and can be changed during or after a measurement without affecting the count. Thus, the full 13 digits of the internal count chain can be examined by changing the AVGS exponent. Time, frequency units, and decimal point are not displayed for this function.

PROBE COMP and TEST

For the PROBE COMP function, the operator applies probe compensating signals to either Channel A or Channel B. For either of these modes, the counter is set up (internally) in RATIO B/A mode. This allows the Channel A or Channel B signals to pass straight through to the accumulators.

For the TEST function, the microprocessor generates artificial signals by programming the digital-to-analog converters (Diagram 6) through their full range. The outputs of the digital-to-analog converters are applied as trigger level changes to the differential amplifier circuits in the Channel A and Channel B Amplifiers (Diagram 2) an end up as counts in the two count chains. If an illegally large signal is present on an input (a signal beyond the range of the digital-to-analog converters), this process does not produce counts, and the TEST may fail. When a failure is indicated, all inputs should be disconnected and the TEST rerun.

A complete description of the self test function is in the Maintenance section. Front panel procedures for the PROBE COMP function are found in the Operating Instructions.

CHANNEL A AND CHANNEL B COUNT CHAINS—DIAGRAM 4

The Channel A and Channel B accumulators are two nearly symmetrical binary ripple counters, each having the capabilities for its contents being "read" serially by the microprocessor. Each accumulator begins with high speed ECL. Then, as the maximum toggle rates decrease, goes to medium speed ECL, then to LS TTL, and eventually CMOS. Wherever possible, a counter IC of a given family is shared: one half is used by Channel A and one half by Channel B.

The Channel A accumulator begins on the Analog board (A12) with signals clocking U1000A, pin 5 (see Diagram 3). The Channel B accumulator signal clocks U1011C, pin 1. The first two binary stages for each accumulator are ECL 100k and consist of U1000A and U1011A (Channel A) and U1011C and U1011B (Channel B).

3-6 REV OCT 1981

The counts (CH A FAST and CH B FAST) are routed from the Analog board to the Digital board (A16) through coaxial cables (W520 and W530). The next two binary stages for each count chain are ECL 10k and use IC's U1810A and U1801A (Channel A) and U1810B and U1801B (Channel B). Transistors Q1702, Q1701, Q1704, and Q1703, with associated circuitry, operate as fast ECL to LS TTL converters. These converters provide drive for the following LS TTL stages and must operate reliably up to 25 MHz. The counts in these (and the preceding) ECL stages must also be converted to CMOS levels for eventual readout by the microprocessor. However, since this conversion occurs long after the count chains have stopped counting and are stabilized, these translators need not be fast. The comparators U1710A, B, C, D and U1102A, B, and C have one input set at a voltage half-way between an ECL high and low. This voltage is set by resistors R1712 and R1710. With pull up resistors R1420 (fixed resistor network), R1207, R1208, and R1209 tied to +5 volts, the ECL transition from high to low (on the other input) results in a full CMOS swing on the comparators output. This results in a highly reliable translator that draws little power.

The next bit of each chain is a single LS TTL flip flop, U1120A, Channel A (U1120B, Channel B). Following this IC is an LS TTL 4-bit counter, U1113A, Channel A (U1113B, Channel B). These stages, too, must be read by the microprocessor. The LS TTL outputs are pulled high by the fixed resistor network, R1014, to ensure valid CMOS levels to the serial readout circuitry. At this point, the two accumulator chains lose their symmetry (not for functional reasons but for more economical use of the components). The Channel A accumulator uses the 16-bit counter contained in U1410 (see Diagram 9). The Channel B accumulator, (Diagram 4) uses 11 of the 12 bits available in the CMOS counter, U1212. The circuitry described provides a total of 29 hardwired bits for the Channel A accumulator and 24 hardwired bits for the Channel B accumulator. Since each accumulator requires 43 bits, the firmware counters supply 14 bits (Channel A) and 19 bits (Channel B) respectively.

Five CMOS parallel-to-serial shift registers consisting of U1121, U1114, U1122, U1211, and U1312 are used by the microprocessor to read out the contents of the Channel A and B accumulators. When the ILATCH control line (pin 9 of each register) is brought high, data are applied into the registers asynchronously with the clock. When pin 9 is brought low again, data can be shifted into (pin 11 of each register) and out of (pin 3 of each register) the registers synchronously with the positive transition of the SERIAL CLOCK signal (pin 10 of each register).

Before each measurement is initiated by the micro-processor, the MR₁ (Master Reset) signal is asserted via pin 33 of U1410 (see Diagram 9). This reset signal is inverted by U1520D (Diagram 4) applying $\overline{\text{MR}}$ to pin 1 of U1120A. The $\overline{\text{MR}}$ signal is also inverted and buffered again by U1314D,

U1314F, and U1520E to provide an ECL, LS TTL, and CMOS compatible reset signal (MR₁) to the ECL stages on both the Analog and Digital board and to the LS TTL and CMOS stages on the Digital board. The MR₁ signal also guarantees the two synchronizer flip flops (located on Diagram 3), U1000C and U1000B, will begin set.

PLL—DIAGRAM 5

The 10 MHz standard time base consists of a 10 MHz crystal, Y1520, and a Colpitts oscillator circuit, Q1420, and associated circuitry. The frequency of the standard time base is adjusted by variable capacitor, C1521 (accessed through the instrument's back plate).

The Option 01 high stability time base consists of a self contained, oven controlled 10 MHz oscillator, Y1530. This time base is adjusted via a hole in the rear of the case (accessed through the instrument back plate). The 18 volts input to the time base is derived from the fused +26 volts in the power module and regulated by a three-terminal regulator circuit, U1430, and associated circuitry.

NOTE

The single-starred schematic diagram 5 components for the standard time base circuit are removed if the Option 01 time base circuit is installed.

The 10 MHz output signal from either the internal time bases or an external source (1, 5, 10 MHz) is applied to the base of Q1500. The buffered signal at the collector of Q1500 can be either 1 MHz, 5 MHz or 10 MHz. This signal is buffered again by U1500F. If the input signal frequency is 1 MHz, jumper plug P1510 (located on the Auxiliary board) connects pins 4 and 5 of J1510. A 5 MHz external input signal requires that IC U1411 divide-by-five (\div 5), therefore, P1510 connects J1510 pins 2 and 3 or pins 3 and 4. A 10 MHz time base signal requires U1411 to divide-by-ten (\div 10). Component P1510 then connects J15120 pins 1 and 2. The signal to the base of Q1401, in all cases, must be 1 MHz.

Emitter follower Q1401 and associated components operate as a single-pole filter generating a sawtooth type signal at the negative input pin of comparator U1400. For the TIME A \rightarrow B, WIDTH A, and EVENTS B DUR A functions, the base of Q1300 is set low via pin 7 of shift register U1200 (as shown on Diagram 3). In these functions, the Noise Generator (Diagram 5), U1410, is enabled by applying +5 volts to the V_{ss} input, pin 4. The output from U1410 (pin 3) will be -12 volts to +5 volts signal with a pseudo-random edge

REV OCT 1981 3-7

Theory of Operation—DC 510

distribution. This signal is then attenuated by resistor, R1410, and applied to pin 2 (+) of U1400. Also, with these functions, U1400 operates as a phase modulator circuit. The output (pin 7) of U1400 is a 1 MHz signal that is phase modulated by the noise signal generated by U1410. For the other remaining functions, transistor Q1300 is turned off, U1410 is disabled, and U1400 operates only as a buffer stage.

The 1 MHz squarewave signal from U1400 (pin 7) is applied to pin 1, U1021 with the negative edge (falling edge) used as a reference edge for the Phase Locked Loop (PLL) U1021. This IC compares the signals negative edge (pin 1) with the positive edge (pin 3) and produces an output proportional to the phase difference between these two input signals. The output at pins 5 and 10 (U1021) is then filtered by a low pass filter with its bandpass providing the proper phase noise bandwidth for time interval measurements. This filter, Q1030A with associated components, is amplified and inverted by operational amplifier U1030B. The amplifier output is a dc level proportional to the phase difference between the 1 MHz reference and the output of the PLL multiplier. The dc level voltage is coupled to a Colpitts oscillator circuit, Q1130 and associated components, and is inductor-tuned by the varactor diode, CR1130, and series capacitor C1032. The PLL adjusts the varactor diode voltage, which adjusts the oscillator frequency producing a precise 320 MHz output signal. The oscillator output is ac coupled to U1022A and a threshold reference voltage is generated by sensing the complementary outputs of U1022C through resistors R1021 and R1026. The at the junction of these two resistors, establishes this threshold reference at pin 3 of U1022A. The oscillator output rate on pin 3 produces a 320 MHz reference sinewave from pin 8. This sinewave is the clock that is counted for the different measurement modes of the counter. The 320 MHz signal is applied to pin 1 of U1022B (a set/reset latch that resets itself at 320 MHz, and buffers and provides proper ECL drive). This signal is then divided down to 160 MHz at pin 12, Q1022B. Another divide-by-two (+2) IC, U1022C, results in an 80 MHz output. This output is ac coupled to U1020, pin 7 and divided-by-eighty, (+80) producing the 1 MHz signal at pin 2. Any error in output at pin 2 of U1020 is sensed by U1021. This sensed voltage, applied to varactor diode CR1130, adjusts the Colpitts oscillator producing the precise 1 MHz signal at pin 3 of U1021.

D/A's, 50 Ω PROTECT, AND ARMING—DIAGRAM $\stackrel{\frown}{6}$

The isolation resistors for the 50 Ω Protect A (B) sense lines were discussed earlier (Diagram 1). The sense lines are routed from the Analog board to the Auxiliary board via jacks J1510 and J1520.

The 50 Ω Protect circuit is composed of a quad comparator (U1111) with associated components. Two of these

comparators are arranged as "window" comparators (Channel A and B), that receive the protect sense levels from the Channel A or B inputs. These voltage sense levels normally operate within a ± 2 V window. If the sense levels go outside this window (high or low), the comparator output changes states (to a low state) and issues a 50 Ω A (B) $\overline{\mbox{PROTECT}}$ signal to the microprocessor. The microprocessor recognizes this protect line and automatically changes the input relays from the 50 Ω TERM to the 1 $\mbox{M}\Omega$ TERM.

Trigger levels (CH A LEVEL and CH B LEVEL) are established, using a 10-bit D/A converter, U1210 and U1310 (Channel A and B). The data (SERIAL DATA lines) are received from the microprocessor through serial-to-parallel converters U1010 and U1020 (Channel A and B-see Diagram 7). These parallel output lines (Diagram 6) form the digital word that is applied to the D/A converter. The digital word corresponds to a unique current that is sinked at pin 3 of the D/A converters (U1210, Channel A; U1310, Channel B). This current, appearing at pin 2 of the operational amplifier circuits, U1200A (Channel A) and U1200B (Channel B), is converted to a voltage. This voltage can be offset by potentiometer R1205, (R1207, Channel B) and the voltage range adjusted by potentiometer R1204 (R1206, Channel B). The output of U1200A (U1200B) at pin 1 is the trigger voltage that is routed to the amplifier circuitry on the Analog board (see Diagram 1).

The arming circuit input load (Diagram 6) is 1 standard TTL load. The input is positive overvoltage protected by diode CR1510 (reverse biases upon receiving an excessive positive overvoltage). Diode CR1511 is the negative overvoltage protection component (clamps the output to a diode below ground) and is current limited by resistor R1500.

Transistors Q1510 and Q1511 form a Schmitt trigger providing noise immunity to the arming inputs (ARM IN and EXT ARM IN). The ARM output signal is routed to the digital circuitry (Diagram 3).

RELAY DRIVE—DIAGRAM (7)

The serial-to-parallel converters, U1010 (Channel A) and U1020 (Channel B), are used to change the serial data from the microprocessor to the parallel data. This data will select the particular relay to be activated. The converter output data are applied to U1110 (U1020, Channel B) that consists of seven Darlington NPN transistors (shown as inverters). These devices are used as current sinks to drive the relay coils. With one end of the selected relay coil brought low via one of the inverters (U1110), a voltage pulse is applied to the opposite coil end. This voltage pulse is generated by the microprocessor (see Diagram 9) and then amplified and regulated by the pulse amplifier circuit consisting of transistors Q1031, Q1030, Q1032 and associated circuitry (Diagram 7).

3-8 REV OCT 1981

The pulse is approximately 8 V in amplitude with a 25 ms width; therefore, when a relay coil is energized, the inverter output is brought low and the microprocessor pulses the pulse amplifier to direct the current flow to the selected relay coil. This causes the relay to change state and latch.

The Darlington transistors Q1121 and Q1120 (with associated circuitry), are used to drive the relay coils, K1612 (K1632, Channel B), that provide for the Common Separate channel input function (see Diagram 1).

POWER SUPPLIES—DIAGRAM (8)



The four main supplies derive power input (through the instrument's two rear interface connectors) from the TM 500 or TM 5000-Series power module. These primary supplies are the +12 V and +5 V, located on the Auxiliary board, and the other +5 V and a -12.2 V, located on the Digital board. They are individually fused and current limited. The four supplies are referenced to the +2.5 V (Master Reference) precision voltage reference supply on the Auxiliary board.

The secondary supplies include the +2.7 V (ECL Termination), +5.7 V (derived from the +12 V supply), -5 V (three-terminal regulator derived from the −12.2 V supply), +33.5 V/+26 V from the power module) that is used in the Option 01 timebase only (see Diagram 5) and the +18 V (three-terminal regulator derived from the Option 01 timebase only (see Diagram 5).

The +12 V supply (located on the Auxilian ard—Diagram 8) is derived from 133.5 V/+26 V dc power. Auxiliary board-Diagram 8) is derived from the unregulated +33.5 V/+26 V dc power in the power module. The +12 Vregulator circuit consists of U1420 and associated components. Load current for this supply passes through resistor R1425 (current limit sensing component) and the PNP series-pass transistor located in the power module. The +12 V supply is regulated within design limits by varying the voltage on the base of the series-pass transistor via P1600 pin 11A. The Zener diodes, VR1410 and VR1411, reduce the voltages to appropriate levels for U1420. Should the load current exceed 0.4 A, the voltage drop across R1425 becomes great enough to current limit U1420. This voltage is sensed at U1420 (pins 2 and 3) and reduces the base-to-collector voltage of the series-pass transistor. Feedback signals for voltage regulation of the +12 V supply appear on pin 4 (U1420) and are compared with the +2.5 V reference voltage on pin 5. Capacitor C1310 provides for frequency compensation.

Emitter follower Q1330 uses pin 6 (V_{ref}) of U1420 to provide an input voltage for the precision voltage reference, U1223. The +2.5 output voltage is used for all four major supplies and is a master reference source for the D/A's.

The +5 V supply (located on the Auxiliary board) is derived from the unregulated +11.5 V/+8 V dc power in the power module. The +5 V regulator circuit consists of U1320 and associated components. Load current for this supply passes through current limit sensing resistor R1426 and the NPN series-pass transistor (located in the power module). This supply is also regulated by varying the voltage on the series-pass transistor base (P1600 pin 6A). If the load current is exceeded, the voltage drop across R1426 will cause U1320 to limit this current. This voltage (sensed at pins 2 and 3 of U1320) causes the series-pass transistor to turn off. The feedback signal for the voltage regulator occurs on pin 4 (U1320) and is compared to the reference voltage on pin 5. Capacitor C1320 provides for frequency compensation.

The other +5 V supply (located on the Digital board) is identical in operation to the +5 V supply just discussed. It consists of the regulator, U1720 and associated components, and an NPN series-pass transistor (located in the power module). An additional filter network consisting of C1022 and L1020 provides the display power and isolates its noise from the rest of the instrument.

The -5 V supply (located on the Auxiliary board) consists of a three-terminal regulator, U1330, that provides reg-

The +2.7 V supply (located on the Auxiliary board) is the ECL termination supply and is used as a terminating supply for all the pull-down resistors located in the ECL circuits on the Analog board (see Diagrams 3 and 5). The +2.7 V supply is derived from the +5 V supply and consists of an error amplifier, Q1333, an amplifier stage, Q1331, an emitterfollower output stage, Q1332, and associated components.

The -12.2 V supply (located on the Digital board) is derived from the unregulated -33.5 V/-26 V dc power in the power module. This supply consists of error amplifier Q1723 and Q1722, error signal amplifier Q1721, current limit sense amplifier Q1720, and associated components. The reference voltage on the base of Q1723 is approximately 0 V. Diode CR1620 provides temperature compensation for the error amplifier circuit. This supply is regulated within design limits by varying the voltage on the base of the PNP seriespass transistor, located in the power module, via the collector of Q1721. An excessive load current through current limit resistor R1718 causes Q1720 to increase conduction and the bases of Q1723 and Q1721 to go more negative. The PNP series-pass transistor base goes more positive, thereby reducing the load current below the design limit.

3-9 **REV OCT 1981**

PROCESSOR AND DISPLAY DRIVERS-DIAGRAM (9

Introduction

The DC 510 is a digital counter based on a microcomputer system. The microprocessor, U1510 (located on the Digital board-Diagram 9), controls the internal operations of the DC 510. The microprocessor recognizes, accepts, and decodes commands (keypushes and control settings) from the front panel logic circuits (Diagram 10) and sets the operating parameters in response to these commands.

Integrated circuit U1410 contains a random access memory (RAM) space that provides a maximum of 128 locations (addresses) which the microprocessor uses to temporarily store 8-bit data bytes. The data is not permanent and will be lost whenever the instrument power is turned off. When power is first applied, the RAM data occurs as random bits and is therefore meaningless. During instrument operation, the microprocessor writes data into the RAM at various addresses for later recall and use.

The instructions (firmware) concerning manual operation of the DC 510 stored in EPROM U1610 (a 4k byte memory) HP://manoman and in the ROM section of U1410 (a 2k byte memory). The other RAM is located in U1311.

System Clock

The microprocessor, U1510, contains a single phase internal clock generator at pins 27 and 28, in conjunction with inverter U1520F, whose 1 µs period (approximately) is controlled by the rc feedback network consisting or R1601 and C1601. The activity of U1510, when it is reading data from or writing data to a memory device, occurs in machine (U1510) cycles. Since no critical system timing relies on the microprocessor clock, a crystal is not needed.

Power Up Reset Cycle

When the instrument is powered up, comparator U1102D (and associated components) operates as a delay/comparator circuit to provide a pulse to reset the microprocessor to its reset vector address location.

Pin 14 of U1102D is held low for approximately 1.5 seconds (to allow all supplies to come up to operating status in the TM 500 or TM 5000-Series power modules). During this time all of the internal registers of U1410 (except the 16-bit counter and serial shift register) are cleared to logic zero. This action places all of the bidirectional input/output lines of U1410 in the input state and disables the internal shift register. Display Interrupt Clock input (pin 37), and the interrupt output (pin 4). Also, during the low level period of the microprocessor reset signal, the writing of data to or from U1510 is inhibited, and a bright digit may be displayed on the DC 510's front panel.

When the positive edge is detected on pin 1 of U1510, the internal mask interrupt flag will be set and the microprocessor will load its internal program counter from the reset vector address listed in Table 3-2. This is the start location for program control.

Interrupt Vector (IRQ)

Integrated circuit U1410 has two internal registers for interrupt control, an interrupt enable register and interrupt flag register. Corresponding bits in these registers are logically ANDed to set an interrupt request pending flag. When U1410 detects the pending flag bit, it asserts pin 4 as a low output, generating an interrupt request to the microprocessor.

When a low level is set on pin 4 of U1410, the microprocessor completes the current instruction before recognizing the interrupt request and examining its own interrupt mask flag bit. If the interrupt mask flag bit is not set, the microprocessor starts an interrupt routine. The contents of its program counter and status register are temporarily stored in RAM, the interrupt mask flag bit will be set to prevent further interrupts, and the program counter will then be loaded with the high and low bytes of the interrupt vector address listed in Table 3-2. This is the start location for the interrupt routine for U1410.

Table 3-2 DC 510 INTERRUPT VECTORS

Vector Address ^a	Type of Interrupt		
\$FFFC - \$FFFD	Power-Up Reset		
\$FFFE - \$FFFF	Interrupt Request (U1410)		

^aDollar sign (\$) indicates that address code is in hexadecimal notation.

There are three possible reasons why U1410 sets an interrupt pending flag, two external events and one internal event. The two external events are: a negative edge detected on pin 36 (CH B SLOW) or a negative edge detected on pin 37 (Display Interrupt Clock); the one internal event occurs when the 16-bit counter inside U1410 overflows.

REV OCT 1981 3-10

Address Decoding

The microprocessor addresses U1610, U1410, and U1313 when communicating with the instrument functions. Table 3-3 lists the hexadecimal address ranges for these devices.

Table 3-3 DC 510 MEMORY ADDRESS RANGE

Hexadecimal Address Range	Comments
\$000 - \$007F	U1311 (128 X 8 RAM)
\$0080 - 0087	U1313 (Front panel display, Serial
	Data latches, and GPIB address
	switches)
\$0400 - \$04FF	U1311 (256 X 8 RAM)
\$0700 - \$070F	U1410 I/Oa
\$0800 - \$0FFF	U1410 (2k X 8 ROM)
\$1000 - \$1FFF	U1610 (4k X 8 ROM)

aSee Table 3-4.

Memory select decoders U1313, U1420, and related components, operate to select the proper memory device during program control.

The input/output sections internal to U1410 are cessed by the microprocessor using address hits ough A3 for specific control of the ble 3-4. accessed by the microprocessor using address bits A0 through A3 for specific control of the internal functions. See Table 3-4.

Table 3-4 **ADDRESS CODE FOR U1410** (\$0700-\$070F)

Address Bits			s	Internal Functions	
А3	A2	A1	A0		
0	0	0	0	Port A	
0	0	0	1	Port B	
0	1	0	0	Read Lower Counter/Write Lower Latch	
0	1	0	1	Read Upper Counter/Write Upper Latch and Download	
0	1	1	0	Write Lower Latch	
0	1	1	1	Write Upper Latch	
1	0	0	0	Serial Data Register	
1	0	0	1	Interrupt Flag Register	
1	0	1	0	Interrupt Enable Register	
1	0	1	1	Auxiliary Control Register	
1	1	0	0	Peripheral Control Register	
1	1	0	1	Data Direction Register—Port A	
1	`1	1	0	Data Direction Register—Port B	

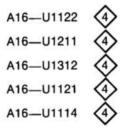
NOTE

Due to the complexity of the internal functions associated with U1410, a detailed description of this device will not be attempted in this manual. If more detailed information is needed, refer to the manufacturer's data sheets.

Serial Data Path. The serial data path is shown on the block diagram (see Figs. 8-6 and 8-7). Serial data are written, via pins 38 and 40 of U1410, to five serial-to-parallel shift registers located on the Auxiliary circuit board (A18 assembly), and one serial-to-parallel shift register on the Analog board (A12 assembly). This is done when the microprocessor sets the instrument's internal circuits for the desired function. These registers are, in sequence:

A18—U1010	\Diamond
A18—U1020	\Diamond
A18—U1222	6
A18—U1220	€
A18—U1221	6
A18—U1200	ᅠ③

The serial data output from A12-U1200 then goes, via P1102-6 (Diagram 3), to five parallel-to-serial shift registers (Channel A and Channel B accumulators) located on the Digital circuit board (A16 assembly). Serial data is shifted through these registers and returned to the microprocessor via the data buffer, U1310B. Serial data is read from the following parallel-to-serial shift registers:



Pin 40 of U1410 serves both as an input and output for serial data. When the microprocessor is in the serial write mode, pin 40 is configured as an output and bytes of information are loaded into the internal serial data registers of U1410. They are then shifted out serially to the shift registers on the A12 assembly (Analog board). During the writing of serial data the three-state data buffer, U1310B, is disabled with a high level on pin 15, preventing the serial data input from contending with the serial data output via U1114-3. The microprocessor addresses U1313, causing a negative pulse on pin 14 (OLATCH) to latch the serial data in the serial-to-parallel shift registers.

Theory of Operation—DC 510

When the microprocessor is reading the serial data from the Channel A and Channel B accumulators, pin 15 of U1310B is set low at the same time pin 40 of U1410 is configured as an input. The serial data are then read in as five consecutive bytes. The microprocessor addresses U1313 and uses pin 15 (ILATCH) to latch data during the serial read process.

Display Interrupt Clock. The front panel keyboard and displays are interrupt driven by the timing circuit consisting of U1520A, U1520B, and associated components. This circuit operates at approximately 1.1 kHz. The negative edges of the signal on pin 37 of U1410 interrupt the microprocessor, telling it to update the display and search for a new keypush or control setting. The microprocessor addresses U1313 and uses pins 7, 9, 10, 11, and 12 during this process.

Power Up Sequence. After the microprocessor and peripheral device U1410 have been reset at power up, the DC 510 microprocessor generates the following sequence of events.

- 1. Loads a 0 in the most significant bit position of the front panel display.
- 2. Tests the RAM, starting at address \$0000. If a RAM failure is found, error code 340 will be displayed.
- Tests the two ROMs for byte location and determines the checksum. If a ROM error is found, error code 361, 380, or 381 will be displayed.
- 4. Checks to see if the Channel A TERM button is held in, and, therefore, if signature analysis (SA) is being requested. If the SA is not requested, the interrupt registers in U1410 are enabled.
 - 5. Initializes peripheral device U1410.
- Performs a serial input/output test. If an error is found, error code 313 will be displayed.
- Sets up the hardware to determine the state of the front panel, loads the serial-to-parallel shift registers, and generates the relay strobe signals via pin 26 of U1410.
- 8. Performs the counter chain (Channel A and Channel B accumulators) integrity test. If this test fails, an error code

(320 through 324 and 329 for Channel A or 330 through 334 and 339 for Channel B) will be displayed.

- Starts the measurement cycle by pulsing the master reset line (pin 33 of U1410).
- 10. After the master reset pulse, the measurement gate on pin 4 of U1200 (Diagram 3) is started. During the measurement gate interval, the microprocessor is continually reading the contents of the Channel A accumulator for a count that is greater than or equal to the number of averages requested by the user. When that count is reached, the measurement gate is unasserted and the microprocessor waits for the signal on pin 35 of U1410 to go low, indicating the end of the measurement cycle. The accumulators are then read again for their final count and a new measurement cycle is started after the result is calculated and the display is updated.

Rear Interface Signals. The PRESCALE line for U1410 (pin 29) operates as an input that indicates to the microprocessor the presence of an external prescaling counter. When an external prescaler is used, the microprocessor multiplies the Channel A accumulated counts by 16 before the display is updated.

The microprocessor interprets the reset input from U1500A (Diagram 6) to pin 32 of U1410 as the electrical equivalent of the front panel MEASUREMENT START/STOP pushbutton.

NOTE

Complete data for all of the rear interface signals are given in the Maintenance section of this manual.

PUSHBUTTONS AND LEDS—DIAGRAM 10

The microprocessor uses five control lines and the 8-bit data bus to communicate with the Pushbuttons and LEDs and Display circuits. The five control lines are all derived from U1313 located on Diagram 9.

The interrupt signal from the Display Interrupt Clock (Timer) circuit to U1410 (Diagram 9, previously discussed) occurs approximately once every 900 μ s. Each interrupt causes the microprocessor to start a software routine for servicing the Pushbuttons and LEDs, and Display circuitry.

Each digit and annunciator in the display, each pushbutton LED, and each control or pushbutton is assigned a time slot period approximately equal to the period between successive interrupts. The time slots are generated by U1121, a decade counter with 10 decode decimal outputs. The counter provides time slot decoding for scanning the front panel controls and multiplexing the seven-segment LEDs and LED annunciators located on Diagrams 10 and 11. The logic high outputs of U1121 are buffered by nine Darlington amplifiers (Q1121, Q1122, etc.).

Each interrupt signal causes the microprocessor to clock U1121 with a negative pulse of approximately 500 ns on pin 14, advancing the count to the next time slot. Immediately after clocking U1121, the microprocessor updates the digit associated with that time slot by sending data to U1112 and U1111, which contain six D-type flip flops each. Data are latched in U1112 and U1111 when pin 9 goes low and transfers to the outputs on the positive edge of the CLOCK signal. The BCD output of U1112 is then decoded to sevensegment information by U1101. Data latches into U1111 and are inverted and buffered by U1110 to drive the decimal point (dp), the pushbuttons, and annunciator LEDs. The display drive power supply filter is a pi-network consisting of C1022, L1020, C1020, and C1021 (Diagram 8). This filter circuit prevents display noise pulses from disturbing the sensitive instrument circuits.

After updating the display and checking the front panel status, the microprocessor returns to the routine of resetting the input circuits (if necessary), monitoring the measurement cycle, or collecting the data for the selected function. This continues until the next front panel interrupt signal occurs, when it again clocks U1121 for the next time slot and repeats the procedure.

DISPLAY—DIAGRAM



The nine digits in the display are seven-segment, common anode LEDs; DS1001 is the Most Significant Digit (MSD) and DS1301 is the Least Significant Digit (LSD). The time slot lines (previously discussed) are generated by a nine-state decade counter, U1121 (Diagram10). The microprocessor sends all 1's (D1-D4) for the seven-segment information when leading zero supression is indicated. All 1's are decoded by U1101 (Diagram 9) as a blank.

To illuminate the proper LED or indicator in the display, the microprocessor sets pins 9, 25, 30, 33, and 36 of P1001 low only during the time slot that corresponds to the displayed units of measurement or indicator.

The pushbutton switches are common to one of the four sense lines (MISC, FUNCTION, RELAYS, and MORE). The microprocessor senses the switch closure during an active time slot (logic high) by addressing U1310 (tri-state buffer).

The illumination interval of the GATE light (DS1304) during time slot six, is only approximately equal to the actual measurement gate interval. The GATE light is turned on and then off only to tell the operator that the counter has been triggered and that the microprocessor has completed the functional measurement for the selected number of averages. The gate light is not directly connected to the actual hardware gate.

CALIBRATION

PERFORMANCE CHECK PROCEDURE

Introduction

This procedure checks the electrical performance requirements as listed in the Specification section in this manual. Perform the Adjustment Procedure if the instrument fails to meet these checks. In some cases, recalibration may not correct the discrepancy; circuit troubleshooting is then indicated. Also, use this procedure to determine acceptability of performance in an incoming inspection facility.

Calibration Interval

To ensure instrument accuracy, check the calibration every 2000 hours of operation or at a minimum of every six months if used infrequently.

Service Available

Tektronix, Inc. provides complete instrument repair and adjustment at local field service centers and at the factory service center. Contact your local Tektronix field office or representative for further information.

Test Equipment Required

The test equipment (or equivalent) listed in Table 4-1 is suggested to perform the Performance Check and Adjustment Procedure.

Table 4-1
LIST OF TEST EQUIPMENT REQUIREMENTS

Description	Performance Requirements	Perf. Check	Adj. Proc.	Example
Power Module		х	х	TEKTRONIX TM 5003, TM 5006, or TM 500-Series
Digital Multimeter	4 1/2 digits, 0.5%. Ranges: 2 kΩ–2 MΩ and 2-20 Vdc	х	x	TEKTRONIX DM 501A
1 MHz Frequency Standard	1 MHz ±1 x 10 ⁻⁹	x		SPECTRACOM CORP TYPE 8161
Leveled Sinewave Generator	Calibrated amplitude @ 350 mV. Frequency: >200 MHz	х		TEKTRONIX SG 503
Leveled Sinewave Generator Calibrated amplitude @ 350 mV. Frequency: >350 MHz		х		TEKTRONIX SG 504
Function Generator Range, sinewave 10 Hz to 1 MHz; offset ±13 Vdc level		х	х	TEKTRONIX FG 501A
Pulse Generator	Risetime <1 ns. Amplitude 0-3 V	х	χ .	TEKTRONIX PG 502
50 Ω Feedthrough Termination	Bnc connectors	х	x	Tektronix Part No. 011-0049-01
Coaxial Cable, 50 Ω Precision 36 inch	Bnc connectors	х	х	Tektronix Part No. 012-0482-00
Coaxial Cable, 50 Ω Precision 18 inch	Bnc connectors Bnc connectors Saprill Colf	x		Tektronix Part No. 012-0076-00
Coaxial Cable, 50 Ω Precision 42 inch	Bnc connectors	х		Tektronix Part No. 012-0057-01
Adapter, Bnc Female To Dual Banana	ttp://man	х	x	Tektronix Part No. 103-0090-00
Cable Assembly RF (bnc-to-slide on connector)	50 Ω coaxial cable	х	x	Tektronix Part No. 175-3765-01
Probe, 5x		Х		TEKTRONIX P6125
Flexible Extender			x	Tektronix Part No. 067-0645-02
Power Dividier GR	1000	х		Tektronix Part No. 017-0082-00
GR To Bnc Female adapters (3)		х		Tektronix Part No. 017-0063-00
50 Ω, 10X Attenuator	Bnc connectors	х	x	Tektronix Part No. 011-0059-02
50 Ω, 5X Attenuator	Bnc connectors			Tektronix Part No. 011-0060-02
50 Ω, 2X Attenuator	Bnc connectors		x	Tektronix Part No. 011-0069-02
Connector, Dual Bnc		x		Tektronix Part No. 103-0029-00

PRELIMINARY CONTROL SETTINGS

DC 510

FREQ A

(lighted)

CHANNEL A and

CHANNEL B

SLOPE

+ (unlighted)

X1 (lighted)

COUPL

DC (unlighted)

TERM

1 M Ω (unlighted)

Check Oscillator Frequency (Standard timebase)

NOTE

The timebase accuracy is a function of temperature and time. The temperature stability for the standard time base is ± 5 ppm (0° C to 50° C) with an aging rate of ± 1 ppm/year.

After one year of operation (since the time base was calibrated), the 1 MHz frequency standard should read 1.0000000, ± 6.0 ppm for any temperature between 0° C to 50° C. The ± 6.0 ppm are determined by ± 5 ppm due to temperature, ± 1 ppm due to aging, and ± 1 count to synchronization error. After this check is completed, the user should determine if a time base recalibration is required.

- a. Connect a coaxial cable from the 1 MHz frequency standard output to the DC 510 CHANNEL A input.
 - b. Press the DC 510 AUTO TRIG button.
- c. CHECK—that the DC 510 readout is within 999.99399 kHz and 1.0000061 MHz (± 6.0 ppm, ± 1 count).

2. Check Time Base Oscillator Frequency (Option 01)

NOTE

The temperature stability for the Option 01 time-base is 0.2 ppm (0°C to 50°C) with an aging rate of \pm 1 ppm/year and \pm 1 count.

 a. Connect a coaxial cable from the 1 MHz frequency standard output to the DC 510 CHANNEL A input.

- b. Press to light the DC 510 FREQ A button, then press the AUTO TRIG button.
- c. CHECK—that the DC 510 readout is within 999.99879 kHz and 1.0000013 MHz.
 - d. Remove all cable connections from the DC 510.

3. Check the Trigger Level CH A and CH B Accuracy

Refer to Fig. 4-1, performance check setup. Use the following control settings.

Digital Multimeter

Function-Range

2 V

DC 510

CHANNEL A and CHANNEL B

ATTEN

X1 (lighted)

- a. Connect the DC 510 CH A SHAPED OUT to the digital multimeter input using the bnc-to-slide on connector assembly (standard accessory).
 - b. Press the DC 510 AUTO TRIG button.
- c. Press the DC 510 ↑ (increment) button until the digital multimeter display just changes to a low readout. Press the DC 510 ↓ (decrement) button until the digital multimeter display just changes to a high readout.
- d. CHECK—that the DC 510 display readout indicates between ± 0.010 and ± 0.010 .
- e. Connect a coaxial cable from the pulse generator output to the digital multimeter input using a bnc-to-banana adapter.
- f. Set the pulse generator for Ext Trig and Ext Dur and adjust the output for a displayed readout of approximately +2.000 on the digital multimeter. Note this reading.
- g. Disconnect the cable from the digital multimeter bncto-banana adapter and connect to the DC 510 CHANNEL A input.
- h. Reconnect the accessory cable assembly to the digital multimeter input.

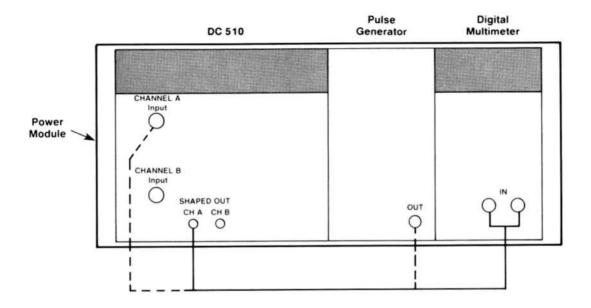


Fig. 4-1. Performance Check setup for step 3.

- i. Press the † (increment) button until the digital http://manonan.sqhill multimeter display just changes to a low readout. Press the . (decrement) button until the digital multimeter display just changes to a high readout.
 - j. Press the DC 510 AUTO TRIG button.
- k. CHECK-that the DC 510 display readout indicates the same value as was noted on step 3-f, \pm 40 mV.
- 4. Check Input Impedance: 50 Ω , $\pm 3\%$; 1 M Ω , ±1%

Refer to Fig. 4-2 performance check setup. Use the following control settings.

Digital Multimeter

Function-Range

 $2 M\Omega$

DC 510

CHANNEL A and CHANNEL B

> X1 (lighted) ATTEN 1 m Ω (unlighted) **TERM**

a. Connect a coaxial cable from the DC 510 CHANNEL A input to the digital multimeter input using a bnc-to-banana adapter.

- b. CHECK-that the digital multimeter display readout indicates between .9800 and 1.0200 (M Ω).
- c. Press the DC 510 CHANNEL A ATTEN X1 button (lighted).
- d. CHECK-that the digital multimeter display readout indicates between .9800 and 1.0200 (M Ω).
- e. Change the digital multimeter Function-Range switch to 2 kΩ.
- f. Press the DC 510 CHANNEL A TERM 50 Ω button (lighted).
- g. CHECK-that the digital multimeter display readout indicates between .0490 and .0510 (k Ω).
- h. Press DC 510 CHANNEL A ATTEN X5 button (unlighted).
- i. CHECK-that the digital multimeter display readout indicates betwen .0490 and .0510 (k Ω).

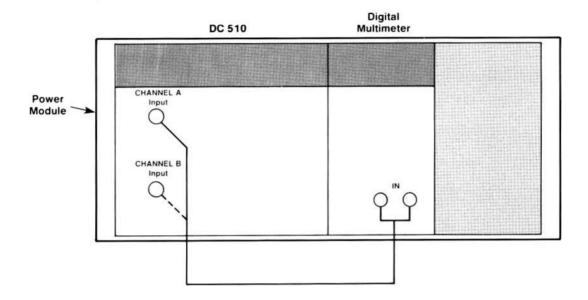


Fig. 4-2. Performance Check setup for steps 4 and 7.

- j. Move the cable connection from the DC 510 CHAN-NEL A input to the CHANNEL B input.
- k. Change the digital multimeter Function-Range switch to 2 M Ω .
- I. CHECK—that the digital multimeter display readout indicates between .9800 and 1.0200 (M Ω).
- m. Press the DC 510 CHANNEL B ATTEN X1 button (lighted).
- n. CHECK—that the digital multimeter display readout indicates betwen .9800 and 1.0200 (M Ω).
- o. Change the digital multimeter Function-Range switch to 2 $k\Omega.$
- p. Press the DC 510 CHANNEL B TERM 50 Ω button (lighted).
- q. CHECK—that the digital multimeter display readout indicates between .0490 and .0510 (k Ω).

- r Press the DC 510 CHANNEL B ATTEN X5 button (unlighted).
- s. CHECK—that the digital multimeter display readout indicates between .0490 and .0510 (k Ω).

5. Check the Arming Input Pulse Response \geq 100 ns (VH \geq 2.4 V, VL \leq 0.4 V)

Refer to Fig. 4-3, performance check setup. Use the following control settings.

Pulse Generator

Pulse Duration	Squarewave
Period	.1 µs
Back Term	(in)

Sinewave Generator

Frequency Range (MHz)	50-100
Output Amplitude	1.25 V

DC 510

CHANNEL A and CHANNEL B

ATTEN X1 (lighted)
TERM 50 Ω (lighted)

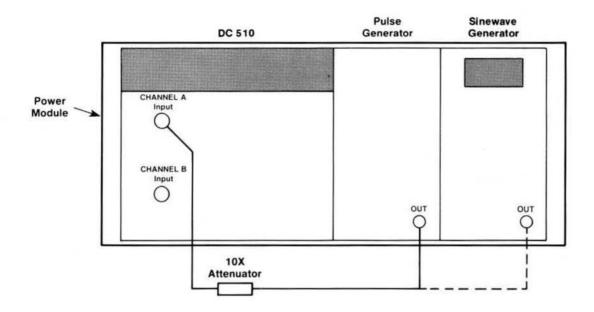


Fig. 4-3. Performance Check setup for steps 5 and 14.

- a. Connect a coaxial cable from the pulse generator output to the DC 510 CHANNEL A input.
- b. Adjust the pulse generator Period Variable control until the DC 510 display readout indicates 200.0000 (ns).
- c. Press the DC 510 † (increment) button to adjust the trigger level for 2.4 V on the display.
- d. Adjust the pulse generator High Level control until the DC 510 trigger level is obtained (2.4 V).
- e. Press the DC 510 ↓ (decrement) button to adjust the trigger level until the display readout indicates 0.4 V.
- f. With the pulse generator High Level control set, adjust the Low Level control until the DC 510 trigger level is obtained (0.4 V).
- g. Remove the DC 510 CHANNEL A input connection and connect the sinewave generator output to the CHAN-NEL A input.

- h. Adjust the sinewave generator Frequency Variable control until the DC 510 display readout indicates approximately 75.0XXXX MHz (the last four digits can vary due to source instability).
- i. Press the DC 510 AUTO TRIG button, then connect the pulse generator output to the ARM IN.
- j. CHECK—that the DC 510 display still indicates approximately 75.0XXXX MHz (the last four digits can vary due to source instability) with the display GATE light blinking.
- k. Disconnect the cable from the pulse generator output and attach a 50 Ω terminator (this causes the line to go to a TTL low).
- CHECK—that the DC 510 readout stops changing values and the display GATE light is not blinking (but may be lighted).

6. Check Input Capacitance: 23 pF, ±10%

Refer to Fig. 4-4, performance check setup. Use the following control settings.

Function Generator

Frequency Hz	2
Multiplier	102
Function	(sine)
Offset	(midrange)
Output	(cw)

DC 510

CHANNEL A and	
CHANNEL B	
TERM	1 M Ω (unlighted)
SLOPE	+ (unlighted)
ATTEN	X1 (lighted)
COUPL	DC (unlighted)
FREQ A	(lighted)
FILTER (20 MHz)	(lighted)

- a. Connect the 20 pF normalizer with a 50 Ω terminator and 5X attenuator from the DC 510 CHANNEL A input through a coaxial cable to the function generator output.
- b. Press the DC 510 LEVEL CH A button, then the DIS-PLAY-TEST button.

- c. Adjust the DC 510 Channel A triggering level using the † (increment) button until the GATE annunciator light (on the display) just stops blinking.
- d. Press the DC 510 DISPLAY-TEST button for the trigger level voltage display readout.
 - e. Note the DC 510 display readout (peak input voltage).
 - f. Change the function generator Multiplier switch to 105.
- g. Press the DC 510 LEVEL CH A button and the DIS-PLAY-TEST button.
- h. Adjust the DC 510 Channel A triggering level using the † (increment) and ↓ (decrement) buttons until the GATE annunciator light (on the display) just starts or stops blinking.

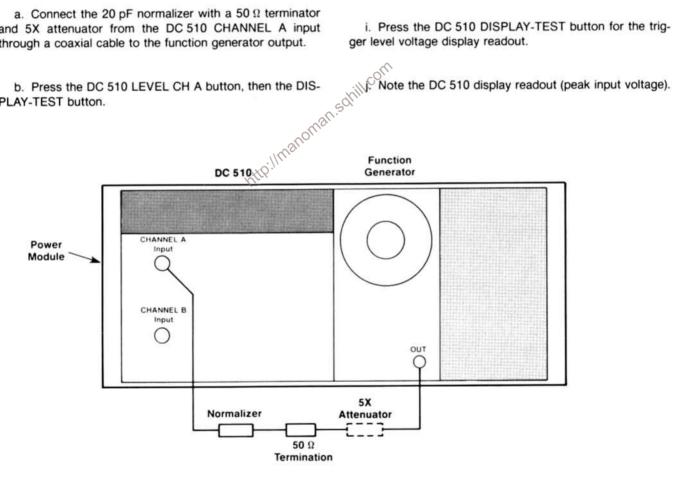


Fig. 4-4. Performance Check setup for step 6.

Calibration Procedure—DC510 Performance Check

- k. Divide the readout on step 6e by the readout on step 6i.
- CHECK—that the ratio between the two readings is between 1.03 and 1.13 (ratio of input capacitance value to the 20 pF normalization).
- m. Remove the DC 510 CHANNEL A input connection and connect it to the CHANNEL B input. Change the function generator Multiplier switch to 10².
- n. Press the DC 510 LEVEL CH B button, then press the DISPLAY-TEST button.
- o. Adjust the DC 510 Channel B triggering level using the † (increment) button until the GATE light (on the display) just stops blinking.
- p. Press the DC 510 DISPLAY-TEST button (trigger level voltage).
- q. Note the DC-5010 display readout (peak input voltage).
 - r. Change the function generator Multiplier switch to 105.
- s. Press the DC 510 LEVEL CH B button and the DIS-PLAY-TEST button.
- t. Adjust the DC 510 Channel B triggering level using the † (increment) and ↓ (decrement) buttons until the GATE light just starts or stops blinking.
- u. Press the DC 510 DISPLAY-TEST button (trigger level voltage).
 - v. Note the DC 510 display readout (peak input voltage).
- w. Divide the readout on step 6q by the readout on step 6v.
- x. CHECK—that the ratio between the two readings is between 1.03 and 1.13 (ratio of input capacitance to the 20 pF normalization).

7. Check RISE/FALL Input Impedance: 50 Ω , $\pm 3\%$, 1 M Ω , 500 k Ω , $\pm 2\%$ (60 MHz sinewave at high level)

Refer to Fig. 4-2, performance check setup.

- a. Set the digital multimeter Function Range switch to 2 $k\Omega.$
- b. Press the DC 510 CHANNEL B ATTEN X1 button (lighted) and press to light the RISE/FALL A button.
- c. CHECK—that the digital multimeter display readout indicates between .0490 and .0510.
- d. Press both DC 510 CHANNEL A and B TERM 1 M Ω buttons (unlighted).
- e. Change the digital multimeter Function-Range switch to 2000 k Ω .
- f. CHECK—that the digital multimeter display readout indicates between .4900 and .5100 (k Ω).

8. Check the Input Sensitivity: X1 Attenuation, DC and AC Coupled; 50 Ω, ≤70 mV p-p

Refer to Fig. 4-5, performance check setup. Use the following control settings.

Sinewave Generator

Frequency MHz 350
Range LOW
Amplitude 0.70

FREQ A

DC 510

(lighted)

CHANNEL A and B
COUPL DC (unlighted)
TERM 50 Ω (lighted)
SLOPE + (unlighted)
ATTEN X1 (lighted)

- a. Connect a coaxial cable with a 10X attenuator from the sinewave generator output to the DC 510 CHANNEL A input.
- b. Press to light the DC 510 AUTO TRIG button, LEVEL CH A button, and the DISPLAY-TEST button.

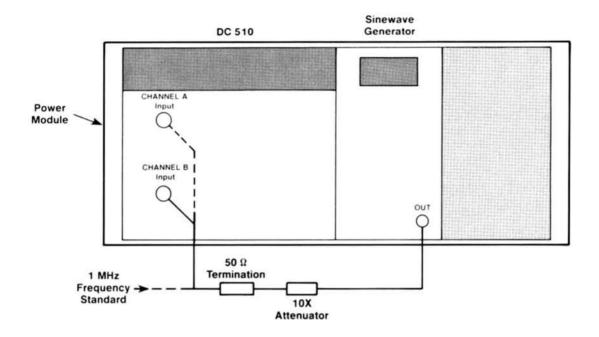


Fig. 4-5. Performance Check setup for steps 8, 9, 10, 11, 12, and 13.

CC

- d. CHECK-that the DC 510 display readout indicates approximately 350.00XXXX (the last four digits can vary due to source instability).
- e. Move the DC 510 CHANNEL A input connection to the CHANNEL B input.
- f. Connect the 1 MHz frequency standard to the DC 510 CHANNEL A input and press the RATIO B/A button (lighted).
- g. Press to light the DC 510 AUTO TRIG button, LEVEL CH B button, and the DISPLAY-TEST button.
- h. Press the DC 510 ↑ (increment) or ↓ (decrement) buttons to adjust the trigger level for a stable display readout.
- i. CHECK-that the DC 510 display readout indicates approximately 350.00XXX (the last three digits can vary due to source instability).

tons to adjust the trigger level for a stable display readout. Check the Input Sensitivity: X5 Attenuation, DC and AC Coupled; 50 Ω ≤350 mV n=n

Refer to Fig. 4-5, performance check setup. Use the following control settings.

Sinewave Generator

Frequency MHz	350
Range	Low
Amplitude	3.5

DC 510

FREQ A	(lighte
	/3

CHANNEL A and B

TERM 50 Ω (lighted) ATTEN X5 (unlighted)

- a. Connect a coaxial cable with a 10X attenuator from the sinewave generator output to the DC 510 CHANNEL A input.
- b. Press to light the DC 510 AUTO TRIG button, LEVEL CH A button, and the DISPLAY-TEST button.
- c. Press the DC 510 ↑ (increment) or ↓ (decrement) buttons to adjust the trigger level for a stable display readout.

Calibration Procedure—DC510 **Performance Check**

- d. CHECK-that the DC 510 display readout indicates approximately 350.00XXXX (the last four digits can vary due to source instability).
- e. Move the DC 510 CHANNEL A input connection to the CHANNEL B input.
- f. Connect the 1 MHz frequency standard to the DC 510 CHANNEL A input and press the RATIO B/A button (lighted).
- a. Press to light the DC 510 AUTO TRIG button, LEVEL CH B button, and the DISPLAY-TEST button.
- h. Press the DC 510 † (increment) or ↓ (decrement) buttons to adjust the trigger level for a stable display readout.
- i. CHECK-that the DC 510 display readout indicates approximately 350.00XXX (the last three digits can vary due to source instability).
- 10. Check Input Sensitivity: X1 Attenuation, DC and AC Coupled; 1 MΩ, ≤42 mV p-p at ≤300 MHz

Refer to Fig. 4-5, performance check setup. Use the following control settings.

Sinewave Generator

Frequency MHz

300

Amplitude

≈120 mV

DC 510

CHANNEL A and B

TERM

1 M Ω (unlighted)

- a. Remove the DC 510 CHANNEL B input connection and attach a 50 Ω termination to the end of the coaxial cable. Reconnect this cable with the termination and 10× attenuator to the CHANNEL B input.
- b. Press to light the DC 510 AUTO TRIG button, LEVEL CH B button, and the DISPLAY-TEST button.
- c. Press the DC 510 ↑ (increment) or ↓ (decrement) button to adjust the trigger level for a stable display readout.
- d. CHECK-that the DC 510 display readout indicates approximately 300.0XXXX (the last four digits can vary due to source instability).

- e. Remove the 1 MHz frequency standard from the DC 510 CHANNEL A input.
- f. Move the DC 510 CHANNEL B input connection to the CHANNEL A input.
- g. Press to light the DC 510 FREQ A button, AUTO TRIG button, LEVEL CH A button, and the DISPLAY-TEST button.
- h. Press the DC 510 ↑ (increment) or ↓ (decrement) button to adjust the trigger level for a stable display readout.
- i. CHECK-that the DC 510 display readout indicates approximately 300.00XXXX (the last four digits can vary due to source instability).
 - i. Remove the cable connections.

11. Check Input Sensitivity: X5 Attenuation, DC and AC coupled; 1 M Ω , \leq 350 mV at \leq 200 MHz

Refer to Fig. 4-5, performance check setup. Use the fol-

Sinewave Generator

Joupled; 1

Solid Refer to Fig. 4-5, per solid s 100-250 200 Amplitude Multiplier X.1 Output Amplitude 3.5

DC 510

RATIO B/A ATTEN

(lighted)

X5

- Connect the 1 MHz frequency standard to the DC 510 CHANNEL A input.
- b. Connect a coaxial cable with a 10X attenuation and 50 Ω termination from the sinewave generator output to the DC 510 CHANNEL B input.
- c. Press to light the DC 510 AUTO TRIG button, LEVEL CH B button, and the DISPLAY-TEST button.
- d. Press the DC 510 ↑ (increment) or ↓ (decrement) button to adjust the triger level for a stable display readout.

- e. CHECK-that the DC 510 display readout indicates approximately 200.00XXX (the last three digits can vary due to source instability).
 - f. Press to light the DC 510 FREQ A button.
- g. Remove the 1 MHz frequency standard from the DC 510 CHANNEL A input.
- h. Move the DC 510 CHANNEL B input connection to the CHANNEL A input.
- i. Press to light the DC 510 AUTO TRIG button, LEVEL CH A button, and the DISPLAY-TEST button.
- j. Press the DC 510 ↑ (increment) or ↓ (decrement) button to adjust the trigger level for a stable display readout.
- k. CHECK-that the DC 510 display readout indicates approximately 200.00XXXX (the last four digits can vary due to source instability).

Refer to Fig. 4-5, performance check setup. Use the following control settings. 12. Check Input Sensitivity: X1 Attenuation, DC and AC coupled; 1 M Ω , \leq 70 mV at \leq 200 MHz

lowing control settings.

Sinewave Generator

100-250
200
X.1
0.70

DC 510

RATIO B/A (lighted)

- a. Connect the 1 MHz frequency standard to the DC 510 CHANNEL A input.
- b. Connect a coaxial cable with a 10× attenuation and 50 Ω termination from the sinewave generator Output to the DC 510 CHANNEL B input.
- c. Press to light the DC 510 AUTO TRIG button, LEVEL CH B button, and the DISPLAY-TEST button.
- d. Press the DC 510 ↑ (increment) or ↓ (decrement) button to adjust the trigger level for a stable display readout.

- e. CHECK-that the DC 510 display readout indicates approximately 200.00XXX (the last three digits can vary due to source instability).
 - f. Press to light the DC 510 FREQ A button.
- g. Remove the 1 MHz frequency standard from the DC 510 CHANNEL A input.
- h. Move the DC 510 CHANNEL B input connection to the CHANNEL A input.
- i. Press to light the DC 510 AUTO TRIG button, LEVEL CH A button, and the DISPLAY-TEST button.
- j. Press the DC 510 ↑ (increment) or ↓ (decrement) button to adjust the trigger level for a stable display readout.
- k. CHECK-that the DC 510 display readout indicates approximately 200.00XXXX (the last four digits can vary due to source instability).
- 13. Check Input Sensitivity: X5 Attenuation, DC and AC Coupled: 1 MΩ, ≤210 mV p-p at

Refer to Fig. 4-5 performance check setup. Use the following control settings.

Sinewave Generator

300 Frequency MHz

DC 510

CHANNEL A and B

TERM 1 MΩ (unlighted) X5 (unlighted) ATTEN

- a. Remove the DC 510 CHANNEL B input connection and insert a 50Ω termination to the coaxial cable. Reconnect this cable to the CHANNEL B input.
- b. Press to light the DC 510 AUTO TRIG button, LEVEL CH B button, and the DISPLAY-TEST button.
- c. Press the DC 510 ↑ (increment) or ↓ (decrement) button to adjust the trigger level for a stable display readout.
- d. CHECK-that the DC 510 display readout indicates approximately 300.00XXX (the last three digits can vary due to source instability).

Calibration Procedure—DC510 Performance Check

- e. Remove the 1 MHz frequency standard from the DC 510 CHANNEL A input.
- f. Move the DC 510 CHANNEL B input connection to the CHANNEL A input.
- g. Press to light the DC 510 FREQ A button, AUTO TRIG button, LEVEL CH A button, and the DISPLAY-TEST button.
- h. Press the DC 510 ↑ (increment) or ↓ (decrement) button to adjust the trigger level for a stable display readout.
- i. CHECK—that the DC 510 display readout indicates approximately 300.00XXXX (the last four digits can vary due to source instability).
 - j. Remove the cable connections.

14. Check WIDTH A: Range \leq 4 ns; minimum Time Stop Edge To Start Edge, \leq 8.5 ns

Refer to Fig. 4-3 (using pulse generator only), performance check setup. Use the following control settings.

Pulse Generator

Period	10 ns	
Variable	(ccw)	
Duration	≤2 ns	1/1
Variable	(ccw)	http://r
Output		//-
Back Term	(out)	
Low Level	0	
High Level	2	

DC 510

CHANNEL A and B

ATTEN X1 (lighted) TERM 50 Ω (lighted) FREQ A (lighted)

- a. Connect a coaxial cable with a $10\times$ attenuator from the pulse generator output to the DC 510 CHANNEL A input.
 - b. Press to light the DC 510 AUTO TRIG button.
- Adjust the pulse generator Period Variable control until the DC 510 indicates approximatrely 80.0000 (MHz).

- d. Press to light the DC 510 WIDTH A button.
- e. CHECK—that the DC 510 display readout indicates between 0.0000 and 4.0000 (ns).

15. Check EVENTS B DUR A Minimum Pulse Width, ≤4.0 ns and ≤8.5 ns

Check Delay Mismatch: Int, ≤ 2 ns Check Minimum TIME B \rightarrow A, ≤ 12.5 ns

Refer to Fig. 4-6, performance check setup. Use the following control settings.

Pulse Generator

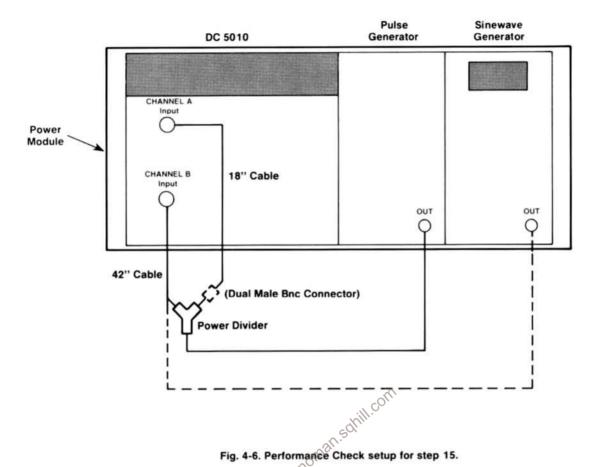
Pulse Period	.1 μs
Pulse Duration	≥2 ns
Low Level	0 V
High Level	3 V
Back Term	(out)

DC 510

(lighted)	
X1 (lighted)	
50 Ω (lighted)	
+ (unlighted)	

EVENTS B DUR A check:

- a. Connect a coaxial cable from the pulse generator output to one connector of a 50 Ω power divider (using the GR-to-bnc adapter).
- b. Connect an 18-inch coaxial cable from another power divider connector to the DC 510 CHANNEL A input (using the GR-to-bnc adapter).
- c. Connect a 42-inch coaxial cable from the other power divider connector to the DC 510 CHANNEL B input (using the GR-to-bnc adapter).
- d. Press the DC 510 AUTO TRIG button, then press to light the NULL button.
- e. Press the DC 510 CHANNEL B SLOPE button (unlighted).
- f. Adjust the pulse generator Duration Variable control until the DC 510 display readout indicates between 3.95 ns and 4.05 ns.



- g. Remove the DC 510 CHANNEL B input cable and terminate this cable end with a 50 Ω terminator.
- h. Set the sinewave generator for 350 MHz at approximately 150 mV, and connect the generator output to the DC 510 CHANNEL B input.
- i. Change the pulse generator Pulse Period to 10 ns (pulse width is 4.0 ns).
 - Press to light the DC 510 FREQ A button.
- k. Adjust the pulse generator Period Variable until the DC 510 display readout indicates 80.XXX MHz (the last three digits can vary due to source instability).
- I. Press to light the DC 510 EVENTS B DUR A button. then press the AUTO TRIG button.

m. CHECK-that the DC 510 display readout indicates between 2.45 and 3.85.

Delay Mismatch Check:

- n. Press to light the DC 510 TIME A → B button, then press the NULL button (lighted).
- o. Replace the 18-inch coaxial cable (from the DC 510 CHANNEL A input to the power divider) with a dual bnc male connector.
- p. CHECK-that the DC 510 display readout indicates approximately 2.5 ns. Note this reading.
- q. Replace the 42-inch coaxial cable (from the DC 510 CHANNEL B input to the power divider) with the 18-inch cable that was removed in Step 15-o.
 - r. Press to light the DC 510 TIME A → B button.

Calibration Procedure—DC510 Performance Check

s. CHECK—that the DC 510 display indication, minus (-) the readout noted in step 15-p, is 0.

a. Connect a bnc-to-slide on cable asembly from the DC 510 PROBE COMP output to the CHANNEL A input.

- Minimum Time B → A Check:
 - t. Press to light the DC 510 FREQ A button.
- u. Change the pulse generator Pulse Period to 10 ns (pulse width remains 4.0 ns).
- v. Adjust the pulse generator Period Variable until the DC 510 display readout indicates 67.XXX MHz (the last three digits can vary due to source instability).
 - w. Press to light the DC 510 TIME A → B button.
- x. CHECK—that the DC 510 display readout indicates between 0 and 6.0 ns.

- b. Press the DC 510 AUTO TRIG button.
- c. CHECK—that the DC 510 display readout indicates between 70,0000 and 170,0000 Hz.
 - d. Press the DC 510 WIDTH A function button.
- e. CHECK—that the DC 510 display readout indicates greater than $600.000~\mu s$ and less than 1.3 ms.

16. Check Probe Compensation

Use the following control settings.

DC 510

CHANNEL A and CHANNEL B

ATTEN

X5

TERM

1 MΩ (unlighted)

FREQ A

TOTAL A

(lighted)

(lighted)

g. CHECK—that the DC 510 display readout indicates between 2.000 and 3.250 V (50% voltage point; peak volt-

age equals 4 V to 6.5 V).

This completes the Performance Check.

f. Press the DC 510 LEVEL CH A button.

ADJUSTMENT PROCEDURE

Introduction

Use this Adjustment Procedure to restore the DC 510 to original performance requirements. This Adjustment Procedure need not be performed unless the instrument fails to meet the Performance Requirements of the Electrical Characteristics listed in the Specification section. If the instrument has undergone repairs, the Adjustment Procedure is recommended. Allow thirty minutes warmup time for operation to specified accuracy (sixty minutes after storage in a high humidity environment).

Satisfactory completion of all adjustment steps in this procedure assures that the instrument will meet the Performance Requirements, providing the instrument is functioning properly.

Test Equipment Required

The test equipment (or equivalent) listed in Table 4-1 is required for adjustment of the DC 510. Specifications given for the test equipment are the minimum necessary for accurate adjustment. All test equipment is assumed to be correctly calibrated and operating within specifications.

If other test equipment is substituted, calibration setup two may need to be altered to meet the requirements of the equipment used.

PRELIMINARY CONTROL SETTINGS

DC 510

FREQ A	(lighted)
CHANNEL A and	
CHANNEL B	
ATTEN	X1 (lighted)
SLOPE	+ (unlighted)
COUPL	DC (unlighted)
TERM	50 Ω (lighted)
AVGS	10 ⁶

Preparation

Access to the internal adjustments is achieved most easily when the DC 510 is connected to the power module with a flexible plug-in extender. Remove the top and side covers of the DC 510 to reach the adjustments and checks on the Auxiliary, Digital, and Analog boards. Refer to the Adjustment Locations and Setups in the pullout pages at the rear of this manual.

NOTE

Make adjustments at an ambient temperature between +20°C and +30°C.

Check the Digital Board + 12 V Accuracy (±2%)

- a. Set the digital multimeter Function-Range switch to 20 Vdc and connect the Low test lead to the DC 510 chassis ground. Connect the Volts/ Ω test lead to the Digital board +12 test point.
- b. Check that the digital multimeter readout indicates between 11.40 and 12.60 (volts).

2. Check the Digital Board - 12.2 V Accuracy (±2%)

- a. Remove the Volts/ Ω test lead from the +12 test point and connect it to the -12 test point (Digital board).
- b. Check that the digital multimeter readout indicates between -11.40 and -12.60 (volts).

3. Check the Digital Board +5 V Accuracy (±2%)

- a. Remove the digital multimeter Volts/ Ω test lead from the -12 test point and connect it to the +5 test point (Digital board).
- b. Check that the digital multimeter redout indicates between ± 4.90 and ± 5.10 (volts).
 - c. Remove the Volts/ Ω test lead from the +5 test point.

Check the Digital Board +2.5 V (V ref) Accuracy (±1%)

- a. Connect the digital multimeter $Volts/\Omega$ test lead to the Digital board Vref test point.
- b. Check that the digital multimeter readout indicates between 2.475 and 2.525 (volts).

Calibration Procedure—DC510 Adjustment Procedure

5. Check the Analog Board +5 V Accuracy (±2%)

- a. Remove the digital multimeter $Volts/\Omega$ test lead from the Vref test point and connect it to the +5 test point (Analog board).
- b. Check that the digital multimeter readout indicates between 4.90 and 5.150 (volts).

Check the Analog Board + 12 V Accuracy (±2%)

- a. Remove the digital multimeter $Volts/\Omega$ test lead from the +5 test point and connect to the +12 test point (Analog board).
- b. Check that the digital multimeter readout indicates between 11.76 and 12.24 (volts).

7. Check the Analog Board -5 V Accuracy ($\pm 5\%$)

- a. Remove the digital multimeter Volts/ Ω test lead form the +12 test point and connect it to the -5 test point (Analog board).
- b. Check that the digital multimeter readout indicates between -4.75 and -5.25 (volts).
 - c. Remove the test lead connections.

8. Adjust the Standard Timebase Accuracy, C1521, Osc Adj

- Connect a coaxial cable from the 1 MHz Frequency Standard to the DC 510 CHANNEL A input.
 - b. Press the DC 510 AUTO TRIG button.
- c. ADJUST—C1521 (through a hole in the back plate) until the DC 510 readout indicates between 999.99990 and 1.0000005 MHz.

NOTE

This sets the DC 510 oscillator within one part in 10⁷. It will take approximately one second for the display to update.

9. Adjust the Optional Timebase Accuracy, Y1530

NOTE

The Option 01 Timebase adjustment is made through an access hole in the back of the oven timebase. Y1530 is located on the back side of the Auxiliary board.

- a. Connect a coaxial cable from the 1 MHz Frequency Standard to the DC 510 CHANNEL A input.
- b. Set the DC 510 LEVEL CH A for a stable display readout.
- c. ADJUST—Y1530 until the DC 510 display readout indicates 1.0000000 MHz.
 - d. Press to light the PERIOD A button.
- e. ADJUST—Y1530 until the DC 510 display readout indicates between 999.99998 and 999.99999.
 - f. Remove the cable connections from the DC 510.

10. Adjust R1205, A Off, and R1207, B Off

Refer to Fig. 8-3, adjustment setup, in the pullout pages. Use the following control settings.

DC 510

CHANNEL A and CHANNEL B

 $\begin{array}{lll} \text{TERM} & 1 \text{ M}\Omega \text{ (unlighted)} \\ \text{SLOPE} & + \text{ (unlighted)} \\ \text{ATTEN} & \text{X1 (lighted)} \\ \text{COUPL} & \text{AC (unlighted)} \\ \text{FREQ A} & \text{ (lighted)} \\ \end{array}$

Digital Multimeter

Function-Range

2 V

Pulse Generator

Output low level (cw)
Output high level (cw)

Pulse Period Ext Duration

Pulse Duration Ext

- a. Connect the interconnecting cable from the DC 510 CH A SHAPED OUT to the digital multimeter input using an rf connector-to-banana adapter.
 - b. Set the DC 510 LEVEL CH A to display 0 V.

- c. ADJUST—R1205 counterclockwise to the point where the digital multimeter display readout changes from approximately 0 V to approximately .2 V.
- d. Move the DC 510 CH A SHAPED OUT connection to the CH B SHAPED OUT.
 - e. Set the DC 510 LEVEL CH B to display 0 V.
- f. ADJUST—R1207 counterclockwise to the point where the digital multimeter display readout changes from approximately 0 V to approximately .2 V.
 - g. Disconnect the digital multimeter cable connection.

11. Adjust R1206, B Rng, and R1204, A Rng

Refer to Fig. 8-3, adjustment setup, in the pullout pages.

- a. Connect a coaxial cable with 50 Ω termination from the pulse generator output to the digital multimeter input connectors using a bnc-to-banana adapter.
 - b. Set the DC 510 CHANNEL A and B COUPL for DC CAN SHITLE
- c. Adjust the pulse generator Low and High level controls until the display readout (digital multimeter) indicates between 1.900 and 2.000 volts. Note this reading.
- d. Move the coaxial cable with the 50 Ω termination from the digital multimeter input to the DC 510 CHANNEL B input.
- e. Reconnect the cable from the DC 510 CH B SHAPED
 OUT to the digital multimeter input connectors.
- Set the DC 510 LEVEL CH B to display the reading obtained in step 11c (within 4 mV).
- g. ADJUST—R1206 to the point where the digital multimeter display readout changes from approximately 0 V to approximately .2 V.
- h. Move the coaxial cable with 50 Ω termination from the DC 510 CHANNEL B input to the CHANNEL A input.

- i. Set the DC 510 LEVEL CH A to display the reading obtained in step 11c (within 4 mV).
- j. ADJUST—R1204 to the point where the digital mulltimeter display readout changes from approximately 0 V to approximately .2 V.

12. Adjust AT1505 (Channel A) and AT1533 (Channel B), Attenuator Compensation

Refer to Fig. 8-4, adjustment setup, in the pullout pages. Use the following control setings.

DC 510

CHANNEL A and CHANNEL B

TERM 1 M Ω (unlighted)
SLOPE + (unlighted)
ATTEN X5 (unlighted)
COUPL AC (lighted)
GOBE COMP (lighted)

PROBE COMP (lighted)
FILTER (lighted)

Function Generator

Frequency Hz 1 Multiplier 10³

Function Squarewave Offset (midrange)

Output 5 V p-to-p (Amplitude)

- a. Connect a 50 Ω terminator and 2X attenuator from the function generator output through a coaxial cable to the DC 510 CHANNEL A input.
 - b. Press the DC 510 PROBE COMP button.
- c. ADJUST—the lower adjustment on AT1505 until the digit on the far left side of the DC 510 display just changes from a steady 1 to a 0. The Channel A X5 attenuation is now compensated.
- d. Move the DC 510 CHANNEL A input connection to the CHANNEL B input and again press the PROBE COMP button.
- e. ADJUST—the lower adjustment on AT1533 until the DC 510 digit on the far right side of the display just changes from a steady 1 to a 0. The Channel B X5 attenuation is now compensated.
 - f. Remove all cable connections.

Calibration Procedure—DC510 Adjustment Procedure

13. Adjust AT1505 (Channel A) and AT1533 (Channel B), Attenuator Input Capacitance.

Function Generator

Output

cw (max amplitude)

- a. Compensate a X5 test probe to the DC 510 CHAN-NEL A input and set for X1 attenuation. Refer to Probe Compensation in the Operating Instructions of this manual.
- b. After the probe has been properly compensated, connect the probe tip to the function generator output using a probe tip-to-bnc connector.
- c. Set the DC 510 CHANNEL A ATTEN to X5 (lighted button) and press to light the PROBE COMP button.
- d. ADJUST—the upper adjustment on AT1505, located on the Analog board, until the digit located on the far left side of the DC 510 display just changes from a steady 1 to a

- 0. The X5 input capacitance is now equal to the X1 input capacitance.
- e. Remove the test probe from the CHANNEL A input and the function generator. Then Compensate the probe (see step 13a) to the DC 510 CHANNEL B X1 attenuator.
- f. Reconnect the probe tip to the function generator output.
- g. Set the DC 510 CHANNEL B ATTEN to $\times 5$ (lighted) and press the PROBE COMP button.
- h. ADJUST—the upper adjustment on AT1533, located on the Analog board until the digit on the far right side of the display just changes from a steady 1 to a 0. The Channel B \times 5 attenuation is now compensated.

This completes the Adjustment Procedure.



MAINTENANCE

Static-Sensitive Components



Static discharge may damage semiconductor components in this instrument.

This instrument contains electrical components that are susceptible to damage from static discharge. See Table 5-1 for relative susceptibility of various classes of semi-conductors. Static voltages of 1 kV to 30 kV are common in unprotected environments.

Observe the following precautions to avoid damage:

- 1. Minimize handling of static-sensitive components.
- 2. Transport and store static-sensitive components or assemblies in their original containers, on a metal rail, or on conductive foam. Label any package that contains static sensitive assemblies or components.
- Discharge the static voltage from your body by wearing a wrist strap while handling these components. Servicing static-sensitive assemblies or components should be performed only at a static-free work station by qualified service personnel.
- Nothing capable of generating or holding a static charge should be allowed on the work station surface.
- Keep the component leads shorted together whenever possible.
 - 6. Pick up components by the body, never by the leads.
 - 7. Do not slide the components over any surface.
- Avoid handling components in areas that have a floor or work surface covering capable of generating a static charge.

- 9. Use a soldering iron that is connected to earth ground.
- Use only special antistatic suction type or wick type desoldering tools.

Test Equipment

Before using any test equipment to make measurements on static-sensitive components or assemblies, be certain that any voltage or current supplied by the test equipment does not exceed the limits of the component to be tested.

Table 5-1
RELATIVE SUSCEPTIBILITY
TO STATIC DISCHARGE DAMAGE

Semiconductor Classes	Relative Susceptibility Levels ^a
MOS or CMOS microcircuits or discretes, or linear microcircuits	
with MOS inputs. (Most Sensitive)	1
ECL	2
Schottky signal diodes	3
Schottky TTL	4
High-frequency bipolar transistors	5
JFETs	6
Linear microcircuits	7
Low-power Schottky TTL	8
TTL (Least Sensitive)	9

Voltage equivalent for levels:

1 = 100 to 500 V 4 = 500 V 7 = 400 to 1000 V(est.) 2 = 200 to 500 V 5 = 400 to 600 V 8 = 900 V

2 = 200 to 500 V 5 = 400 to 600 V 6 = 900 V 3 = 250 V 6 = 600 to 800 V 9 = 1200 V

(Voltage discharged from a 100 pF capacitor through a resistance of 100 Ω .)

Circuit Board Removal and Replacement

Qualified service personnel will find the DC 510 instrument cover and board removal quite simple using the following procedure. Refer to Fig. 5-1 and the Parts Location Grids in the pullout pages.

1. Remove the two side covers (four 1/4 turn fasteners).

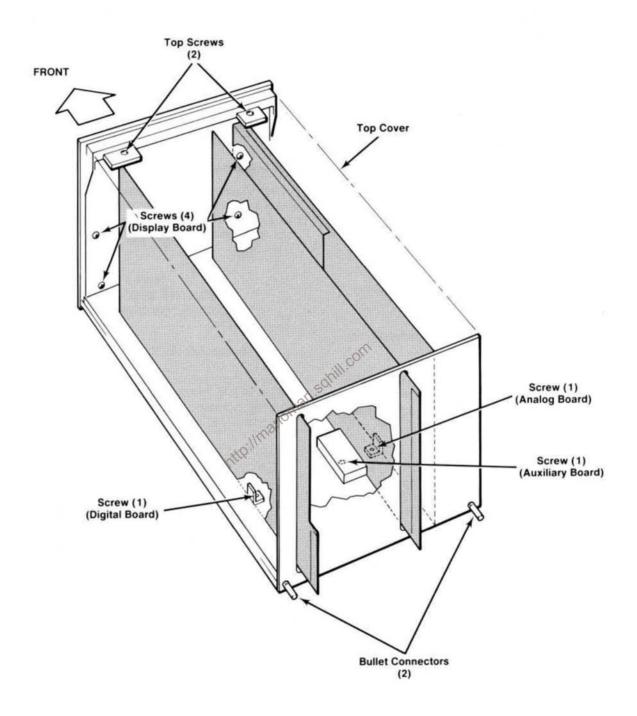


Fig. 5-1. Circuit boards removal and replacement.

- Remove the top and back covers (may be easily removed as a single unit).
 - a. Remove the top cover screws (2).
 - Remove the back cover 3/16" hex bullet connectors (2).
 - Carefuly pull the covers up and back to remove.
 - 3. To remove the Digital board.
 - a. Repeat steps 1 and 2 above.
 - Remove the bottom cover screw that secures the Digital board.
 - Disconnect the connector, P1611 (J1611), from the Auxiliary board.
 - d. Carefully remove the Digital board.
- To remove the Analog board or the Auxiliary board (these boards are interconnected and must be removed together).
 - a. Repeat steps 1 and 2 above.
 - b. Remove the 9/16" nuts (2) from the front panel Channel A and B bnc input connectors.
 - Remove the bottom cover screws (2) securing both the Analog and Auxiliary boards.
 - Disconnect the two connectors, P1201 (J1201) and P1130 (J1130), from the Analog board.
 - e. Disconnect the connectors, P1500 (J1500) and P1611 (J1611), from the Auxiliary board.
 - f. Carefully pull the interconnected boards away from the connector (front panel back) using a gentle up and down rocking motion. Allow sufficient clearance for the input connectors through the front panel.
 - g. Gently pull the two boards apart, taking care not to damage the interface connector pins. Often it is easier to begin at one end of the board and separate the connectors one at a time.

NOTE

With the Analog board out of the instrument, the Channel A and B bnc connectors are subject to damage. Care should be taken to prevent breaking the bnc solder connections.

- To remove the Display board (use following to access the seven-segment LEDs and annunciator LEDs).
 - a. Repeat steps 1 through 5 above.
 - Disconnect the single-pin harmonica connector, P1321.
 - Remove the screws (4) that secure the Display board to the front panel (back).
 - Carefully remove the Display board, pulling up and away from the bottom and lifting out.
- To replace the circuit boards, reverse the above procedure.

Magnetic Latch Relays

To prevent damage to these relays, do not remove them from the Analog circuit board unless absolutely necessary. If the relay contacts become noisy or the relay fails to operate, remove the relay from the circuit board. Remove the two relay hold down screws located on the rear of the Analog board and carefully remove the relay.

Clean the circuit board contacts with a small brush and isopropyl alcohol. Do not use any solvent that may attack polycarbonates such as hydrocarbon chlorides, ketones, esters, etc. Do not use a cotton swab as small cotton filaments may remain on the contact area.

Clean the contact fingers on the relay armature by lightly brushing the contacts with a brush dipped in isopropyl alcohol.

To remove the relay armature from the relay, obtain a wire or tool with a diameter less than 0.040 inch, such as a paper clip. Before removing the armature, mark the orientation of the armature to the housing. Orientation is important for proper operation. Place the tool in the slot on the side of the housing and gently lift the relay armature. (See Fig.5-2.)

Clean the interior of the relay, around the pole pieces, with isopropyl alcohol. The interior of the relay must be completely dry before reinstalling the armature. Use air to dry excess alcohol from the housing.

NOTE

Do not spray contact cleaners of any type on the relays or the board contacts. Any foreign material, including lubricants, can cause faulty operation.

Cleaning Instructions

This instrument should be cleaned only as often as operating conditions require. Accumulation of dirt on components acts as an insulating blanket and prevents efficient heat dissipation that can cause overheating and component breakdown.



Avoid the use of chemical cleaning agents that might leave a film or damage the plastic material used in this instrument. Use a nonresidue type of cleaner; preferably, isopropyl alcohol or totally denatured ethyl alcohol. Before using any other type of cleaner, consult your Tektronix Service Center or representative.

Exterior. Loose dust accumulated on the front panel can be removed with a soft cloth or a small brush. Dirt that remains can be removed with a soft cloth dampened with a mild detergent and water solution. Abrasive cleaners should not be used.

Interior. Dust in the interior of the instrument should be removed occasionally, due to its electrical conductivity under high humidity conditions. The best way to clean the interior is to blow off the accumulated dust with dry, low pressure air then use a soft brush. If further cleaning is required, use a mild detergent and water solution, flushing well with clean water.



Do not clean the circuit board with water, air, or any solvent, unless the relays are removed first. Any dirt forced or carried under the contacts can cause intermittent operation. Circuit boards and components must be dry before applying power to prevent damage from electrical arcing.

Drying can be accomplished with dry, low-pressure air or by placing in an oven at 40°C to 60°C for approximately four hours.

After making minor board repairs, cleaning is best accomplished by carefully flaking or chipping the solder flux from the repaired area.

Isopropyl alcohol can be used to clean major repairs to the circuit board; however, flush the board well with clean, isopropyl alcohol. Make certain that resin or dirt is carefully removed from the board.

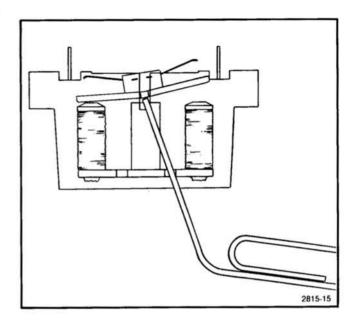


Fig. 5-2. Method of removing magnetic latch relay armature.

Obtaining Replacement Parts

Electrical and mechanical parts can be obtained through your local Tektronix Field Office or representative. However, many of the standard electronic components can be obtained from a local commercial source. Before purchasing or ordering parts from a source other than Tektronix, Inc., check the Replaceable Electrical Parts list for the proper value, rating, tolerance, and description.

Ordering Parts

When ordering replacement parts from Tektronix, Inc., it is important to include all of the following information.

- Instrument type (include modification or option numbers).
 - 2. Instrument serial number.
- A description of the part (if electrical, include the component number).
 - Tektronix part number.

Soldering Techniques



To avoid electric shock hazard, disconnect the instrument from the power source before soldering. The reliability and accuracy of this instrument can be maintained only if proper soldering techniques are used when repairing or replacing parts. General soldering techniques which apply to maintenance of any precision electronic equipment should be used when working on this instrument. Use only 60/40 rosin-core, electronic grade solder. The choice of soldering iron is determined by the repair to be made.



The Analog board in the DC 510 is a multilayer type board with a conductive path laminated between the top and bottom board layers. All soldering on this board should be done with extreme care to prevent breaking the connections to this conductive path. Only experienced maintenance personnel should attempt to repair this board. Do not allow solder or solder flux to flow under printed circuit board relays. The printed circuit board is part of the relay contacts; intermittent relay operation can occur if the contacts are contaminated.

When soldering on circuit boards or small wiring, use only a 15 watt, pencil type soldering iron. A higher wattage soldering iron can cause the etched circuit wiring to separate from the board base material and melt the insulation from small wiring. Always keep the soldering iron tip properly tinned to ensure the best heat transfer to the solder joint. Apply only enough heat to remove the component or to make a good solder joint. To protect heat sensitive components, hold the component lead with a pair of long-nose pliers between the component body and the solder joint. Use a solder removing wick to remove excess solder from connections or to clean circuit board pads.

To remove in-line integrated circuits use an extracting tool. This tool is available from Tektronix, Inc.; order Tektronix Part Number 003-0619-00. If an extracting tool is not available, use care to avoid damaging the pins. Pull slowly and evenly on both ends of the integrated circuit. Try to avoid disengaging one end before the other end.

Interconnecting Pins

Several methods of interconnection, including square pin, are used to electrically connect the circuit boards with the other boards and components.

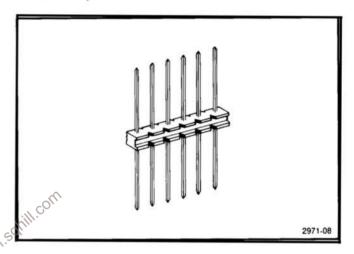
Several types of mating connectors are used for these interconnecting pins. The following information provides the removal and replacement procedure for the various interconnecting methods.

Square Pin Assemblies

See Fig. 5-3. These pins are of various lengths. They are attached to each other with a plastic strip. To remove them simply unsolder from the circuit board.

Bottom Entry and Side Entry Circuit Board Pin Sockets

To remove or replace these sockets unsolder the pins from the circuit board. Use a vacuum or other type desoldering tool to remove excess solder. Use caution to prevent circuit board damage. See Fig. 5-4 for bottom entry socket example.



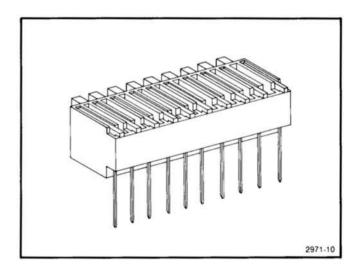


Fig. 5-4. Bottom entry circuit board pin socket.

Multipin Connectors

The pin connectors used to connect the wires to the interconnecting pins are clamped to the ends of the wires.

Maintenance—DC 510

To replace damaged multipin connectors, remove the old pin connector from the holder. Do this by inserting a scribe between the connector and the holder and prying the connector from the holder. Clamp the replacement connector to the wire. Reinstall the connector in the holder.

If the individual end lead pin connectors are removed from the plastic holder, note the order of the individual wires for correct replacement in the holder. For proper replacement see Fig. 5-5.

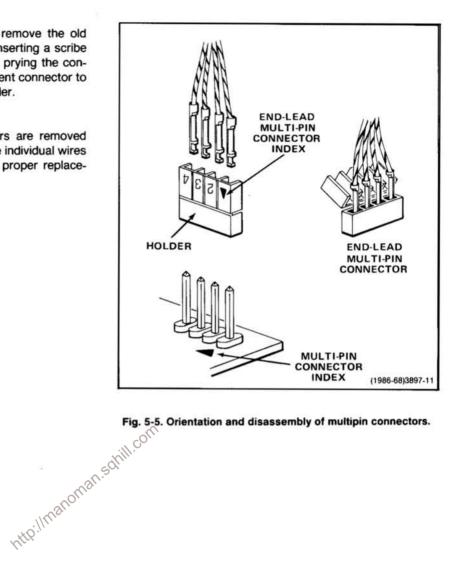


Fig. 5-5. Orientation and disassembly of multipin connectors.

5-6

REAR INTERFACE CONNECTORS

Introduction

Refer to Fig. 5-6 for the following.

A slot between pins 21 and 22 on the rear connector identifies this instrument as a member of the TM 5000 counter family. Insert a barrier in the corresponding position of the power module jack to prevent noncompatible plug-ins from being used in that compartment. Consult the power module manual for further information.

Functions Available at Right Rear Interface Connector (P1600)

- Pin 14A. External Clock Input—This input allows an external 1, 5, or 10 MHz frequency standard to be used in place of the internal timebase. The input is ac coupled and has a 1 kΩ input resistance. The peak-to-peak input voltage required is ≥0.5 V.
- Pin 14B. Prescale—When this available line is held low, the counter automatically adjusts the displayed answer for use with a divide-by-16 prescaler in FREQ A, PERIOD A, RATIO B/A, and TOTALIZE A modes (≤1 TTL load).
- Pin 15A. 10 MHz Clock Out Ground—This terminal is the ground return for the clock input-output signals.
- Pin 15B. 10 MHz Clock Out—This available output line will drive one TTL load. This line is not intended to drive large capacitance loads and cable length should be kept to a minimum.
- Pin 26A. Reset Input—When this line is set low, the current measurement process is aborted for all selected functions and causes all digits in the display to read 8.8.8.8.8.8.8.8.8. All eight annunciators (and push buttons) are also illuminated. When this line is set high, a new measurement process is initiated for the selected FUNCTION and operating conditions. (CMOS VIL ≤1.5 V and VIH ≥3.5 V with a minimum pulse width of approximately 10 ms.) When not used, the line is in the high state.

OUTPUT OR INPUT	PIN		PIN	OUTPUT OR INPUT
	28		28	ARMING INPUT GROUND
	27	1	27	ARMING INPUT
	26	1	26	RESET INPUT
	25]	25	
	24		24	0000000
	23		23	
	22	SLOT	22	
	21		21	
	20]	20	
	19		19	
Maria de la companya della companya della companya della companya de la companya della companya	18		18	
	17		17	
98/11 08/02/0	16		16	
10MHz CLOCK OUT	15		15	1 ØMHz CLOCK OUT GROUND
PRESCALE	14		14	EXTERNAL CLOCK INPUT
	13		13	
+33.5V DC	12		12	+33,5V DC
COLLECTOR LEAD OF PNP SERIES PASS	11		11	BASE LEAD OF PNP SERIES PASS
	10		10	EMITTER LEAD OF PNP SERIES PASS
±33.5V COMMON	9	1	9	±33.5V COMMON
-33.5V DC	8		8	-33.5V DC
COLLECTOR LEAD OF NPN SERIES PASS	7	TM 500 BARRIER SLOT	7	EMITTER LEAD OF NPN SERIES PASS
	6		6	BASE LEAD OF NPN SERIES PASS
	5	1 1	5	
+11.5V COMMON	4]]	4	+11.5V COMMON
+11.5V COMMON	3	1	3	+11.5V COMMON
+11.5V DC	2	REAR VIEW	2	+11.5V DC
	1	OF PLUC-IN	1	

Fig. 5-6. Right rear interface connector assignments.

Maintenance—DC 510

Pin 27A. Arming Input—This terminal is normally at a TTL high level. When pulled to a TTL low state with a TTL signal or transistor collector, the counter is prevented from making a measurement until the input goes to a TTL high state. When this input is routed to the rear interface it is dc coupled to the front panel arm signal. (^VH ≥ 2.4 V, ^VL ≤0.4 V approximately 2 TTL loads).

Pin 28A. Arming Input Ground—This terminal is the ground return for the rear interface arming input signal.

Functions Available at Left Rear Interface Connector (P1820)

Refer to Fig. 5-7 for connector assignments.

OUTPUT OR INPUT	PIN B		PIN	OUTPUT OR INPUT
+33.5V DC	12		12	+33.5V DC
COLLECTOR LEAD OF PNP SERIES PASS	11		11	BASE LEAD OF PNP SERIES PASS
	10		10	EMITTER LEAD OF PNP SERIES PASS
±33.5V COMMON	9	1	9	±33.5V COMMON
-33.5V DC	8 TM 500		8	-33.5V DC
COLLECTOR LEAD OF NPN SERIES PASS	7 .	BARRIER SLOT	7	EMITTER LEAD OF NPN SERIES PASS
	6		6	BASE LEAD OF NPN SERIES PASS
	5		5	
+11.5V COMMON	4	1	4	+11.5V COMMON
+11.5V COMMON	3	1	3	+11.5V COMMON
+11.5V DC	2	REAR VIEW	2	+11.5V DC
	1	OF PLUG-IN	1	

3552-10

(for

Fig. 5-7. Left rear interface connector assignments.

DIAGNOSTICS

Introduction

The following information is intended to aid in the diagnosis and repair of a malfunctioning instrument. With power-on Self Test, signature analysis checks, and other troubleshooting data, the qualified service personnel will be able to verify proper operation or detect malfunction in this instrument.

Not all of the instrument faults may be isolated by this information or indicated by the instrument's built-in self test features. The service personnel should then refer to the Theory of Operation section, in this manual for a better understanding of the circuit details.

Equipment Required

The recommended diagnostic tests require the following equipment or equivalent.

Data analyzer.

TEKTRONIX type SA 501 or type 308

Data Analyzer (for signature analysis)

Digital counter.

TEKTRONIX type DC 503A (for time-

base frequency checks)

Digital multimeter. TEKTRONIX type DM 501A checking power supplies)

Also refer to the equipment list in the Calibration section of this manual for suggestions on oscilloscope systems, probes, adapters, terminations and other equipment that may be useful for troubleshooting purposes.

Adjustment and Test Point Locations

When locating adjustable components and test points, refer to the Adjustment and Setups Location in the pullout pages of this manual.

Self Test

The DC 510 has two modes of self test. The automatic test sequence at power on and the TEST function selected by the front panel TEST button.

The automatic test sequence at power-on (Power On Self Test) is initiated each time the power is applied to the instrument. The microprocessor sequences through special data patterns to test the operation of the circuits in the in-

strument. At power-on, after the microprocessor reset line has been released, the following tests are performed:

- The display (time slot generator, diagram 10) is reset to the most significant digit (digit to extreme left) and a 0 readout is displayed.
- 2. The RAM is tested by writing a known bit pattern into the RAM and reading it back. Each byte in the RAM is verified. If any byte does not verify, the RAM test error code is displayed on the front panel and the test sequence stops. The patterns written are FF, AA, 55, 00 (hexidecimal) in succession leaving the RAM cleared when the test is finished. If this test is not successfully completed, the proper error code is displayed and the self test sequence stops.
- The ROM's are checked for proper checksums. If any of these tests fail, the power on self test sequence is stopped and the proper error code is displayed. The order of the RAM and ROM test is given in Table 5-2.

Table 5-2

RAM & ROM Test Sequence
(DC 510 Placement and Checksum)

RAM \$0000 - \$007F
\$0400 - \$04FF
ROM \$0800 - \$0FFF
\$1000 - \$1FFF

- 4. Next, the automatic test sequence sets the instrument gating to the RATIO B/A function.
- 5. The serial I/O data loop is checked next, by writing out a data pattern to the serial-to-parallel shift registers. The data pattern is read back through the parallel-to-serial shift registers. If the data are correct, the power-on sequence continues. If the data are not correct, the error code for this test is displayed and the test sequence stops. This test checks the shift registers and the data path, including the serial clock but does not check the input or output stages of the shift registers or the latch control lines. Troubleshooting of the serial I/O loop is best accomplished using signature analysis.
- 6. The next test is the counter integrity test. This test first resets the instrument's Channel A and Channel B accumulators by pulsing the MR (master reset) line. It then checks each of the tested counter stages to verify that all bits are reset. If any bits are not reset, the proper error code is displayed and the test sequence stops. Next, the GATE signal, (diagram 3) is asserted. The instrument then inputs counts to the accumulators. These counts are generated by changing the trigger levels for both Channel A and Channel

B using the D/A converters. The D/A converter level changes (cycles) from its current setting to $+2.0\,\mathrm{V}$ then to $-2.0\,\mathrm{V}$ and back to $+2.0\,\mathrm{V}$. This cycle represents one count if the Channel A and Channel B input voltages are within this voltage range and the ARM signal, (diagram 6) is in the high state.

After each cycle or set of cycles, the accumulators are read and checked to see if the proper count has been reached. If a count greater than or equal to the proper count has not been accumulated, the error code for that accumulator stage is displayed and the self test sequence stops.

An improper count might occur because of a bad counter chip, a bad readout chip, or a disconnected cable.

NOTE

The signal path starts at the D/A converters and the cycle must pass through the amplifiers, gating, and the accumulators. A first bit error (320, 330) may indicate an amplifier, FET or Schmitt error.

The gating (diagram 3), remains in the RATIO B/A function and by applying a signal, that crosses the -2 V Trigger level settings, to the appropriate channel input, the service personnel can trace this signal through the amplifier, gating, and accumulator circuits. Also refer to Table 8-2 in the pullout pages.

TEST Function

The TEST function from the front panel is similar to the Power On Self Test sequence with one exception. The RAM test is not executed, thereby preventing the instrument's settings from being lost while in the TEST function.

TROUBLESHOOTING

The following is a general troubleshooting procedure to use when the instrument malfunctions.

First, verify that the instrument is properly connected to the appropriate power module and that this power module is operable. Then refer to Fig. 8-5, General Troubleshooting Flowchart, in the pullout pages. This flowchart is a guide for qualified service personnel to locate various areas of circuitry, depending on the instrument symptoms. It may also refer the service personnel to the following signature analysis procedure.

SIGNATURE ANALYSIS

Introduction

The DC 510 was designed to be compatible with two signature analysis methods.

Internal signature analysis—this is a microprocessor driven pattern generator contained in the ROM. This method will only work when the kernel microprocessor and its associated ROM. RAM, and connections are functional.

Kernel signature analysis—this requires the use of an external kernel test service kit (Tektronix part number 067-1007-00). This method allows qualified service personnel to test and isolate problems in the kernel of the instrument.

Internal Signature Analysis

The internal signature analysis mode is entered at poweron by pressing the CHANNEL A TERM button (50 Ω) as power is applied. This mode will not operate if the instrument fails the power on RAM test. Refer to Figs. 8-6, 8-7, 8-8, and 8-9 in the pullout pages, for the internal signatures setup information for each circuit board.

In the internal signature analysis mode, the serial loop is most easily diagnosed. The START, STOP, and CLOCK edge polarities must be properly set as shown on the appropriate signature diagram. When the instrument is in this mode, all segments and annunciators in the display are lighted, with the extreme left digit brighter than the other digits. The pushbuttons are also lighted.

To exit the Internal Signature Analysis mode, the instrument must be powered down and then powered up.

Kernel Signature Analysis

CAUTION

The Digital board microprocessor, U1301, is removed (observing proper static handling procedures) before making the kernel test.

The kernel signature analysis mode is used to diagnose problems that prevent the microprocessor kernel circuitry from functioning properly. It is used with a signature analyzer to verify signatures in the kernel circuitry.

Refer to Fig. 5-8 for the following.

Make certain the power module power is off when connecting this service kit to the instrument. Then, connect J1002 and J1003 of the Kernel Test board to J1210 and J1211 on the instrument Digital board (A16), respectively, using the cables and square pin adapters provided with the kit. Make sure that the cables do not get twisted. Connect the START, STOP, CLOCK, and GROUND connections of the analyzer to the test points as indicated on the appropriate Kernel Signature (Fig. 8-10) in the pullout pages. Also make sure that the START, STOP, and CLOCK polarities have been properly selected on the analyzer.

In troubleshooting the kernel, the following information may be helpful.

Two physically adjacent points having the same signature, whether one or both are incorrect, may indicate they are shorted together.

A point with 0000 signature is grounded, or in a low state. A point with the +5 V signature (noted on each signature diagram) may be opened or the driving node may be stuck in the high state. The point might also be shorted to +5 V.

Selected Components (R1307 and R1326)

Refer to diagram 2 (board A12) in the pullout pages for the following.

If IC's U1310 and U1330 (M234 Type) are replaced and the input sensitivity (50 Ω) is found to exceed 57 mV peak-to-peak at 100 MHz (25°C ambient temperature), the following procedure is recommended.

NOTE

If IC's U1310 and U1330 (M234) should have to be replaced, the input sensitivity is unlikely to vary.

The values of selected resistors, R1307 and R1326 (nominal value of 1.4 k Ω each) may be changed to alter the input sensitivity for channels A and B respectively.

If the instrument requires more than a 57 mV peak-to-peak signal to trigger it, the resistance values of R1307 and R1326 will need to increase. The sensitivity will change approximately 10 mV peak-to-peak for each 500 Ω of resistance change. See the Specification section of this manual for the input sensitivity limits.

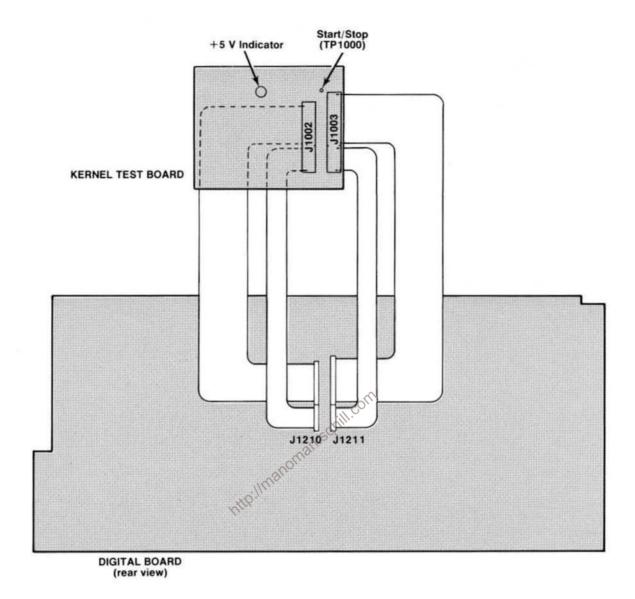


Fig. 5-8. Kernel signature analysis connections.

OPTIONS

Your instrument may be equipped with one or more instrument options or optional accessories. A brief description of each instrument option is given below. For further information on instrument options or optional accessories, see your Tektronix Catalog or contact your Tektronix Field Office. If additional options are made available for this instrument, they may be described in a Change Information insert at the back of this manual or in this section.

OPTION 01

Replaces the standard 10 MHz oscillator with a self contained, proportional temperature controlled oven oscillator for increased accuracy and stability. Information relative to Option 01 can be found on schematic 5, and in the Specification, Calibration, and Theory of Operation sections.



REPLACEABLE ELECTRICAL PARTS

PARTS ORDERING INFORMATION

Replacement parts are available from or through your local Tektronix, Inc. Field Office or representative.

Changes to Tektronix instruments are sometimes made to accommodate improved components as they become available, and to give you the benefit of the latest circuit improvements developed in our engineering department. It is therefore important, when ordering parts, to include the following information in your order: Part number, instrument type or number, serial number, and modification number if applicable.

If a part you have ordered has been replaced with a new or improved part, your local Tektronix, Inc. Field Office or representative will contact you concerning any change in part number.

Change information, if any, is located at the rear of this manual.

LIST OF ASSEMBLIES

A list of assemblies can be found at the beginning of the Electrical Parts List. The assemblies are listed in numerical order. When the complete component number of a part is known, this list will identify the assembly in which the part is located.

CROSS INDEX-MFR. CODE NUMBER TO MANUFACTURER

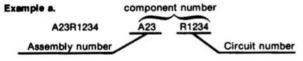
The Mfr. Code Number to Manufacturer index for the Electrical Parts List is located immediately after this page. The Cross Index provides codes, names and addresses of manufacturers of components listed in the Electrical Parts List

ABBREVIATIONS

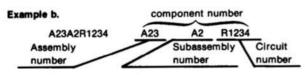
Abbreviations conform to American National Standard Y1.1.

COMPONENT NUMBER (column one of the Electrical Parts List)

A numbering method has been used to identify assemblies, subassemblies and parts. Examples of this numbering method and typical expansions are illustrated by the following:



Read: Resistor 1234 of Assembly 23



Read: Resistor 1234 of Subassembly 2 of Assembly 23

Only the circuit number will appear on the diagrams and circuit board illustrations. Each diagram and circuit board illustration is clearly marked with the assembly number. Assembly numbers are also marked on the mechanical exploded views located in the Mechanical Parts List. The component number is obtained by adding the assembly number prefix to the circuit number.

The Electrical Parts List is divided and arranged by assemblies in numerical sequence (e.g., assembly A1 with its subassemblies and parts, precedes assembly A2 with its subassemblies and parts).

Chassis-mounted parts have no assembly number prefix and are located at the end of the Electrical Parts List.

TEKTRONIX PART NO. (column two of the Electrical Parts List)

Indicates part number to be used when ordering replacement part from Tektronix.

SERIAL/MODEL NO. (columns three and four of the Electrical Parts List)

Column three (3) indicates the serial number at which the part was first used. Column four (4) indicates the serial number at which the part was removed. No serial number entered indicates part is good for all serial numbers.

NAME & DESCRIPTION (column five of the Electrical Parts List)

In the Parts List, an Item Name is separated from the description by a colon (:). Because of space limitations, an Item Name may sometimes appear as incomplete. For further Item Name identification, the U.S. Federal Cataloging Handbook H6-1 can be utilized where possible.

MFR. CODE (column six of the Electrical Parts List)

Indicates the code number of the actual manufacturer of the part. (Code to name and address cross reference can be found immediately after this page.)

MFR. PART NUMBER (column seven of the Electrical Parts List)

Indicates actual manufacturers part number.

CROSS INDEX-MFR. CODE NUMBER TO MANUFACTURER

Mfr. Code	Manufacturer	Address	City, State, Zip
000ID	G & E MICROCIRCUITS	2000 W 14TH STREET	TEMPE, AZ 85281
00779	AMP, INC.	P O BOX 3608	HARRISBURG, PA 17105
01121	ALLEN-BRADLEY COMPANY	1201 2ND STREET SOUTH	MILWAUKEE, WI 53204
01295	TEXAS INSTRUMENTS, INC., SEMICONDUCTOR GROUP	P O BOX 5012, 13500 N CENTRAL EXPRESSWAY	DALLAS, TX 75222
03508	GENERAL ELECTRIC COMPANY, SEMI-CONDUCTOR PRODUCTS DEPARTMENT	ELECTRONICS PARK	SYRACUSE, NY 13201
03888	KDI PYROFILM CORPORATION	60 S JEFFERSON ROAD	WHIPPANY, NJ 07981
04222	AVX CERAMICS, DIVISION OF AVX CORP.	P O BOX 867, 19TH AVE. SOUTH	MYRTLE BEACH, SC 29577
04713	MOTOROLA, INC., SEMICONDUCTOR PROD. DIV.	5005 E MCDOWELL RD, PO BOX 20923	PHOENIX, AZ 85036
07263	FAIRCHILD SEMICONDUCTOR, A DIV. OF		
	FAIRCHILD CAMERA AND INSTRUMENT CORP.	464 ELLIS STREET	MOUNTAIN VIEW, CA 94042
11532	TELEDYNE RELAYS	3155 W EL SEGUNDO BLVD.	HAWTHORNE, CA 90250
14433	ITT SEMICONDUCTORS	3301 ELECTRONICS WAY	
		P O BOX 3049	WEST PALM BEACH, FL 33402
18324	SIGNETICS CORP.	811 E. ARQUES	SUNNYVALE, CA 94086
22526	BERG ELECTRONICS, INC.	YOUK EXPRESSWAY	NEW CUMBERLAND, PA 17070
24546	CORNING GLASS WORKS, ELECTRONIC		
	COMPONENTS DIVISION	550 HIGH STREET	BRADFORD, PA 16701
24931	SPECIALITY CONNECTOR CO., INC.	2620 ENDRESS PLACE	GREENWOOD, IN 46142
27014	NATIONAL SEMICONDUCTOR CORP.	2900 SEMICONDUCTOR DR.	SANTA CLARA, CA 95051
32997	BOURNS, INC., TRIMPOT PRODUCTS DIV.	1200 COLUMBIA AVE.	RIVERSIDE, CA 92507
33096	COLORADO CRYSTAL CORPORATION	2303 W 8TH STREET	LOVELAND, CO 80537
34576	ROCKWELL INTERNATIONAL CORP.	Stational Septical Visiting States (S. Video II)	
	ELECTRONIC DEVICES DIVISION	3310 MIRALBMA AVE.	ANAHEIM, CA 92803
50434	HEWLETT-PACKARD COMPANY	640 PAGE MILL ROAD	PALO ALTO, CA 94304
50522	MONSANTO CO., ELECTRONIC SPECIAL PRODUCTS	3400 HILLVIEW AVENUE	PALO ALTO, CA 94304
51642	CENTRE ENGINEERING INC.	2820 E COLLEGE AVENUE	STATE COLLEGE, PA 16801
		2020 2 :///	
51984	NEC AMERICA INC. RADIO AND TRANSMISSION DIV.	2990 TELESTAR CT. SUITE 212	FALLS CHURCH, VA 22042
52262	B AND H ELECTRONICS, INC., DBA MICRO	an.	Totals say to be a
	COMPONENTS ASSOCIATES	202 E STEVENS ST., SUITE 6	SANTA ANA, CA 92707
52648	PLESSEY SEMICONDUCTORS	1641 KAISER	IRVINE, CA 92714
53184	XCITON CORPORATION	202 E STEVENS ST., SUITE 6 1641 KAISER 5 HEMLOCK STREET PO BOX 85, OFF ROUTE 45 3050 CORONADO DR 6435 N PROESEL AVENUE	LATHAM, NY 12110
55210	GETTIG ENG. AND MFG. COMPANY	PO BOX 85, OFF ROUTE 45	SPRING MILLS, PA 16875
55576	SYNERTEX	3050 CORONADO DR	SANTA CLARA, CA 95051
55680	NICHICON/AMERICA/CORP.		CHICAGO, IL 60645
56289	SPRAGUE ELECTRIC CO.	87 MARSHALL ST.	NORTH ADAMS, MA 01247
71400	BUSSMAN MFG., DIVISION OF MCGRAW- EDISON CO.	2536 W. UNIVERSITY ST.	ST. LOUIS, MO 63107
72982	ERIE TECHNOLOGICAL PRODUCTS, INC.	644 W. 12TH ST.	ERIE, PA 16512
73138	BECKMAN INSTRUMENTS, INC., HELIPOT DIV.	2500 HARBOR BLVD.	FULLERTON, CA 92634
	JOHNSON, E. F., CO.	299 10TH AVE. S. W.	WASECA, MN 56093
74970 75042	TRW ELECTRONIC COMPONENTS, IRC FIXED		
73042	RESISTORS, PHILADELPHIA DIVISION	401 N. BROAD ST.	PHILADELPHIA, PA 19108
76493	BELL INDUSTRIES, INC.,		
70493	MILLER, J. W., DIV.	19070 REYES AVE., P O BOX 5825	COMPTON, CA 90224
80009	TEKTRONIX, INC.	P O BOX 500	BEAVERTON, OR 97077
	JOHANSON MFG. COMPANY	P O BOX 329	BOONTON, NJ 07005
91293		P. O. BOX 609	COLUMBUS, NE 68601
91637	DALE ELECTRONICS, INC.	r. o. box 009	

Component No.	Tektronix Part No.	Serial/Model No. Eff Dscont	Name & Description	Mfr Code	Mfr Part Number
A10	670-6993-00		CKT BOARD ASSY: DISPLAY	80009	670-6993-00
A12	670-6994-00		CKT BOARD ASSY: ANALOG	80009	
A16	670-6995-00		CKT BOARD ASSY: DIGITAL	80009	670-6995-00
A18	670-6996-00		CKT BOARD ASSY: AUXILIARY	80009	670-6996-00
			(STANDARD ONLY)		
A18	670-6997-00		CKT BOARD ASSY: AUXILIARY W/OVEN	80009	670-6997-00
nio			(OPTION 01 ONLY)		
			OVE BOARD ACCU. DICHLAY		
A10	201 0765 00		CKT BOARD ASSY:DISPLAY	51642	G1710100X5P101J
A10C1321	281-0765-00		CAP.,FXD,CER DI:100PF,5%,100V LAMP,LED RDOUT:ORANGE,7 SEG,0.4 DIGIT	50522	
A10DS1001	150-1053-00 150-1053-00		LAMP, LED ROUT: ORANGE, 7 SEG, 0.4 DIGIT	50522	
A10DS1002 A10DS1003	150-1053-00		LAMP, LED ROOUT: ORANGE, 7 SEG, 0.4 DIGIT	50522	
A10DS1003	150-1031-00		LT EMITTING DIO: RED, 650NM, 40MA MAX	53184	XC209R
RIODSTOOT	130 1031 00		21 20111110 21011129,0001111,111111		
A10DS1005	150-1031-00		LT EMITTING DIO: RED, 650NM, 40MA MAX	53184	XC209R
A10DS1101	150-1053-00		LAMP, LED RDOUT: ORANGE, 7 SEG, 0.4 DIGIT	50522	MAN 4610A
A10DS1102	150-1053-00		LAMP, LED RDOUT: ORANGE, 7 SEG, 0.4 DIGIT	50522	MAN 4610A
A10DS1103	150-1053-00		LAMP, LED RDOUT: ORANGE, 7 SEG, 0.4 DIGIT	50522	
A10DS1104	150-1031-00		LT EMITTING DIO: RED, 650NM, 40MA MAX	53184	XC209R
A10DS1111	150-1043-00		LT EMITTING DIO: RED, 20MA, 5V	50522	MV5774C
A10DS1112	150-1043-00		LT EMITTING DIO:RED, 20MA, 5V		MV5774C
A10DS1113	150-1043-00		LT EMITTING DIO: RED, 20MA, 5V		MV5774C
A10DS1114	150-1043-00		LT EMITTING DIO RED, 20MA, 5V	Part of the Control o	MV5774C
A10DS1131	150-1043-00		LT EMITTING DIO: RED, 20MA, 5V		MV5774C
A10DS1132	150-1043-00		LT EMITTING DIO: RED, 20MA, 5V		MV5774C
A10DS1133	150-1043-00		LT EMITTING DIO: RED, 20MA, 5V	30322	MV5774C
A10DS1134	150-1043-00		LT EMITTING DIO: RED, 20MA, 5V	50522	MV5774C
A10DS1201	150-1053-00		DAMP, LED RDOUT: ORANGE, 7 SEG, 0.4 DIGIT	50522	
A10DS1201	150-1053-00	///	LAMP, LED RDOUT: ORANGE, 7 SEG, 0.4 DIGIT	50522	MAN 4610A
A10DS1202	150-1031-00	1.0%	LT EMITTING DIO: RED, 650NM, 40MA MAX	53184	XC209R
A10DS1211	150-1043-00	Wire	LT EMITTING DIO: RED, 20MA, 5V	50522	MV5774C
A10DS1213	150-1043-00		LT EMITTING DIO: RED, 20MA, 5V	50522	MV5774C
			22 V 20		MIT 77/ 6
A10DS1214	150-1043-00		LT EMITTING DIO: RED, 20MA, 5V		MV5774C
A10DS1221	150-1043-00		LT EMITTING DIO: RED, 20MA, 5V		MV5774C
A10DS1222	150-1043-00		LT EMITTING DIO: RED, 20MA, 5V		MV5774C MV5774C
A10DS1223	150-1043-00		LT EMITTING DIO:RED,20MA,5V LT EMITTING DIO:RED,20MA,5V		MV5774C
A10DS1224	150-1043-00 150-1043-00		LT EMITTING DIO:RED,20MA,5V		MV5774C
A10DS1231	130-1043-00				
A10DS1232	150-1043-00		LT EMITTING DIO: RED, 20MA, 5V	50522	MV5774C
A10DS1233	150-1043-00		LT EMITTING DIO: RED, 20MA, 5V	50522	MV5774C
A10DS1234	150-1043-00		LT EMITTING DIO: RED, 20MA, 5V		MV5774C
A10DS1301	150-1053-00		LAMP, LED RDOUT: ORANGE, 7 SEG, 0.4 DIGIT	50522	MAN 4610A
A10DS1302	150-1031-00		LT EMITTING DIO:RED,650NM,40MA MAX	53184	
A10DS1303	150-1031-00		LT EMITTING DIO: RED, 650NM, 40MA MAX	53184	XC209R
	150 1001 00		IT PULLTUING DYO, DED CEONY ANY	52194	VC200P
A10DS1304	150-1031-00		LT EMITTING DIO:RED,650NM,40MA MAX LT EMITTING DIO:RED,650NM,40MA MAX	53184	XC209R XC209R
A10DS1306	150-1031-00		LT EMITTING DIO: RED, 630NM, 40MA MAX		MV5774C
A10DS1311	150-1043-00 150-1043-00		LT EMITTING DIO:RED, 20MA, 5V		MV5774C
A10DS1313	150-1043-00		LT EMITTING DIO:RED, 20MA, 5V	100 T 100 100 100 100 100 100 100 100 10	MV5774C
A10DS1314 A10DS1321	150-1043-00		LT EMITTING DIO:RED, 20MA, 5V		MV5774C
ALOUGIJE	130 1043 00				
A10DS1323	150-1043-00		LT EMITTING DIO: RED, 20MA, 5V		MV5774C
A10DS1325	150-1031-00		LT EMITTING DIO: RED, 650NM, 40MA MAX		XC209R
A10DS1331	150-1043-00		LT EMITTING DIO: RED, 20MA, 5V		MV5774C
A10DS1332	150-1043-00		LT EMITTING DIO: RED, 20MA, 5V		MV5774C
A10DS1333	150-1043-00		LT EMITTING DIO: RED, 20MA, 5V		MV5774C
A10P1001	131-1934-00		TERM. SET, PIN: 1 X 36,0.1 CTR, 0.9 L	22526	65539-001

Component No.	Tektronix Part No.	Serial/Model No. Eff Dscont	Name & Description	Mfr Code	Mfr Part Number
A10P1002	131-1934-00		TERM. SET, PIN:1 X 36,0.1 CTR, 0.9 L	22526	65539-001
A10P1321	131-1934-00		TERM. SET, PIN:1 X 36,0.1 CTR,0.9 L		65539-001
A1001121	151-0254-00		TRANSISTOR: SILICON, NPN		X38L3118
A10Q1122	151-0254-00		TRANSISTOR: SILICON, NPN	03508	
A10Q1123	151-0254-00		TRANSISTOR: SILICON, NPN	03508	X38L3118
A10Q1124	151-0254-00		TRANSISTOR: SILICON, NPN		X38L3118
.1001105	151 025/ 00		TRANSISTOR: SILICON, NPN	03508	X38L3118
A10Q1125 A10Q1126	151-0254-00 151-0254-00		TRANSISTOR: SILICON, NPN	03508	
A10Q1126	151-0254-00		TRANSISTOR: SILICON, NPN		X38L3118
A10Q1221	151-0254-00		TRANSISTOR: SILICON, NPN		X38L3118
A1001222	151-0254-00		TRANSISTOR: SILICON, NPN		X38L3118
A10R1321	315-0103-00		RES., FXD, CMPSN: 10K OHM, 5%, 0.25W	01121	CB1035
		2010100 2010020	LOTE LOOK DE WONTHENDY	80009	263-0019-01
A1051111	263-0019-01	B010100 B010239	ACTR ASSY, PB: MOMENTARY	80009	
A10S1111	263-0019-35	B010240 B010100 B010239	SWITCH, PB ASSY: MOMENTARY	80009	
A10S1112	263-0019-01 263-0019-35	B010100 B010239	ACTR ASSY, PB: MOMENTARY SWITCH, PB ASSY: MOMENTARY	80009	
A10S1112	263-0019-01	B010100 B010239	ACTR ASSY, PB: MOMENTARY	80009	263-0019-01
A10S1113 A10S1113	263-0019-01	B010100 B010237	SWITCH, PB ASSY: MOMENTARY	80009	
Alosilis	203 0017 37	D010240	on I on the control of the control o		
A10S1114	263-0019-01	B010100 B010239	ACTR ASSY, PB: MOMENTARY	80009	263-0019-01
A10S1114	263-0019-35	B010240	SWITCH, PB ASSY: MOMENTARY	80009	263-0019-35
A10S1131	263-0019-01	B010100 B010239	ACTR ASSY, PB: MOMENTARY	80009	263-0019-01 263-0019-35
A10S1131	263-0019-35	B010240	SWITCH, PB ASSY: MOMENTARY	80009 80009	
A10S1132	263-0019-01	B010100 B010239	ACTR ASSY, PB: MOMENTARY	80009	263-0019-01 263-0019-35
A10S1132	263-0019-35	B010240	SWITCH, PB ASSY: MOMENTARY	80009	203-0019-33
A10S1133	263-0019-01	B010100 B010239	ACTR ASSY, PB: MOMENTARY	80009	263-0019-01
A10S1133	263-0019-35	B010240	SWITCH, PB ASSY: MOMENTARY	80009	263-0019-35
A10S1134	263-0019-01	B010100 B010239	ACTR ASSY PB: MOMENTARY	80009	263-0019-01
A10S1134	263-0019-35	B010240	SWITCH PB ASSY: MOMENTARY	80009	
A10S1211	263-0019-01	B010100 B010239	ACTR ASSY, PB: MOMENTARY	80009	
A10S1211	263-0019-35	в010240	SWITCH, PB ASSY: MOMENTARY	80009	263-0019-35
A10S1212	263-0019-03	B010100 B010239	ACTR ASSY, PB: MOMENTARY	80009	263-0019-03
A10S1212	263-0019-38	B010240	SWITCH PB ASSY: MOMENTARY	80009	263-0019-38
A10S1213	263-0019-01	во10100 во10239	ACTR ASSY, PB: MOMENTARY	80009	263-0019-01
A10S1213	263-0019-35	B010240	SWITCH, PB ASSY: MOMENTARY	80009	
A10S1214	263-0019-01	B010100 B010239	ACTR ASSY, PB: MOMENTARY	80009	263-0019-01
A10S1214	263-0019-35	B010240	SWITCH, PB ASSY: MOMENTARY	80009	263-0019-35
A10S1221	263-0019-01	B010100 B010239	ACTR ASSY, PB: MOMENTARY	80009	263-0019-01
A10S1221	263-0019-35	B010240	SWITCH, PB ASSY: MOMENTARY	80009	263-0019-35
A10S1222	263-0019-01	B010100 B010239	ACTR ASSY, PB: MOMENTARY	80009	263-0019-01
A10S1222	263-0019-35	B010240	SWITCH, PB ASSY: MOMENTARY	80009	263-0019-35
A10S1223	263-0019-01	B010100 B010239	ACTR ASSY, PB: MOMENTARY	80009	
A10S1223	263-0019-35	B010240	SWITCH, PB ASSY: MOMENTARY	80009	263-0019-35
A10S1224	263-0019-01	B010100 B010239	ACTR ASSY, PB: MOMENTARY	80009	263-0019-01
A10S1224	263-0019-35	B010240	SWITCH, PB ASSY: MOMENTARY	80009	263-0019-35
A10S1231	263-0019-01	B010100 B010239	ACTR ASSY, PB: MOMENTARY	80009	263-0019-01
A10S1231	263-0019-35	B010240	SWITCH, PB ASSY: MOMENTARY	80009	263-0019-35
A10S1232	263-0019-01	B010100 B010239	ACTR ASSY, PB: MOMENTARY	80009	
A10S1232	263-0019-35	B010240	SWITCH, PB ASSY: MOMENTARY	80009	263-0019-35
A10S1233	263-0019-01	B010100 B010239	ACTR ASSY, PB: MOMENTARY	80009	263-0019-01
A10S1233	263-0019-35	B010240	SWITCH, PB ASSY: MOMENTARY		263-0019-35
A10S1234	263-0019-01	B010100 B010239	ACTR ASSY, PB: MOMENTARY	80009	263-0019-01
A10S1234	263-0019-35	B010240	SWITCH, PB ASSY: MOMENTARY	80009	263-0019-35
A10S1311	263-0019-01	B010100 B010239	ACTR ASSY, PB: MOMENTARY	80009	263-0019-01
A10S1311	263-0019-35	B010240	SWITCH, PB ASSY: MOMENTARY	80009	263-0019-35
A10S1312	263-0019-30	B010100 B010239	SWITCH, PB ASSY: MOMENTARY	80009	263-0019-35
A10S1312	263-0019-35	B010240	SWITCH, PB ASSY: MOMENTARY	80009	14 17 18 18 18 18 18 18 18 18 18 18 18 18 18
A10S1313	263-0019-01	B010100 B010239	ACTR ASSY, PB: MOMENTARY	80009	
2 - 22 (24 HERE) 5 (5 (5 (5 (5 (5 (5 (5 (5 (5 (5 (5 (5 (senr 788335 - 67.		STANDARD STA		

	Tektronix	Serial/Model No.		Mfr		
Component No.	Part No.	Eff Dscont	Name & Description	Code	Mfr Part Number	
A10S1313	263-0019-35	B010240	SWITCH, PB ASSY: MOMENTARY	80009	263-0019-35	
A10S1314	263-0019-01	B010100 B010239	ACTR ASSY, PB: MOMENTARY	80009	263-0019-01	
A10S1314	263-0019-35	B010240	SWITCH, PB ASSY: MOMENTARY	80009	263-0019-35	
A10S1321	263-0019-01	B010100 B010239	ACTR ASSY, PB: MOMENTARY	80009	263-0019-01	
A10S1321	263-0019-35	B010240	SWITCH, PB ASSY: MOMENTARY	80009	263-0019-35	
A10S1322	263-0019-03	B010100 B010239	ACTR ASSY, PB: MOMENTARY	80009	263-0019-03	
A10S1322	263-0019-38	B010240	SWITCH PB ASSY: MOMENTARY	80009	263-0019-38	
A10S1323	263-0019-01	B010100 B010239	ACTR ASSY, PB: MOMENTARY	80009	263-0019-01	
A10S1323	263-0019-35	B010240	SWITCH, PB ASSY: MOMENTARY	80009	263-0019-35	
A10S1324	263-0019-03	B010100 B010239	ACTR ASSY, PB: MOMENTARY	80009	263-0019-03	
A10S1324	263-0019-38	B010240	SWITCH PB ASSY: MOMENTARY	80009	263-0019-38	
A10S1331	263-0019-01	B010100 B010239	ACTR ASSY, PB: MOMENTARY	80009	263-0019-01	
A10S1331	263-0019-35	B010240	SWITCH, PB ASSY: MOMENTARY	80009	263-0019-35	
A10S1332	263-0019-01	B010100 B010239	ACTR ASSY, PB: MOMENTARY	80009	263-0019-01	
A10S1332	263-0019-35	B010240	SWITCH, PB ASSY: MOMENTARY	80009	263-0019-35	
A10S1333	263-0019-01	B010100 B010239	ACTR ASSY, PB: MOMENTARY	80009	263-0019-01	
A10S1333	263-0019-35	B010240	SWITCH, PB ASSY: MOMENTARY	80009	263-0019-35	
A10S1334	263-0019-04	B010100 B010239	ACTR ASSY, PB: MOMENTARY	80009	263-0019-04	
A10S1334	263-0019-37	в010240	SWITCH, PB ASSY: MOMENTARY	80009	263-0019-37	
A10U1121	156-0799-00		MICROCIRCUIT, DI: DECADE CNTR/DTV	80009	156-0799-00	



	Taldessin	Carial/Madel No		144	
Component No.	Tektronix Part No.	Serial/Model No. Eff Dscont	Name & Description	Mfr	Mfr Part Number
Component No.	rait No.	EII DSCOIR		Code	WIII FAIT NUMBER
A12			CKT BOARD ASSY: ANALOG		
A12AT1505	307-1012-00		ATTENUATOR, FXD: 5X	80009	307-1012-00
A12AT1533	307-1012-00		ATTENUATOR, FXD: 5X	80009	307-1012-00
A12C1003	283-0220-00		CAP.,FXD,CER DI:0.01UF,20%,50V	72982	8121N075X7R0103M
A12C1004	283-0220-00		CAP., FXD, CER DI:0.01UF, 20%, 50V	72982	8121N075X7R0103M
A12C1005	283-0220-00		CAP., FXD, CER DI:0.01UF, 20%, 50V	72982	8121N075X7R0103M
A12C1010	281-0808-00		CAP., FXD, CER DI: 7PF, 20%, 100V	72982	8035D9AADC0G709G
A12C1011	283-0220-00		CAP., FXD, CER DI:0.01UF, 20%, 50V	72982	8121N075X7R0103M
A12C1012	281-0773-00		CAP., FXD, CER DI:0.01UF, 10%, 100V	04222	
A12C1013	283-0220-00		CAP., FXD, CER DI:0.01UF, 20%, 50V	72982	8121N075X7R0103M
A12C1014	290-0776-00		CAP., FXD, ELCTLT: 22UF, +50-10%, 10V	55680	10ULA22V-T
A12C1015	290-0776-00		CAP., FXD, ELCTLT: 22UF, +50-10%, 10V	55680	10ULA22V-T
A12C1020	281-0770-00		CAP., FXD, CER DI:0.001UF, 20%, 100V	72982	8035D9AADX5R102M
A12C1021	281-0773-00		CAP., FXD, CER DI:0.01UF, 10%, 100V	04222	GC70-1C103K
A12C1022	281-0773-00		CAP., FXD, CER DI:0.01UF, 10%, 100V	04222	GC70-1C103K
A12C1023	281-0773-00		CAP., FXD, CER DI:0.01UF, 10%, 100V	04222	GC70-1C103K
A12C1024	283-0220-00		CAP., FXD, CER DI:0.01UF, 20%, 50V	72982	8121N075X7R0103M
A12C1025	283-0220-00		CAP., FXD, CER DI:0.01UF, 20%, 50V	72982	8121N075X7R0103M
A12C1030	283-0423-00		CAP., FXD, CER DI:0.22UF, +80-20%, 50V	04222	DG015E224Z
A12C1031	283-0423-00		CAP., FXD, CER DI:0.22UF, +80-20%, 50V	04222	DG015E224Z
A12C1032	281-0798-00		CAP., FXD, CER DI:51PF, 1%, 100V	04222	
A12C1032	290-0782-00		CAP., FXD, ELCTLT: 4.7UF, +75-10%, 35V	55680	35ULA4R7V-T
A12C1107	283-0220-00		CAP., FXD, CER DI:0.01UF, 20%, 50V	72982	
A12C1107	283-0220-00		CAP., FXD, CER DI:0.01UF, 20%, 50V	72982	8121N075X7R0103M
.11001110	283 0220 00		CAP., FXD, CER DE 0.01UF, 20%, 50V	72082	9121N075Y7P0103M
A12C1110	283-0220-00			72982	
A12C1113	283-0220-00		CAP., FXD, CER DI:0.01UF, 20%, 50V CAP., FXD, CER DI:0.01UF, 20%, 50V	72982 72982	
A12C1114	283-0220-00			72982	
A12C1118	283-0220-00		CAP., FXE, CER DI:0.01UF, 20%, 50V	72982	8035D9AADX5R102M
A12C1120 A12C1121	281-0770-00 281-0810-00		CAP. (FXD, CER DI:0.001UF, 20%, 100V CAR., FXD, CER DI:5.6PF, 0.5%, 100V	72982	1035D2ADC0G569D
	281 0772 00		CAP., FXD, CER DI:5.6PF, 0.5%, 100V CAP., FXD, CER DI:0.01UF, 10%, 100V CAP., FXD, CER DI:0.01UF, 20%, 50V CAP., FXD, CER DI:5.6PF, 0.5%, 100V	04222	CC70-1C103V
A12C1122	281-0773-00	2//:	CAP., FXD, CER DI:0.010F, 10%, 100V	04222	
A12C1123	283-0220-00	*45.	CAP., FXD, CER DI: 0.010F, 20%, 50V	72982	8121N075X7R0103M
A12C1130	281-0810-00	Kir	CAP., FXD, CER DI:5.6PF, 0.5%, 100V	72982	1035D2ADC0G569D
A12C1131	290-0782-00		CAP., FXD, ELCTLT: 4.7UF, +75-10%, 35V	55680	35ULA4R7V-T
A12C1140 A12C1200	281-0773-00 283-0220-00		CAP., FXD, CER DI:0.01UF, 10%, 100V CAP., FXD, CER DI:0.01UF, 20%, 50V	04222 72982	GC70-1C103K 8121N075X7R0103M
A12C1200	283-0220-00		on the few billion of the few por	,,,,,,	01211073171101001
A12C1201	283-0220-00		CAP., FXD, CER DI:0.01UF, 20%, 50V	72982	
A12C1210	290-0776-00		CAP., FXD, ELCTLT: 22UF, +50-10%, 10V	55680	10ULA22V-T
A12C1211	290-0776-00		CAP., FXD, ELCTLT: 22UF, +50-10%, 10V	55680	10ULA22V-T
A12C1212	290-0782-00		CAP., FXD, ELCTLT: 4.7UF, +75-10%, 35V	55680	35ULA4R7V-T
A12C1213	290-0776-00 290-0782-00		CAP.,FXD,ELCTLT:22UF,+50-10%,10V CAP.,FXD,ELCTLT:4.7UF,+75-10%,35V		10ULA22V-T 35ULA4R7V-T
A12C1220	290-0782-00		CAP.,FAD,EDCILI.4.70F, +75-104,554	33000	330BN4K/1
A12C1221	290-0782-00		CAP., FXD, ELCTLT: 4.7UF, +75-10%, 35V	55680	35ULA4R7V-T
A12C1230	290-0776-00		CAP., FXD, ELCTLT: 22UF, +50-10%, 10V	55680	
A12C1231	290-0782-00		CAP., FXD, ELCTLT: 4.7UF, +75-10%, 35V	55680	35ULA4R7V-T
A12C1233	290-0776-00		CAP., FXD, ELCTLT: 22UF, +50-10%, 10V	55680	10ULA22V-T
A12C1234	290-0776-00		CAP., FXD, ELCTLT: 22UF, +50-10%, 10V	55680	10ULA22V-T
A12C1303	283-0220-00		CAP., FXD, CER DI:0.01UF, 20%, 50V	72982	8121N075X7R0103M
A12C1304	283-0220-00		CAP., FXD, CER DI:0.01UF, 20%, 50V	72982	8121N075X7R0103M
A12C1312	283-0094-00		CAP., FXD, CER DI:27PF, 10%, 200V	72982	835-583-C0G0270K
A12C1313	281-0814-00		CAP., FXD, CER DI:100PF, 10%, 100V	04222	GC70-1-A101K
A12C1317	283-0220-00		CAP., FXD, CER DI:0.01UF, 20%, 50V	72982	8121N075X7R0103M
A12C1319	283-0260-00		CAP., FXD, CER DI:5.6PF, 5%, 200V	72982	8111B200C0G569C
A12C1322	283-0220-00		CAP., FXD, CER DI:0.01UF, 20%, 50V	72982	8121N075X7R0103M
A12C1323	283-0220-00		CAP., FXD, CER DI:0.01UF, 20%, 50V	72982	8121N075X7R0103M
A12C1330	283-0094-00		CAP., FXD, CER DI: 27PF, 10%, 200V	72982	835-583-C0G0270K
A12C1331	281-0814-00		CAP., FXD, CER DI:100PF, 10%, 100V		GC70-1-A101K
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	Tektronix	Serial/Model No.		Mfr	
Component No.	Part No.	Eff Dscont	Name & Description	Code	Mfr Part Number
A12C1333	283-0220-00		CAP., FXD, CER DI:0.01UF, 20%, 50V	72982	8121N075X7R0103M
A12C1339	283-0260-00		CAP., FXD, CER DI:5.6PF, 5%, 200V	72982	
A12C1401	283-0220-00		CAP., FXD, CER DI:0.01UF, 20%, 50V	72982	
A12C1403	283-0107-00		CAP.,FXD,CER DI:51PF,5%,200V	72982	
A12C1405	283-0220-00		CAP., FXD, CER DI:0.01UF, 20%, 50V	72982	
A12C1412	281-0775-00		CAP., FXD, CER DI:0.1UF, 20%, 50V	72982	8005D9AABZ5U104M
	.02 0000 00		CAR PUR CUR DY O CHUR 20% FOU	71001	0101807597801039
A12C1413	283-0220-00		CAP., FXD, CER DI:0.01UF, 20%, 50V CAP., FXD, ELCTLT:22UF, +50-10%, 10V	72982 55680	8121N075X7R0103M 10ULA22V-T
A12C1414	290-0776-00 281-0775-00		CAP., FXD, CER DI:0.1UF, 20%, 50V	72982	8005D9AABZ5U104M
A12C1415	283-0107-00		CAP., FXD, CER DI:51PF, 5%, 200V	72982	8121B232C0G0510J
A12C1425 A12C1432	281-0775-00		CAP., FXD, CER DI:0.1UF, 20%, 50V	72982	
A12C1435	283-0220-00		CAP., FXD, CER DI:0.01UF, 20%, 50V	72982	8121N075X7R0103M
A1201433	203 0220 00		on ,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,	,,,,,,	0121107511711010511
A12C1500	290-0782-00		CAP., FXD, ELCTLT: 4.7UF, +75-10%, 35V	55680	35ULA4R7V-T
A12C1501	281-0770-00		CAP., FXD, CER DI:0.001UF, 20%, 100V	72982	8035D9AADX5R102M
A12C1502	283-0220-00		CAP., FXD, CER DI:0.01UF, 20%, 50V	72982	8121N075X7R0103M
A12C1503	283-0220-00		CAP., FXD, CER DI:0.01UF, 20%, 50V	72982	
A12C1504	283-0185-00		CAP., FXD, CER DI:2.5PF, 5%, 50V	72982	
A12C1506	283-0220-00		CAP., FXD, CER DI:0.01UF, 20%, 50V	72982	8121N075X7R0103M
11201507	283-0220-00		CAP., FXD, CER DI:0.01UF, 20%, 50V	72982	8121N075X7R0103M
A12C1507 A12C1509	283-0160-00		CAP., FXD, CER DI:1.5PF, 10%, 50V	72982	8101A058C0K159B
A12C1512	283-0220-00		CAP., FXD, CER DI:0.01UF, 20%, 50V	72982	
A12C1512	283-0220-00		CAP., FXD, CER DI:0.01UF, 20%, 50V	72982	
A12C1514	283-0220-00		CAP.,FXD,CER DI:0.01UF,20%,50V	72982	
A12C1515	283-0220-00		CAP., FXD, CER DI:0.01UF, 20%, 50V	72982	8121N075X7R0103M
	700 0000 00			70000	0101007577001039
A12C1516	283-0220-00		CAP., FXD, CER DESO.01UF, 20%, 50V	72982	
A12C1517	283-0220-00		CAP., FXD, CER DI:0.01UF, 20%, 50V	72982 04222	8121N075X7R0103M ULA105C102K2T60
A12C1518	283-0252-00		CAP., FXD, CER DI:1000PF, 10%, 50V	72982	8121N075X7R0103M
A12C1519	283-0220-00 290-0782-00		CAP., FXD, CER DI:0.01UF, 20%, 50V CAP., FXD, ELCTLT:4.7UF, +75-10%, 35V	55680	35ULA4R7V-T
A12C1520 A12C1521	281-0770-00			72982	8035D9AADX5R102M
	ribetri rahasis 164		CAP., FXD, CER DI:0.001UF, 20%, 100V CAP., FXD, CER DI:0.01UF, 20%, 50V CAP., FXD, CER DI:0.01UF, 10%, 100V CAP., FXD, CER DI:0.01UF, 20%, 50V		
A12C1522	283-0220-00	1/1/	CAP., FXD, CER DI:0.01UF, 20%, 50V	72982	8121N075X7R0103M
A12C1523	281-0773-00	4,0,1	CAP., FXD, CER DI:0.01UF, 10%, 100V	04222	
A12C1524	283-0220-00	Wro.	CAP., FXD, CER DI:0.01UF, 20%, 50V	72982	8121N075X7R0103M
A12C1525	283-0220-00		CAP.,FXD,CER DI:0.01UF,20%,50V	72982	
A12C1527	283-0160-00		CAP., FXD, CER DI:1.5PF, 10%, 50V	72982 72982	8101A058C0K159B 8121N075X7R0103M
A12C1530	283-0220-00		CAP., FXD, CER DI:0.01UF, 20%, 50V	12902	ST2THO/ JA/ ROTOSH
A12C1531	290-0776-00		CAP., FXD, ELCTLT: 22UF, +50-10%, 10V	55680	10ULA22V-T
A12C1532	281-0775-00		CAP., FXD, CER DI:0.1UF, 20%, 50V	72982	8005D9AABZ5U104M
A12C1533	283-0185-00		CAP., FXD, CER DI:2.5PF, 5%, 50V	72982	8101B057C0K0295B
A12C1535	283-0252-00		CAP., FXD, CER DI:1000PF, 10%, 50V	04222	
A12C1536	283-0220-00		CAP., FXD, CER DI:0.01UF, 20%, 50V		8121N075X7R0103M
A12C1537	283-0220-00		CAP.,FXD,CER DI:0.01UF,20%,50V	72982	8121N075X7R0103M
A12C1538	283-0220-00		CAP., FXD, CER DI:0.01UF, 20%, 50V	72982	8121N075X7R0103M
A12C1539	283-0220-00		CAP., FXD, CER DI:0.01UF, 20%, 50V	72982	8121N075X7R0103M
A12C1601	281-0773-00		CAP., FXD, CER DI:0.01UF, 10%, 100V	04222	GC70-1C103K
A12C1607	283-0220-00		CAP., FXD, CER DI:0.01UF, 20%, 50V	72982	8121N075X7R0103M
A12C1610	283-0410-00		CAP., FXD, CER DI:0 .022UF, 10%, 500V	91293	501548W223KBS
A12C1611	283-0220-00		CAP., FXD, CER DI:0.01UF, 20%, 50V	72982	8121N075X7R0103M
A12C1612	283-0220-00		CAP., FXD, CER DI:0.01UF, 20%, 50V	72982	8121N075X7R0103M
A12C1612 A12C1613	283-0220-00		CAP., FXD, CER DI:0.01UF, 20%, 50V		8121N075X7R0103M
A12C1614	283-0220-00		CAP., FXD, CER DI:0.01UF, 20%, 50V	72982	
A12C1615	283-0220-00		CAP., FXD, CER DI:0.01UF, 20%, 50V		8121N075X7R0103M
A12C1616	283-0220-00		CAP.,FXD,CER DI:0.01UF,20%,50V	72982	
A12C1617	283-0220-00		CAP., FXD, CER DI:0.01UF, 20%, 50V	72982	
			112 222 233 233 233 233		
A12C1620	283-0410-00		CAP., FXDK, CER DI:0.022UF, 10%, 500V	91293	
A12C1621	283-0220-00		CAP., FXD, CER DI:0.01UF, 20%, 50V CAP., FXD, CER DI:0.01UF, 20%, 50V	72982	8121N075X7R0103M 8121N075X7R0103M
A12C1622	283-0220-00		ORE., FAD, ORR DI.O. OLDF, ZUA, JUV	72902	OLETHO / JA / ROTOJA

-	Tektronix	Serial/Model No.	20 2 20 1075	Mfr	STATE OF STATE OF
Component No.	Part No.	Eff Dscont	Name & Description	Code	Mfr Part Number
A12C1623	283-0220-00		CAP., FXD, CER DI:0.01UF, 20%, 50V	72982	8121N075X7R0103M
A12C1624	283-0220-00		CAP., FXD, CER DI:0.01UF, 20%, 50V	72982	8121N075X7R0103M
A12C1625	283-0220-00		CAP., FXD, CER DI:0.01UF, 20%, 50V	72982	8121N075X7R0103M
A12C1626	283-0220-00		CAP., FXD, CER DI:0.01UF, 20%, 50V	72982	
A12C1631	281-0773-00		CAP., FXD, CER DI:0.01UF, 10%, 100V	04222	
A12C1632	283-0220-00		CAP., FXD, CER DI:0.01UF, 20%, 50V	72982	8121N075X7R0103M
	000 0000 00		CAR TWO CER DY O CLUB OON FOR	70000	8121N075X7R0103M
A12C1633	283-0220-00		CAP., FXD, CER DI:0.01UF, 20%, 50V	72982 72982	8121N075X7R0103M
A12C1634	283-0220-00		CAP., FXD, CER DI:0.01UF, 20%, 50V	72982	8121N075X7R0103M
A12C1635	283-0220-00		CAP., FXD, CER DI:0.01UF, 20%, 50V CAP., FXD, CER DI:0.01UF, 20%, 50V	72982	
A12C1636 A12C1637	283-0220-00 283-0220-00		CAP., FXD, CER DI:0.01UF, 20%, 50V	72982	8121N075X7R0103M
A12C1639	283-0220-00		CAP., FXD, CER DI:0.01UF, 20%, 50V	72982	
RIZOTOSS	203 0220 00		om tyrkbyour bitotototypowysot		
A12CR1111	152-0141-02		SEMICOND DEVICE: SILICON, 30V, 150MA	01295	1N4152R
A12CR1130	152-0269-00		SEMICOND DEVICE: SILICON, VAR VCAP., 4V, 33PF	80009	152-0269-00
A12CR1200	152-0141-02		SEMICOND DEVICE: SILICON, 30V, 150MA	01295	1N4152R
A12CR1201	152-0141-02		SEMICOND DEVICE: SILICON, 30V, 150MA	01295	1N4152R
A12CR1220	152-0141-02		SEMICOND DEVICE: SILICON, 30V, 150MA	01295	1N4152R
A12CR1300	152-0322-00		SEMICOND DEVICE: SILICON, 15V, HOT CARRIER	50434	5082-2672
			The SACRET Wilders Control of the Co		****
A12CR1310	152-0322-00		SEMICOND DEVICE: SILICON, 15V, HOT CARRIER	50434	5082-2672
A12CR1311	152-0141-02		SEMICOND DEVICE: SILICON, 30V, 150MA	01295	1N4152R
A12CR1320	152-0322-00		SEMICOND DEVICE: SILICON, 15V, HOT CARRIER	50434	5082-2672
A12CR1330	152-0141-02		SEMICOND DEVICE:SILICON, 30V, 150MA	01295	
A12CR1331	152-0141-02		SEMICOND DEVICE:SILICON, 30V, 150MA SEMICOND DEVICE:SILICON, 15V, HOT CARRIER	01295 50434	1N4152R 5082-2672
A12CR1332	152-0322-00		SEMICOND DEVICE: SILICON, 15V, HOI CARRIER	30434	3002-2072
A12CR1400	152-0141-02		SEMICOND DEVICE: SILICON, 30V, 150MA	01295	1N4152R
A12CR1401	152-0141-02		SEMICOND DEVICE: SILICON, 30V, 150MA	01295	1N4152R
A12CR1410	152-0536-00		SEMICOND DEVICE: SILICON, HOT CARRIER, 4V	80009	152-0536-00
A12CR1411	152-0536-00		SEMICOND DEVICE: SILICON, HOT CARRIER, 4V	80009	152-0536-00
A12CR1420	152-0141-02		SEMICOND DEVICE: SILICON, 30V, 150MA	01295	1N4152R
A12CR1430	152-0536-00		SEMICOND DEVICE: SILICON, HOT CARRIER, 4V	80009	152-0536-00
		,	alle		972489000248 - 2002
A12CR1431	152-0536-00	2//:	SEMICOND DEVICE: SILICON, HOT CARRIER, 4V	80009	152-0536-00
A12CR1510	152-0322-00	1.034	SEMICOND DEVICE: SILICON, 15V, HOT CARRIER	50434	5082-2672
A12CR1511	152-0322-00	Kr	SEMICOND DEVICE: SILICON, 15V, HOT CARRIER	50434	5082-2672
A12CR1512	152-0246-00		SEMICOND DEVICE:SW,SI,40V,200MA	03508 03508	DE140 DE140
A12CR1513	152-0246-00		SEMICOND DEVICE:SW,SI,40V,200MA SEMICOND DEVICE:SILICON,30V,150MA	01295	1N4152R
A12CR1520	152-0141-02		SEMICOND DEVICE: SILICON, SOV, ISONA	01293	1841328
A12CR1530	152-0322-00		SEMICOND DEVICE: SILICON, 15V, HOT CARRIER	50434	5082-2672
A12CR1531	152-0322-00		SEMICOND DEVICE:SILICON, 15V, HOT CARRIER	50434	5082-2672
A12CR1532	152-0246-00		SEMICOND DEVICE:SW,SI,40V,200MA	03508	DE140
A12CR1533	152-0246-00		SEMICOND DEVICE:SW,SI,40V,200MA	03508	DE140
A12DL500	119-1367-00		DELAY LINE, ELEC: 4 NAO SEC, 50 OHM	80009	119-1367-00
A12J500	131-1097-00		CONNECTOR, RCPT, : BNC, FEMALE, CKT BOARD MT	24931	28JR220-2
A12J510	131-1097-00		CONNECTOR, RCPT, : BNC, FEMALE, CKT BOARD MT	24931	28JR220-2
A12J1010	131-2651-00		CONN, RCPT, ELEC: HEADER, 1 X 36,0.1 CTR	22526	
A12J1102	131-2651-00		CONN, RCPT, ELEC: HEADER, 1 X 36, 0.1 CTR	22526	
A12J1130	131-1003-00		CONN, RCPT, ELEC: CKT BD MT, 3 PRONG	80009	131-1003-00
A12J1201	131-1003-00		CONN, RCPT, ELEC: CKT BD MT, 3 PRONG	80009 22526	131-1003-00 65506-436
A12J1230	131-2132-01		CONN, RCPT, ELEC: HEADER, 1 X 36,01 CTR	22320	63306-436
A12J1400	131-2132-01		CONN, RCPT, ELEC: HEADER, 1 X 36,01 CTR	22526	65506-436
A12J1400 A12J1420	131-2132-01		CONN, RCPT, ELEC: HEADER, 1 X 36,01 CTR	22526	
A12J1510	131-2651-00		CONN, RCPT, ELEC: HEADER, 1 X 36,0.1 CTR	22526	
A12J1520	131-2651-00		CONN, RCPT, ELEC: HEADER, 1 X 36,0.1 CTR	22526	
A12K1500	148-0128-00		RELAY, ARMATURE: 1 FORM X & 1 FORM Y,8VDC	80009	148-0128-00
A12K1510	148-0128-00		RELAY, ARMATURE: 1 FORM X & 1 FORM Y, 8VDC	80009	148-0128-00
A12K1511	148-0128-00		RELAY, ARMATURE: 1 FORM X & 1 FORM Y, 8VDC	80009	148-0128-00
A12K1520	148-0128-00		RELAY, ARMATURE: 1 FORM X & 1 FORM Y, 8VDC	80009	148-0128-00
A12K1521	148-0128-00		RELAY, ARMATURE: 1 FORM X & 1 FORM Y, 8VDC	80009	148-0128-00

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	Tektronix	Serial/Model No.	99 N 250 G 200	Mfr	
Component No.	Part No.	Eff Dscont	Name & Description	Code	Mfr Part Number
11021520	140 0100 00		RELAY, ARMATURE: 1 FORM X & 1 FORM Y, 8VDC	80009	148-0128-00
A12K1530	148-0128-00 148-0128-00		RELAY, ARMATURE: 1 FORM X & 1 FORM Y, 8VDC	80009	148-0128-00
A12K1600 A12K1610	148-0128-00		RELAY, ARMATURE: 1 FORM X & 1 FORM Y, 8VDC	80009	148-0128-00
A12K1611	148-0128-00		RELAY, ARMATURE: 1 FORM X & 1 FORM Y, 8VDC	80009	148-0128-00
A12K1612	148-0108-00		RELAY, ARMATURE: 2 FORM C,5VDC COIL, 2A	11532	720-5
A12K1620	148-0128-00		RELAY, ARMATURE: 1 FORM X & 1 FORM Y, 8VDC	80009	148-0128-00
HIZKIOZO	140 0120 00		naming in a result of the resu		200 1001 00
A12K1630	148-0128-00		RELAY, ARMATURE: 1 FORM X & 1 FORM Y, 8VDC	80009	148-0128-00
A12K1631	148-0128-00		RELAY, ARMATURE: 1 FORM X & 1 FORM Y, 8VDC	80009	148-0128-00
A12K1632	148-0108-00		RELAY, ARMATURE: 2 FORM C, 5VDC COIL, 2A	11532	720-5
A12L1009	108-0436-00		COIL, RF: FIXED, 240NH	80009	108-0436-00
A12L1120	120-0382-00		XFMR, TOROID: 14 TURNS, SINGLE	80009	120-0382-00
A12L1220	108-0245-00		COIL, RF: 3.9UH	76493	B6310-1
			to proper where we have required to the results of		
A12L1221	108-0245-00		COIL, RF: 3.9UH	76493	B6310-1
A12L1230	108-0245-00		COIL, RF: 3.9UH	76493	B6310-1
A12L1231	108-0245-00		COIL, RF: 3.9UH	76493	B6310-1
A12L1232	108-0245-00		COIL, RF: 3.9UH	76493	B6310-1
A12L1233	108-0245-00		COIL, RF: 3.9UH	76493	B6310-1
A12L1302	108-0245-00		COIL, RF: 3.9UH	76493	B6310-1
A12L1310	108-0262-00		COIL, RF: FIXED, 510MH	80009	108-0262-00
A12L1311	108-0262-00		COIL, RF: FIXED, 510MH	80009	108-0262-00
A12L1312	108-0245-00		COIL, RF: 3.9UH	76493	B6310-1
A12L1322	108-0245-00		COIL, RF: 3.9UH	76493	B6310-1
A12L1330	108-0262-00		COIL, RF: FIXED, 510MH	80009	108-0262-00
A12L1331	108-0262-00		COIL, RF: FIXED, 510MH	80009	108-0262-00
•			A	237722	10111
A12L1332	108-0245-00		COIL, RF: 3.9UH	76493	B6310-1
A12L1410	108-0245-00		COIL, RF: 3.90H	76493	B6310-1
A12L1430	108-0245-00		COIL, RF: 3,9UH	76493	
A12Q1000	151-0188-00		TRANSISTOR: SILICON, PNP	04713	
A12Q1100	151-0190-00		TRANSISTOR: SILICON, NPN	07263	
A12Q1110	151-0188-00		TRANSISTOR: SILICON, PNP	04713	SPS6868K
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A12Q1111	151-0188-00	.///:	TRANSISTOR: SILICON, PNP	04713	
A12Q1112	151-0220-00	199	TRANSISTOR: SILICON, PNP		S036228
A12Q1114	151-0220-00	Kin	TRANSISTOR: SILICON, PNP	07263	
A12Q1122	151-0369-00		TRANSISTOR: SILICON, PNP	01295	
A12Q1130	151-0369-00		TRANSISTOR: SILICON, PNP	01295	SKA6664
A12Q1200	151-0190-00		TRANSISTOR: SILICON, NPN	07263	S032677
.1001001	151-02/1-00		TRANSFEROD STITCON NEW	07263	S040065
A12Q1201	151-0341-00		TRANSISTOR: SILICON, NPN TRANSISTOR: SILICON, NPN	07263	
A12Q1202	151-0341-00		TRANSISTOR: SILICON, NPN	01295	
A12Q1203	151-0369-00		TRANSISTOR: SILICON, PNP	01295	SKA6664
A12Q1204	151-0369-00		TRANSISTOR: SILICON, PNP TRANSISTOR: SILICON, NPN	07263	
A12Q1210 A12Q1211	151-0341-00 151-0341-00		TRANSISTOR: SILICON, NPN TRANSISTOR: SILICON, NPN		S040065
MIZUIZII	131-0341-00			3,200	0.233011
A12Q1220	151-0341-00		TRANSISTOR: SILICON, NPN	07263	S040065
A12Q1221	151-0341-00		TRANSISTOR: SILICON, NPN	07263	S040065
A12Q1222	151-0369-00		TRANSISTOR: SILICON, PNP	01295	SKA6664
A12Q1300	151-0369-00		TRANSISTOR: SILICON, PNP	01295	SKA6664
A12Q1301	151-0369-00		TRANSISTOR: SILICON, PNP	01295	SKA6664
A12Q1302	151-0369-00		TRANSISTOR: SILICON, PNP	01295	SKA6664
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A12Q1303	151-0427-00		TRANSISTOR: SILICON, NPN	80009	151-0427-00
A1201320	151-0369-00		TRANSISTOR: SILICON, PNP	01295	
A12Q1321	151-0369-00		TRANSISTOR: SILICON, PNP	01295	SKA6664
A12Q1322	151-0369-00		TRANSISTOR: SILICON, PNP	01295	SKA6664
A12Q1323	151-0427-00		TRANSISTOR: SILICON, NPN	80009	151-0427-00
A12Q1400	151-0427-00		TRANSISTOR: SILICON, NPN	80009	151-0427-00
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A12Q1401	151-0427-00		TRANSISTOR: SILICON, NPN	80009	151-0427-00
A12Q1402	151-0427-00		TRANSISTOR: SILICON, NPN	80009	151-0427-00
A12Q1403	151-0427-00		TRANSISTOR: SILICON, NPN	80009	151-0427-00

	Tektronix	Serial/Model No.	18	Mfr	
Component No.	Part No.	Eff Dscont	Name & Description		Mfr Part Number
A12Q1410	151-1117-00		TRANSISTOR: FE, DUAL, N-CHANNEL, SI	80009	151-1117-00
A12Q1420	151-0427-00		TRANSISTOR: SILICON, NPN	80009	151-0427-00
A12Q1421	151-0427-00		TRANSISTOR: SILICON, NPN	80009	
A12Q1422	151-0427-00		TRANSISTOR: SILICON, NPN	80009	
A12Q1423	151-0427-00		TRANSISTOR: SILICON, NPN	80009	
A12Q1430	151-1117-00		TRANSISTOR: FE, DUAL, N-CHANNEL, SI	80009	151-1117-00
A12R1000	315-0750-00		RES., FXD, CMPSN: 75 OHM, 5%, 0.25W	01121	
A12R1001	315-0132-00		RES., FXD, CMPSN:1.3K OHM, 5%, 0.25W	01121	CB1325
A12R1002	315-0750-00		RES., FXD, CMPSN: 75 OHM, 5%, 0.25W	01121	
A12R1003	315-0472-00		RES., FXD, CMPSN: 4.7K OHM, 5%, 0.25W	01121	
A12R1004	307-0546-00		RES NTWK, FXD FI:5,75 OHM, 5%, 0.15W	91637 01121	MSP06A01750J CB7505
A12R1005	315-0750-00		RES.,FXD,CMPSN:75 OHM,5%,0.25W	01121	CB7303
A12R1006	315-0510-00		RES., FXD, CMPSN:51 OHM, 5%, 0.25W	01121	
A12R1007	315-0750-00		RES., FXD, CMPSN: 75 OHM, 5%, 0.25W	01121	CB7505
A12R1008	315-0750-00		RES., FXD, CMPSN: 75 OHM, 5%, 0.25W	01121	
A12R1009	315-0750-00		RES., FXD, CMPSN: 75 OHM, 5%, 0.25W	01121	
A12R1010	315-0750-00		RES., FXD, CMPSN: 75 OHM, 5%, 0.25W	01121	
A12R1013	315-0132-00		RES.,FXD,CMPSN:1.3K OHM,5%,0.25W	01121	CB1325
A12R1014	315-0391-00		RES., FXD, CMPSN: 390 OHM, 5%, 0.25W	01121	
A12R1015	315-0430-00		RES., FXD, CMPSN: 43 OHM, 5%, 0.25W	01121	
A12R1016	315-0132-00		RES., FXD, CMPSN: 1.3K OHM, 5%, 0.25W	01121	
A12R1017	315-0391-00		RES., FXD, CMPSN: 390 OHM, 5%, 0.25W	01121 01121	
A12R1018	315-0430-00		RES., FXD, CMPSN:43 OHM, 5%, 0.25W RES., FXD, CMPSN:390 OHM, 5%, 0.25W	01121	
A12R1019	315-0391-00			01121	
A12R1020	315-0153-00		RES.,FXD,CMPSN315K OHM,5%,0.25W	01121	CB1535
A12R1021	315-0361-00		RES., FXD, CMPSN: 360 OHM, 5%, 0.25W	01121	
A12R1022	315-0391-00		RES., FXD CMPSN: 390 OHM, 5%, 0.25W	01121	
A12R1023	315-0391-00		RES., EXD, CMPSN: 390 OHM, 5%, 0.25W	01121 01121	
A12R1030	315-0393-00		RES., FXD, CMPSN:39K OHM, 5%, 0.25W RES., FXD, CMPSN:9.1K OHM, 5%, 0.25W	01121	
A12R1031	315-0912-00	http:///	003., FAD, CHESN. 3. 12 OHH, 34, 0.234		
A12R1032	315-0113-00	.///.	RES., FXD, CMPSN:11K OHM, 5%, 0.25W	01121	
A12R1033	315-0113-00	"itip."	RES., FXD, CMPSN: 11K OHM, 5%, 0.25W	01121	
A12R1034	315-0361-00			01121	
A12R1035	315-0333-00		RES., FXD, CMPSN: 33K OHM, 5%, 0.25W	01121	
A12R1036	315-0361-00		RES., FXD, CMPSN: 360 OHM, 5%, 0.25W	01121 01121	CB3615 CB1135
A12R1037	315-0113-00		RES.,FXD,CMPSN:11K OHM,5%,0.25W	01121	
A12R1101	315-0512-00		RES., FXD, CMPSN: 5.1K OHM, 5%, 0.25W	01121	
A12R1102	315-0472-00		RES., FXD, CMPSN: 4.7K OHM, 5%, 0.25W	01121	
A12R1103	315-0102-00		RES., FXD, CMPSN: 1K OHM, 5%, 0.25W	01121	CB1025 MSP06A01750J
A12R1104	307-0546-00		RES NTWK, FXD FI:5,75 OHM,5%,0.15W	91637	CB1025
A12R1105 A12R1106	315-0102-00 315-0472-00		RES., FXD, CMPSN:1K OHM, 5%, 0.25W RES., FXD, CMPSN:4.7K OHM, 5%, 0.25W		CB4725
AIZKIIO	313-0472-00				
A12R1107	321-0085-00		RES., FXD, FILM: 75 OHM, 1%, 0.125W	91637	
A12R1108	321-0085-00		RES., FXD, FILM: 75 OHM, 1%, 0.125W	91637	
A12R1109	315-0750-00		RES., FXD, CMPSN: 75 OHM, 5%, 0.25W	01121	
A12R1110	315-0102-00		RES., FXD, CMPSN: 1K OHM, 5%, 0.25W	01121	
A12R1112	321-0085-00		RES., FXD, FILM: 75 OHM, 1%, 0.125W	91637 01121	MFF1816G75R00F CB7505
A12R1113	315-0750-00		RES.,FXD,CMPSN:75 OHM,5%,0.25W	01121	GB7303
A12R1116	315-0391-00		RES., FXD, CMPSN: 390 OHM, 5%, 0.25W	01121	
A12R1117	315-0750-00		RES., FXD, CMPSN: 75 OHM, 5%, 0.25W	01121	CB7505
A12R1118	315-0101-00		RES., FXD, CMPSN: 100 OHM, 5%, 0.25W	01121	
A12R1119	315-0750-00		RES., FXD, CMPSN: 75 OHM, 5%, 0.25W	01121	CB7505
A12R1120	321-0193-00		RES., FXD, FILM: 1K OHM, 1%, 0.125W	91637	
A12R1121	315-0101-00		RES., FXD, CMPSN: 100 OHM, 5%, 0.25W	01121	CB1015
A12R1122	307-0489-00		RES, NTWK, FXD, FI:100 OHM, 20%, 1W	32997	4308R-101-101
A12R1123	315-0510-00		RES., FXD, CMPSN:51 OHM, 5%, 0.25W	01121	CB5105
A12R1124	315-0201-00		RES.,FXD,CMPSN:200 OHM,5%,0.25W	01121	CB2015

		Tektronix	Serial/Model No.		Mfr	
	Component No.	Part No.	Eff Dscont	Name & Description		Mfr Part Number
		321-0236-00		RES.,FXD,FILM:2.8K OHM,1%,0.125W	91637	MFF1816G28000F
	A12R1125 A12R1126	321-0251-00		RES., FXD, FILM: 4.02K OHM, 1%, 0.125W	91637	
	A12R1127	315-0751-00		RES., FXD, CMPSN: 750 OHM, 5%, 0.25W	01121	CB7515
	A12R1128	315-0101-00		RES., FXD, CMPSN:100 OHM, 5%, 0.25W		CB1015
	A12R1130	315-0431-00		RES., FXD, CMPSN: 100 OHM, 5%, 0.25W	01121	CB4315
		315-0620-00		4 [10] [14] [16] [16] [16] [16] [16] [16] [16] [16		CB6205
	A12R1131	313-0020-00		RES., FXD, CMPSN: 62 OHM, 5%, 0.25W	01121	CB0203
	A12R1132	315-0620-00		RES., FXD, CMPSN: 62 OHM, 5%, 0.25W	01121	CB6205
	A12R1133	315-0620-00		RES., FXD, CMPSN:62 OHM, 5%, 0.25W	01121	CB6205
	A12R1140	315-0102-00		RES., FXD, CMPSN:1K OHM, 5%, 0.25W	01121	CB1025
	A12R1200	315-0302-00		RES., FXD, CMPSN: 3K OHM, 5%, 0.25W	01121	CB3025
	A12R1201	321-0236-00		RES., FXD, FILM: 2.8K OHM, 1%, 0.125W	91637	MFF1816G28000F
	A12R1202	315-0201-00		RES., FXD, CMPSN: 200 OHM, 5%, 0.25W	01121	CB2015
					01101	cm1015
	A12R12O3	315-0101-00		RES., FXD, CMPSN: 100 OHM, 5%, 0.25W	01121	CB1015
٠	A12R1204	315-0510-00		RES., FXD, CMPSN: 51 OHM, 5%, 0.25W	01121	CB5105
	A12R1205	321-0251-00		RES., FXD, FILM: 4.02K OHM, 1%, 0.125W	91637	
	A12R1206	321-0235-00		RES., FXD, FILM: 2.74K OHM, 1%, 0.125W	91637	MFF1816G27400F
	A12R1207	321-0173-00		RES., FXD, FILM: 619 OHM, 1%, 0.125W	91637	
	A12R1208	315-0470-00		RES., FXD, CMPSN: 47 OHM, 5%, 0.25W	01121	CB4705
	A12R1209	315-0470-00		RES., FXD, CMPSN: 47 OHM, 5%, 0.25W	01121	CB4705
	A12R1211	321-0193-00		RES., FXD, FILM: 1K OHM, 1%, 0.125W	91637	MFF1816G10000F
	A12R1212	315-0271-00		RES., FXD, CMPSN: 270 OHM, 5%, 0.25W	01121	CB2715
	A12R1213	321-0256-00		RES., FXD, FILM: 4.53K OHM, 1%, 0.125W	91637	MFF1816G45300F
	A12R1214	321-0203-00		RES., FXD, FILM: 1.27K OHM, 1%, 0.125W	91637	MFF1816G12700F
	A12R1215	321-0010-00		RES., FXD, FILM:12.4 OHM, 1%, 0.125W	91637	MFF1816G12R40F
	MILMILIA					
	A12R1216	321-0068-00		RES., FXD, FILM: 49.9 OHM, 1%, 0.125W	91637	MFF1816G49R90F
	A12R1217	321-0085-00		RES., FXD, FILM: 75 OHM, 1%, 0.125W	91637	MFF1816G75R00F
	A12R1218	321-0193-00		RES., FXD, FILM: 1K OHM, 1%, 0.125W	91637	MFF1816G10000F
	A12R1220	321-0193-00		RES., FXD, FILM: 1K OHM, 1%, 0.125W	91637	MFF1816G10000F
	A12R1221	315-0620-00		RES. FXD, CMPSN: 62 OHM, 5%, 0.25W	01121	CB6205
	A12R1222	315-0302-00		RES., FXD, CMPSN: 3K OHM, 5%, 0.25W	01121	CB3025
	A12D1222	321-0235-00		RES.,FXD,CMPSN:3K OHM,5%,0.25W RES.,FXD,FILM:2.74K OHM,1%,0.125W RES.,FXD,FILM:619 OHM,1%,0.125W RES.,FXD,CMPSN:47 OHM,5%,0.25W	91637	MFF1816G27400F
	A12R1223	321-0173-00	:///	DEC PVD PILM-619 OUM 17 0 125W	91637	MFF1816G619R0F
	A12R1224	315-0470-00	Stip.	DEC FYD CMDCN-47 OHM 5% 0 25W	01121	CB4705
	A12R1225	315-0470-00	//-	RES., FXD, CMPSN: 47 OHM, 5%, 0.25W	01121	CB4705
	A12R1226	321-0256-00		RES., FXD, FILM: 4.53K OHM, 1%, 0.125W	91637	MFF1816G45300F
	A12R1230 A12R1231	321-0203-00		RES., FXD, FILM:1.27K OHM, 1%, 0.125W	91637	MFF1816G12700F
	AIZRIZJI	321-0203-00		Abbi, Tab, Tibilitiera Olai, Ta, Olii,	,,,,,	
	A12R1233	321-0068-00		RES., FXD, FILM: 49.9 OHM, 1%, 0.125W	91637	MFF1816G49R90F
	A12R1234	321-0010-00		RES., FXD, FILM: 12.4 OHM, 1%, 0.125W	91637	
	A12R1300	315-0101-00		RES., FXD, CMPSN: 100 OHM, 5%, 0.25W	01121	CB1015
	A12R1301	321-0097-00		RES., FXD, FILM: 100 OHM, 1%, 0.125W	91637	MFF1816G100R0F
	A12R1302	315-0470-00		RES., FXD, CMPSN: 47 OHM, 5%, 0.25W	01121	CB4705
	A12R1303	315-0470-00		RES., FXD, CMPSN: 47 OHM, 5%, 0.25W	01121	CB4705
	A12R1304	321-0097-00		RES., FXD, FILM: 100 OHM, 1%, 0.125W	91637	MFF1816G100R0F
	A12R1305	321-0173-00		RES., FXD, FILM:619 OHM, 1%, 0.125W	91637	MFF1816G619R0F
	A12R1306	321-0235-00		RES., FXD, FILM: 2.74K OHM, 1%, 0.125W	91637	MFF1816G27400F
		321-0233-00		RES., FXD, FILM: 1.4K OHM, 12, 0.125W	91637	MFF1816G14000F
	A12R1307			RES., FXD, FILM: 1K OHM, 1%, 0.125W	91637	MFF1816G10000F
	A12R1308	321-0193-00		RES., FXD, FILM: 18 OHM, 12, 0.125W	91637	MFF1816G267R0F
	A12R1309	321-0138-00		RES., FAD, FILM. 207 OHM, 1%, 0.125W	,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,	111101002071101
	A12R1313	321-0068-00		RES., FXD, FILM: 49.9 OHM, 1%, 0.125W	91637	MFF1816G49R90F
	A12R1314	315-0302-00		RES., FXD, CMPSN: 3K OHM, 5%, 0.25W	01121	CB3025
	A12R1315	315-0302-00		RES.,FXD,CMPSN:3K OHM,5%,0.25W	01121	CB3025
	A12R1316	321-0239-00		RES., FXD, FILM: 3.01K OHM, 12, 0.125W	91637	MFF1816G30100F
	A12R1317	321-0239-00		RES., FXD, FILM: 3.01K OHM, 1%, 0.125W	91637	MFF1816G30100F
	A12R1318	315-0102-00		RES.,FXD,CMPSN:1K OHM,5%,0.25W	01121	CB1025
	A1201210	315-0101-00		RES., FXD, CMPSN: 100 OHM, 5%, 0.25W	01121	CB1015
	A12R1319	321-0097-00		RES., FXD, FILM: 100 OHM, 1%, 0.125W	91637	MFF1816G100R0F
	A12R1320			RES., FXD, CMPSN:47 OHM, 5%, 0.25W	01121	CB4705
	A12R1321	315-0470-00		mo., rab, on on. 47 onn, 78, 0.23	01121	204103

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Component No	Tektronix	Serial/Model No. Eff Dscont	Nama & Description	Mfr	Mir Dort Number
Component No.	Part No.	Eff Dscont	Name & Description	Code	Mfr Part Number
A12R1322	315-0470-00		RES., FXD, CMPSN: 47 OHM, 5%, 0.25W	01121	CB4705
A12R1323	321-0097-00		RES., FXD, FILM: 100 OHM, 1%, 0.125W	91637	
A12R1324	321-0173-00		RES., FXD, FILM: 619 OHM, 1%, 0.125W		MFF1816G619R0F
A12R1325	321-0235-00		RES., FXD, FILM: 2.74K OHM, 1%, 0.125W	91637	
A12R1326 A12R1327	321-0207-00 321-0193-00		RES.,FXD,FILM:1.4K OHM,1%,0.125W RES.,FXD,FILM:1K OHM,1%,0.125W	91637 91637	
A12R1327	321-0193-00		RES., PRE, PIEM. IN ORM, 18, 0.125W	31037	MITTOTOGIOUUT
A12R1328	321-0138-00		RES., FXD, FILM: 267 OHM, 1%, 0.125W	91637	MFF1816G267R0F
A12R1329	315-0101-00		RES., FXD, CMPSN: 100 OHM, 5%, 0.25W	01121	CB1015
A12R1331	315-0271-00		RES., FXD, CMPSN: 270 OHM, 5%, 0.25W	01121	
A12R1332	321-0068-00		RES., FXD, FILM: 49.9 OHM, 1%, 0.125W		MFF1816G49R90F
A12R1333	315-0302-00		RES., FXD, CMPSN: 3K OHM, 5%, 0.25W	01121 01121	
A12R1334	315-0302-00		RES.,FXD,CMPSN:3K OHM,5%,0.25W	01121	CB3023
A12R1335	321-0239-00		RES., FXD, FILM: 3.01K OHM, 1%, 0.125W	91637	MFF1816G30100F
A12R1336	321-0239-00		RES., FXD, FILM: 3.01K OHM, 1%, 0.125W	91637	MFF1816G30100F
A12R1337	315-0102-00		RES., FXD, CMPSN: 1K OHM, 5%, 0.25W	01121	CB1025
A12R1339	315-0101-00		RES., FXD, CMPSN: 100 OHM, 5%, 0.25W	01121	
A12R1400	321-0259-00		RES., FXD, FILM: 4.87K OHM, 1%, 0.125W	91637	
A12R1401	321-0186-00		RES.,FXD,FILM:845 OHM,1%,0.125W	91637	MFF1816G845R0F
A12R1402	315-0510-00		RES., FXD, CMPSN:51 OHM, 5%, 0.25W	01121	СВ5105
A12R1403	315-0510-00		RES., FXD, CMPSN:51 OHM, 5%, 0.25W		CB5105
A12R1404	315-0103-00		RES., FXD, CMPSN: 10K OHM, 5%, 0.25W	01121	CB1035
A12R1405	317-0150-00		RES., FXD, CMPSN: 15 OHM, 5%, 0.125W	01121	BB1505
A12R1406	317-0150-00		RES., FXD, CMPSN: 15 OHM, 5%, 0.125W		BB1505
A12R1407	307-0488-00		RES,NTWK,FXD,FI:100 OHM,20%,0.75W	01121	206A101
A12R1408	315-0470-00		RES., FXD, CMPSNa47 OHM, 5%, 0.25W	01121	CB4705
A12R1409	315-0470-00		RES., FXD, CMPSN: 47 OHM, 5%, 0.25W		CB4705
A12R1411	315-0101-00		RES., FXD, CMPSN: 100 OHM, 5%, 0.25W	01121	CB1015
A12R1412	315-0101-00		RES., FXD, CMPSN: 100 OHM, 5%, 0.25W	01121	CB1015
A12R1413	315-0102-00		RES. EXD, CMPSN: 1K OHM, 5%, 0.25W	01121	CB1025
A12R1417	307-0514-00		RES., FXD, FILM: 27 OHM, 1%, 0.075W	52262	MCRA270FYZ
A12R1420	321-0186-00	.1.0	RES., FXD, FILM: 27 OHM, 1%, 0.075W RES., FXD, FILM: 845 OHM, 1%, 0.125W RES., FXD, CMPSN: 51 OHM, 5%, 0.25W RES., FXD, CMPSN: 51 OHM, 5%, 0.25W	91637	MFF1816G845R0F
A12R1421	315-0510-00		RES. FXD CMPSN:51 OHM 5% 0.25W		CB5105
A12R1422	315-0510-00	Hill	RES., FXD, CMPSN: 51 OHM, 5%, 0.25W		CB5105
A12R1423	321-0259-00		RES., FXD, FILM: 4.87K OHM, 1%, 0.125W	91637	MFF1816G48700F
A12R1424	315-0103-00		RES., FXD, CMPSN: 10K OHM, 5%, 0.25W	01121	CB1035
A12R1425	317-0150-00		RES.,FXD,CMPSN:15 OHM,5%,0.125W	01121	BB1505
A1201/26	317-0150-00		RES., FXD, CMPSN:15 OHM, 5%, 0.125W	01121	BB1505
A12R1426 A12R1427	307-0488-00		RES, NTWK, FXD, FI:100 OHM, 20%, 0.75W	01121	
A12R1428	315-0470-00		RES., FXD, CMPSN: 47 OHM, 5%, 0.25W		CB4705
A12R1429	315-0470-00		RES., FXD, CMPSN: 47 OHM, 5%, 0.25W		CB4705
A12R1432	315-0101-00		RES., FXD, CMPSN: 100 OHM, 5%, 0.25W		CB1015
A12R1433	315-0101-00		RES., FXD, CMPSN: 100 OHM, 5%, 0.25W		CB1015
410D1/21	215 0100 00		DEC. BYD OWNER, IV OWN ES A ACT.	01101	CB1025
A12R1434	315-0102-00		RES., FXD, CMPSN:1K OHM, 5%, 0.25W		CB1025
A12R1438 A12R1500	307-0514-00		RES., FXD, FILM: 27 OHM, 1%, 0.075W RES., FXD, FILM: 1.15K OHM, 1%, 0.125W	91637	MCRA270FYZ MFF1816G11500F
A12R1500 A12R1501	321-0199-00 321-0256-00		RES., FXD, FILM:1.13K OHM, 12,0.125W		MFF1816G45300F
A12R1502	315-0203-00		RES., FXD, CMPSN: 20K OHM, 5%, 0.25W	01121	CB2035
A12R1503	315-0510-00		RES., FXD, CMPSN:51 OHM, 5%, 0.25W	01121	CB5105
	201 212:		AND	A	NA/D100/ P
A12R1504	321-0481-00		RES., FXD, FILM: 1M OHM, 1%, 0.125W		NA4D1004F
A12R1506	317-0361-00		RES., FXD, CMPSN: 360 OHM, 5%, 0.125W	01121	BB3615 BB1115
A12R1507	317-0111-00		RES., FXD, CMPSN:110 OHM, 5%, 0.125W	01121	BB5645
A12R1510 A12R1511	317-0564-00 321-0068-00		RES., FXD, CMPSN: 560K OHM, 5%, 0.125W RES., FXD, FILM: 49.9 OHM, 1%, 0.125W		MFF1816G49R90F
A12R1511	315-0103-00		RES., FXD, CMPSN:10K OHM, 5%, 0.25W	01121	CB1035
A12R1514	323-0107-00		RES., FXD, FILM: 127 OHM, 1%, 0.50W	75042	
A12R1515	323-0107-00		RES., FXD, FILM: 127 OHM, 1%, 0.50W	75042 03888	CECTO-1270F
A12R1516	307-0734-00		RES., FXD, FILM: 200 OHM, 1%, 0.5W	03000	PCWT200X235

	Component No.	Tektronix Part No.	Serial/Model No. Eff Dscont	Name & Description	Mfr Code	Mfr Part Number
		Delete State Sp. 500	LII DOCUIR		r, 5011 (454 755)	
	A12R1520	321-0199-00		RES., FXD, FILM: 1.15K OHM, 1%, 0.125W	91637	MFF1816G11500F
	A12R1521	321-0256-00		RES., FXD, FILM: 4.53K OHM, 1%, 0.125W	91637	MFF1816G45300F
	A12R1522	315-0203-00		RES., FXD, CMPSN: 20K OHM, 5%, 0.25W	01121	
	A12R1523	315-0510-00		RES., FXD, CMPSN: 51 OHM, 5%, 0.25W	01121	
	A12R1524	321-0068-00		RES., FXD, FILM: 49.9 OHM, 1%, 0.125W	91637	
	A12R1525	315-0103-00		RES., FXD, CMPSN: 10K OHM, 5%, 0.25W	01121	CB1035
	A12R1526	323-0107-00		RES., FXD, FILM: 127 OHM, 1%, 0.50W	75042	CECTO-1270F
	A12R1527	323-0107-00		RES., FXD, FILM: 127 OHM, 1%, 0.50W	75042	CECTO-1270F
	A12R1528	307-0734-00		RES., FXD, FILM: 200 OHM, 1%, 0.5W	03888	PCWT200X235
	A12R1530	317-0564-00		RES., FXD, CMPSN: 560K OHM, 5%, 0.125W	01121	BB5645
	A12R1531	321-0481-00		RES., FXD, FILM: 1M OHM, 1%, 0.125W	24546	NA4D1004F
	A12R1535	317-0111-00		RES.,FXD,CMPSN:110 OHM,5%,0.125W	01121	BB1115
	A12R1536	317-0361-00		RES., FXD, CMPSN: 360 OHM, 5%, 0.125W	01121	BB3615
	A12R1601	315-0105-00		RES., FXD, CMPSN: 1M OHM, 5%, 0.25W		CB1055
•	A12R1610	315-0390-00		RES., FXD, CMPSN: 39 OHM, 5%, 0.25W	01121	CB3905
	A12R1611	307-0733-00		RES., FXD, FILM:25 OHM, 1%, 0.5W		PCWT200X235
	A12R1612	315-0394-00		RES., FXD, CMPSN: 390K OHM, 5%, 0.25W		CB3945
	A12R1620	315-0394-00		RES., FXD, CMPSN: 390K OHM, 5%, 0.25W		CB3945
		215 2125 22		DEC. THE CHECK-IN OUR ST 0 250	01121	CB1055
	A12R1631	315-0105-00		RES., FXD, CMPSN: 1M OHM, 5%, 0.25W	01121	CB3905
	A12R1632	315-0390-00		RES., FXD, CMPSN: 39 OHM, 5%, 0.25W		
	A12T1410	120-0286-00		XFMR, TOROID: 2 TURNS, BIFILAR	80009	120-0286-00
	A12T1430	120-0286-00		XFMR, TOROID: 2 TURNS, BIFILAR	80009	120-0286-00
	A12TP1020	214-0579-00		TERM, TEST POINT: BRS CD PL	80009	214-0579-00
	A12TP1310	214-0579-00		TERM, TEST POINT: BRS CD PL	80009	214-0579-00
	A12TP1330	214-0579-00		TERM, TEST POINT: BRS CD PL	80009	214-0579-00
	A12U1000	156-1031-00		MICROCIRCUIT, DI:TRIPLE D FLIPFLOP	07263	F100131FC
	A12U1001	156-1032-00		MICROCIRCUIT, DI: QUINT 2 OR/NOR	80009	156-1032-00
	A12U1011	156-1031-00		MICROCIRCUIT, DI:TRIPLE D FLIPFLOP	07263	F100131FC
	A12U1020	156-1449-00		MICROCIRCUIT, DI: DIVIDE BY 80 150MHZ	52648	SP8627DG
	A12U1021	156-0124-00		MICROCIRCUIT, DI:SGL FREQ/PHASE DETECTOR	80009	156-0124-00
	A12U1022	156-1031-00	.///	MICROCIRCUIT, DI:TRIPLE D FLIPFLOP	07263	F100131FC
	A1201022	156-0158-00	·~://	MICROCIRCUIT, LI: DUAL OPERATIONAL AMPLIFIER	18324	MC1458V
	A12U1110	156-1032-00	Nith N	MICROCIRCUIT, DI:QUINT 2 OR/NOR	80009	156-1032-00
	A12U1200	156-0796-00	*\	MICROCIRCUIT, DI:8 STG SHF & STORE BUS RGTR	80009	156-0796-00
	A12U1202	156-0158-00		MICROCIRCUIT, LI: DUAL OPERATIONAL AMPLIFIER	18324	
	A12U1210	156-0494-00		MICROCIRCUIT, DI: HEX INVERTER/BUFFER	80009	156-0494-00
		155 0052 00		MADOCIDOUS IT UTOU CHEED COUNTY TRICCED	80009	155-0253-00
	A12U1310	155-0253-00		MICROCIRCUIT, LI: HIGH SPEED SCHMITT TRIGGER	80009	
	A12U1311	155-0078-10		MICROCIRCUIT, LI:ML, VERTICAL AMPLIFIER	80009	155-0078-10
	A12U1330	155-0253-00		MICROCIRCUIT, LI:HIGH SPEED SCHMITT TRIGGER	80009	155-0253-00
	A12U1331	155-0078-10		MICROCIRCUIT, LI:ML, VERTICAL AMPLIFIER		155-0078-10
	A12VR1412	152-0693-00		SEMICOND DEVICE: ZENER, 0.4W, 4V, 5%	80009 80009	152-0693-00
	A12VR1413	152-0693-00		SEMICOND DEVICE: ZENER, 0.4w, 4v, 5%	80009	152-0693-00
	A12VR1432	152-0693-00		SEMICOND DEVICE: ZENER, 0.4W, 4V, 5%	80009	152-0693-00
	A12VR1433	152-0693-00		SEMICOND DEVICE: ZENER, 0.4W, 4V, 5%	80009	152-0693-00

	Tektronix	Serial/Model No.		Mfr	
Component No.	Part No.	Eff Dscont	Name & Description	Code	Mfr Part Number
A16			CKT BOARD ASSY:DIGITAL	-	
A16C1020	290-0776-00		CAP., FXD, ELCTLT: 22UF, +50-10%, 10V	55680	10ULA22V-T
A16C1021	281-0775-00		CAP., FXD, CER DI:0.1UF, 20%, 50V	72982	8005D9AABZ5U104M
A16C1022	290-0746-00		CAP., FXD, ELCTLT: 47UF, +50-10%, 16V	55680	16U-47V-T
A16C1023	281-0775-00		CAP., FXD, CER DI:0.1UF, 20%, 50V	72982	8005D9AABZ5U104M
A16C1101	281-0775-00		CAP., FXD, CER DI:0.1UF, 20%, 50V	72982	8005D9AABZ5U104M
41601101	281-0775-00		CAR PUR CER DI O THE 20% FOU	72002	9005D0AAB75H106M
A16C1121 A16C1201	290-0755-00		CAP.,FXD,CER DI:0.1UF,20%,50V CAP.,FXD,ELCTLT:100UF,+50-10%,10V	72982 56289	8005D9AABZ5U104M 502D223
A16C1211	281-0775-00		CAP., FXD, CER DI:0.1UF, 20%, 50V	72982	8005D9AABZ5U104M
A16C1401	281-0775-00		CAP., FXD, CER DI:0.10F, 20%, 50V	72982	8005D9AABZ5U104M
A16C1501	281-0775-00		CAP., FXD, CER DI:0.1UF, 20%, 50V	72982	8005D9AABZ5U104M
A16C1520	281-0773-00		CAP., FXD, CER DI:0.01UF, 10%, 100V	04222	GC70-1C103K
	775 7017 12		,		
A16C1601	281-0811-00		CAP., FXD, CER DI:10PF, 10%, 100V	72982	8035D2AADC1G100K
A16C1610	281-0775-00		CAP., FXD, CER DI:0.1UF, 20%, 50V	72982	8005D9AAB25U104M
A16C1621	281-0812-00		CAP., FXD, CER DI:1000PF, 10%, 100V	72982	8035D9AADX7R102K
A16C1721	281-0773-00		CAP.,FXD,CER DI:0.01UF,10%,100V	04222	GC70-1C103K
A16C1722	290-0776-00		CAP., FXD, ELCTLT: 22UF, +50-10%, 10V	55680	10ULA22V-T
A16C1723	281-0775-00		CAP., FXD, CER DI:0.1UF, 20%, 50V	72982	8005D9AABZ5U104M
A16C1801	281-0775-00		CAP., FXD, CER DI:0.1UF, 20%, 50V	72982	8005D9AABZ5U104M
A16C1810	290-0745-00		CAP., FXD, ELCTLT: 22UF, +50-10%, 25V	56289	502D225
A16CR1001	152-0141-02		SEMICOND DEVICE: SILICON, 30V, 150MA	01295	1N4152R
A16CR1010	152-0141-02		SEMICOND DEVICE: SILICON, 30V, 150MA	01295	1N4152R
A16CR1020	152-0141-02		SEMICOND DEVICE: SILICON, 30V, 150MA	01295	1N4152R
A16CR1620	152-0141-02		SEMICOND DEVICE: SILICON, 30V, 150MA	01295	1N4152R
	150 0066 00		SEMICOND DEVICESSILICON, 400V, 750MA	1//22	10/01/
A16CR1720	152-0066-00		SEMICOND DEVICE:SILICON, 400V, 750MA SEMICOND DEVICE:SILICON, 400V, 750MA	14433 14433	
A16CR1721	152-0066-00		FUSE, CARTRIDGE: 3AG, 0.75A, 250V, FAST-BLOW	71400	AGC 3/4
A16F1820 A16F1821	159-0042-00 159-0015-00		FUSE, CARTRIDGE: 3AG, 3A, 250V, FAST-BLOW	71400	AGC 3/4
A16J1001	131-1632-00		CONNECTOR, RCPT, : CKT CD MTG, 20CONTACT, FEM	22526	65001-025
A16J1210	131-2132-01		CONN, RCPT, ELEC: HEADER, 1 X 36,01 CTR	22526	65506-436
			2 No. 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1	22526	65506 126
A16J1211	131-2132-01	\\\	CONN, RCPT, ELEC: HEADER, 1 X 36,01 CTR	22526 80009	65506-436 108-0473-00
A16L1020 A16Q1701	108-0473-00 151-0188-00	194	COIL, RF: 150UH TRANSISTOR: SILICON, PNP	04713	SPS6868K
A16Q1701	151-0188-00	//-	TRANSISTOR: SILICON, PNP	04713	SPS6868K
A16Q1703	151-0188-00		TRANSISTOR: SILICON, PNP	04713	
A16Q1704	151-0188-00		TRANSISTOR: SILICON, PNP	04713	SPS6868K
200					500000
A16Q1720	151-0190-00		TRANSISTOR: SILICON, NPN	07263	S032677
A16Q1721	151-0432-00		TRANSISTOR: SILICON, NPN	80009	151-0432-00
A16Q1722	151-0453-00		TRANSISTOR: SILICON, PNP	80009	151-0453-00
A16Q1723	151-0453-00 315-0200-00		TRANSISTOR: SILICON, PNP	80009	151-0453-00 CB2005
A16R1001 A16R1002	315-0200-00		RES.,FXD,CMPSN:20 OHM,5%,0.25W RES.,FXD,CMPSN:20 OHM,5%,0.25W		CB2005
ATORTOOZ	313 0200 00		Rub., FRD, OH BH. 20 OH, 5%, 0.25%	01121	002003
A16R1003	307-0106-00		RES.,FXD,CMPSN:4.7 OHM,5%,0.25W	01121	CB47G5
A16R1004	315-0200-00		RES., FXD, CMPSN: 20 OHM, 5%, 0.25W	01121	CB2005
A16R1005	315-0200-00		RES., FXD, CMPSN: 20 OHM, 5%, 0.25W	01121	CB2005
A16R1006	315-0200-00		RES., FXD, CMPSN: 20 OHM, 5%, 0.25W	01121	CB2005
A16R1007	315-0200-00		RES., FXD, CMPSN: 20 OHM, 5%, 0.25W		CB2005
A16R1008	315-0200-00		RES., FXD, CMPSN: 20 OHM, 5%, 0.25W	01121	CB2005
A16R1009	315-0200-00		RES., FXD, CMPSN: 20 OHM, 5%, 0.25W	01121	CB2005
A16R1010	315-0100-00		RES., FXD, CMPSN:10 OHM, 5%, 0.25W	01121	CB1005
A16R1011	315-0100-00		RES., FXD, CMPSN:10 OHM, 5%, 0.25W	01121	CB1005
A16R1012	315-0100-00		RES., FXD, CMPSN:10 OHM, 5%, 0.25W	01121	CB1005
A16R1013	315-0100-00		RES., FXD, CMPSN:10 OHM, 5%, 0.25W	01121	CB1005
A16R1014	307-0675-00		RES NTWK, FXD, F1:9,1K OHM, 2%, 1.25W	01121	210A102
A1601021	315-0103-00		DEC PYD CMBCN-1V OUM 57 O 25U	01121	CR1025
A16R1021 A16R1022	315-0102-00 315-0222-00		RES.,FXD,CMPSN:1K OHM,5%,0.25W RES.,FXD,CMPSN:2.2K OHM,5%,0.25W	01121	CB1025 CB2225
A16R1103	315-0105-00		RES., FXD, CMPSN:1M OHM, 5%, 0.25W		CB1055
	217 0107 00				· 조금(쿠 중 조건)

	T -1.4	0-1-1/11-1-1			
Component No	Tektronix	Serial/Model No.	Nama & Description	Mfr	Mfr Cart Number
Component No.	Part No.	Eff Dscont	Name & Description	Code	Mfr Part Number
A16R1201	321-0311-00		RES., FXD, FILM: 16.9K OHM, 1%, 0.125W		MFF1816G16901F
A16R1202	321-0318-00		RES., FXD, FILM: 20K OHM, 1%, 0.125W		MFF1816G20001F
A16R1203	321-0275-00		RES., FXD, FILM: 7.15K OHM, 12, 0.125W	91637	MFF1816G71500F
A16R1204	321-0275-00		RES., FXD, FILM: 7.15K OHM, 1%, 0.125W	91637	MFF1816G71500F
A16R1205	315-0102-00		RES., FXD, CMPSN: 1K OHM, 5%, 0.25W	01121	CB1025
A16R1206	315-0103-00		RES., FXD, CMPSN: 10K OHM, 5%, 0.25W	01121	CB1035
			DEC. THE CHECK LOW COM ES O OFFI	01121	CB1025
A16R1207	315-0103-00		RES., FXD, CMPSN:10K OHM, 5%, 0.25W		CB1035
A16R1208	315-0103-00		RES., FXD, CMPSN:10K OHM, 5%, 0.25W		CB1035 CB1035
A16R1209	315-0103-00		RES., FXD, CMPSN:10K OHM, 5%, 0.25W		MSP10A01-103M
A16R1210	307-0446-00		RES, NTWK, FXD FI:10K OHM, 20%, (9) RES		CB1025
A16R1220	315-0102-00		RES., FXD, CMPSN: 1K OHM, 5%, 0.25W	01121	
A16R1301	315-0103-00		RES.,FXD,CMPSN:10K OHM,5%,0.25W	01121	CBIOSS
A16R1420	307-0446-00		RES,NTWK,FXD FI:10K OHM,20%,(9) RES	91637	MSP10A01-103M
A16R1520	315-0393-00		RES., FXD, CMPSN: 39K OHM, 5%, 0.25W	01121	CB3935
A16R1521	315-0104-00		RES., FXD, CMPSN: 100K OHM, 5%, 0.25W	01121	CB1045
A16R1601	315-0303-00		RES., FXD, CMPSN: 30K OHM, 5%, 0.25W	01121	CB3035
A16R1620	315-0362-00		RES., FXD, CMPSN: 3.6K OHM, 5%, 0.25W	01121	CB3625
A16R1621	315-0272-00.		RES., FXD, CMPSN: 2.7K OHM, 5%, 0.25W	01121	CB2725
			territorio participa dispresanti producento accompanione		
A16R1622	315-0202-00		RES., FXD, CMPSN: 2K OHM, 5%, 0.25W		CB2025
A16R1701	315-0560-00		RES., FXD, CMPSN: 56 OHM, 5%, 0.25W		CB5605
A16R1702	315-0560-00		RES., FXD, CMPSN: 56 OHM, 5%, 0.25W		CB5605
A16R1703	307-0541-00		RES, NTWK, THK FI: (7)1K OHM, 10%, 1W		MSP08A01-102G
A16R1710	315-0132-00		RES., FXD, CMPSN: 1.3K OHM, 5%, 0.25W		CB1325
A16R1711	315-0132-00		RES., FXD, CMPSN:1.3K OHM, 5%, 0.25W	01121	CB1325
A16R1712	315-0362-00		RES.,FXD,CMPSN33.6K OHM,5%,0.25W	01121	CB3625
A16R1713	315-0132-00		RES., FXD, CMPSN: 1.3K OHM, 5%, 0.25W		CB1325
A16R1714	315-0132-00		RES., FXD, CMPSN: 1.3K OHM, 5%, 0.25W		CB1325
A16R1715	315-0132-00		RES., FXD, CMPSN: 1.3K OHM, 5%, 0.25W		CB1325
A16R1716	315-0201-00		RES . FXD, CMPSN: 200 OHM, 5%, 0.25W		CB2015
A16R1717	315-0201-00				CB2015
			RES., FXD, CMPSN: 200 OHM, 5%, 0.25W RES., FXD, WW: 1 OHM, 5%, 2W RES., FXD, CMPSN: 1K OHM, 5%, 0.25W RES., FXD, CMPSN: 100 OHM, 5%, 0.25W	750/0	PLUI - 1 POOO 1
A16R1718	308-0677-00	.///.	RES., FXD, WW:1 OHM, 5%, 2W		BWH-1R000J
A16R1719	315-0102-00	: 11/2	RES., FXD, CMPSN: 1K OHM, 5%, 0.25W		CB1025
A16R1720	315-0101-00	Ke			CB1015
A16R1721	315-0152-00		RES., FXD, CMPSN: 1.5K OHM, 5%, 0.25W		CB1525
A16R1722	315-0132-00		RES., FXD, CMPSN:1.3K OHM, 5%, 0.25W	01121	
A16R1724	321-0231-00		RES., FXD, FILM: 2.49K OHM, 1%, 0.125W	91037	MFF1816G24900F
A16R1725	321-0231-00		RES., FXD, FILM: 2.49K OHM, 1%, 0.125W	91637	MFF1816G24900F
A16R1726	315-0102-00		RES., FXD, CMPSN:1K OHM, 5%, 0.25W	01121	CB1025
A16R1727	321-0231-00		RES., FXD, FILM: 2.49K OHM, 1%, 0.125W	91637	MFF1816G24900F
A16R1728	308-0244-00		RES., FXD, WW:0.3 OHM, 10%, 2W	91637	RS2B162ER3000K
A16R1820	315-0102-00		RES., FXD, CMPSN: 1K OHM, 5%, 0.25W	01121	CB1025
A16R1821	321-0297-00		RES., FXD, FILM: 12.1K OHM, 1%, 0.125W	91637	MFF1816G12101F
41601212	260-1589-00		SWITCH, PUSH: (6)SPST, 0.1A,5V	00779	435166-4
A16S1210			TERM, TEST POINT: BRS CD PL		214-0579-00
A16TP1410	214-0579-00				214-0579-00
A16TP1411	214-0579-00		TERM, TEST POINT: BRS CD PL		214-0579-00
A16TP1420	214-0579-00		TERM, TEST POINT: BRS CD PL		156-1243-00
A16U1101	156-1243-00		MICROCIRCUIT, DI:BCD-TO-7 SEGMENT DECODER		LM339N
A16U1102	156-0411-00		MICROCIRCUIT, LI: QUAD-COMP, SGL SUPPLY	2/014	Leijjyn
A16U1110	156-1245-00		MICROCIRCUIT, LI:7 XSTR, HV/HIGH CUR		MC1413PDS
A16U1111	156-0391-00		MICROCIRCUIT, DI: HEX LATCH WITH CLEAR		74LS174(N OR J)
A16U1112	156-0391-00		MICROCIRCUIT, DI: HEX LATCH WITH CLEAR		74LS174(N OR J)
A16U1113	156-1172-00		MICROCIRCUIT, DI: DUAL 4 BIT BIN CNTR		156-1172-00
A16U1114	156-0576-00		MICROCIRCUIT, DI:8 BIT PRL INP-SERIAL OUTPT		MC14021BCL
A16U1115	156-0579-00		MICROCIRCUIT, DI: DUAL 4-BIT BIN COUNTER	04713	MC14520BCL
A16U1120	156-0388-00		MICROCIRCUIT, DI: DUAL D-TYPE FLIP-FLOP	80009	156-0388-00
A16U1121	156-0576-00		MICROCIRCUIT, DI: 8 BIT PRL INP-SERIAL OUTPT		MC14021BCL
A16U1122	156-0576-00		MICROCIRCUIT, DI:8 BIT PRL INP-SERIAL OUTPT		MC14021BCL
A1001122	130-0370-00		HILDEROVIE, DIE VER IN UBRING VOILE		

Replaceable Electrical Parts—DC 510

Component No.	Tektronix Part No.	Serial/ Eff	Model No. Dscont	Name & Description	Mfr Code	Mfr Part Number
A16U1210	156-0649-00			MICROCIRCUIT, DI: 3 STATE HEX. NON INVT BFR	80009	156-0649-00
A16U1211	156-0576-00			MICROCIRCUIT, DI:8 BIT PRL INP-SERIAL OUTPT	04713	MC14021BCL
A16U12·12	156-0545-00			MICROCIRCUIT, DI:12-BIT BINARY COUNTER	80009	156-0545-00
A16U1310	156-0649-00			MICROCIRCUIT, DI: 3 STATE HEX. NON INVT BFR	80009	156-0649-00
A16U1311	156-1484-00			MICROCIRCUIT, DI: 256 X 8 SCRM	000ID	35392C
A16U1312	156-0576-00			MICROCIRCUIT, DI:8 BIT PRL INP-SERIAL OUTPT	04713	MC14021BCL
A16U1313	156-0469-00			MICROCIRCUIT, DI: 3-LINE TO 8-LINE DECODER	01295	SN74LS138N
A16U1314	156-0494-00			MICROCIRCUIT, DI: HEX INVERTER/BUFFER	80009	156-0494-00
A16U1410	160-1183-00			MICROCIRCUIT, DI: I/O TIMER, ROM, RAM	34576	R6531P
A16U1420	156-0541-00			MICROCIRCUIT, DI: DECODER/DEMULTIPLEXER	27014	DM74LS139N
A16U1421	156-0382-00			MICROCIRCUIT, DI: QUAD 2-INPUT NAND GATE	01295	SN74LS00(N OR J
A16U1510	156-1482-00			MICROCIRCUIT, DI:8-BIT MICROPRC, 8K ADDRESS	55576	SYP6504
A16U1520	156-0494-00			MICROCIRCUIT, DI:HEX INVERTER/BUFFER	80009	156-0494-00
A16U1610	160-1111-00			MICROCIRCUIT, DI: 4096 X 8 MROM, PRGM	55576	SYP2333
A16U1710	156-0411-00			MICROCIRCUIT, LI: QUAD-COMP, SGL SUPPLY	27014	LM339N
A16U1720	156-0071-00			MICROCIRCUIT, LI: VOLTAGE REGULATOR	04713	MC1723CL
A16U1801	156-0230-00			MICROCIRCUIT, DI: DUAL D MA-SLAVE FLIP-FLOP	80009	156-0230-00
A16U1810	156-0880-00			MICROCIRCUIT, DI: DUAL D MASTER SLAVE FF	80009	156-0880-00
A16W1303	131-0566-00			BUS CONDUCTOR: DUMMY RES, 2.375, 22 AWG	55210	L-2007-1

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	Tektronix	Serial/Model No.		Mfr	
Component No	Part No.	Eff Dscont	Name & Description	1,550,55	Mfr Part Number
Component No.	rait No.	EII DSCOIR	Name & Description	Code	WITH FAIT WUITIDE
A18			CKT BOARD ASSY: AUXILIARY		
A18C1030	290-0745-00		CAP., FXD, ELCTLT: 22UF, +50-10%, 25V	56289	502D225
A18C1031	281-0773-00		CAP., FXD, CER DI:0.01UF, 10%, 100V	04222	GC70-1C103K
A18C1230	281-0773-00		CAP., FXD, CER DI:0.01UF, 10%, 100V	04222	GC70-1C103K
A18C1231	281-0775-00		CAP., FXD, CER DI:0.1UF, 20%, 50V	72982	8005D9AABZ5U104M
A18C1232	281-0775-00		CAP., FXD, CER DI:0.1UF, 20%, 50V	72982	8005D9AABZ5U104M
A18C1300	281-0775-00		CAP., FXD, CER DI:0.1UF, 20%, 50V	72982	8005D9AABZ5U104M
A18C1301	290-0776-00		CAP., FXD, ELCTLT: 22UF, +50-10%, 10V	55680	10ULA22V-T
A18C1310	281-0775-00		CAP., FXD, CER DI:0.1UF, 20%, 50V	72982	8005D9AABZ5U104M
A18C1320	281-0770-00		CAP., FXD, CER DI:0.001UF, 20%, 100V	72982	8035D9AADX5R102M
A18C1321	281-0773-00		CAP., FXD, CER DI:0.01UF, 10%, 100V	04222	GC70-1C103K
A18C1322	290-0776-00		CAP., FXD, ELCTLT: 22UF, +50-10%, 10V	55680	10ULA22V-T
			AND THE CONTRACTOR OF THE CONTRACT OF THE CONT		ADADA KARISTI MITA DI SINDI
A18C1324	290-0782-00		CAP., FXD, ELCTLT: 4.7UF, +75-10%, 35V	55680	35ULA4R7V-T
A18C1330	281-0775-00		CAP., FXD, CER DI:0.1UF, 20%, 50V	72982	8005D9AABZ5U104M
A18C1331	283-0220-00	B010100 B010469	CAP., FXD, CER DI:0.01UF, 20%, 50V	72982	
A18C1331	281-0773-00	B010470	CAP., FXD, CER DI:0.01UF, 10%, 100V	04222	
A18C1332	281-0775-00		CAP., FXD, CER DI:0.1UF, 20%, 50V	72982	
A18C1410	281-0775-00		CAP., FXD, CER DI:0.1UF, 20%, 50V	72982	8005D9AABZ5U104M
A18C1411	281-0773-00		CAP., FXD, CER DI:0.01UF, 10%, 100V	04222	
A18C1413	281-0814-00		CAP., FXD, CER DI:100PF, 10%, 100V	04222	GC70-1-A101K
A18C1420	281-0630-00		CAP., FXD, CER DI:390PF, 5%, 500V	72982	630000Y5D391J
			(STANDARD ONLY)		
A18C1421	281-0775-00		CAP., FXD, CER DI:0.1UF, 20%, 50V	72982	8005D9AABZ5U104M
			(STANDARD ONLY)	1200-1700-1200-1200	
A18C1430	281-0775-00		CAP., FXD, CER DI:0.1UF, 20%, 50V	72982	8005D9AABZ5U1U4M
			(OPTION 01 ONLY)		
			COV.		
A18C1431	281-0775-00		CAP., FXD, CER DI:0.1UF, 20%, 50V	72982	8005D9AABZ5U104M
			(OPTION ON ONLY)		
A18C1510	281-0775-00		CAP., FXD, CER DI:0.1UF, 20%, 50V	72982	8005D9AABZ5U104M
A18C1521	281-0198-00		CAP, VAR, AIR DI:1.7-11PF, 250V	74970	187-0306-105
			(STANDARD ONLY)	50100	
A18C1522	281-0564-00	4	(STANDARD ONLY) (STANDARD ONLY) CAP.,FXD,CER DI:24PF,5%,500V CAP.,FXD,CER DI:390PF,5%,500V	72982	301-000C0G0240J
		.\\	(STANDARD ONLY)		
		istic.		70000	420000VED201 T
A18C1523	281-0630-00	//-	하게 있어서 되어 있다면 하게 되었다면 하게 되었다면 하다 보다 하다 보다 보다 되었다면 하나 보다 되었다.	72982	630000Y5D391J
			(STANDARD ONLY)	14422	104016
A18CR1120	152-0066-00		SEMICOND DEVICE:SILICON,400V,750MA	14433 14433	
A18CR1121	152-0066-00		SEMICOND DEVICE: SILICON, 400V, 750MA	14433	
A18CR1122	152-0066-00		SEMICOND DEVICE: SILICON, 400V, 750MA	14433	
A18CR1123	152-0066-00		SEMICOND DEVICE: SILICON, 400V, 750MA	14433	104010
410cm11c/	150 0000 00		SEMICOND DEVICE: SILICON, 400V, 750MA	14433	LG4016
A18CR1124	152-0066-00		SEMICOND DEVICE: SILICON, 400V, 750MA SEMICOND DEVICE: SILICON, 400V, 750MA		LG4016
A18CR1232	152-0066-00		가는 사람들이 되었다는 그 전 한 것 같아. 나는 내가 있는 데 가게 되었다. 그 얼굴하는 이 불어를 하고 있다.		1N4152R
A18CR1500	152-0141-02		SEMICOND DEVICE: SILICON, 30V, 150MA SEMICOND DEVICE: SILICON, 30V, 150MA		1N4152R
A18CR1510	152-0141-02		SEMICOND DEVICE: SILICON, 30V, 150MA SEMICOND DEVICE: SILICON, 30V, 150MA	01295	1N4152R
A18CR1511	152-0141-02		FUSE, CARTRIDGE: 3AG, 0.75A, 250V, FAST-BLOW	71400	AGC 3/4
A18F1510	159-0042-00		FUSE, CARTRIDGE. JAG, U. / JA, 2304, FAST BLOW	, 1400	
41001511	150-0015-00		FUSE, CARTRIDGE: 3AG, 3A, 250V, FAST-BLOW	71400	AGC 3
A18F1511	159-0015-00 131-1003-00		CONN, RCPT, ELEC: CKT BD MT, 3 PRONG	80009	131-1003-00
A18J1500	131-1857-00		TERM. SET, PIN: 36/0.025 SQ PIN, ON 0.1 CTRS	22526	65500136
A18J1510			TERM. SET, PIN: 36/0.025 SQ PIN, ON 0.1 CTRS	22526	65500136
A18J1511	131-1857-00 131-1857-00		TERM. SET, PIN: 36/0.025 SQ PIN, ON 0.1 CTRS	22526	65500136
A18J1611	108-0245-00		COIL, RF: 3.9UH	76493	B6310-1
A18L1420	100 0243-00				
A18L1421	108-0245-00		COIL, RF: 3.9UH	76493	B6310-1
A18Q1030	151-0342-00		TRANSISTOR: SILICON, PNP	07263	
A18Q1031	151-0341-00		TRANSISTOR: SILICON, NPN	07263	
A18Q1031	151-0335-00		TRANSISTOR: SILICON, PNP	04713	SJE917
A18Q1120	151-0353-00		TRANSISTOR: SILICON, NPN	03508	
A18Q1121	151-0254-00		TRANSISTOR: SILICON, NPN	03508	X38L3118
HINGITEI	0234 00		70 200 20 P. T. T. T. S. S. S. T. T. S.	X 200	
A18Q1300	151-0188-00		TRANSISTOR: SILICON, PNP	04713	SPS6868K
	0.00 00				

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	Tektronix	Serial/Model No.		Mfr	
Component No.	Part No.	Eff Dscont	Name & Description		Mfr Part Number
A18Q1330	151-0190-00		TRANSISTOR: SILICON, NPN	07263	S032677
A18Q1331	151-0342-00		TRANSISTOR: SILICON, PNP	07263	S035928
A18Q1332	151-0462-00		TRANSISTOR: SILICON, PNP	04713	TIP30C
A18Q1333	151-0341-00		TRANSISTOR: SILICON, NPN	07263	S040065
A18Q1401	151-0190-00		TRANSISTOR: SILICON, NPN	07263	S032677
A18Q1420	151-0190-00		TRANSISTOR: SILICON, NPN	07263	S032677
			(STANDARD ONLY)		
A18Q1500	151-0188-00		TRANSISTOR: SILICON, PNP	04713	
A18Q1510	151-0190-00		TRANSISTOR: SILICON, NPN	07263	S032677
A18Q1511	151-0190-00		TRANSISTOR: SILICON, NPN		S032677
A18R1000	315-0101-00		RES., FXD, CMPSN: 100 OHM, 5%, 0.25W		CB1015
A18R1030	315-0301-00		RES., FXD, CMPSN: 300 OHM, 5%, 0.25W		CB3015
A18R1031	315-0512-00		RES.,FXD,CMPSN:5.1K OHM,5%,0.25W	01121	CB5125
A18R1032	315-0121-00		RES., FXD, CMPSN:120 OHM, 5%, 0.25W		CB1215
A18R1033	315-0431-00		RES., FXD, CMPSN: 430 OHM, 5%, 0.25W		CB4315
A18R1100	315-0103-00		RES., FXD, CMPSN:10K OHM, 5%, 0.25W		CB1035
A18R1101	315-0103-00		RES., FXD, CMPSN: 10K OHM, 5%, 0.25W	01121	
A18R1110	321-0229-00		RES., FXD, FILM: 2.37K OHM, 1%, 0.125W	91637	
A18R1111	321-0239-00		RES., FXD, FILM: 3.01K OHM, 1%, 0.125W	91637	MFF1816G30100F
A18R1112	315-0103-00		RES.,FXD,CMPSN:10K OHM,5%,0.25W	01121	CB1035
A18R1113	315-0103-00		RES.,FXD,CMPSN:10K OHM,5%,0.25W	01121	CB1035
A18R1114	321-0229-00		RES., FXD, FILM: 2.37K OHM, 1%, 0.125W	91637	
A18R1115	321-0239-00		RES., FXD, FILM: 3.01K OHM, 1%, 0.125W	91637	
A18R1120	315-0102-00		RES., FXD, CMPSN: 1K OHM, 5%, 0.25W	01121	
A18R1121	315-0102-00		RES., FXD, CMPSN: 1K OHM, 5%, 0.25W	01121	CB1025
A18R1200	321-0197-00		RES., FXD, FILM:1.1K OHM, 1%, 0.125W	91637	MFF1816G11000F
A18R1201	321-0202-00		RES., FXD, FILM: 1.24K OHM, 1%, 0.125W	91637	
A18R1202	321-0197-00		RES., FXD, FILM: 1.1K OHM, 1%, 0.125W		MFF1816G11000F
A18R1203	321-0202-00		RES. FXD, FILM: 1.24K OHM, 1%, 0.125W		MFF1816G12400F
A18R1204	311-1236-00		RES., VAR, NONWIR: 250 OHM, 10%, 0.50W	73138	72-22-0
A18R1205	311-1236-00	http://	RES., VAR, NONWIR: 250 OHM, 10%, 0.50W	73138	72-22-0
A18R1206	311-1236-00	111:0%	RES., VAR, NONWIR: 250 OHM, 10%, 0.50W	73138	72-22-0
A18R1207	311-1236-00	Him	RES., VAR, NONWIR: 250 OHM, 10%, 0.50W	73138	72-22-0
A18R1210	321-0202-00		KES., FAD, FILM: 1.24K OHM, 14, U.123W		MFF1816G12400F
A18R1211	321-0189-00		RES., FXD, FILM: 909 OHM, 1%, 0.125W		MFF1816G909R0F
A18R1212	321-0173-00		RES., FXD, FILM: 619 OHM, 1%, 0.125W	91637	
A18R1213	321-0173-00		RES.,FXD,FILM:619 OHM,1%,0.125W	91637	MFF1816G619R0F
A18R1214	321-0189-00		RES.,FXD,FILM:909 OHM,1%,0.125W	91637	
A18R1215	321-0202-00		RES., FXD, FILM: 1.24K OHM, 1%, 0.125W		MFF1816G12400F
A18R1310	315-0512-00		RES., FXD, CMPSN: 5.1K OHM, 5%, 0.25W	01121	
A18R1311	315-0102-00		RES., FXD, CMPSN:1K OHM, 5%, 0.25W		CB1025
A18R1312	315-0393-00		RES., FXD, CMPSN: 39K OHM, 5%, 0.25W		CB3935
A18R1313	321-0287-00		RES., FXD, FILM: 9.53K OHM, 1%, 0.125W	91637	MFF1816G95300F
A18R1314	321-0231-00		RES., FXD, FILM: 2.49K OHM, 1%, 0.125W	91637	MFF1816G24900F
A18R1315	315-0202-00		RES., FXD, CMPSN: 2K OHM, 5%, 0.25W	01121	CB2025
A18R1321	321-0231-00		RES., FXD, FILM: 2.49K OHM, 1%, 0.125W	91637	
A18R1322	321-0231-00		RES., FXD, FILM: 2.49K OHM, 1%, 0.125W	91637	
A18R1323	315-0202-00		RES., FXD, CMPSN: 2K OHM, 5%, 0.25W	01121	CB2025
A18R1324	315-0202-00		RES.,FXD,CMPSN:2K OHM,5%,0.25W	01121	CB2025
A18R1331	315-0511-00		RES., FXD, CMPSN: 510 OHM, 5%, 0.25W		CB5115
A18R1332	315-0361-00		RES., FXD, CMPSN: 360 OHM, 5%, 0.25W		CB3615
A18R1333	315-0751-00		RES., FXD, CMPSN: 750 OHM, 5%, 0.25W		CB7515
A18R1334	315-0201-00		RES., FXD, CMPSN: 200 OHM, 5%, 0.25W		CB2015
A18R1335	315-0681-00		RES., FXD, CMPSN: 680 OHM, 5%, 0.25W		CB6815
A18R1400	315-0512-00		RES., FXD, CMPSN: 5.1K OHM, 5%, 0.25W	01121	CB5125
A18R1401	315-0102-00		RES., FXD, CMPSN: 1K OHM, 5%, 0.25W	01121	CB1025
A18R1402	315-0121-00		RES., FXD, CMPSN: 120 OHM, 5%, 0.25W	01121	CB1215

7-18

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Component No.	Tektronix Part No.	Serial/Model No. Eff Dscont	Name & Description	Mfr Code	Mfr Part Number
A18R1403	315-0104-00		RES., FXD, CMPSN: 100K OHM, 5%, 0.25W	01121	CB1045
A18R1410	315-0105-00		RES., FXD, CMPSN: 1M OHM, 5%, 0.25W	01121	CB1055
A18R1411	315-0102-00		RES., FXD, CMPSN: 1K OHM, 5%, 0.25W	01121	CB1025
A18R1412	315-0102-00		RES., FXD, CMPSN:1K OHM, 5%, 0.25W		CB1025
A18R1413	315-0101-00		RES., FXD, CMPSN:100 OHM, 5%, 0.25W		CB1015
A18R1414	315-0302-00		RES.,FXD,CMPSN:3K OHM,5%,0.25W		CB3025
A18R1420	315-0152-00		RES.,FXD,CMPSN:1.5K OHM,5%,0.25W	01121	CB1525
A18R1421	315-0102-00		(STANDARD ONLY) RES.,FXD,CMPSN:1K OHM,5%,0.25W (STANDARD ONLY)	01121	CB1025
A18R1424	315-0562-00		RES., FXD, CMPSN: 5.6k OHM, 5%, 0.25W (STANDARD ONLY)	01121	CB5625
(/***			PRO THE 171 1 5 OW 10% 111	750/2	BU20-19500F
A18R1425	308-0058-00		RES., FXD, WW:1.5 OHM, 10%, 1W		BW20-1R500K
A18R1426	308-0742-00		RES., FXD, WW:0.24 OHM, 5%, 2W		BWH-R2400J
A18R1430	321-0213-00		RES.,FXD,FILM:1.62K OHM,1%,0.125W (OPTION 01 ONLY)	91637	MFF1816G16200F
A18R1431	321-0105-00		RES., FXD, FILM:121 OHM, 1%, 0.125W (OPTION 01 ONLY)	91637	MFF1816G121R0F
410n1500	315-0511-00		RES.,FXD,CMPSN:510 OHM,5%,0.25W	01121	CB5115
A18R1500	315-0511-00 315-0181-00		RES., FXD, CMPSN: 180 OHM, 5%, 0.25W		CB1815
A18R1501			RES., FXD, CMPSN:1.1K OHM, 5%, 0.25W		CB1125
A18R1502	315-0112-00		RES., FXD, CMPSN: 2.4K OHM, 5%, 0.25W		CB2425
A18R1503	315-0242-00		RES., FXD, CMPSN: 2.4K OHM, 5%, 0.25W		CB4725
A18R1504 A18R1510	315-0472-00 315-0511-00		RES., FXD, CMPSN: 4.7K Ohm, 5%, 0.25W		CB5115
mourate					
A18R1511	315-0122-00		RES., FXD, CMPSN 1.2K OHM, 5%, 0.25W		CB1225
A18R1512	315-0472-00		RES., FXD, CMPSN: 4.7K OHM, 5%, 0.25W		CB4725
A18R1513	315-0122-00	-	RES., FXD CMPSN: 1.2K OHM, 5%, 0.25W		CB1225
A18R1514	315-0511-00		RES., FXD, CMPSN:510 OHM, 5%, 0.25W		CB5115
A18R1515	315-0511-00		RES PXD, CMPSN:510 OHM, 5%, 0.25W		CB5115
A18R1516	315-0511-00		RES., FXD, CMPSN: 510 OHM, 5%, 0.25W	01121	CB5115
A18R1520	315-0183-00	211:0%	RES.,FXD,CMPSN:18K OHM,5%,0.25W (STANDARD ONLY)	01121	CB1835
A18TP1400	214-0579-00	Kiri	TERM, TEST POINT: BRS CD PL	80009	214-0579-00
A18U1010	156-0796-00		MICROCIRCUIT, DI:8 STG SHF & STORE BUS RGTR	80009	156-0796-00
A18U1020	156-0796-00		MICROCIRCUIT, DI:8 STG SHF & STORE BUS RGTR	80009	156-0796-00
A18U1021	156-1245-00		MICROCIRCUIT, LI:7 XSTR, HV/HIGH CUR	04713	MC1413PDS
41011110	156-1245-00		MICROCIRCUIT, LI:7 XSTR, HV/HIGH CUR	04713	MC1413PDS
A18U1110	156-0411-00		MICROCIRCUIT, LI: QUAD-COMP, SGL SUPPLY		LM339N
A18U1111			MICROCIRCUIT, LI: DUAL OPERATIONAL AMPLIFIER		
A18U1200	156-0158-00		MICROCIRCUIT, LI: DIGITAL TO ANALOG CONVERTER	80009	156-0927-00
A18U1210	156-0927-00		MICROCIRCUIT DI:8 STG SHF & STORE BUS RGTR	80009	156-0796-00
A18U1220 A18U1221	156-0796-00 156-0796-00		MICROCIRCUIT, DI:8 STG SHF & STORE BUS RGTR	80009	
A18U1222	156-0796-00		MICROCIRCUIT, DI:8 STG SHF & STORE BUS RGTR	80009	156-0796-00
A18U1223	156-1173-00		MICROCIRCUIT, LI: VOLTAGE REFERENCE	04713	
A18U1310	156-0927-00		MICROCIRCUIT, LI: DIGITAL TO ANALOG CONVERTER	80009	156-0927-00
A18U1320	156-0071-00		MICROCIRCUIT, LI: VOLTAGE REGULATOR		MC1723CL
A18U1330	156-1150-00		MICROCIRCUIT, LI: VOLTAGE REGULATOR, NEGATIVE		
A18U1400	156-1126-00		MICROCIRCUIT, LI: VOLTAGE COMPARATOR	51984	UPC311C
A18U1410	156-1433-00		MICROCIRCUIT, DI: NOISE SOURCE	27014	MM5837N
A18U1411	156-0656-00		MICROCIRCUIT, DI: DECADE COUNTER		SN74LS90N OR J
A18U1420	156-0071-00		MICROCIRCUIT, LI: VOLTAGE REGULATOR		MC1723CL
A18U1430	156-1161-00		MICROCIRCUIT, LI: VOLTAGE REGULATOR		LM317T
A 1911 500	156-0385-00		(OPTION 01 ONLY) MICROCIRCUIT, DI: HEX. INVERTER	80009	156-0385-00
A18U1500	156-0385-00				
A18VR1001	152-0195-00		SEMICOND DEVICE: ZENER, 0.4W, 5.1V, 5%		SZ11755
A18VR1410	152-0166-00		SEMICOND DEVICE: ZENER, 0.4W, 6.2V, 5%		SZ11738
A18VR1411	152-0166-00		SEMICOND DEVICE: ZENER, 0.4W, 6.2V, 5%	04/13	SZ11738

Replaceable Electrical Parts—DC 510

	Tektronix	Serial/	Model No.		Mfr	
Component No.	Part No.	Eff	Dscont	Name & Description	Code	Mfr Part Number
A18Y1520	158-0129-00			XTAL UNIT, QTZ:10MHZ, 0.001%, PARALLEL	33096	PB1109
				(STANDARD ONLY)		
A18Y1530	119-0894-01			OSCILLATOR, RF: 10MHZ, 18V	80009	119-0894-01
				(OPTION 01 ONLY)		

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DIAGRAMS AND CIRCUIT BOARD ILLUSTRATIONS

Symbols

Graphic symbols and class designation letters are based on ANSI Standard Y32.2-1975.

Logic symbology is based on ANSI Y32.14-1973 in terms of positive logic. Logic symbols depict the logic function performed and may differ from the manufacturer's data.

The overline on a signal name indicates that the signal performs its intended function when it is in the low state.

Abbreviations are based on ANSI Y1.1-1972.

Other ANSI standards that are used in the preparation of diagrams by Tektronix, Inc. are:

Y14.15, 1966 Drafting Practices.

Y14.2, 1973 Line Conventions and Lettering.

Y10.5, 1968 Letter Symbols for Quantities Used in Electrical Science and Electrical

Engineering.

American National Standard Institute 1430 Broadway New York, New York 10018

Component Values

Electrical components shown on the diagrams are in the following units unless noted otherwise:

Capacitors = Values one or greater are in picofarads (pF).

Values less than one are in microfarads
(uF).

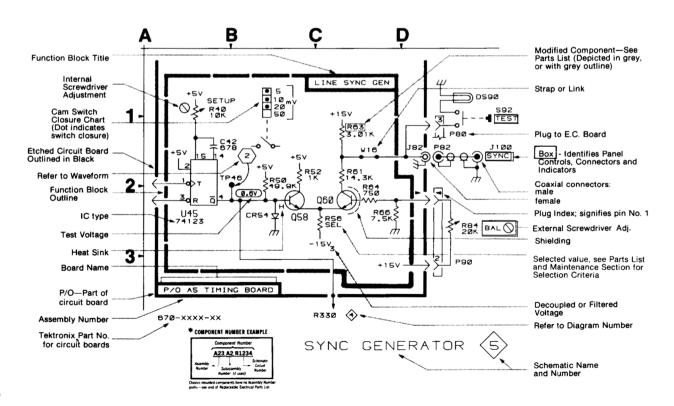
Resistors = Ohms (Ω) .

The information and special symbols below may appear in this manual. -

Assembly Numbers and Grid Coordinates

Each assembly in the instrument is assigned an assembly number (e.g., A20). The assembly number appears on the circuit board outline on the diagram, in the title for the circuit board component location illustration, and in the lookup table for the schematic diagram and corresponding component locator illustration. The Replaceable Electrical Parts list is arranged by assemblies in numerical sequence; the components are listed by component number *(see following illustration for constructing a component number).

The schematic diagram and circuit board component location illustration have grids. A lookup table with the grid coordinates is provided for ease of locating the component. Only the components illustrated on the facing diagram are listed in the lookup table. When more than one schematic diagram is used to illustrate the circuitry on a circuit board, the circuit board illustration may only appear opposite the first diagram on which it was illustrated; the lookup table will list the diagram number of other diagrams that the circuitry of the circuit board appears on.



ADJUSTMENT LOCATIONS

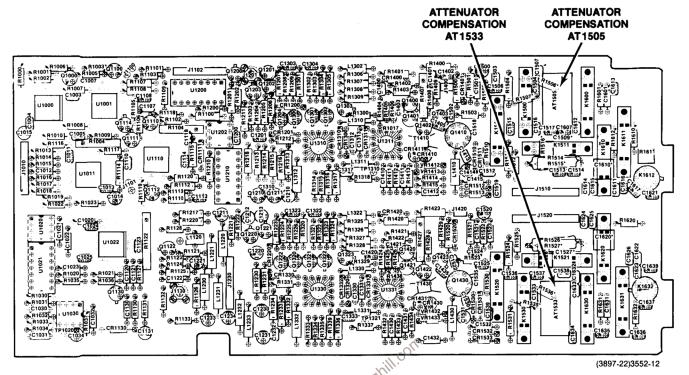
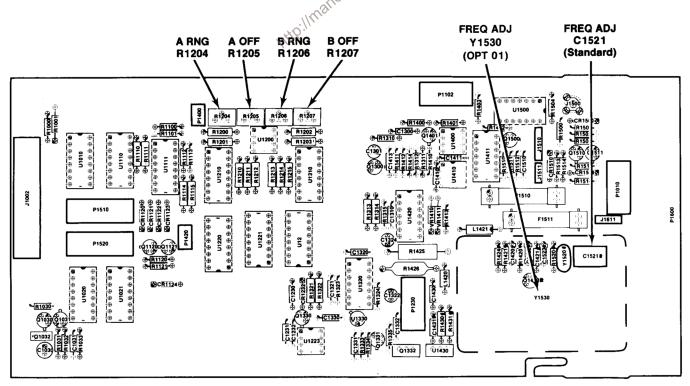


Fig. 8-1. Analog Board (A12).



(3897-23)3552-13

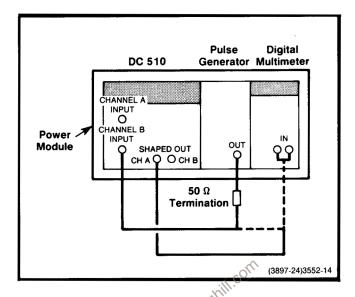


Fig. 8-3. Adjustment setup for steps 10 and 11.

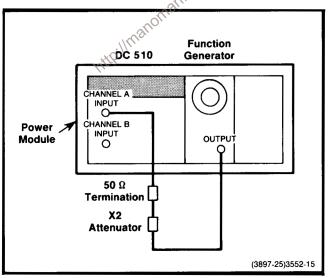


Fig. 8-4. Adjustment setup for steps 12 and 13.

Table 8-2 COUNTER INTEGRITY ERRORS

	COUNTER INTEGRITT ERRORS
ERROR CODE	SUSPECT CIRCUITRY
320	1. CHECK THAT INPUT SIGNAL IS WITHIN TRIGGER LEVEL RANGE, OR NO INPUT. 2. MAKE SURE ARM INPUT IS HIGH. 6 3. CHECK +12V, -12V,-5V. 4. SUSPECT FET Q1410, CHECK FOR SIGNAL ON T1418 5. CHECK MR AND MR LINES. 4 6. CHECK CH A DAC. 6 7. CHECK CH A AMP. 1, 2 8. CHECK GATING. 3 9. CHECK INPUT TO ACCUMULATOR. 4 10. SUSPECT U10000A. 3
321	1. SUSPECT U1000A, U1011 3 2. SUSPECT U1710D, U1121 4
322	1. SUSPECT U1011A 3 2. CHECK CABLE W528 3. SUSPECT U1810A 4 4. SUSPECT U1710B, U1121 4
323	1. SUSPECT U1801A (4), LEVEL SHIFTER Q1702, Q1701 (4) 2. SUSPECT U1121 (4)
324	1. SUSPECT LEVEL SHIFTER Q1702, Q1701 2. SUSPECT U1120A 3. SUSPECT U1121
329	1. SUSPECT CABLE 1528 OR ANY ACCUMULATOR IC
33Ø	1. CHECK CH B DAC 6 2. CHECK CH B AMP 1 2 3. CHECK FET Q1430 4. CHECK FOR SIGNAL ON T1430 5. CHECK GATING 3 6. CHECK INPUT TO ACCUMULATOR 3 7. SUSPECT U1011C 3 8. SUSPECT U1102A OR U1122 4
331	1. SUSPECT U1011C, U1011B 3 2. SUSPECT U1710C, U1122 4
332	1. SUSPECT U1011, OR CABLE W538 3 2. SUSPECT U1810B 4 3. SUSPECT U1103 4
333	1. SUSPECT U1810B, LEVEL SHIFTER Q1704, Q1703 4 2. SUSPECT U1122 4
334	1. SUSPECT LEVEL SHIFTER Q1704, Q1703 4 2. SUSPECT U1120B, U1122 4
339	1. SUSPECT CABLE W529 OR ANY ACCUMULATOR IC

Table 8-1 GENERAL PROBLEMS

PROBLEM	SUSPECT CIRCUITRY
MEASUREMENTS ARE STABLE BUT NOT ACCURATE.	TIME BASE OSCILLATOR (+18V SUPPLY FOR OPT. 1). BUFFER - Q1500, DIVIDER - U1411, AND PHASE LOCKED LOOP COMPONENTS OR JUMPERS J1511 OR J1515 LOOSE.
DOES NOT TRIGGER PROPERLY (MAY BE INDICATED BY INCORRECT SHAPED OUTPUTS).	DUAL DMOS IN AMPLIFIER (1),+12V, -12V, -5V, +5V ₂ SUPPLIES (8), AMPLIFIER COMPONENTS (1),(2).
INPUT CONDITIONING DOES NOT FUNCTION PROPERLY.	SWITCH (9) (8), RELAYS (1), RELAY DRIVERS (7),
DISPLAY DOES NOT FUNCTION PROPERLY.	DISPLAY CIRCUITRY (10) (1)
AUTO TRIGGER DOES NOT FUNCTION PROPERLY.	+2.5V SUPPLY (8), D/A CONVERTERS - U1210, U1310 (6), SERIAL-TO-PARALLEL SHIFT REGISTERS - U12222, U1220, U1221 (6), INPUT AMPLIFIERS (1), (2), BUFFERS - U1200 (6).
MEASUREMENTS WITH LOW FREQUENCY INPUT SIGNAL ARE NOT STABLE. CATE LIGHT ALWAYS ON. NO MEASUREMENT COMPLETED.	END SIGNAL 3,4 SUSPECT U1102C, U1410 9, SCHMITT TRIGGERS, AMPLIFIERS 1,2. END SIGNAL 3,4 SUSPECT U1102C, U1410 9.
	ARM STUCK LOW: Q1510,Q1511 6

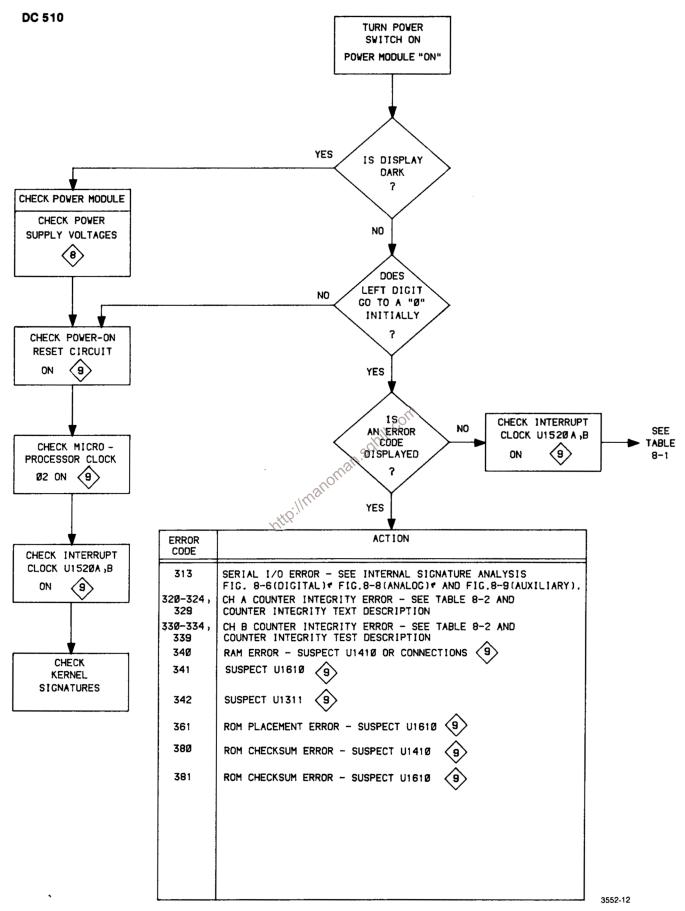


Fig. 8-5. General troubleshooting flow chart.

A12,A16,A18

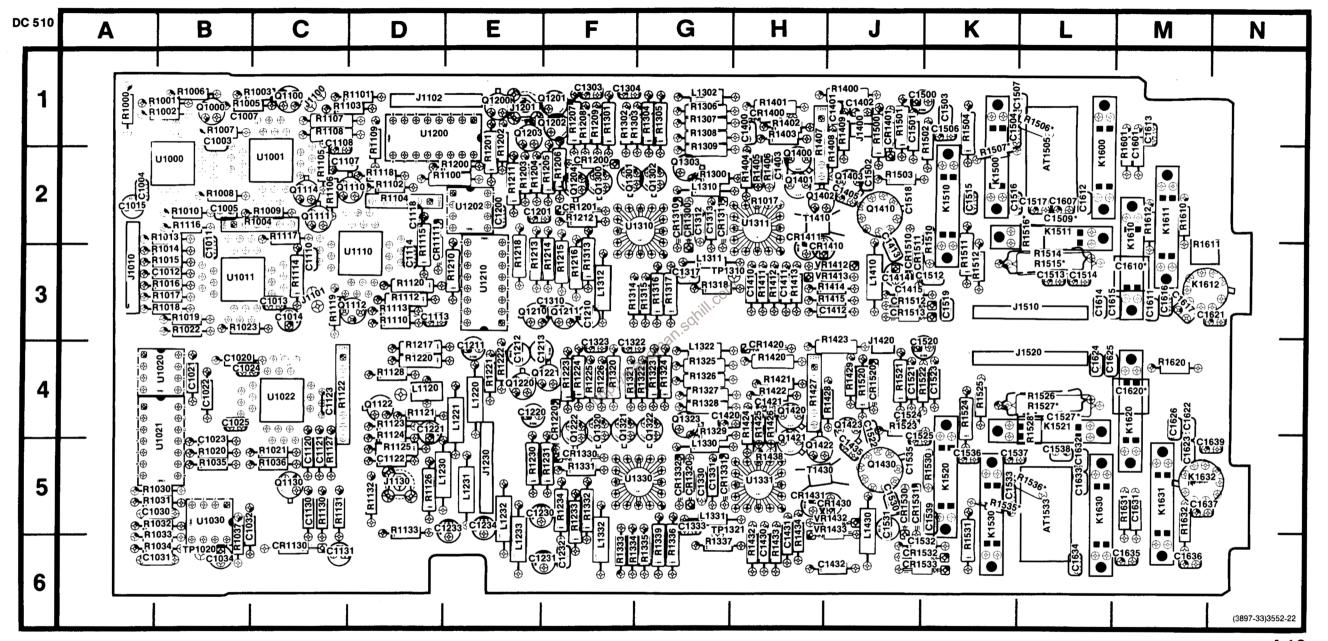
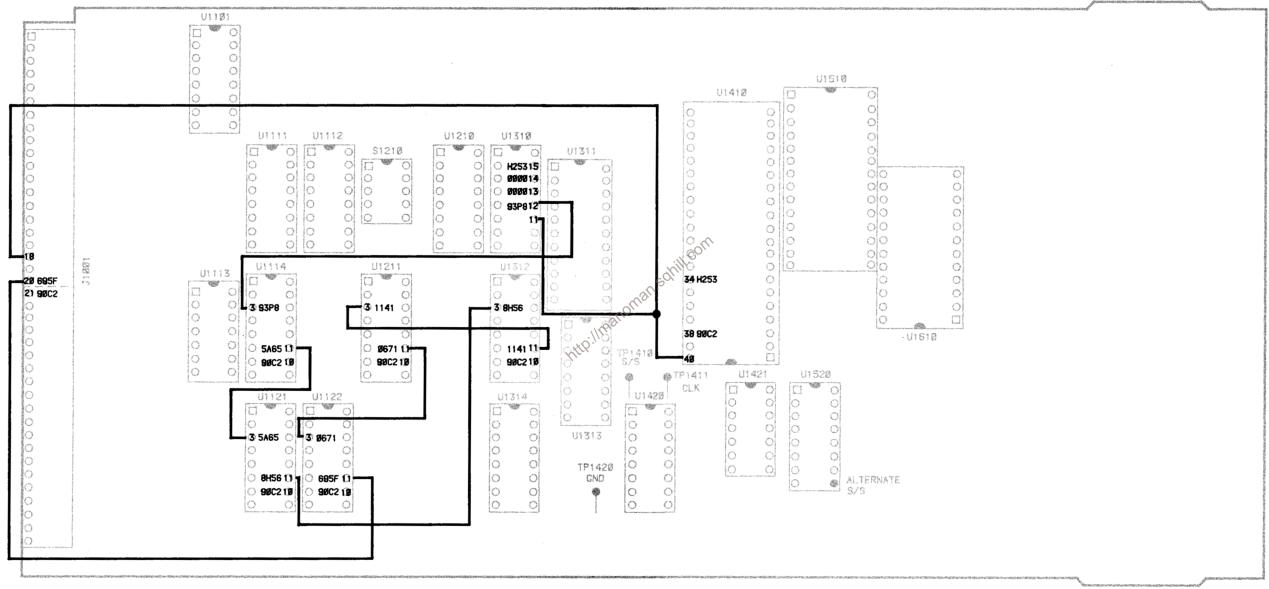


Table 8-3 **COMPONENT REFERENCE CHART** (see Fig. 8-11)

SCHEMATIC				SIG	NAL CONDITION	ONING & AMPLIF	FIERS (1)
SCHEMATIC							
	BOARD	CIRCUIT	SCHEMATIC	BOARD	CIRCUIT	SCHEMATIC	BOARD
LOCATION	LOCATION	NUMBER	LOCATION	LOCATION	NUMBER	LOCATION	LOCATIO
E3	L2	CR1532	G6	K6	R1421	K8	H4
E7	L5	CR1533	H5	K6	R1422	K8	H4
			_				J4
							H4
							H4
							H4 H4
		J5 10	D 0	Chassis			J4
		K1500S	FΔ	K2		.18	J4
							H6
		K1511S	Ē1	L2	R1433	K6	Н6
12	J3	K1520S	G6	K5	R1434	J6	H6
	J3	K1521S	E6	L4	R1438		H5
			F8				J1
							J1
							K1
							J2 K1
							Li
			D8	VI 5			K2
			C6	. CO M5			K2
F3			C7	M5			K3
		11.0020		,		F2	K3
		L1310	M2	G2	R1514	D2	L3
K9	J4	L1311	M3`	G3	R1515	E2	L3
G8	J4	L1330	™ 6				L2
		L1331	M7				J4
		L1410	(\) 2				J4
		L1430	16	J5			K4
		04940	V4	Ea			J4 K4
	Ne Jo	01210		E3	D1524		K4
							L4
							L4
			H4		R1528		L4
D3	M3	Q1403	14	J2	R1530	G6	K5
D 7	M4	Q1410	H2	J2		F7	K6
C7	M5						K5
							L5
							M1
							M2
		Q 1430	по	Jo			M3 M2
	G5 G5	R1318	K2	G3	R1620		M4
	G5						M5
		R1400				C7	M5
J4	J1	R1401	L4	Ĥ1			
J2	H2	R1402	K4	H1	T1410	J2	H2
12	H2		K4			J7_	H5
	H4						G 3
					IP1321	M7	G5
					114044	10	шо
							H2 H5
	J3				01331	, J/	пэ
	13		K2		VR1412	13	J3
			J2	H3			J3
							J5
H6	J5	R1420	Ĺ9	H4	VR1433	ÿ7	J5
_	E7 M3 M7 L7 14 K43 11 12 12 15 15 16 16 16 16 16 16 16 16 16 16 16 16 17 17 17 17 17 17 17 17 17 17 17 17 17	E7 M3 G2 G2 G5 G5 G5 G5 G5 G5 G5 G5	M3 G2 J1400 L3 G2 J1420 M7 G5 J500 L7 G5 J510 L7 G5 J510 L7 G5 J510 L7 L7 G5 J510 L7 L7 G5 J510 L7 L7 G5 J510 L7 L7 G5 J510 L8 L1 J1 K1500S L8 K1510S L9 L2 L2 L3 K1521S L9 L3 K1521S L1 L3 K1521S L8 H4 K1600S L5 L6 K1610S L7 L7 L5 K1611S L5 L6 K1610S L7 L7 L620S L8 L1310 L8 K1632S L9 L2 L2 L2 L3 L1310 L1331 L1331 L1332 L1311 L1333 L1333 L1311 L1334 L1331 L1334 L1331 L1335 L134 L1331 L135 L135 L136 L137 L138 L138 L138 L138 L138 L138 L138 L138	M3 G2	M3 G2	E7	Beautiful

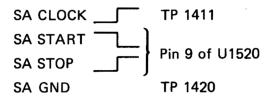
P/O A12 ASSY also shown on $\langle 2 \rangle \langle 3 \rangle \langle 5 \rangle \langle 7 \rangle \langle 8 \rangle$

Serial path signatures



+5V SIGNATURE - 47C6

Internal Signatures (Digital Board)

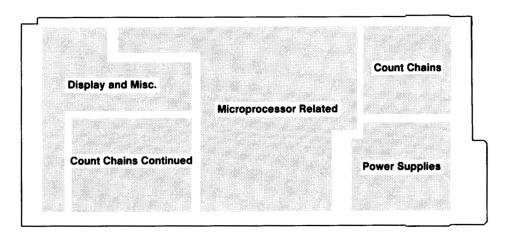


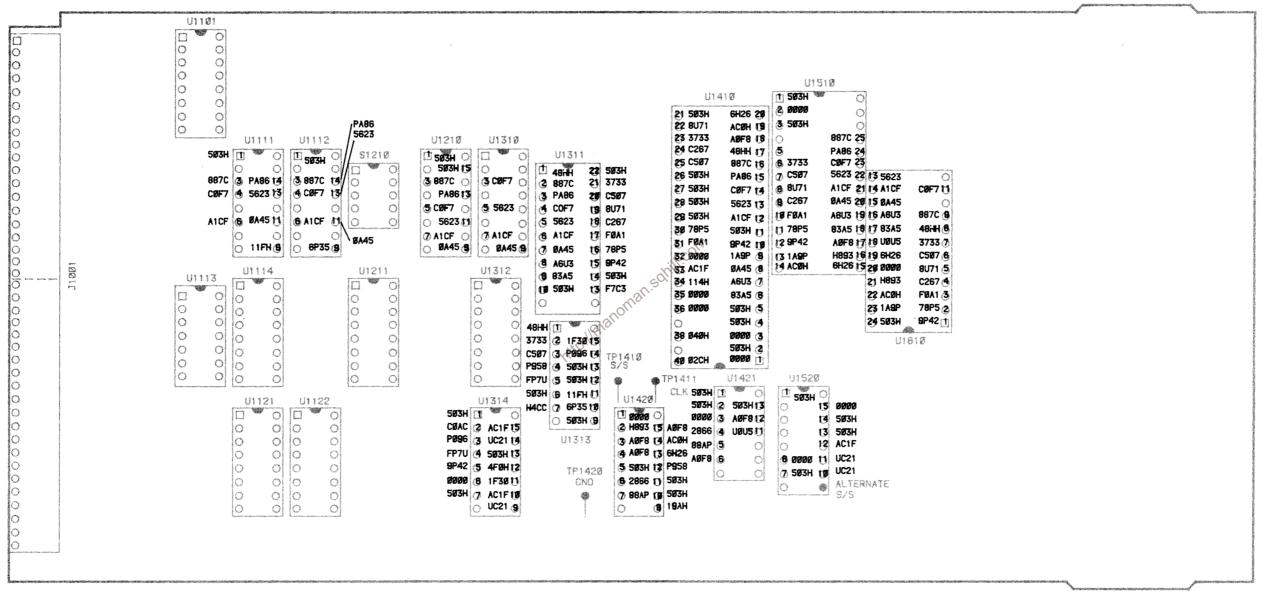
NOTE

Power up DC 510 while holding in CH A ATTEN button to get signatures.

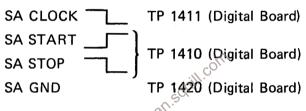
Address switch S1210 set to 20:







Internal Signatures (Digital Board)

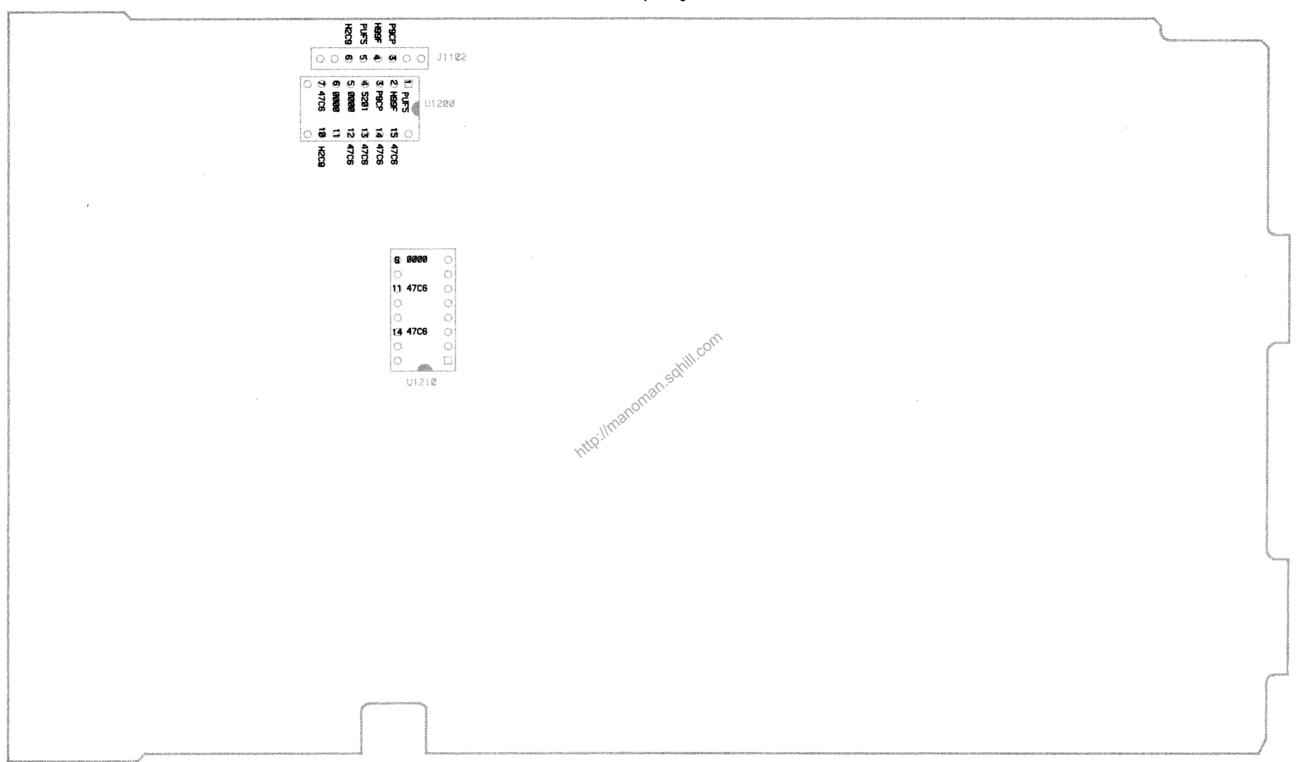


NOTE

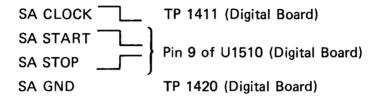
Power up DC 510 While holding in CH A ATTEN button to get signatures.

Address switch S1210 set to 20:



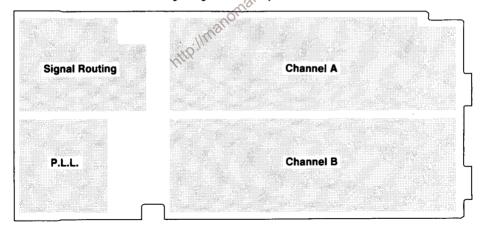


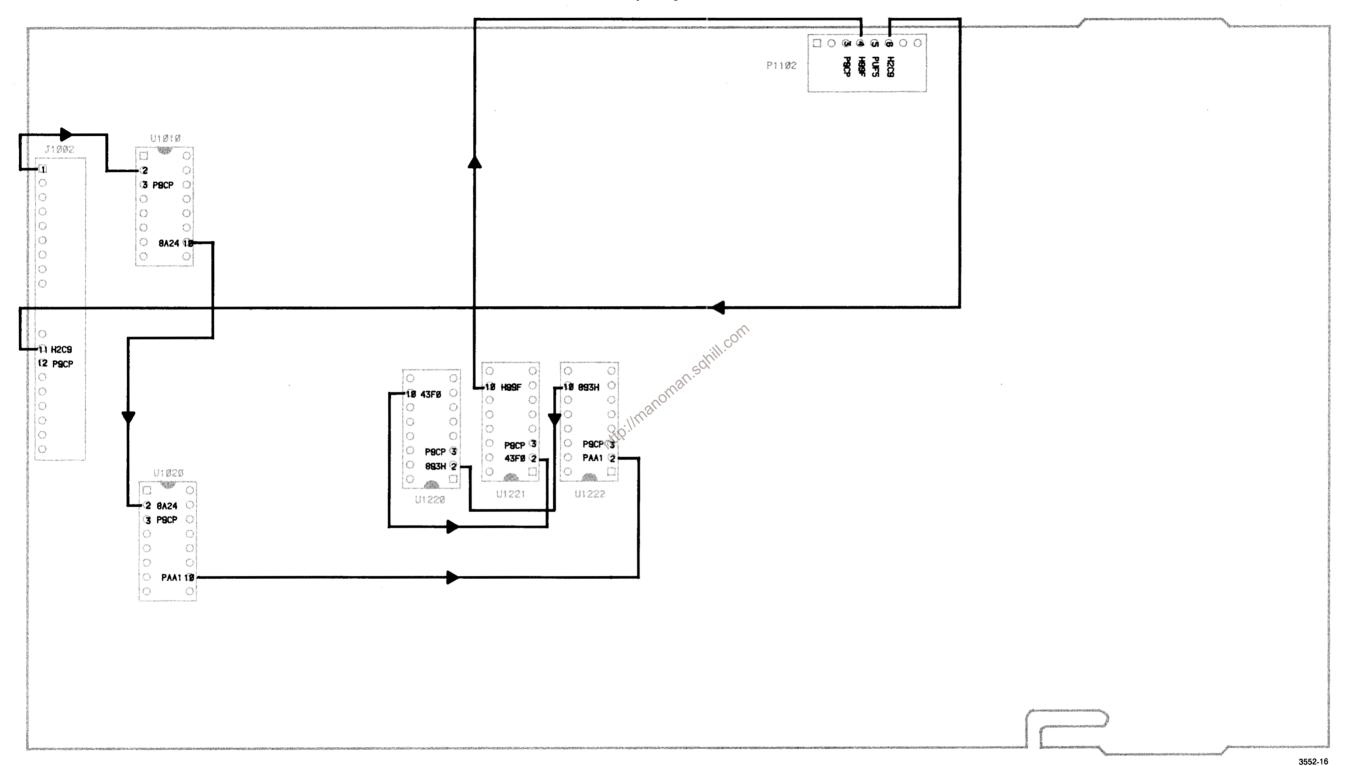
Internal Signatures (Analog Board)



NOTE

Power up DC 510 while holding CH A ATTEN button to get signature analysis.



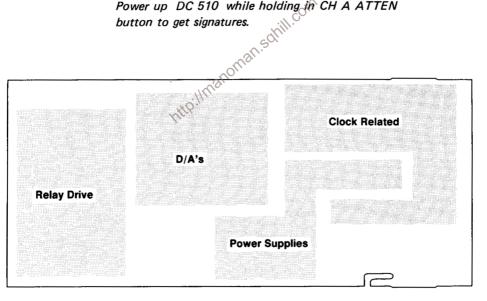


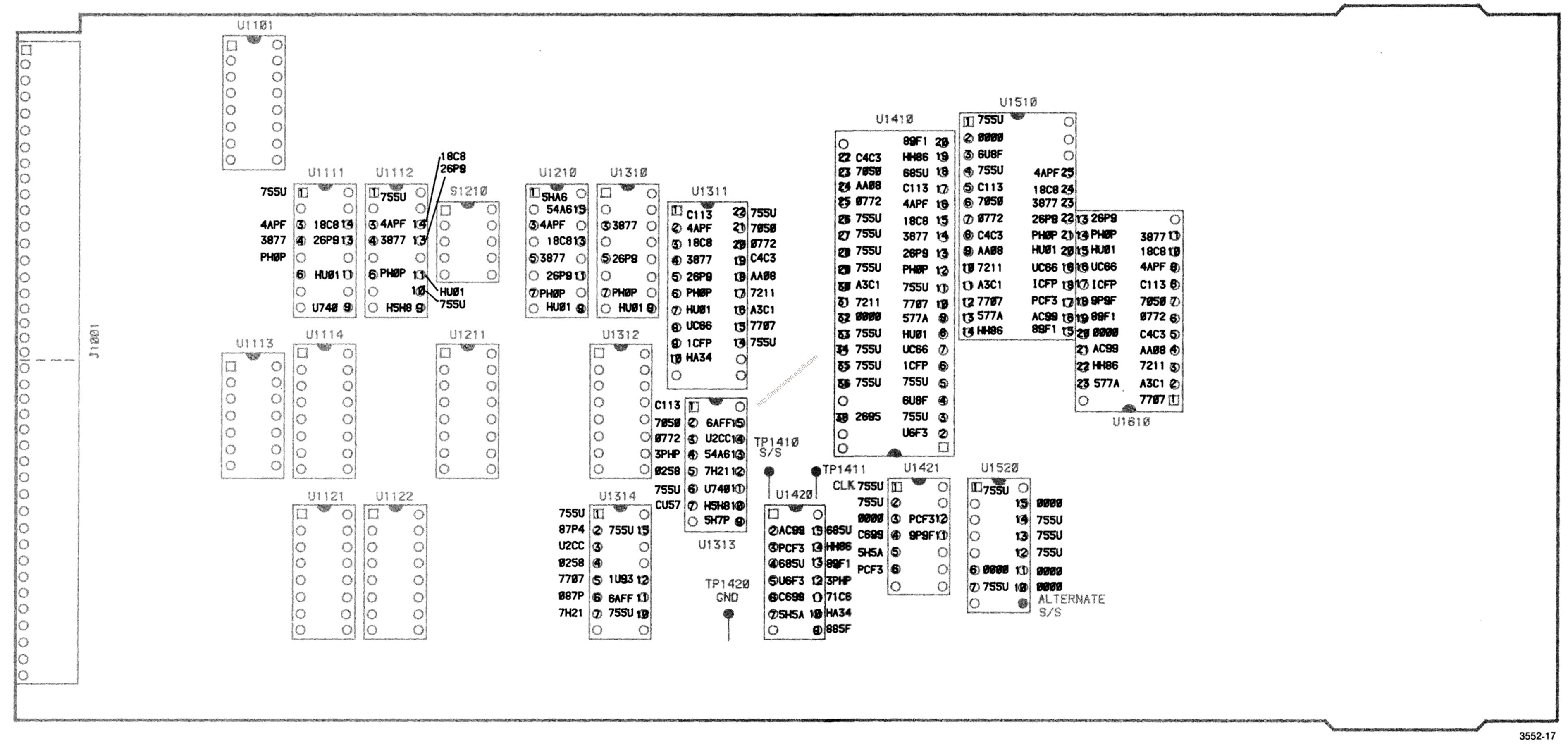
Internal Signatures (Auxiliary Board)

SA CLOCK TP 1411 (Digital Board) SA START Pin 9 of U1520 (Digital Board) SA STOP SA GND TP 1420 (Digital Board)

NOTE

Power up DC 510 while holding in CH A ATTEN button to get signatures.





+5V SIGNATURES -755U

DC 510

Kernel Test Signatures (Digital Board)



NOTE

Power up DC 510 while holding in CH A ATTEN button to get signatures.

Address switch \$1210 set to 20:



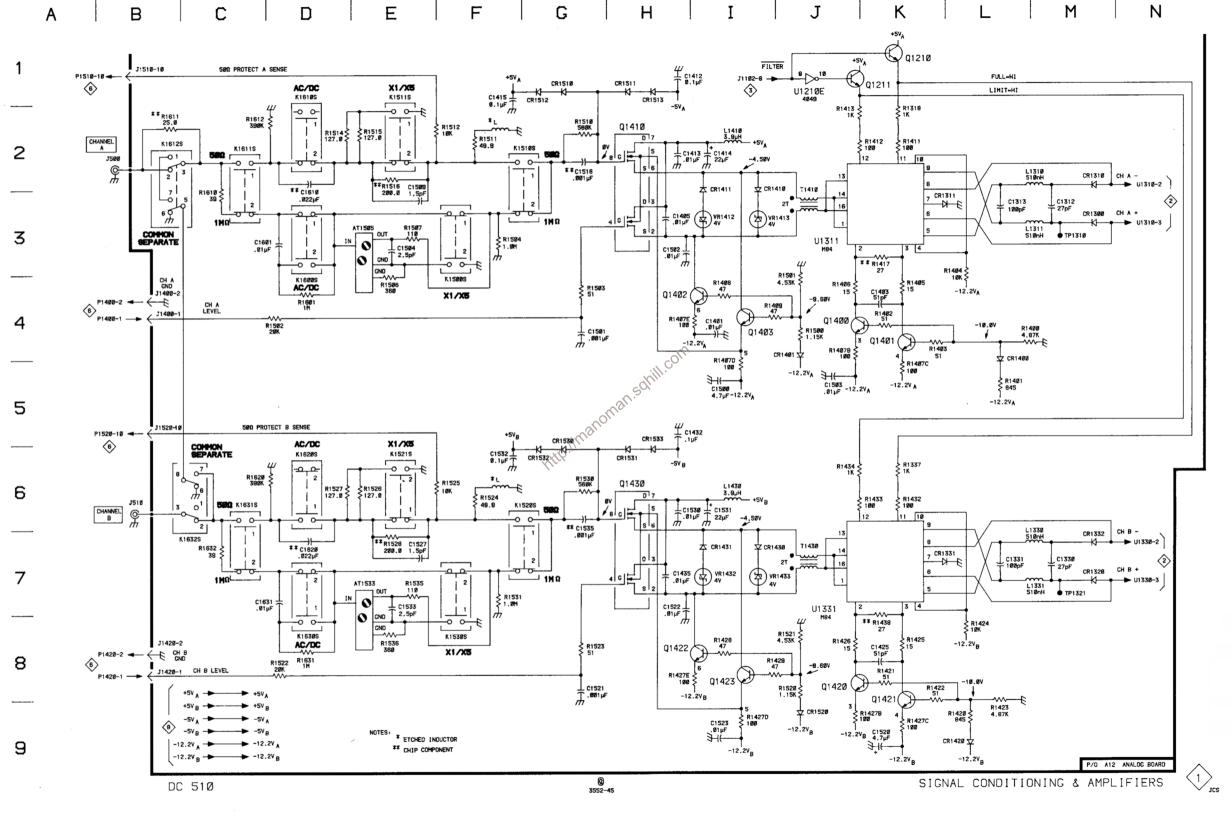


Table 8-4 COMPONENT REFERENCE CHART (see Fig. 8-11)

P/O A12 AS	SSY			SCHMITT TRIG	GERS (2)
CIRCUIT NUMBER	SCHEMATIC LOCATION	BOARD LOCATION	CIRCUIT NUMBER	SCHEMATIC LOCATION	BOARD LOCATION
C1108	F5	C2	R1204	C5	E2
C1113	F10	D3	R1205	C5	F2
C1122	B9 B4	D5 E2	R1206 R1207	J4 J4	F2 F1
C1200 C1201	J2	E2 E2	R1207	H4	F1
C1210	J2	F3	R1209	E4	F1
C1230	J7	E5	R1211	G5	E2
C1303 C1304	H3 G3	F1 F1	R1212 R1213	H2 I3	F2 E3
C1304 C1317	H1	G3	R1214	H3	F3
C1319	G2	G2	R1215	12	F3
C1322	G8	F4	R1216	H2	F3
C1323 C1333	H8 H6	F4 G5	R1217 R1218	G10 G5	D4 E3
C1339	G7	G5	R1220	Ğ10	D4
			R1222	J10	E4
CR1200 CR1201	13 13	F2 F2	R1223 R1224	78 78	F4 F4
CR1201	13 18	F4	R1225	H9	F4
CR1330	18	F5	R1226	E9	F4
14400	D.10	5.5	R1230	18	E5
J1130 J1201	B10 B5	D5 E1	R1231 R1233	H8 H7	F5 F5
J520	A5	Chassis	R1234	17	F5
J530	A10	Chassis	R 1300	F2	G2
L1302	нз	G1	R1301 R1302	G3 D4	F1 F1
L1312	J2	F3	R1303	F4	Fi
L1322	H <u>8</u>	G4	R1304	F3	G1
L1332	J7	F6	R1305 R1306	13 14	G1 G1
P1130	B10	G4 F6 D5/M2/10/1	R1307	Ë2	G 1
P1201	B4	K/E1		E3	G1
Q1122	C9	D4	R1309 R1313	E3 H2	G2 F3
Q1201	15	F1	R1314	ĞÎ	F3
Q1202	J4_	F1	R1315	F1	G3
Q1203 Q1204	C5 G4	E1 F2	R1316 R1317	H1 G1	G3 G3
Q1220	J9	E4	R1319	Ği	G3
Q1221	110	F4	R1320	G8	F4
Q1222 Q1300	G9 E4	F4 F2	R1321 R1322	D9 F9	F4 G4
Q1301	D4	F2	R1323	F8	G4
Q1302	G4	G2	R1324	18	G4
Q1303 Q1320	E3 E9	G2 F4	R1325 R1326	19 E8	G4 G4
Q1321	D9	F4	R1327	E8	G4
Q1322	G9	G4	R1328	E8	G4
Q1323	F8	G4	R1329 R1331	F7 H7	G4 F5
R1107	F5	C1	R1332	H7	F5
R1108	G5	ČÍ	R1333	G6	F6
R1112	F10	D3	R1334	F6	F6 G6
R1118 R1120	G5 G10	D2 D3	R1335 R1336	H6 G6	G6
R1121	D9	D4	R1339	G6	G6
R1123	C10	D4	R1407	H4	H1
R1124 R1125	C9 C9	D4 D5	U1202	H5	E2
R1126	C10	D5	U1210	J9	E3
R1128	G10	D4	U1310	F1	G2
R1200 R1201	J5 C4	E2 E1	U1330	F7	G5
R1202	Č4	Ēi	W500	B5	Chassis
R1203	D4	E2	W510	B10	Chassis
	P/O A12 AS	SSY also shown	on (1) (3) (\$ \$ \$	

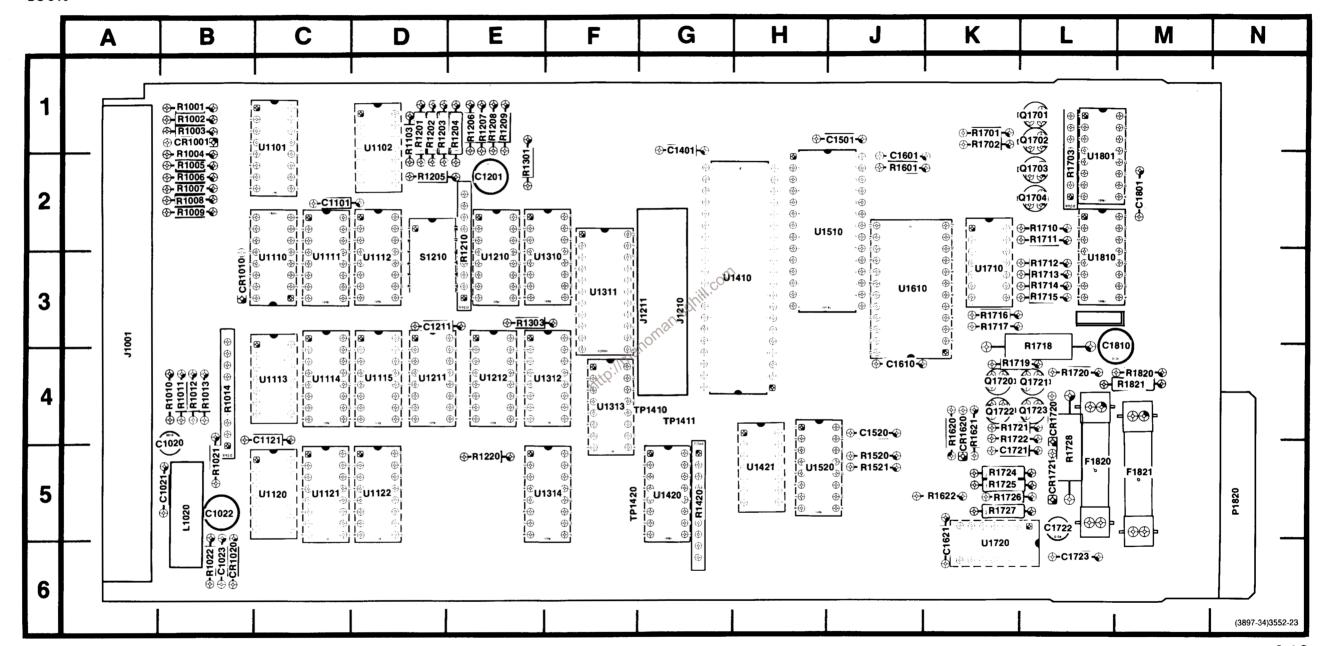


Fig. 8-12. Digital board (A16).

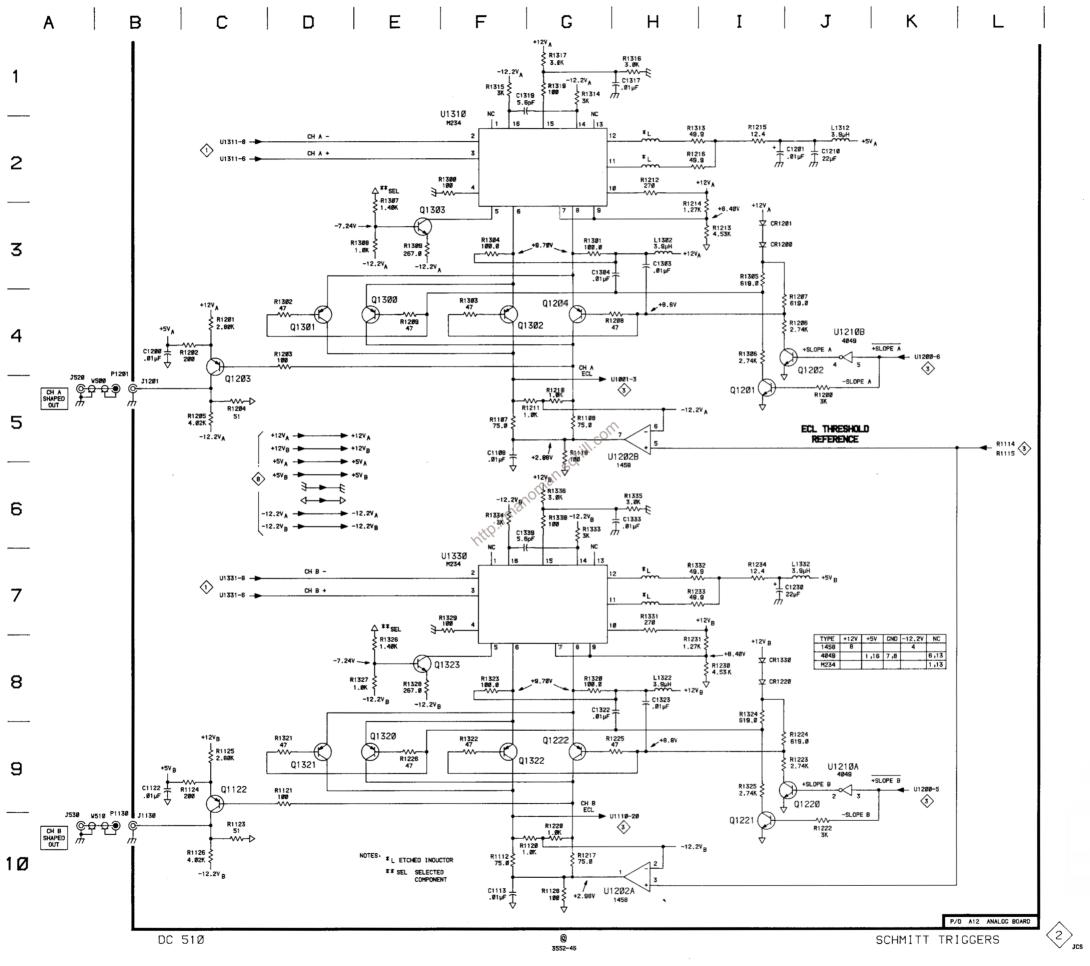
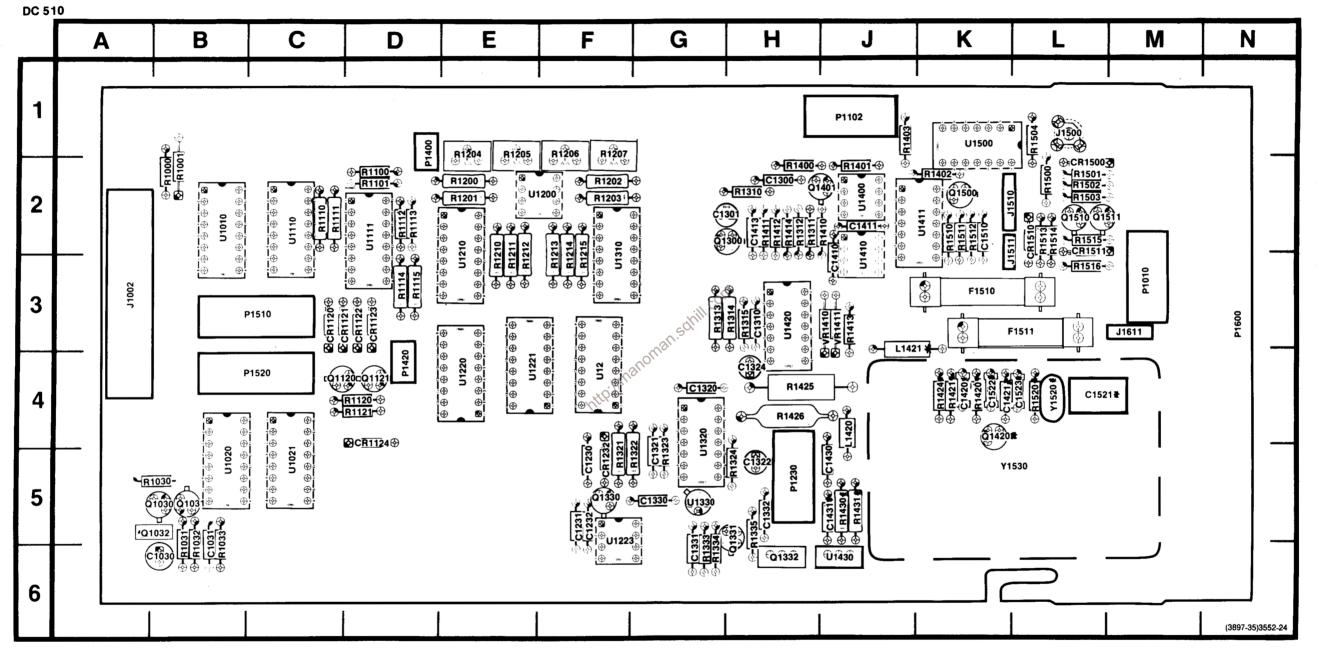


Table 8-5 COMPONENT REFERENCE CHART (see Fig. 8-11 and 8-13)

P/O A12 AS	SY			MAIN (GATING 3
CIRCUIT NUMBER	SCHEMATIC LOCATION	BOARD LOCATION	CIRCUIT NUMBER	SCHEMATIC LOCATION	BOARD LOCATION
C1003	L7	B1	R1004	K2	C2
C1004	Ľ8	A2	R1005	K3	B1
C1005	F3	B2	R1006	G4	B1
C1010	J4	B2	R1007	E2	B1
C1011	07	B3	R1008	L2	B2
C1012	M6	B3	R1009	J2	C2
C1013	N8	C3	R1010	J3	B2
C1014	N7	C3	R1013	M1	B 2
C1015	13	A2	R1014	M1	B3
C1107	L8	C2	-R 1015	N2	B3
C1110	09	C3	R1016	M4	B3
C1114	N10	D3	S R1017	M5	B3
C1118	K5	D2	R1018	O6	B3
C1140	17		R1019	N2	B3
-		, _O ,	R1022	M6	B3
CR1111	H7	D3 D2nahori	R1023	N6	B3
		:///	R1101	H8	D1
DL500	E4	Chassis	R1102	D3	D2
		Urr.	R1103	F5	C1
J1010	N2	A3	R1104	C4	D2
J1102	B 7	D1	R1105	D6	C2
			R1106	C6	C2
L1009	J2	C2	R1109	F3	D1
			R1110	F6	D3
Q1000	13	B1	R1113	H7	D3
Q1100	F4	C1	R1116	M2	B2
Q1110	C3	C2	R1117	L6	C2
Q1111	C5	C2	R1119	H6	C3
Q1112	F5	D3	R1140	17	D3
Q1114	D2	C2			
Q1200	F8	E1	U1000	L8	B2
			U1001	M8	C2
R1000	H3	A1	U1011	N8	B3
R1001	K4	B1	U1110	N9	D3
R1002	H3	B1	U1200	C6	D1
R1003	14	C1	U1200	18	D1
	P/O A12 ASSY	also shown on	1)25	⟨↑⟨δ⟩	



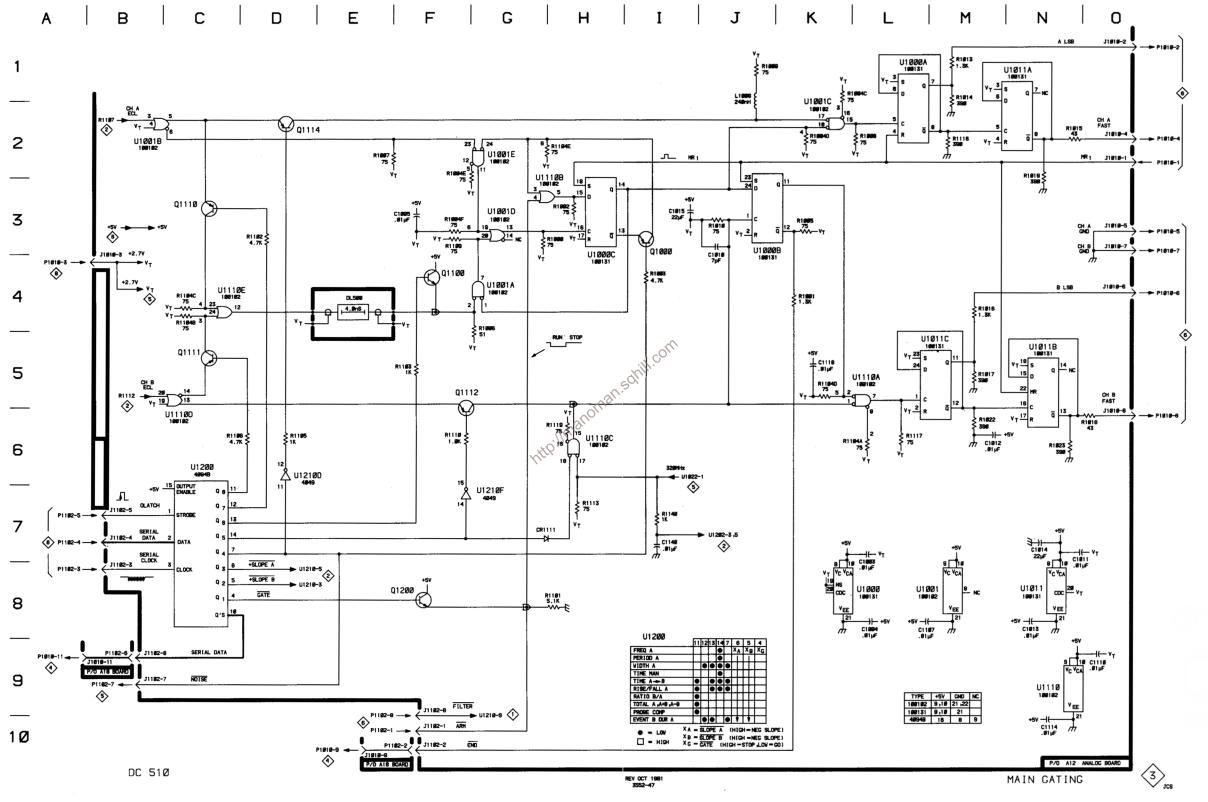


Table 8-6 COMPONENT REFERENCE CHART (see Fig. 8-12)

P/O A16 A	SSY		CH A & CH B COUNT CHAINS 4			
CIRCUIT NUMBER	SCHEMATIC LOCATION	BOARD LOCATION	CIRCUIT NUMBER	SCHEMATIC LOCATION	BOARD LOCATION	
C1121 C1211 C1801	L8 M8 M8	C4 D3 M2	R1714 R1735 R1716 R1717	D2 C7 G3 F9	L3 L3 K3 K3	
Q1701 Q1702 Q1703 Q1704	G2 F2 G8 F8	L1 L1 L2 L2	U1102 U1113 U1114	E4 J2 K4	D1 C4 C4	
R1014 R1021 R1207	17 H8 E4	84 85 E1	U1115 U1120 U1121 U1122	K2 H2 G4 G6	D4 C5 C5 D5	
R1208 R1209 R1701 R1702	E6 E4 G1 F8	E1 E1 K1 K1	U1211 U1212 U1312 U1710	16 L8 L6 E7	D4 E4 F4 K3	
R1703 R1710 R1711 R1712	E2 D3 C7 D7	L2 L2 L2 L3	U1801 U1810 W520A	E2 D2 B2	L2 L3 Chassis	
R1713	C2	L3	W530A	B8	Chassis	

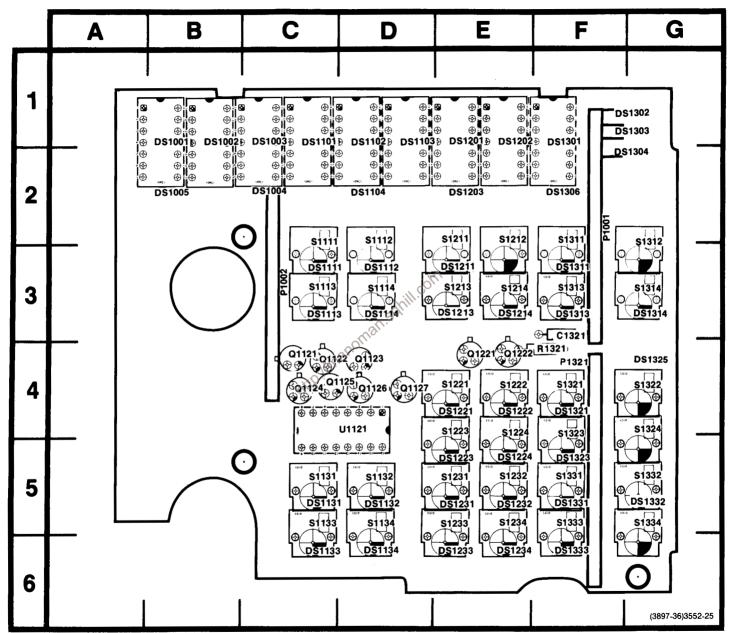


Fig. 8-14. Display board (A10).

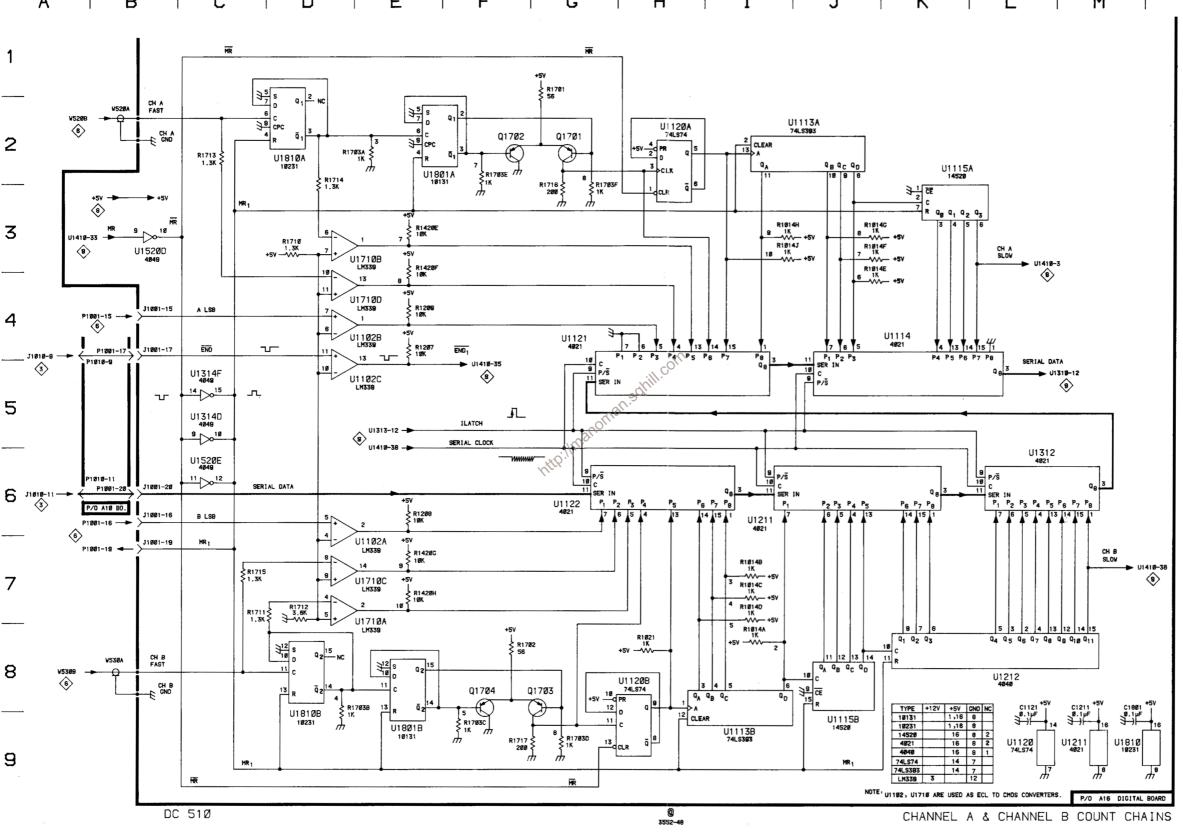


Table 8-7 COMPONENT REFERENCE CHART (see Fig. 8-11 and 8-13)

DC 510	(see	Fig. 8-	11 and	8-13)					
P/O A12 AS	sy		TIME	BASE & 320 MH	Iz PLL 5				
CIRCUIT NUMBER	SCHEMATIC LOCATION	BOARD LOCATION	CIRCUIT NUMBER	SCHEMATIC LOCATION	BOARD LOCATION				
C1020	Н8	B4	R1030	G5	A 5				
C1021	F7	B4	R1031	H5	A5				
C1022 C1023	G8 G6	B4 B5	R1032 R1033	15 J5	A5 A6				
C1023	L8	B4	R1033	J6	A6				
C1025	L8	B4	R1035	H5	B5				
C1030	15	A 5	R1036	17	C5				
C1031	K6	<u>A6</u>	R1037	K5	B 5				
C1032	L6	B5 B6	R1122	J8	C4				
C1034 C1120	M8 K7	C5	R1127 R1130	L7 K6	C5 C5				
C1121	Ľ6	C5	R1131	M9	C5				
C1123	Ľ8	C4	R1132	M7	D5				
C1130	K7	C5							
C1131	М8	C6	TP1020	J5	B6				
CR1130	L5	C6	U1020	G 7	B4				
Q1130	L7	C5	U1021 U1022	F6 H7	B4 C4				
Q1130	Li	CS	U1030	J6	B5				
R1020	H6	B5	COK	00	50				
R1021	H7	C5	ikill.						
	P/O A12 ASSY also shown on 1 2 3 3 7 8								
P/O A18 A	SSY	a: Ilmanon	TIME	BASE & 320 MH	Iz PLL 5				
C1300	B4	YILH2	R1312	D6	H2				
C1301	D4	H2	R1400	C4	H2				
C1410 C1411	D7 D5	J3 J2	R1401 R1402	D5 G2	J2 K2				
C1413	C5	H2	R1410	C6	J2				
C1420	D3	K4	R1411	B5	H2				
C1421	D2	K4	R1412	C5	H2				
C1430	C1	J4	R1414	D6	H2				
C1431 C1510	D1 H2	J4 K2	R1420 R1421	D2 D3	K4 K4				
C1510	B3	L4	R1424	C3	K4				
C1522	C2	K4	R1430	D2	J4				
C1523	D3	L4	R1431	D1	J4				
14540	12	K2	R1510	G2	K2				
J1510 J1511	13 12	K2 K2	R1511 R1512	H2 H2	K2 K2				
l "''''	12	17.6	R1512	C2	L4				
L1420	В3	J4			<u>-·</u>				
L1421	C2	J3	TP1400	E6	J2				
P1510	13	СЗ	U1400	C5	J2				
P1511	12	K2	U1410	C7	J2				
			U1411	F3	K2				
Q1300	C7	H2	U1430	C1	J6				
Q1401 Q1420	C4 D3	H2 K4	U1500 U1500	14 G2	K1 K1				
Q1420 Q1500	H2	K2		G2	N I				
			Y1520	B2	L4				
R1310 R1311	B6 D6	H2 H2	Y1530	E1	L5				
		SY also shown or	3 6 4	7) (8)					
Ī			V V 	V V					

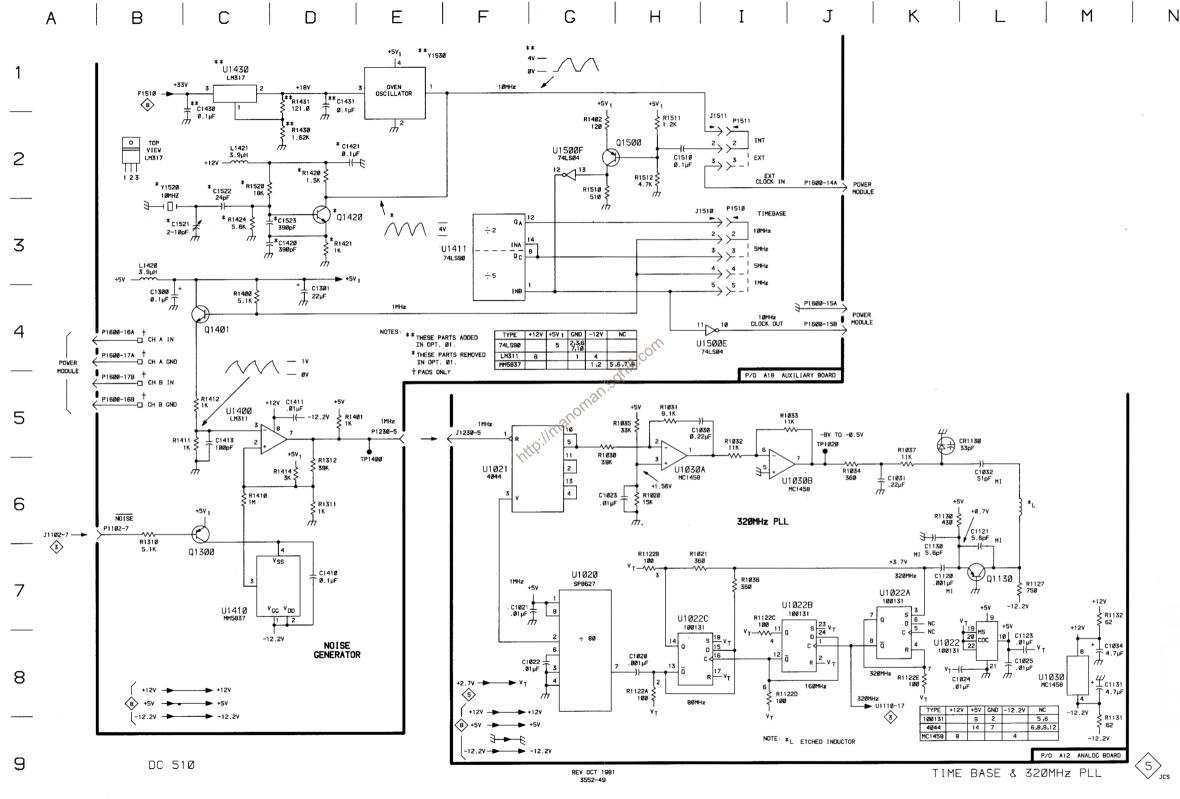


Table 8-8 COMPONENT REFERENCE CHART (see Fig. 8-13)

P/O A18 AS	SSY		D/A'S, REL	AY PROTECT & A	RMING 6
CIRCUIT NUMBER	SCHEMATIC LOCATION	BOARD LOCATION	CIRCUIT NUMBER	SCHEMATIC LOCATION	BOARD LOCATION
004500			Dance	140	P.4
CR1500	L7	L2	R1206	M6	F1
CR1510	18	L2	R1207	K6	F1
CR1511	J8	L2	R1210	H5	E2
J1500	Н8	L1	R1211 R1212	16 15	E2
J1500 J1611	C5	M3	R1212	15 L6	E2 F2
J1611 J540	G8	พง Chassis		L6 L6	
J540	Go	Chassis	R1214 R1215	K5	F2 F2
P1400	M6	D1	R1403	D7	Г2 J1
P1400	M6	D4	S R1500	H8	L2
P1420 P1500	H8	K1	R1501	ло J7	L2 L2
P1520	C8	C4 4	R1502	57 L7	L2 L2
P1611	B5	M2 O	R1502	Ľ8	L2 L2
PIOII	93	C4 M3 L2\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\	R1503	D6	L1
Q1510	J8	13////	R1513	18	L2
Q1511	K8	<u> </u>	R1514	17	L2
QISTI	NO	Vier	R1515	K8	L2
R1000	C 7	B2	R1516	H7	L3
R1100	F6	D2	1 1310	***	LJ
R1101	F5	D2	U1111	E 7	D2
R1110	E4	C2	U1200	J5	E2
R1111	Ē7	Č2	U1210	14	E2
R1112	F5	D2	U1220	H2	E4
R1113	F6	D2	U1221	L2	Ē4
R1114	E8	D3	U1222	F2	F4
R1115	E5	D3	U1310	M4	F2
R1200	H5	E2	0.0.0	141-4	
R1201	G5	E2	VR1001	D7	B2
R1202	K6	F2	W520B	B4	Chassis
R1203	J6	F2	W530B	B4	Chassis
R1204	16	E1	W540	G8	Chassis
R1205	H5	Ēi			3.10000

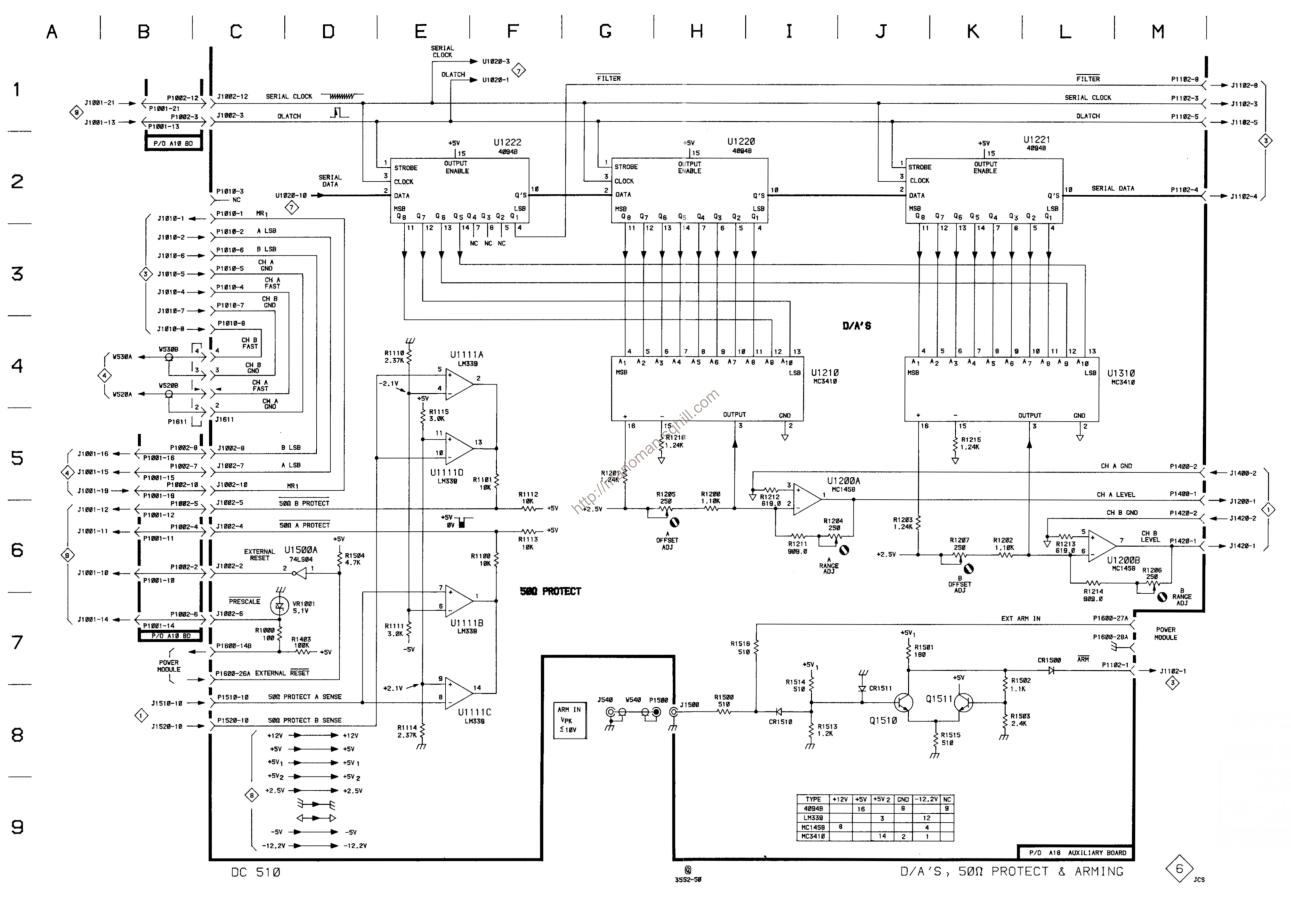


Table 8-9 COMPONENT REFERENCE CHART

DC 510	(see Fig. 8-11 and 8-13)							
P/O A12 AS	SSY			RELAY	DRIVE (7)			
CIRCUIT NUMBER	SCHEMATIC LOCATION	BOARD LOCATION	CIRCUIT NUMBER	SCHEMATIC LOCATION	BOARD LOCATION			
C1506 C1507 C1512 C1513 C1514 C1515 C1516 C1517 C1519 C1524 C1525 C1538 C1537 C1538 C1539 C1607 C1611 C1612 C1613 C1614 C1615 C1616 C1617 C1621 C1622 C1623 C1623	L4 O4 L3 M4 L4 O2 N4 N2 K4 L8 K6 O7 N7 N5 L5 N4 K4 M2 N4 K3 M4 I4 J3 J6 L6	K1 K3 L3 L3 K2 K2 K2 K2 K3 J4 J4 K5 K5 K5 L2 M3 L3 M3 M3 M3 M3	C1625 C1626 C1632 C1633 C1634 C1635 C1637 C1637 C1639 J1510 J1520 K1500 K1510 K1521 K1530 K1521 K1530 K1611 K1612 K1620 K1631 K1631 K1632	M8 13 M7 M6 M5 K5 M5 J4 J6 12 17 O3 L3 N3 L7 N7 O7 M3 L3 K3 L3 K3 L7 M7 K7 J3	L4 M4 L5 L6 M6 M6 M5 N5 L3 L4 K2 K2 K2 K2 K5 L4 K5 L4 K5 L8 M2 M2 M3 M4 L5 M55 M55			
	P/O A12 ASS	Y also shown on	\$	\$ \$				
P/O A18 A	SSY			RELAY	DRIVE (7)			
C1030 C1031	E4 D5	B6 B5	R1030 R1031 R1032	D5 D4 D4	B5 B5 B5			
CR1120 CR1121 CR1122 CR1123 CR1124	H6 G6 G6 G6 F4	C3 C3 D3 D3 D4	R1033 R1120 R1121 U1010	D5 F5 G5	B5 D4 D4			
Q1030 Q1031 Q1032 Q1120 Q1121	E5 D5 E4 F5 F5	B5 B5 B5 C4 D4	U1020 U1021 U101110	D6 F8 F1	B5 C5 C2			

P/O A18 ASSY also shown on 3



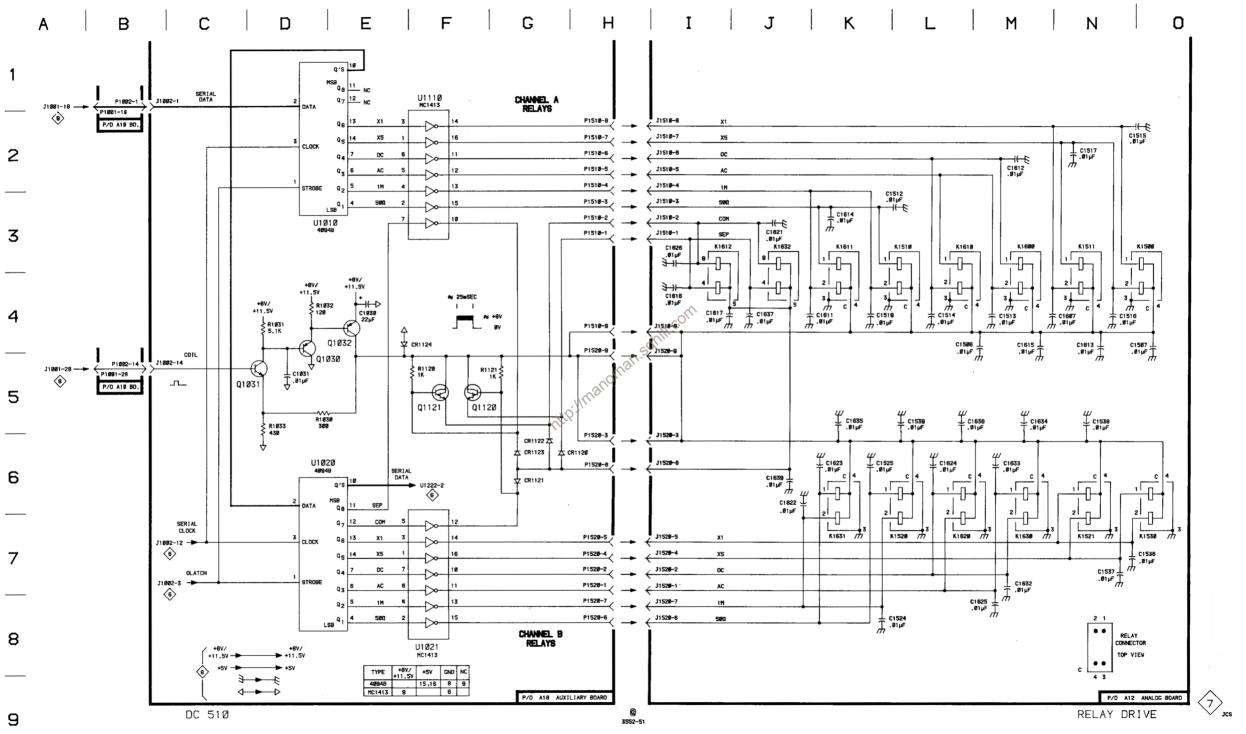


Table 8-10 COMPONENT REFERENCE CHART (see Fig. 8-11, 8-12 and 8-13)

P/O A16 A	ASSY						POWER SUPP	LIES (8)
CIRCUIT NUMBER	SCHEMATIC LOCATION	BOARD LOCATION	CIRCUIT NUMBER	SCHEMATIC LOCATION	BOARD LOCATION	CIRCUIT NUMBER	SCHEMATIC LOCATION	BOARD LOCATION
C1020	Н8	B4	F1820	В6	L5	R1621	D6	K4
C1021 C1022	18 H8	B5 B5	F1821	B8	M5	R1622 R1718	C8 E6	K5 L4
C1023	18	B6	L1020	Н8	B5	R1719	Ē6	K4
C1621	C9	K5	D4000	• •		R1720	E6	L4
C1721 C1722	D6 H8	K5 L5	P1820	A6	N5	R1721 R1722	D6 C6	K4 K4
C1723	G8	L6	Q1720	D6	K4	R1724	B 5	K5
C1810	G6	L4	Q1721	E6	L4	R1725	B9	K5
CR1020	J8	В6	Q1722 Q1723	C6 C5	K4 L4	R1726 R1727	E9 B8	K5 K5
CR1620	D5	K4				R1728	F8	L5
CR1720	F7	L4	R1022	17 05	B6	R1820	F6	M4
CR1721	G8	L5	R1620	C5	K4	R1821	В6	M4
						U1720	D8	K6
			P/O A16 AS	SY also shown o	n 🚯 🧐			
P/O A12	ASSY			sdri			POWER SUPP	LIES 😵
C1211	K6	E4	C1233	K6 K5 K4	E 5	L1221	K6	E4
C1212 C1213	K6 K4	E4 E4	C1234	OK5	E5	L1230 L1231	K3 K4	D5 E5
C1213	K4	E4	J1230 🔻	Mar K4	E 5	L1231	K3	E5
C1221	K3	D4				L1233	K7	E6
C1231	K7	F6	L1120 L1220	K4 K4	D4 E4	R1133	K6	D5
			LIZZO			R1221	K6	E4
		P/O A	12 ASSY also	shown on 1	2 3 5	>♦		
P/O A18	ASSY						POWER SUPI	LIES (8)
C1230	Н3	F5	J1002	H5	А3	R1323	C4	G5
C1231	H2	F5	D4040	V.	840	R1324	E4	H5
C1232 C1310	12 C2	F5 H3	P1010 P1230	K2 J4	M3 H5	R1331 R1332	J2 J2	H6 H5
C1320	C4	G4	P1600	A3	N3	R1333	J2	G6
C1321	B4	G5	04000	00		R1334	J2	G6
O4222	G3 G1	H5 H4	Q1330 Q1331	G2 K1	F5 H5	R1335 R1413	J1 E1	H5 J3
C1322 C1324	16	G5		15.1		R1425	Fi	H4
C1324 C1330		G6	Q1332	K2	H6	R1426	F3	H4
C1324 C1330 C1331	J2		Q1333	J2	Н6	U1223	H2	F5
C1324 C1330	J2 H6	H5			1			
C1324 C1330 C1331		H5 F5	R1313	В2	G3	U1320	D3	G4
C1324 C1330 C1331 C1332 CR1232	H6 G3	F5	R1313 R1314	B2	Н3	U1330	16	G4 G5
C1324 C1330 C1331 C1332 CR1232 F1510	H6 G3 B1	F5 K3	R1313 R1314 R1315	B2 C1	H3 H3			
C1324 C1330 C1331 C1332 CR1232	H6 G3	F5	R1313 R1314	B2	Н3	U1330	16	G5

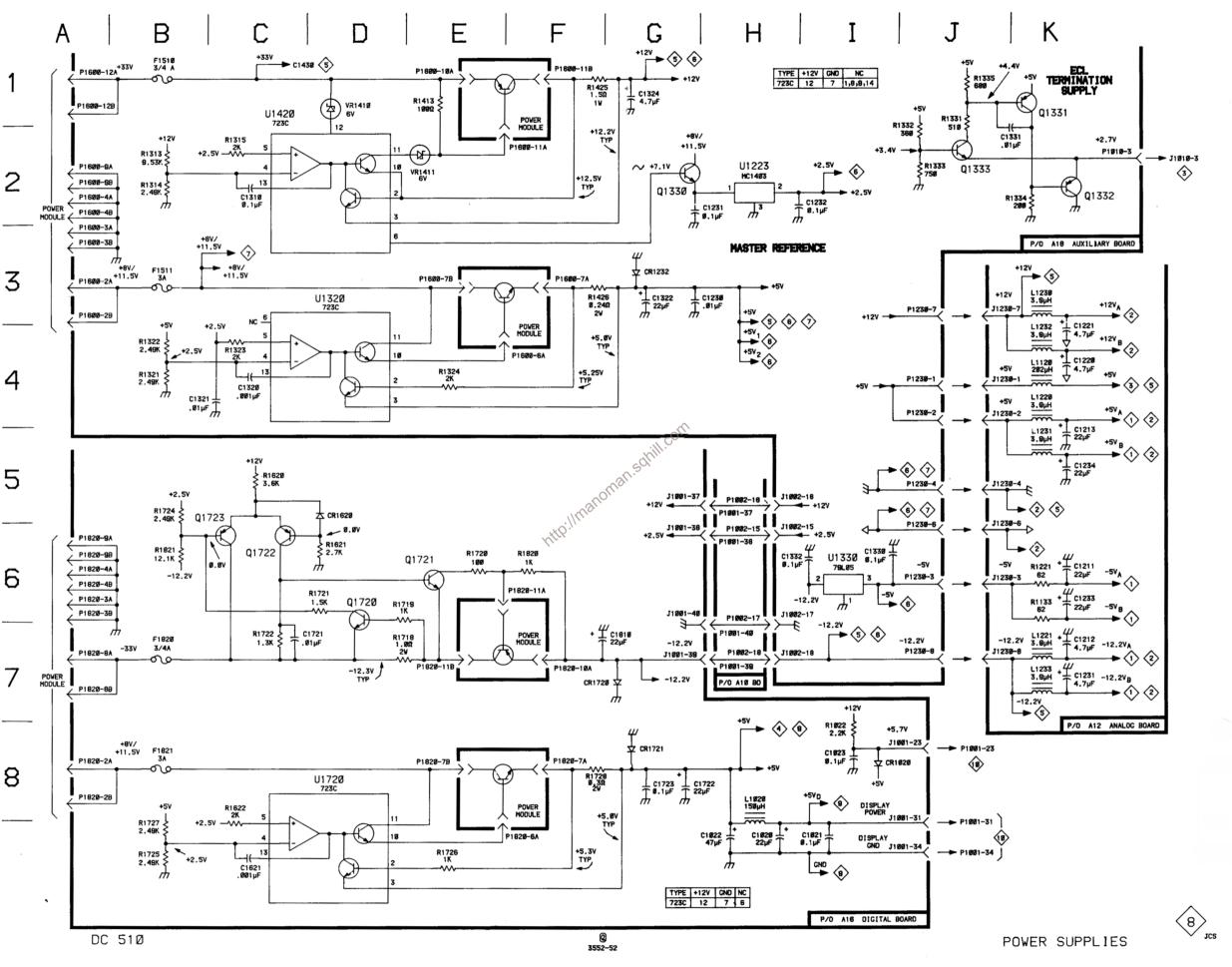


Table 8-11 COMPONENT REFERENCE CHART (see Fig. 8-12)

P/O A16 A5	SSY		PROCESSOR A	AND DISPLAY DI	RIVERS 9
CIRCUIT NUMBER	SCHEMATIC LOCATION	BOARD LOCATION	CIRCUIT NUMBER	SCHEMATIC LOCATION	BOARD LOCATION
C1101	Н9	C2	R1205	H2	D2
C1201	H2	E2	R1206	12	E1
C1401	E3	Ğ1	R1210	K2	E3
C1501	E1	J1	R1220	C3	E5
C1520	D4	J4	R1301	L2	E2
C1601	G1	J2	R1420	J3	G5
C1610	E6	J2 J4	R1520	D4	J5
CIOIO	E0	U-4	R1521	C4	J5
CR1001	K7	В1	R1601	H1	J2
CR 1001	J8	B3	1 001	п	JZ
CHIUIU	00	D 3	50 S1210	K4	D3
J1001	L7	A 3	31210	14	D3
J1210	L7 L5	63 .<	TP1410	C2	G4
J1210	B8	G3 O	TP1411	G1	G4
JIZII	Бо	G3 G3 BYN ^T ATON	TP1420	11	F5
R1001	L6	p4///v	171420	"	FO
R1001	L7	×81	U1101	16	C1
R1002	L7 L7	YILB1	U1110	J9	C3
R 1003	L/ L6	B2	U1111	H8	C3
R1004	L6	B2	U1112	H6	D3
R1005	L0 L7	B2	U1210	14	E3
R1007	L7 L7	B2	U1310	J1	F3
R1007	L7 L8	B2 B2	U1311	F9	F3
R 1008	L8	B2 B2	U1313	D2	F3 F4
	LO L9	B4	U1314	C1	F5
R1010 R1011	L9 L8	B4	U1410	G6	H3
	LO L9	B4	U1410	C5	пз G5
R1012				C6	
R1013	L9	B4	U1421		H5
R1103	12	D1	U1510	G1	J2
R1201	12	D1	U1520	D5	H5
R1202	H3	D1	U1610	G7	J3
R1203	G2	D1			
R1204	G2	E1	W 1303	D3	E3

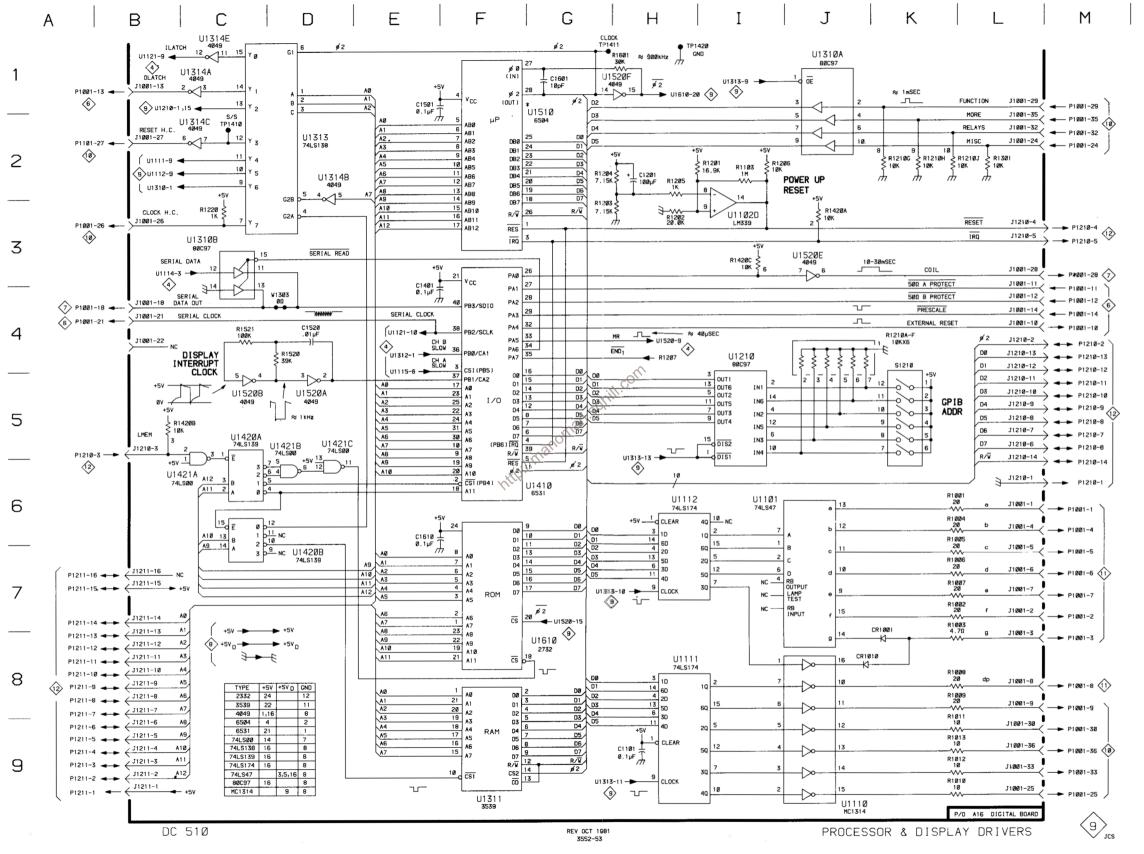


Table 8-12 COMPONENT REFERENCE CHART (see Fig. 8-14)

			OIDOURT CONFIRM DOAL			
CIRCUIT NUMBER	SCHEMATIC LOCATION	BOARD LOCATION	CIRCUIT NUMBER	SCHEMATIC LOCATION	BOARD LOCATION	
C1321	C1	F3	Q1123 Q1124	G2 E3	D4 C4	
DS1004	13	C2	Q1125	F3	C4	
D\$1005	13	B2	Q1126	F2	D4	
DS1104	J3	D2	Q1127	F2	D4	
DS1111	L4	C3	Q1221	G2	E4	
DS1112	L4	D3	Q1222	H1	E4	
DS1113 DS1114	L5 L5	C3 D3	R1321	C1	F4	
DS1114 DS1131	L3 L7	C5	RISZI	Ci	Г4	
DS1131	L7 L7	D5	S1111	C3	C2	
DS1132	L8	C6	S1112	C4	D2	
DS1134	L8	D6	S1113	C5	C3	
DS1203	J3	E2	S11#4	C5	D3	
DS1211	16	E3	S1131	C7	C5	
DS1213	J6	E3	\$1132	C7	D5	
DS1214	15	E3	6 ⁰ \$1133	C8	C5	
DS1221	K4	E4	\$1133 \$1134 \$1211	C8	D5	
DS1222	K4	E4	S1211	C6	E2	
DS1223 DS1224	K5 K6	E5 200	\$1212 \$1213	C5 C6	E2 E3	
DS1224 DS1231	K7	E8/1/10	S1213	C5	E3	
DS1231	K7	E4 E5 E5 E5 r d Off	S1214 S1221	C4	E4	
DS1232	K9	√(1, <u>E</u> 6	S1222	C4	Ē4	
DS1234	K9	E6	S1223	Č5	Ē4	
DS1302	K2	G1	S1224	C6	E4	
DS1303	L1	G1	S1231	C7	E5	
DS1304	L2	G2	S1232	C7	E5	
DS1306	K2	F2	S1233	C9	E5	
DS1311	110	F3	S1234	C9	E5	
DS1313	19 18	F3 G3	S1311	C10	F2	
DS1314 DS1321	18 J4	G3 F4	\$1312 \$1313	C8 C9	G2 F3	
DS 1321	J6	F5	S1313	C8	G3	
DS1325	18	G4	S1321	C4	F4	
DS1331	J7	F5	S1322	C4	G4	
DS1332	J8	G5	S1323	Č6	F4	
DS1333	J9	F6	S1324	C6	G4	
			S1331	C7	F5	
J1321	B1	F4	S1332	C8	<u>G</u> 5	
J550	B1	Chassis	\$1333 \$1334	C9 C9	F5 G5	
P1321	B1	F4				
Q1121	H1	C4	U1121	C2	D4	
Q1121	E3	C4				

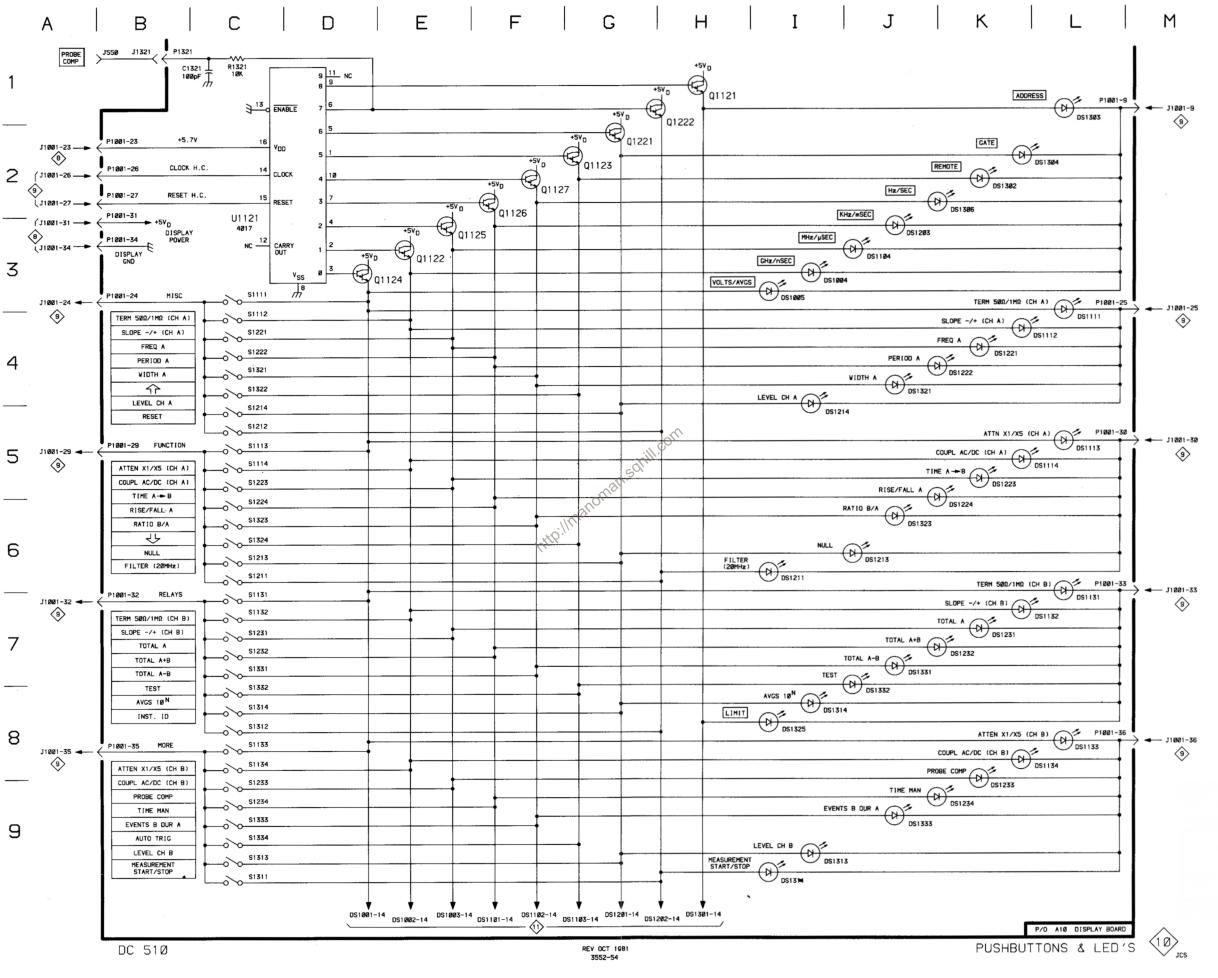
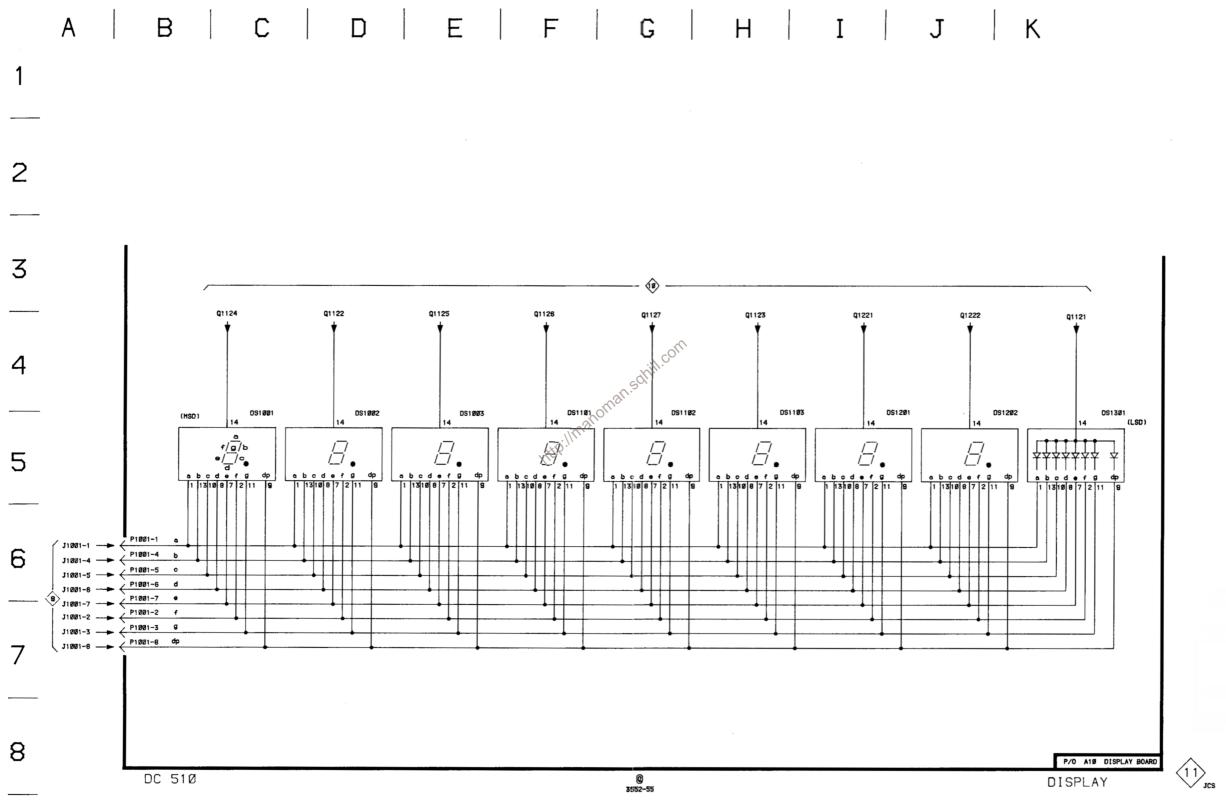


Table 8-13 COMPONENT REFERENCE CHART (see Fig. 8-14)

P/O A10 AS			:111:0		SPLAY (11)
CIRCUIT NUMBER	SCHEMATIC LOCATION	BOARD LOCATION	CIRCUIT	SCHEMATIC LOCATION	BOARD LOCATION
DS1001	C5	B1 anol	DS1201	J5	E1
DS1002 DS1003	D5 E5	BILITION	DS1202 DS1301	K5 L5	E1 F1
DS 1003	F5	C1///	1 23.301		• • •
DS1102	G5	D1	P1001	B6	G2
DS1103	15	D1			



REPLACEABLE MECHANICAL PARTS

PARTS ORDERING INFORMATION

Replacement parts are available from or through your local Tektronix, Inc. Field Office or representative.

Changes to Tektronix instruments are sometimes made to accommodate improved components as they become available, and to give you the benefit of the latest circuit improvements developed in our engineering department. It is therefore important, when ordering parts, to include the following information in your order: Part number, instrument type or number, serial number, and modification number if applicable.

If a part you have ordered has been replaced with a new or improved part, your local Tektronix, Inc. Field Office or representative will contact you concerning any change in part number.

Change information, if any, is located at the rear of this manual.

SPECIAL NOTES AND SYMBOLS

X000 Part first added at this serial number

00X

Part removed after this serial number

Items in this section are referenced by figure and index bers to the illustrations. http:/ numbers to the illustrations.

INDENTATION SYSTEM

This mechanical parts list is indented to indicate item relationships. Following is an example of the indentation system used in the description column.

1 2 3 4 5

Name & Description

Assembly and/or Component Attaching parts for Assembly and/or Component

Detail Part of Assembly and/or Component Attaching parts for Detail Part

Parts of Detail Part Attaching parts for Parts of Detail Part

Attaching Parts always appear in the same indentation as the item it mounts, while the detail parts are indented to the right. Indented items are part of, and included with, the next higher indentation. The separation symbol - - - * - - - indicates the end of attaching parts.

Attaching parts must be purchased separately, unless otherwise specified.

ITEM NAME

In the Parts List, an Item Name is separated from the description by a colon (:). Because of space limitations, an Item Name may sometimes appear as incomplete. For further Item Name identification, the U.S. Federal Cataloging Handbook H6-1 can be utilized where possible.

ABBREVIATIONS

	INCH	ELCTRN	ELECTRON	IN	INCH	SE	SINGLE END
	NUMBER SIZE	ELEC	ELECTRICAL	INCAND	INCANDESCENT	SECT	SECTION
ACTR	ACTUATOR	ELCTLT	ELECTROLYTIC	INSUL	INSULATOR	SEMICOND	SEMICONDUCTOR
ADPTR	ADAPTER	ELEM	ELEMENT	INTL	INTERNAL	SHLD	SHIELD
ALIGN	ALIGNMENT	EPL	ELECTRICAL PARTS LIST	LPHLDR	LAMPHOLDER	SHLDR	SHOULDERED
AL	ALUMINUM	EOPT	EQUIPMENT	MACH	MACHINE	SKT	SOCKET
ASSEM	ASSEMBLED	EXT	EXTERNAL	MECH	MECHANICAL	SL	SLIDE
ASSY	ASSEMBLY	FIL	FILLISTER HEAD	MTG	MOUNTING	SLFLKG	SELF-LOCKING
ATTEN	ATTENUATOR	FLEX	FLEXIBLE	NIP	NIPPLE	SLVG	SLEEVING
AWG	AMERICAN WIRE GAGE	FLH	FLAT HEAD	NON WIRE	NOT WIRE WOUND	SPR	SPRING
BD	BOARD	FLTR	FILTER	OBD	ORDER BY DESCRIPTION	SQ	SQUARE
BRKT	BRACKET	FR	FRAME or FRONT	OD	OUTSIDE DIAMETER	SST	STAINLESS STEEL
BRS	BRASS	FSTNR	FASTENER	OVH	OVAL HEAD	STL	STEEL
BRZ	BRONZE	FT	FOOT	PH BRZ	PHOSPHOR BRONZE	SW	SWITCH
BSHG	BUSHING	FXD	FIXED	PL	PLAIN or PLATE	т	TUBE
CAB	CABINET	GSKT	GASKET	PLSTC	PLASTIC	TERM	TERMINAL
CAP	CAPACITOR	HDL	HANDLE	PN	PART NUMBER	THD	THREAD
CER	CERAMIC	HEX	HEXAGON	PNH	PAN HEAD	THK	THICK
CHAS	CHASSIS	HEX HD	HEXAGONAL HEAD	PWR	POWER	TNSN	TENSION
CKT	CIRCUIT	HEX SOC	HEXAGONAL SOCKET	RCPT	RECEPTACLE	TPG	TAPPING
CQMP	COMPOSITION	HLCPS	HELICAL COMPRESSION	RES	RESISTOR	TRH	TRUSS HEAD
CONN	CONNECTOR	HLEXT	HELICAL EXTENSION	RGD	RIGID	V	VOLTAGE
COV	COVER	HV	HIGH VOLTAGE	RLF	RELIEF	VAR	VARIABLE
CPLG	COUPLING	IC	INTEGRATED CIRCUIT	RTNR	RETAINER	W/	WITH
CRT	CATHODE RAY TUBE	ID	INSIDE DIAMETER	SCH	SOCKET HEAD	WSHR	WASHER
DEG	DEGREE	IDENT	IDENTIFICATION	SCOPE	OSCILLOSCOPE	XFMR	TRANSFORMER
DWR	DRAWER	IMPLR	IMPELLER	SCR	SCREW	XSTR	TRANSISTOR

Replaceable Mechanical Parts—DC 510

CROSS INDEX-MFR. CODE NUMBER TO MANUFACTURER

Mfr. Code	Manufacturer	Address	City, State, Zip
000ВВ	BERQUIST COMPANY	4350 WEST 78TH	MINNEAPOLIS, MN 55435
00779	AMP, INC.	P O BOX 3608	HARRISBURG, PA 17105
05820	WAKEFIELD ENGINEERING, INC.	AUDUBON ROAD	WAKEFIELD, MA 01880
22526	BERG ELECTRONICS, INC.	YOUK EXPRESSWAY	NEW CUMBERLAND, PA 17070
49671	RCA CORPORATION	30 ROCKEFELLER PLAZA	NEW YORK, NY 10020
71279	CAMBRIDGE THERMIONIC CORP.	445 CONCORD AVE.	CAMBRIDGE, MA 02138
71785	TRW, CINCH CONNECTORS	1501 MORSE AVENUE	ELK GROVE VILLAGE, IL 60007
73803	TEXAS INSTRUMENTS, INC., METALLURGICAL		
	MATERIALS DIV.	34 FOREST STREET	ATTLEBORO, MA 02703
78189	ILLINOIS TOOL WORKS, INC.		
100000	SHAKEPROOF DIVISION	ST. CHARLES ROAD	ELGIN, IL 60120
80009	TEKTRONIX, INC.	P O BOX 500	BEAVERTON, OR 97077
83385	CENTRAL SCREW CO.	2530 CRESCENT DR.	BROADVIEW, IL 60153
93907	TEXTRON INC. CAMCAR DIV	600 18TH AVE	ROCKFORD, IL 61101



Fig. & Index		Serial/Model No.	(1. 4. (200)		3. 4. 001040		Mfr	*** D N
No.	Part No.	Eff Dscont	Qty	1 2 3 4 5	Nam	e & Description	Code	Mfr Part Number
1-1	337-2807-02		2	SHIELD, EL	EC:SIDE, PLUG-	IN UNIT	80009	337-2807-02
-2	105-0932-00		4	LATCH, PAN	EL:SIDE		80009	105-0932-00
	214-3364-00		4	FASTENER,	LATCH: ACETAL,	SIL GRAY	80009	214-3364-00
-3	334-4224-00	9	1	MARKER, ID	ENT: GPIB INST	RUCTION	80009	334-4224-00
-4	333-2670-00		1	PANEL, REA	R:		80009	333-2670-00
					(ATTACHIN	NG PARTS)		
-5	213-0868-00		2	SCREW, TPG	,TF:6-32 X 0.3	375 L, FILM, STEEL	93907	OBD
-6	386-3657-01		2	SUPPORT, P	LUG IN:		93907	OBD
					1	t		
-7	426-1801-00		1	FR SECT, P	LUG-IN: TOP		80009	426-1801-00
					(ATTACHIN	NG PARTS)		
-8	211-0541-00		2	SCREW, MAC	HINE: 6-32 X 0.	25"100 DEG,FLH STL	83385	OBD
						t		
-9	214-1061-00		1	SPRING, GR	OUND: FLAT		80009	214-1061-00
-10	351-0672-00		6		BOARD: PLASTIC		80009	351-0672-00
-11	407-2556-00		2		NGLE: CIRCUIT I		80009	407-2556-00
					(ATTACHIN			
-12	211-0007-00		2	SCREW, MAC	HINE: 4-40 X 0.	.188 INCH, PNH STL	83385	OBD
-13	211-0105-00		2	SCREW, MAC	HINE:4-40 X 0.	.188,100 DEG,FLH STL	83385	OBD
						*		
-14			1	CKT BOARD	ASSY: ANALOG (S	SEE A12 REPL)		
			2	. CONNECT	OR.RCPT:(SEE A	112J500,J510 REPL)		
-16	337-2850-01				ELEC: CIRCUIT E		80009	337-2850-01
-17					경기가 있다면 내가 있습니다. 그런 가장이 되었습니다.	112K1500,K1510,K1511,		
			-			600,K1610,K1611,K1620,		
			-		K1631 REPL)			
					(ATTACHIN	G PARTS)		
-18	213-0848-00		24	. SCREW,T	PG, TF:0-40 X		93907	OBD
-19	214-1291-00		2	. HEAT SI).72 OD X 0.375"H	05820	207-AB
-20			3			A12TP1020, TP1310,		
			-	. TP1330				
-21	136-0260-02		2			CIRCUIT, 16 DIP, LOW CLE	71785	133-51-92-008
-22	136-0269-02		1			CIRCUIT, 14 DIP, LOW CLE	73803	CS9002-14
-23	136-0514-00		3	. SKT.PL-	IN ELEC:MICRO	CIRCUIT, 8 DIP	73803	CS9002-8
-24			2	CONN, RC	PT, ELEC: (SEE A	12J1130,J1201 REPL)		
-25	136-0252-07		154	SOCKET,	PIN CONN:W/O D	IMPLE	22526	75060-012
-26						12J1010,J1102,J1510,		
				. J1520	REPL)	A A A		
-27			1	. DELAY L	INE, ELEC: (SEE	A12J1100,J1101 REPL)		
					(ATTACHIN	IG PARTS)		
-28	211-0173-00		1	. SCREW, M.	ACHINE:4-40 X	0.375,FLH,STL	83385	OBD
-29	210-0551-00		1	. NUT, PLA	IN, HEX.: 4-40 X	0.25 INCH, STL	83385	OBD
					*		Ngt Works	
-30	337-2852-01		1			SOARD W/SPRING		337-2852-01
	337-2851-00		1		ELEC:CIRCUIT E		80009	337-2851-00
-32			1			112J1230,J1400,		
			-	. J1420		700 WAS PAIN W/VE	P200000000	12/2/2 12/2/207 (200)
-33	175-3448-00				Y,RF:50 OHM CO	강하루 바다 전에 가지 아니다 하네요	80009	175-3448-00
			-) TO A12J1201)		100000000000000000000000000000000000000	
-34	175-3449-00				Y,RF:50 OHM CO		80009	175-3449-00
			-		TO A12J1130)			744 274
-35	175-3450-00				RF:50 OHM CO		80009	175-3450-00
					TO A18J1500)			1000 0000 000
	195-1597-00				TRICAL: 26 AWG,		80009	195-1597-00
					TO A10P1321)		00000	250 0121
2.2	352-0171-00	-010100 -0105			RM CONN: 1 WIRE			352-0171-00
-36		B010100 B010239				X 0.25 X 1.09		366-1851-00
	366-1851-01	B010240	1		H: IVORY GY,0.6	25 X U.25		366-1851-01
-37	333-2746-00		1	PANEL, FROM	TO \$10,000 DO STORES OF THE ST	o pinga)	80009	333-2746-00
	010 0075 55			con toom	(ATTACHIN		02007	ORD
-38			2			.5, TAPTITE, PNH	93907	OBD
	210-1365-00		2	WASHER, FLA	AT:0.141 ID X	U. J THK, AL	80009	210-1365-00

Fig. & Index No.	Tektronix Part No.	Serial/M Eff	odel No. Dscont	Qty	12345		Name & Description		Mfr Code	Mfr Part Number
1-39	334-3965-0	10			PLATE, IDEN	чт∙			80009	334-3965-00
-40	378-0159-0						W/MARKINGS		80009	378-0159-03
					JACK, TIP:		W/ FIARKTROS		71279	
-41	136-0387-0			1	CDDING UIE	OKAI	5 OD V O 5/5 1 V 1/	NO.B	80009	
-42	214-3143-0						5 OD X 0.545 L, X LO	OP	80009	
-43	105-0865-0				BAR, LATCH		A POPUMAT			105-0865-00
-44	105-0866-0			1					80009	105-0866-00
-45	426-1802-0	01		1	FR SECT, PI		OTTOM W/SPRING		80009	426-1802-01
-46	211-0105-0	00		1	SCREW, MACH	HINE:4-4	TACHING PARTS) 0 X 0.188,100 DEG,FI	H STL	83385	OBD
17	251 0672 6			2	CUITE CUT				80009	351-0672-00
-47	351-0672-0			3	GUIDE, CKT				00009	331-0072-00
-48				1		(AT	SPLAY(SEE A10 REPL) TACHING PARTS)		02205	OBD
-49	211-0005-0	00		4	SCREW, MACH		0 X 0.125 INCH, PNH S	STL	83385	OBD
			(*)	-	. CKT BOAR					
-50				1	. TERM SET	r,PIN:(S	EE A10P1001,P1002,P1	321 REPL)		
-51				1	. SWITCH, F	PB ASSY:	(SEE AlOS1312 REPL)			
-52				3	. ACTR ASS	SY, PB: (S	EE A10S1212,S1322,S1	324 REPL)		
-53				1	. ACTR ASS	SY, PB: (S	EE AlOS1334 REPL)			
-54				27	. ACTR ASS	SY, PB: (S	EE A10S1111,S1112,S1	1113,		
				-			132,81133,81134,812			
				-			222, \$1223, \$1224, \$123			
				-			311,81313,81314,8132			
				_			333 REPL)			
-55	386-4581-0			1			333 1101 07		80009	386-4581-00
-56				1			XILIARY(SEE A18 REPI	.)		THE RESIDENCE OF STATE
-57	136-0631-0						9 PIN FEMALE	-6	00779	1-380949-9
-58	136-0499-1			2			:10 CONTACT			4-380949-0
				2	. CONNECTO					3-380949-2
-59	136-0499-0			3			8 CONTACT		00779	30380949-8
-60	136-0499-0							1	00///	30300747 0
-61	124 0050 4			1			:(SEE A18TP1400 REPI	-/-	22526	75060-012
-62	136-0252-0			1			:W/O DIMPLE		22320	75000 012
-63				1			(SEE A18J1500 REPL)		20000	266-0156-62
-64	344-0154-0			4	. CLIP KEE	ECTRICAL	:FUSE,CKT BD MT	(li peni)	80009	344-0154-03
-65				1			EE A18J1510,J1511,J1	OII KEPL)	00770	E201E2 0
-66	131-0993-0			2			WIRE BLACK		00779	530153-8
-67							SEE A18Y1530 REPL)			
				1=0	. (OPTION		TACHING PARTS)			
-68	211-0097-0	00		2	SCREW MA		-40 X 0.312 INCH, PNI	STI.	83385	OBD
-00	211-0097-0			-				. 515	03303	
60							25 ID X 0.25 OD X 0.	110 ID	80009	361-0548-00
-69	361-0548-0			-	. (OPTION	01 ONLY)	IIIO ID	00007	301 0340 00
							*			
-70							EE A18U1430 REPL)			
				-	. (OPTION		District of the second of the party of the p			
					CORPUL NA		TACHING PARTS)	CTT	02205	OPD
-71	211-0097-0			1			-40 X 0.312 INCH, PNI	SIL	83385	OBD
-				-	. (OPTION			IC TOMOD	1.0471	DP 1274
-72	210-1178-0			2			:FOR MTG TO-220 TRAN	SISIOK	49671	DF 137A
				-	. (OPTION				00000	7402 00mm E1
-73	342-0355-0			1			:TRANSISTOR, SILICONE	RUBBER	осовв	7403-09FR-51
				-	. (OPTION					
						8	*			
-74				1	. TRANSIST		A18Q1332 REPL)			
							TACHING PARTS)			
-75	211-0097-0	00		1	. SCREW, MA	ACHINE: 4	-40 X 0.312 INCH, PNE	STL	83385	
-76	210-1178-0						:FOR MTG TO-220 TRAM			DF 137A
-77	342-0355-0	00		1	. INSULATO		:TRANSISTOR, SILICONE	RUBBER	000BB	7403-09FR-51
							*			19818987 - 188181888 - 188181 - 188181 - 188181 - 188181 - 188181 - 188181 - 188181 - 188181 - 188181 - 188181
-78	214-3134-0	00		1	. HT SK,MI	ICROCKT:	TO-220,AL		80009	214-3134-00
	Account West Code (1)						TACHING PARTS)			
-79	211-0097-0	00		1	. SCREW, MA		-40 X 0.312 INCH, PNE	STL	83385	OBD
							*			
-80	136-0514-0	00		4	. SKT, PL-	IN ELEC:	MICROCIRCUIT, 8 DIP			CS9002-8
-81	136-0269-0			5	. SKT PL-	IN ELEK:	MICROCIRCUIT, 14 DIP,	LOW CLE	73803	CS9002-14
-82	136-0260-0			9	. SKT PL-	IN ELEK:	MICROCIRCUIT, 16 DIP	LOW CLE	71785	133-51-92-008
100		200								

Fig. & Index	Tektronix	Serial	/Model No.						Mfr	
No.	Part No.	Eff	Dscont	Qty	1	2 3	4 5	Name & Description	Code	Mfr Part Number
1-83				1	CI	T E	BOARD	ASSY:DIGITAL(SEE A16 REPL)		
-84	4 129-0425-00		2	•	. SPACER, POST: 0.90 L X 0.25 HEX (ATTACHING PARTS)		80009	129-0425-00		
-85	211-0678-00		2	*	SCF	R, ASSE	M WSHR:4-40 X 0.281 L,PNH STEEL	78189	OBD	
-86	344-0154-03		4		CLI	P,ELE	CTRICAL: FUSE, CKT BD MT	80009	344-0154-03	
-87			3		TER	M TES	T POINT: (SEE A16TP1410, TP1411,			
				-		TF	21420	REPL)		
-88	136-0694-00		1		SKT	PL-I	N ELEK:MICROCIRCUIT, 28 CONTACT	73803	CS9002-28	
-89	136-0621-00		1		SOC	KET, P	LUG-IN:22 CONTACT	73803	CS9002-22	
-90	136-0578-0	00		1		SKI	PL-I	N ELEK: MICROCKT, 24 PIN, LOW PROFILE	73803	C S9002-24
-91	136-0623-	00		1		SOC	KET, P	LUG-IN:40 DIP, LOW PROFILE	73803	CS9002-40
-92	136-0269-0	02		6		SKT	PL-I	N ELEK: MICROCIRCUIT, 14 DIP, LOW CLE	73803	CS9002-14
-93	136-0260-	02		19				N ELEK: MICROCIRCUIT, 16 DIP, LOW CLE	71785	133-51-92-008
-94				2				R,RCPT:(SEE A16J1001 REPL)		
-95				1		CON	IN , RCP	T,ELEC:(SEE A16J1210,J1211 REPL)		
	198-4522-6	00		1				,ELEC:	80009	198-4522-00
				-		(FF	ROM Al	6 TO A18J1611)		
	352-0162-0	05		1		. 0	CONN B	ODY, PL, EL: 4 WIRE GREEN	80009	352-0162-05

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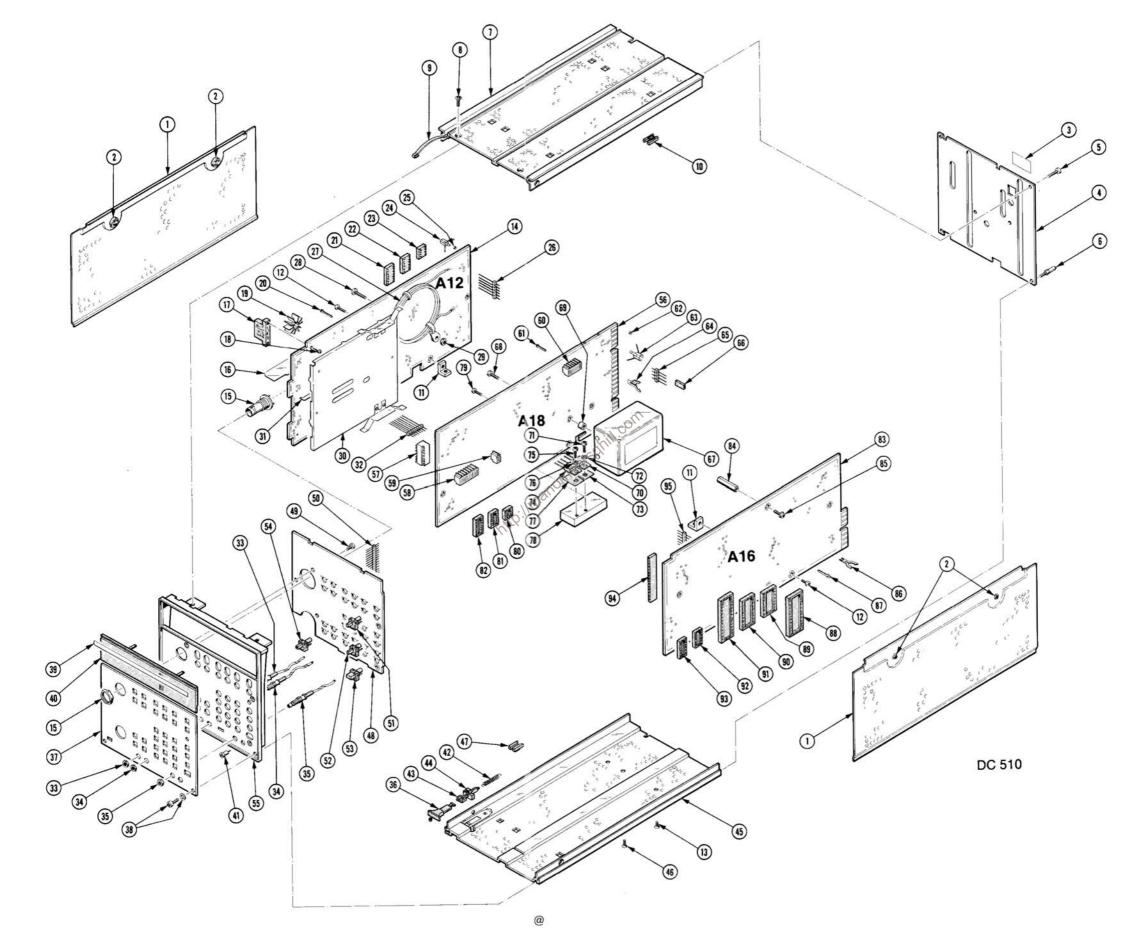


Fig. & Index No.	Tektronix Part No.	Serial.	/Model No. Dscont	Otv	1 2 3 4 5	Name & Description	Mfr Code	Mfr Part Number
140.	rait ito.		Dacont	uly	12010	A CONTRACTOR OF THE STATE OF TH		
						ACCESSORIES		
	070-3552-	01		1	MANUAL, TECH:	INSTRUCTION	80009	070-3552-01
070-3553-00			1	MANUAL, TECH:	REFERENCE GUIDE	80009	070-3553-00	
	012-0532-	00		1	CABLE, INTCON	:50 OHM COAX,42.0 L	80009	012-0532-00
						OPTIONAL ACCESSORIES		
	010-6125-	01		1	PROBE, COUNTER	R:P6125,1.5 METER	80009	010-6125-01

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MANUAL CHANGE INFORMATION

At Tektronix, we continually strive to keep up with latest electronic developments by adding circuit and component improvements to our instruments as soon as they are developed and tested.

Sometimes, due to printing and shipping requirements, we can't get these changes immediately into printed manuals. Hence, your manual may contain new change information on following pages.

A single change may affect several sections. Since the change information sheets are carried in the manual until all changes are permanently entered, some duplication may occur. If no such change pages appear following this page, your manual is correct as printed.

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MANUAL CHANGE INFORMATION

Date: 10-7-81 Change Reference: C2/1081

Product: DC 510 UNIVERSAL COUNTER/TIMER Manual Part No.: 070-3552-01

DESCRIPTION

All references to the SA 501 in this manual now apply to the 067-1090-00 Signature Analyzer.

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MANUAL CHANGE INFORMATION

Date: ____10-20-81 ____ Change Reference: ____C3/1081

Product: DC 510 UNIVERSAL COUNTER/TIMER Manual Part No.: 070-3552-01

DESCRIPTION

Pilot Changes #13 and #14

REPLACEABLE ELECTRICAL PARTS LIST CHANGE

CHANGE TO:

(EFFECTIVE SN B010470 - Pilot Change #13)

A18C1331

281-0773-00 CA

CAP., FXD, CER DI:0.01UF, 10%, 100V

(located on the AUXILIARY board and shown on diagram 8)

DIAGRAM (9) PROCESSOR AND DISPLAY DRIVERS - Partial

(EFFECTIVE SN B020000 - Pilot Change #14)

Use a 74LS00 inverter in the clock (\$\psi 2\$) instead of a CMOS 4049

